

2012 -  $\frac{50M}{95M} \frac{125M}{}$

2013 -  $\frac{50M}{85M} \frac{139M}{}$

### Syllabus:

- ✓ → Electrons & Holes in Semiconductors
- ✓ → Carrier Statistics
- ✓ → Mechanism of Current flow in a Semiconductor
- ✓ → Hall Effect
- ✓ → p-n junction theory
  - Different types of diodes and their characteristics
- ✓ → Bipolar Junction Transistor (BJT)
  - Field Effect Transistor (FET)
  - Power Switching Devices SCR, GTOs, Power MOSFET (only for IES)
  - Basics of IC:
    - Bipolar, MOS & CMOS
  - Basics of Opto-Electronic Devices (only for IES)

Semiconductor Physics

## Electronic Device:

- It is a device in which conduction takes place by the movement of electrons through a semiconductor.
- Electronic Devices are capable of performing various functions like amplification (magnifying the signals), rectification (converting AC to DC), generation (Converting DC power to AC power) and control (switching).
- Oscillator - Low power, High frequency
- Inverter - High Power, Low frequency.

## Matter:

- It is anything which has certain weight and occupies some space.
- Matter is divided into molecules without changing its identity.
- Molecules are again subdivided into smallest minute particles called atoms.

## Electric Field Intensity / Electric field (E & E):

It is defined as force per unit positive charge that would be experienced by a stationary point charge at a given location in the field.

$$E = F/q \rightarrow \text{volts}/\text{C} \text{ or } \text{volts}/\text{m}$$

$$PE = QV = F.d, \text{ J rev}$$

$$1 \text{ eV} = 1.6 \times 10^{-19} \text{ J}$$

## Nature/Structure of Atom:

### 1. Rutherford Atomic Model: (1911)

- Atom consists of central core called nucleus which is positively charged.
- Negatively charged electrons orbit around the nucleus.
- The charge of the proton is positive and electron is negative. Therefore, atom is electrically neutral.
- According to Coulomb's law, the attractive force exists between electrons and protons and is given by

$$F = \frac{-e^2}{4\pi\epsilon_0 r^2} \quad \textcircled{1}$$

$e$  is the charge

$\epsilon_0$  is the permittivity

- This attractive force is compensated by centripetal force i.e,

$$F = -\frac{mv^2}{r} \quad \textcircled{2}$$

$m$  is the mass of  $e^-$

$r$  is the radius

$v$  is the velocity of  $e^-$

$$\frac{mv^2}{r} = \frac{e^2}{4\pi\epsilon_0 r^2}$$

$$\Rightarrow \boxed{mv^2 = \frac{e^2}{4\pi\epsilon_0 r}} \quad \textcircled{3}$$

- The energy of  $e^-$  is the sum of PE and KE.

$$W = KE + PE$$

As the  $e^-$  approaches nucleus, energy of  $e^-$  decreases.

As the  $e^-$  moves away from nucleus, energy of  $e^-$  increases.

Drawback:

It could not explain the stability of the atom.

2. Bohr Atomic Model: (1913)

→ When  $e^-$  orbiting in the stationary energy levels, atom will not radiate any energy.

→ When  $e^-$  moves from one energy level to the another energy level, then atom will radiate or absorb energy.

→ Radiated/Absorbed energy  $\omega_2 - \omega_1 = hf$

$$\Rightarrow \omega_n - \omega_{n-1} = hf ; h = 6.625 \times 10^{-34} \text{ J-sec}$$

where  $h$  is Planck's constant

$f$  is the frequency of radiation

→ The energy of the stationary states/energy levels can be calculated by equating angular momentum of  $e^-$  to integral multiples of  $\hbar/2\pi$

$$\Rightarrow mvr = \frac{nh}{2\pi} \quad \text{where } n = 1, 2, 3, \dots$$

$$v = \frac{nh}{2\pi mr} \quad \text{--- (5)}$$

Substitute (5) in (3)

$$W = \frac{-e^4 m}{8 \epsilon^2 h^2 n^2}$$

i.e, Energy levels are not equidistant.

$$W = \frac{-me^4}{8\epsilon^2 h^2} \cdot \frac{1}{n^2}$$

$$W_n = \frac{-me^4}{8\epsilon^2 h^2} \cdot \left(\frac{1}{n^2}\right)$$

$$\rightarrow \omega_2 - \omega_1 = hf$$

$$\Rightarrow \text{frequency of radiation } f = \frac{\omega_2 - \omega_1}{h}$$

$$\omega_2 - \omega_1 = \frac{me^4}{8\epsilon^2 h^2} \left[ \frac{1}{n_1^2} - \frac{1}{n_2^2} \right]$$

$$f = \frac{me^4}{8\epsilon^2 h^3} \left[ \frac{1}{n_1^2} - \frac{1}{n_2^2} \right]$$

$$\lambda = \frac{c}{f} \Rightarrow \lambda = \frac{c}{\frac{me^4}{8\epsilon^2 h^3} \left[ \frac{1}{n_1^2} - \frac{1}{n_2^2} \right]}$$

$$\lambda = \frac{c}{\frac{\omega_2 - \omega_1}{h}} = \frac{ch}{\omega_2 - \omega_1} = \frac{ch}{\Delta\omega}$$

$$\text{Unit of } \lambda = \frac{\text{cm/sec} \cdot \cancel{\text{J/sec}}}{\cancel{\text{J}}} \quad (8) \quad \frac{\text{m/s} \cdot \text{J}}{\text{J}}$$

$$\lambda = \text{cm}$$

$$\lambda = \text{m}$$

$$1 \text{ eV} = 1.6 \times 10^{-19} \text{ J}$$

$$1 \text{ J} = \frac{1 \text{ eV}}{1.6 \times 10^{-19}}$$

$$\Rightarrow \lambda = \frac{ch / 1.6 \times 10^{-19}}{E_2 - E_1} = \frac{ch / 1.6 \times 10^{-19}}{\Delta E} = \frac{\text{cm/s} \times \cancel{\text{J/sec}}}{\cancel{\text{eV}}} = \frac{\text{cm}}{\text{m}}$$

$$\lambda = \frac{12400 \times 10^{-10}}{E_2 - E_1} m. = \frac{12400}{E_2 - E_1} \text{ Å}^{\circ}$$

$$\text{Å}^{\circ} = 10^{-10} \text{ m}$$

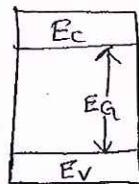
$$\boxed{\lambda = \frac{12400}{E_2 - E_1} \text{ Å}^{\circ} \& \frac{12400}{\Delta E} \text{ Å}^{\circ} / (2012 IES)}$$

E in eV

For Semiconductors,

$$E_G = E_C - E_V = hf$$

$$\lambda = \frac{12400}{E_C - E_V} \text{ Å}^{\circ} \& \lambda = \frac{12400}{E_G} \text{ Å}^{\circ}$$



→ The wavelength of the light radiated from GaAs LASER is  $8670 \times 10^{-10} \text{ m}$ . Calculate Energy gap of GaAs at room temperature

$$\lambda = \frac{12400}{\Delta E} \text{ Å}^{\circ}$$

$$8670 \text{ Å}^{\circ} = \frac{12400 \text{ Å}^{\circ}}{\Delta E}$$

$$\Rightarrow \Delta E = \frac{12400}{8670} = \underline{\underline{1.43 \text{ eV}}}$$

\*  $E_G$  for GaAs at room temperature is  $1.43 \text{ eV}$ .

→ A photon of wavelength  $1400 \text{ Å}^{\circ}$  absorbed by mercury and it radiated two photons out of which one is having a wavelength of  $1850 \text{ Å}^{\circ}$ . Calculate the wavelength of the second photon.

$$E_{G_2} = 8.857 - 6.7 \\ = 2.15 \text{ eV}$$

$$\lambda_{EC_2} = \frac{12400}{2.15} = 5756 \text{ Å}^{\circ}$$

#### \* Energy Band Theory:

1S  $\xrightarrow{2e^-}$   
2 states

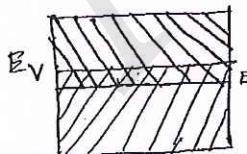
2S  $\xrightarrow{2e^-}$   
2 states

2P  $\xrightarrow{6e^-}$   
6 states

$$E_G = E_C - E_V$$

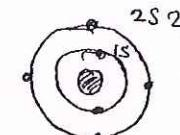
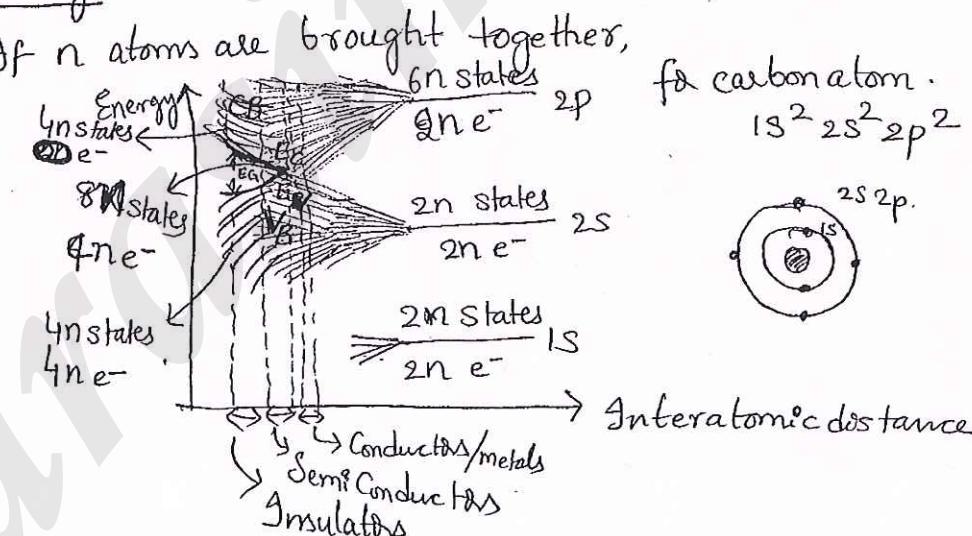
$\rightarrow$  Metals/Conductors

$$E_G = 0$$



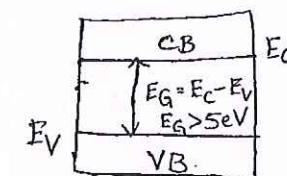
$\rightarrow$  No holes are present.

$\rightarrow$  Ex: Gold, Silver, Cu, Al



Insulator

$$E_G > 5 \text{ eV}$$

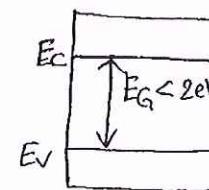


$\rightarrow$  Ex: Diamond ( $E_G = 6 \text{ eV}$ )

Porcelain, Glass,  
Quartz, Rubber,  
Bakelite

Semiconductor

$$E_G \approx 1 \text{ eV} (\text{a}) \quad E_G < 2 \text{ eV}$$



$\rightarrow$  Ex: Si, Ge

$\text{mho/cm}$  (or)  $\text{mho/m}$

$\text{S/cm}$  (or)  $\text{S/m}$ .

$$E_G = 1.21 - 3.6 \times 10^{-4} T \text{ eV at } T_K$$

where  $T$  is temperature in K.

Conductor

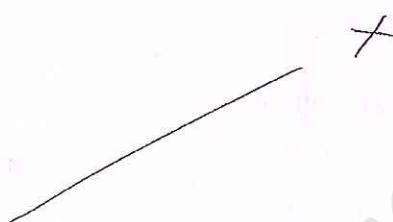
Conductivity:  $10^3$  to  $10^7 \text{ S/m}$

Insulator

Conductivity:  $10^{-20}$  to  $10^{-12} \text{ S/m}$

Semi Conductor

Conductivity:  $10^{-7}$  to  $10^4 \text{ S/m}$



Germanium:

$$E_{G_0} = 0.785 \text{ eV at } 0\text{K}$$

$$E_G = 0.72 \text{ eV at } 300\text{K}$$

$\Rightarrow E_G$  depends on temperature

As  $T \uparrow$ ,  $E \downarrow$  by  $2.23 \times 10^{-4} \text{ eV/K}$

$$E_G = 0.785 - 2.23 \times 10^{-4} T \text{ eV}$$

$$\text{Ge: } E_G(T) = 0.785 - 2.23 \times 10^{-4} T \text{ eV}$$

$$\text{Si: } E_G(T) = 1.21 - 3.6 \times 10^{-4} T \text{ eV}$$

$$E_G^{(T)} = E_{G_0} - \beta T$$

Si:

$$E_{G_0} = 1.21 \text{ eV}$$

$$\beta = 3.6 \times 10^{-4}$$

$$\text{Ge: } E_{G_0} = 0.785 \text{ eV}$$

$$\beta = 2.23 \times 10^{-4}$$

785 eV

2.23

II	III	IV	V	VI
B	C	N		
Al	Si	P	S	
Zn	Ga	Ge	As	Se
			Sb	Te
10/7/13 Cd	In		Bi	

### Classification of semiconductors based on no. of Elements:

1. Elementary SC ex: Si, Ge

2. Compound SC:

i) Two element (Binary) Compound SC.

Ex: GaAs, GaP, ~~AlAs~~, InP (Compounds formed with III-V groups)

CdS, CdSe, ZnS, ZnSe (II-VI Compounds)

SiC, SiGe (IV-IV Compounds)

ii) Three element (Ternary) Compound SC.

Ex: GaAsP, AlGaAs

iii) Four element (Quaternary) Compound SC

Ex: GaAlAsP, InGaAsP

### Atomic Concentration:

It represents no. of atoms per cubic volume.

$$AC = \frac{A_0 d}{A} \text{ atoms/cm}^3$$

where  $A_0$  is Constant Avogadro's number =  $6.023 \times 10^{23}$  molecule/mole

d is the density

A is the atomic weight

Electron concentration (n)

Density = 5.32 g/cm<sup>3</sup>

$$= A \cdot C \times \text{no: of free } e^-/\text{atom.}$$

$$A \cdot C = \frac{6.023 \times 10^{23} \times 5.32}{72.6} \text{ atoms/cm}^3$$

Ex: If Si AC = 1000 atoms/cm<sup>3</sup>  
and each atom has 1 free  $e^-$ .

$$\text{then } n = \frac{1000 \text{ atoms}}{\text{cm}^3} \times 1 e^-/\text{atom} \\ = 1000 e^-/\text{cm}^3.$$

→ The specific gravity of Tungsten is 18.8 gm/cm<sup>3</sup> and its atomic weight is 184. If each atom is having 2 free  $e^-$   
Calculate n (e<sup>-</sup> concentration).

$$AC = \frac{A \cdot d}{A} = \frac{6.023 \times 10^{23} \times 18.8}{184} \\ = 6.154 \times 10^{22} \text{ atoms/cm}^3$$

$$n = AC \times \text{no: of free } e^-$$

$$= 6.154 \times 10^{22} \times 2$$

$$= 1.23 \times 10^{23} e^-/\text{cm}^3.$$

$$n = 1.23 \times 10^{23}/\text{cm}^3$$

### Electron Gas theory:

According to  $e^-$  gas theory of a metal,  $e^-$  are in continuous motion. Their direction of flight being changed when they collide with the heavy ions.

obtained by the electron under the influence of the applied electric field is called drift velocity or drift speed.

→ The drift velocity is proportional to applied electric field.

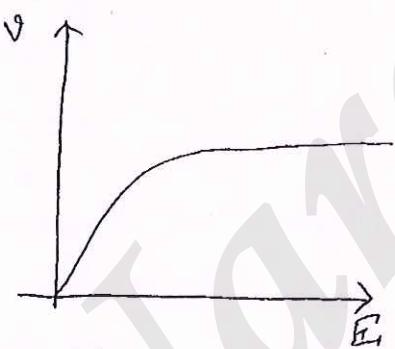
$$v \propto E$$

$$v = \mu E$$

where  $\mu$  is the mobility of electrons.

$$\Rightarrow \text{Mobility } \mu = \frac{v}{E} \quad \frac{\text{m/sec}}{\text{V/m}} = \frac{\text{m}^2}{\text{V sec}}$$

$$\frac{\text{cm/sec}}{\text{V/cm}} = \frac{\text{cm}^2}{\text{V sec}}$$



$v$  is not proportional to all the values of  $E$ , it is proportional to only a set of values of  $E$ .

→ Mobility depends on temperature and electric field.

Mobility wrt temperature:

As temperature increases, mobility decreases. (due to scattering)

### Scattering

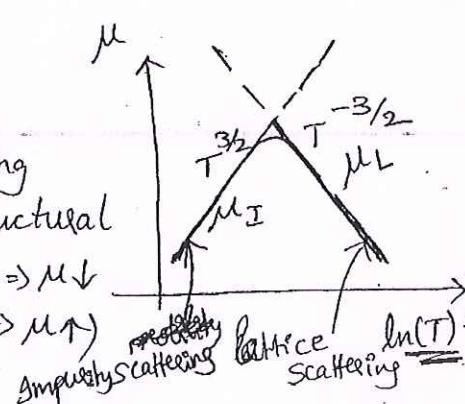
Lattice scattering  
(As temp↑ vibration ↑ mobility ↓)

$$\mu_L \propto T^{-3/2}$$

Impurity Scattering  
(because of structural defects, as  $T \downarrow \Rightarrow \mu \downarrow$ )

$$\mu_I \propto T^{3/2} \quad T \uparrow \Rightarrow \mu \uparrow$$

$$\frac{1}{\mu} = \frac{1}{\mu_L} + \frac{1}{\mu_I}$$



## Mobility wrt E :

$\mu$ : constant for  $E < 10^3 \text{ V/cm}$

$\mu \propto E^{-\frac{1}{2}}$  for  $10^3 \text{ V/cm} < E < 10^4 \text{ V/cm}$

$\mu \propto E^{-1}$  for  $E > 10^4 \text{ V/cm}$

$$v = \mu E$$

$v$  = Drift Velocity

$\mu$  = Mobility of an  $e^-$

$$v_n = \mu_n E \quad (\text{for } e^-)$$

$$v_p = \mu_p E \quad (\text{for holes})$$

\* Because of interaction b/n atoms, there is a deviation in the mass of  $e^-$  and it is called effective mass of electron.

$m_n$  = Effective mass of  $e^-$

Ge      Si      GaAs

$$m_n = 0.55m \quad 1.08m \quad 0.067m$$

$$m_p = 0.37m \quad 0.56m \quad 0.48m$$

$$v_p = \mu_p E \Rightarrow \mu_p = \frac{v_p}{E} = \frac{e \tau_{cp}}{m_p} = \frac{e \tau_{sc}}{m_p}$$

$\tau_{cp}$  = mean time b/n collisions for holes

$\tau_{sc}$  = scattering time

$m_p$  = Effective mass of hole

$$\begin{aligned} v_n &= \mu_n E \Rightarrow \mu_n = \frac{v_n}{E} \\ &= \frac{e \tau_{cn}}{m_n} \\ &= \frac{e \tau_{sc}}{m_n} \end{aligned}$$

where  $e$  is charge of  $e^-$

$\tau_{cn}$  is mean time between collisions for electrons

$m_n$  is effective mass of the electron.

$\tau_{sc}$  is scattering time

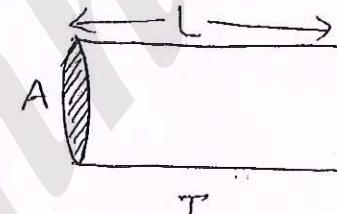
Conductivity and Current Density of a Metal:  $\mu_n = 8500 \text{ cm}^2/\text{V-sec}$

$n = e^-$  concentration,  $e^-/\text{m}^3$  &  $e^-/\text{cm}^3$

$N = \text{Total no: of } e^- \text{ & no: of } e^-, e^-$

$$N = n \times \text{volume} = e^-/\text{m}^3 \times \text{m}^3, e^-$$
$$= e^-/\text{cm}^3 \times \text{cm}^3, e^-$$

$$n = \frac{N}{\text{Volume}}, e^-/\text{m}^3 \text{ & } e^-/\text{cm}^3$$



T = Time taken by carriers to move from one end to other end

$$\text{Drift Velocity } (v) = \frac{L}{T}$$

$$\Rightarrow v = \frac{L}{T} \quad \text{--- (1)}$$

$$\text{Current } (I) = \frac{Q}{T} = \frac{Av}{T} = \frac{Ne}{T}, \text{ where } q \text{ is the charge of } e^-$$

$$I = \frac{Ne}{T} = \frac{Nev}{T} \quad \text{--- (2)}$$

$$\text{Current Density } J = \frac{I}{A} = \frac{Ne}{TA} = \frac{Nev}{TA} \quad \text{--- (3)}$$

$$\text{From (1), } T = \frac{L}{v}$$

$$\text{in (3)} \Rightarrow J = \frac{Ne}{\frac{L}{v} A} = \frac{Nev}{LA} = \underbrace{\frac{LA}{n}}_{N} \cdot ev$$

$$J = nev = nqv$$

$$J = ne\mu E = nq\mu E$$

$$J = n\mu eE = n\mu v E$$

### Resistivity of a metal (J).

$$\rho = \frac{1}{n} \frac{1}{\tau e M} = \frac{1}{n \mu q}, \text{ ohm-cm} \& \text{ ohm-m}$$

### Current Density of a metal (J):

$$J = n \mu e E = n \mu q V = n e v = n q v, \text{ A/cm}^2 \& \text{ A/m}^2$$

### Current (I):

$$I = J \cdot A = n \mu e E A = n q \mu E A \\ = n e v A = n q v A, \text{ Amp}$$

All these are Drift equations.

→ A specimen of a metal having square cross section area of  $3\text{mm} \times 3\text{mm}$  and its length 5cm. When a PD of 1V applied across its length gives a current of 6mA. Calculate concentration of  $e^-$ , drift velocity of  $e^-$  and no: of  $e^-$ . (Assume  $M = 1300 \text{ cm}^2/\text{V-sec}$ )

$$A = 9 \text{ mm}^2 = 9 \times 10^{-2} \text{ cm}^2$$

$$L = 5 \text{ cm}$$

$$V = 1V \Rightarrow E = 1/5 \text{ V/cm}$$

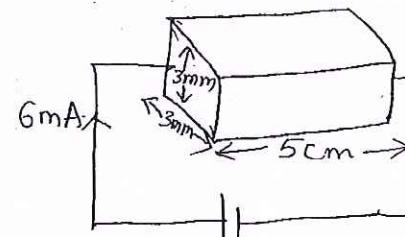
$$I = 6 \text{ mA}$$

$$J = \frac{I}{A} = \frac{6 \times 10^{-3}}{9 \times 10^{-2}} = \frac{2}{3} \times 10^{-1}$$

$$I = n \mu e E A = n \mu e E A$$

$$n = \frac{I}{v q A}$$

$$n = \frac{6 \times 10^{-3}}{260 \times 1.6 \times 10^{-19} \times 9 \times 10^{-2}} = 1.6 \times 10^{15} \text{ e}^-/\text{cm}^3$$



$$v = \mu E$$

$$= 1300 \times \frac{1}{5}$$

$$= 260 \text{ cm/sec}$$

$$= 1.6 \times 10^{15} \text{ e}^-/\text{cm}^3$$

$$dn = \rho_E dE$$

$dn$  = no: of free  $e^-$

$\rho_E$  = Density of  $e^-$

$$\rho_E = f(E) \cdot N(E)$$

where  $f(E)$  = density of states

$N(E)$  = no: of states per cubic volume

$$N(E) = \gamma E^{1/2}$$

$$\text{where } \gamma = \text{constant} = \frac{4\pi}{h^3} \times (2m)^{3/2} \times (1.6 \times 10^{-19})^{3/2}$$

$$\gamma = \frac{4\pi}{h^3} (2m)^{3/2} (1.6 \times 10^{-19})^{3/2}$$
$$= 6.82 \times 10^{27}$$

$E$  is the energy of states

$f(E)$ : Fermi-Dirac probability function

Fermi-Dirac Probability function  $f(E)$ :

$$f(E) = \frac{1}{1 + e^{(E-E_F)/kT}}$$

$f(E)$  represents probability of occupancy of energy states by the electrons.

$E$  is the energy of states

$E_F$  is the fermi level. It represents probability of finding  $e^-$ .

$$E_F > E_F$$

$$f(E) = \frac{1}{1+e^{\alpha}} = 0$$

Probability of filled states =  $f(E)$

Probability of empty states =  $1-f(E)$

$$f_n(E) + f_p(E) = 1$$

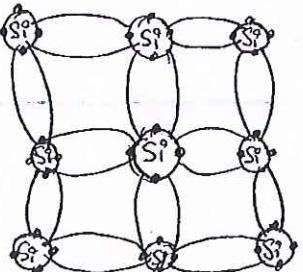
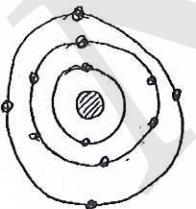
$$\Rightarrow f_p(E) = 1 - f_n(E)$$

→ Fermi-Dirac probability function symmetrical about the fermi level.

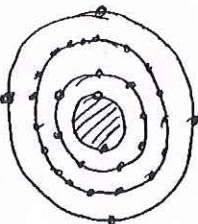
### Semiconductor:

Si : 14

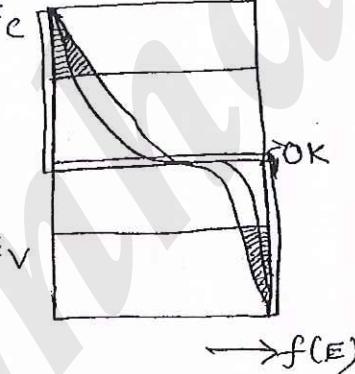
$1s^2 2s^2 2p^6 3s^2 3p^2$



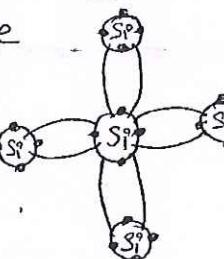
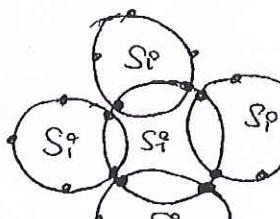
Ge : 32  
 $ns^2 np^6$



Crystalline Structure  
and Tetrahedral shape



No. of  $e^-$  in  $n^{th}$  energy level =  $2n^2$



## Conductivity of a Semiconductor:

$$\sigma = \sigma_p + \sigma_n$$

$$= (n\mu_n) qv + (p\mu_p) qv$$

$$\sigma = (n\mu_n + p\mu_p) qv$$

## Resistivity of a Semiconductor

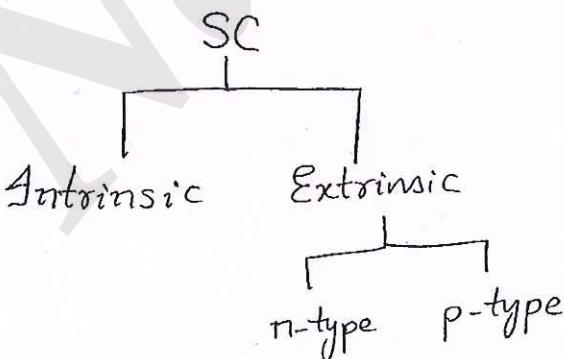
$$\rho = \frac{1}{\sigma} = \frac{1}{(n\mu_n + p\mu_p) qv}$$

## Current Density of a Semiconductor

$$J = (n\mu_n + p\mu_p) qv E$$

$$\text{Current } I = J \times A$$

$$= (n\mu_n + p\mu_p) qv E A$$

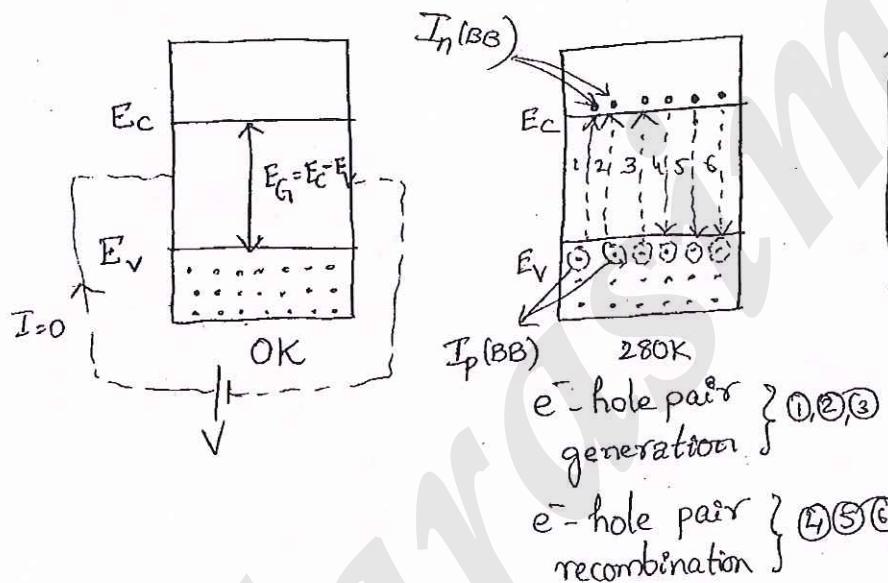
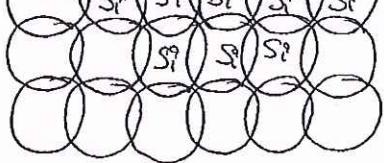


	<u>Ge</u>	<u>Si</u>	<u>GaAs</u>
$m_n =$	0.55m	1.08	0.068
$m_p =$	0.37	0.56	0.48

## Intrinsic Semiconductor:

Pure and non defective semiconductors are called intrinsic semiconductors.

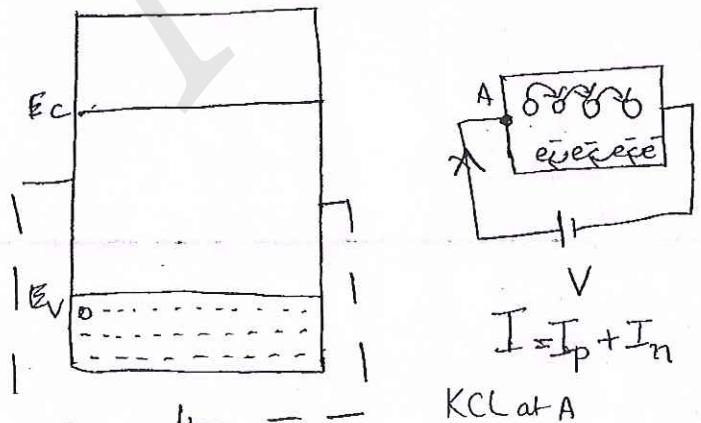
Ex: Pure Si, Pure Ge.



e<sup>-</sup> hole pair generation rate is equal to e<sup>-</sup> hole pair recombination at a given temperature

e<sup>-</sup> concentration = hole concentration in Intrinsic SC.

$$\Rightarrow n = p = n_i \text{ (Intrinsic concentration)}$$



BB: Band to Band Transition

$$I = \underbrace{I_p}_{I_p} + \underbrace{I_n}_{I_n}$$

$$I_n > I_p \quad (\because \mu_n > \mu_p)$$

$$I = \frac{qV}{T} = -\frac{1.6 \times 10^{-19}}{T}$$

$$\Rightarrow I = I_p - I_n$$

$$= I_p - (-I_n) = I_p + I_n$$

$$n = \int_{E_c}^{\infty} f(E) N(E) dE$$

$$N(E) = \gamma E^{1/2}$$

Consider E level in CB, then

$$N(E) = \gamma (E - E_c)^{1/2} \quad (\because \gamma = \frac{4\pi}{h^3} (2m)^{3/2} (1.6 \times 10^{-19})^{3/2})$$

$$\approx \frac{4\pi}{h^3} (2m)^{3/2} (1.6 \times 10^{-19})^{3/2} (E - E_c)^{1/2}$$

$$f(E) = \frac{1}{1 + e^{(E - E_F)/kT}}$$

$$K: \text{Boltzmann's Constant} = 8.62 \times 10^{-5} \text{ eV/K}$$

$$K \delta(\bar{k}) = 1.38 \times 10^{-23} \text{ J/K}$$

$$\bar{k} = K \cdot q_v = 8.82 \times 10^{-5} \times 1.6 \times 10^{-19}$$

$$\Rightarrow k = \frac{\bar{k}}{q_v}$$

$v_T$  : Thermal voltage & Voltage equivalent of temperature

$$v_T = \frac{\bar{k} T}{q_v} = kT = \frac{T}{11600} = \frac{T}{11600}$$

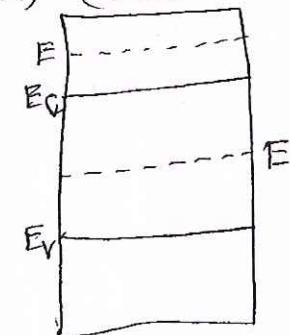
$$\Rightarrow v_T = \frac{T}{11600}$$

At room temperature,

$$v_T = \frac{300}{11600} = 0.02586 \simeq 26 \text{ mV}$$

$$f(E) = \frac{1}{1 + e^{(E - E_F)/kT}} \quad (\because e^{(E - E_F)/kT} \gg 1)$$

$$\begin{aligned} dn &= \rho_E dE \\ \Rightarrow n &= \int_{E_c}^{\infty} dn = \int_{E_c}^{\infty} \rho_E dE \\ &= \int f(E) \cdot N(E) dE \end{aligned}$$



$$= 8 \int_{E_C}^{\infty} (E - E_C)^{1/2} e^{-(E - E_F)/KT} dE$$

$$\stackrel{x = E - E_C}{=} \int_{E_C}^{\infty} (x - K_T x)^{1/2} e^{-(x - E_F)/KT} dx$$

Let  $E - E_C = K_T x \Rightarrow E = E_C + K_T x$

If  $E = E_C \Rightarrow E - E_C = K_T x \Rightarrow 0 = K_T x \Rightarrow x = 0$

$E = \infty \Rightarrow E - E_C = K_T x \Rightarrow \infty = K_T x \Rightarrow x = \infty$

$$n = 8 \int_0^{\infty} (K_T x)^{1/2} e^{-(E_C - E_F)/KT} \cdot e^{-K_T x/K_T} \frac{K_T x}{K_T} dx$$

$$= 8 \int_0^{\infty} (K_T x)^{1/2} e^{-(E_C - E_F)/KT} \cdot e^{-x} \frac{dx}{K_T}$$

$$E - E_C = K_T x \Rightarrow n = 8 \int_0^{\infty} (K_T x)^{1/2} e^{-(E_C + K_T x - E_F)/KT} \frac{dx}{K_T}$$

$$\Rightarrow n = 8(KT)^{3/2} \int_0^{\infty} x^{1/2} e^{-(E_C - E_F)/KT} \cdot e^{-x} dx$$

$$\Rightarrow n = 8(KT)^{3/2} \int_0^{\infty} x^{1/2} e^{-(E_C - E_F)/KT} e^{-x} dx$$

$$\Rightarrow n = 8(KT)^{3/2} e^{-(E_C - E_F)/KT} \int_0^{\infty} x^{1/2} e^{-x} dx$$

$$\Rightarrow n = \frac{4\pi}{h^3} (2m)^{3/2} (1.6 \times 10^{-19})^{3/2} (KT)^{3/2} e^{-(E_C - E_F)/KT} \underbrace{\int_0^{\infty} \sqrt{x} e^{-x} dx}_{\frac{\sqrt{\pi}}{2}}$$

$$= \frac{4}{\sqrt{\pi}} (2m_n)^{3/2} (1.6 \times 10^{-19})^{3/2} (KT)^{3/2} e^{-(E_C - E_F)/KT} \frac{\sqrt{\frac{\pi}{2}}}{2}$$

$\therefore$  If  $m$  is the entire semiconductor mass could be effective mass  $m_n$ .

$$N_c = \text{Effective density of states}$$

$$N_c = 2 \left[ \frac{2\pi m_n \bar{k} T}{h^2} \right]^{3/2} \quad \text{where } \bar{k} = k \cdot q$$

$$N_c = 2 \left[ \frac{2\pi \times \bar{k} \times 9.107 \times 10^{-31}}{h^2} \right]^{3/2} \left( \frac{m_n}{m} \right)^{3/2} \cdot T^{3/2}$$

$$\textcircled{R} \quad N_c = 4.82 \times 10^{21} \times \left( \frac{m_n}{m} \right)^{3/2} T^{3/2} / \text{m}^3 \quad (\text{mass of } e^- \text{ in kg})$$

$$= 4.82 \times 10^{15} \left( \frac{m_n}{m} \right)^{3/2} T^{3/2} / \text{cm}^3 \quad (\text{mass of } e^- \text{ in gms})$$

$$n = N_c e^{-(E_c - E_F)/kT}$$

$$N_c = 4.82 \times 10^{21} \left( \frac{m_n}{m} \right)^{3/2} T^{3/2} / \text{m}^3$$

$$N_c = 4.82 \times 10^{15} \left( \frac{m_n}{m} \right)^{3/2} T^{3/2} / \text{cm}^3$$

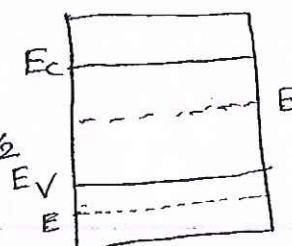
Hole Concentration in VB:

$$P = \int_{-\infty}^{E_V} (1-f(E)) N(E) dE$$

$$N(E) = \gamma (E_v - E)^{1/2}, \quad \gamma = \frac{4\pi}{h^3} (2m)^{3/2} (1.6 \times 10^{-19})^{3/2} E_v$$

$$1 - f(E) = 1 - \frac{1}{1 + e^{(E - E_F)/kT}}$$

$$= \frac{e^{(E - E_F)/kT}}{1 + e^{(E - E_F)/kT}}$$



$$= \gamma \int_{-\infty}^{E_F} (E_V - E)^{1/2} e^{- (E_F - E)/KT} dE$$

$$E_V - E = KTx$$

$$-dE = KTdx$$

$$= \gamma \int_{-\infty}^{E_V} (E_V - E)^{1/2} e^{- (E_F - E)/KT} dE$$

~~cancel~~

$$= \gamma \int_{-\infty}^{E_V} (KTx)^{1/2} e^{- (E_F - E_V + KTx)/KT} (-KTdx)$$

$$= +\gamma (KT)^{3/2} \int_0^{\infty} x^{1/2} e^{- (E_F - E_V)/KT} e^{-x} dx$$

$$= + \frac{4\pi}{h^3} (2m)^{3/2} (1.6 \times 10^{-19})^{3/2} (KT)^{3/2} e^{- (E_F - E_V)/KT} \int_0^{\infty} x^{1/2} e^{-x} dx$$

$$= \frac{4}{\sqrt{\pi}} (2m_p)^{3/2} (1.6 \times 10^{-19})^{3/2} (KT)^{3/2} e^{- (E_F - E_V)/KT} \frac{\sqrt{\pi}}{2}$$

$$P = 2 \left[ \frac{2\pi m_p KT}{h^2} \right]^{3/2} (1.6 \times 10^{-19})^{3/2} e^{- (E_F - E_V)/KT}$$

$$\Rightarrow P = N_v \cdot e^{- (E_F - E_V)/KT}$$

$N_v$  is the effective density of states function

$$N_v = 2 \left[ \frac{2\pi m_p KT}{h^2} \right]^{3/2} (1.6 \times 10^{-19})^{3/2}$$

$$= 2 \left[ \frac{2\pi K \times 9.1 \times 10^{-3}}{h^2} \right]^{3/2} \left( \frac{m_p}{m} \right)^{3/2} T^{3/2}$$

$$N_c e^{-(E_c - E_F)/kT} = N_v e^{-(E_F - E_v)/kT}$$

$$\frac{N_c}{N_v} = e^{\frac{-(E_F - E_v)/kT}{e^{-(E_c - E_F)/kT}}}$$

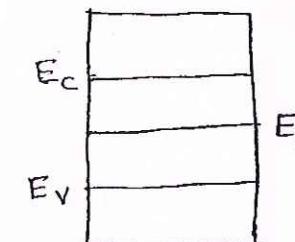
$$\cancel{\times \frac{N_c}{N_v} = e^{-\frac{(E_F - E_v + E_c - E_F)/kT}{kT}}}$$

$$\cancel{\Rightarrow \frac{N_c}{N_v} = e^{-\frac{(E_c - E_v)/kT}{kT}}}$$

$$\frac{N_c}{N_v} = e^{-(E_F - E_v)/kT} \cdot e^{(E_c - E_F)/kT}$$

$$\frac{N_c}{N_v} = e^{(E_c + E_v - 2E_F)/kT}$$

$$\Rightarrow \ln\left(\frac{N_c}{N_v}\right) = (E_c + E_v - 2E_F)/kT$$



$$E_c + E_v - 2E_F = kT \ln\left(\frac{N_c}{N_v}\right)$$

$$\Rightarrow 2E_F = E_c + E_v - kT \ln\left(\frac{N_c}{N_v}\right)$$

$$\Rightarrow E_F = \frac{E_c + E_v}{2} - \frac{kT}{2} \ln\left(\frac{N_c}{N_v}\right)$$

$$E_{F_i} = \frac{E_c + E_v}{2} - \frac{kT}{2} \ln\left(\frac{N_c}{N_v}\right)$$

If  $\frac{KT}{2} \ln\left(\frac{N_C}{N_V}\right)$  is -ve  $\Rightarrow$   $E_F$  lies above the centre of gap.

$\rightarrow$  In a semiconductor, if  $m_n$  is 2 times that of hole, find the position of fermilevel in an intrinsic semi conductor with reference to the centre of the energy gap at room temperature.

$$m_n = 2m_p$$

$$\Rightarrow \frac{m_n}{m_p} = 2$$

$$\frac{KT}{2} \ln\left(\frac{N_C}{N_V}\right) = \frac{0.02586}{2} \ln\{(2)^{3/2}\}$$

$$= 0.0134 > 0$$

$\Rightarrow$  Fermilevel is below the centre at a distance of 0.0134 eV

### Mass Action Law:

According to Mass-Action law, the product of electrons and holes remains constant at fixed temperature.

This will be applicable for intrinsic as well as extrinsic semiconductors.

$$\boxed{n \cdot P = n_i^2}$$

$$\text{Ge: } \Rightarrow n_p^2 = N_c N_v e^{-E_G / kT}$$

$$N_c = 4.82 \times 10^{15} \times \left(\frac{0.55 \text{ m}}{\text{m}}\right)^{3/2} \times (300)^{3/2}$$

$$= 1.02 \times 10^{19}$$

$$\text{Si: } N_c = 4.82 \times 10^{15} \times \left(\frac{1.08 \text{ m}}{\text{m}}\right)^{3/2} \times 300^{3/2}$$

$$= 2.81 \times 10^{19}$$

$$n_i^2 = 4.82 \times 10^{21} \left(\frac{m_n m_p}{m}\right)^{3/2} T^{3/2} \cdot 4.82 \times 10^{21} \left(\frac{m_p}{m}\right)^{3/2} T^{3/2} e^{-E_G / kT}$$

$$n_i^2 = 2.33 \times 10^{43} \underbrace{\left(\frac{m_n m_p}{m^2}\right)^{3/2}}_N T^3 e^{-E_G / kT} / \text{m}^3$$

$$n_i^2 = N T^3 e^{-E_G / kT}$$

$$N = 2.33 \times 10^{43} \left(\frac{m_n m_p}{m^2}\right)^{3/2} / \left(\frac{m^3}{\text{cm}^3}\right)^2 \quad (\because \text{we are calculating for } n_i^2)$$

$$N = 2.33 \times 10^{31} \left(\frac{m_n m_p}{m^2}\right)^{3/2} / \left(\frac{\text{cm}^3}{\text{cm}^3}\right)^2$$

$$n_i^2 = 2.33 \times 10^{31} \left(\frac{m_n m_p}{m^2}\right)^{3/2} T^3 e^{-E_G / kT} / \text{cm}^3$$

$$\therefore E_G = E_{G_0} - \beta T$$

$$e^{-E_G / kT} = e^{-(E_{G_0} - \beta T) / kT} = e^{-E_{G_0} / kT} \cdot e^{\beta T / k}$$

$$n_i^2 = A_0 T^3 e^{-E_{G0}/kT} / \text{cm}^3$$

Si:  
 $n_i = 1.5 \times 10^{10} / \text{cm}^3$

$$A_0 = 2.33 \times 10^{31} \left( \frac{m_n m_p}{m^2} \right)^{3/2} e^{\beta/k}$$

IES → Calculate intrinsic concentration of Ge at 400K

$n_i$  at 400K

$$\Rightarrow n_i^2 = 2.33 \times 10^{31} \left( \frac{m_n m_p}{m^2} \right)^{3/2} T^3 e^{-E_G/kT}$$

$$= 2.33 \times 10^{31} \left( \frac{0.55 \times 0.37 \text{ m}^2}{m^2} \right)^{3/2} 400 \times e^{-0.696 / 0.0345}$$

$$E_G = E_{G0} - \beta T$$

$$= 0.785 - 2.23 \times 10^{-4} \times 400$$

$$= 0.696 \text{ eV}$$

~~$$2.33 \times 10^{31} \times e^{-0.696 / 0.0345} = 2.07 \times 10^{29}$$~~

$$n_i^2 = 4.08 \times 10^{14} / \text{cm}^3$$

$$KT = T = \frac{400}{11600} = 0.0345$$

Conductivity of a Semiconductor (Intrinsic) : ( $\sigma_i$ )

$$\sigma_i = n_i (\mu_n + \mu_p) q \quad (\because n = p = n_i) \quad \text{S/m} \& \text{S/cm}$$

Resistivity of an Intrinsic Semiconductor ( $\rho_i$ ):

$$\rho_i = \frac{1}{\sigma_i} = \frac{1}{n_i (\mu_n + \mu_p) q} \quad \text{ohm-m} \& \text{ ohm-cm}$$

Ge at room temperature.

$$\mu_p = 0.18 \text{ m}^2/\text{V-sec} = 1800 \text{ cm}^2/\text{V-sec}$$

$$\mu_n = 0.38 \text{ m}^2/\text{V-sec} = 3800 \text{ cm}^2/\text{V-sec}$$

$$T = 300 \text{ K}$$

$$n_i = 2.5 \times 10^{13} / \text{cm}^3; qV = 1.6 \times 10^{-19} \text{ e}$$

$$\rho_i = \frac{1}{n_i(\mu_n + \mu_p)qV} = 44.64 \text{ ohm-cm}$$

$$\text{Conductivity } \sigma_i = 0.0224 \text{ S/cm}$$

(R) Intrinsic resistivity =  $44.64 \text{ }\Omega\text{-cm} \approx 45$   
Intrinsic Conductivity =  $0.0224 \text{ S/cm}$  for Ge

→ Calculate intrinsic resistivity and conductivity of Si at room temperature

$$\mu_p = 500 \text{ cm}^2/\text{V-sec}$$

$$\mu_n = 1300 \text{ cm}^2/\text{V-sec}$$

$$T = 300 \text{ K}$$

$$n_i = 1.5 \times 10^{10} / \text{cm}^3$$

$$\sigma_i = n_i(\mu_n + \mu_p)qV = 4.32 \times 10^{-6} \text{ S/cm}$$

$$\rho_i = 231.481 \text{ k}\Omega\text{-cm}$$

(R) Intrinsic resistivity =  $231.481 \text{ k}\Omega\text{-cm} \approx 230 \text{ k}\Omega\text{-cm}$   
Intrinsic Conductivity =  $4.32 \times 10^{-6} \text{ S/cm}$  for Si

- In the case of intrinsic semiconductors, as temperature increases, conductivity increases and also resistivity decreases. Therefore resistance decreases.
- Intrinsic semiconductors are having negative temperature coefficient. Therefore these can be used as thermostats except Silicon and Germanium. Because Silicon and Germanium are too sensitive to impurities.
- The conductivity of Germanium increases by 6% per °C rise in temperature.
- The conductivity of Silicon increases by 8% per °C rise in temperature.

### Metal & Conductivity wrt Temperature:

$$T \uparrow \rightarrow \mu \downarrow \rightarrow \sigma \downarrow \rightarrow \rho \uparrow \rightarrow R \uparrow$$

PTC

In the case of metals as temperature ↑, mobility ↓, conductivity ↓. Therefore resistivity increases and also resistance increases.

Metals are having positive temperature coefficient. The resistance of metals increases by 0.4% per degree rise in temperature.

→ This impurity is called extrinsic semiconductor.

Extrinsic semi conductor.  
ESC - [ n-type  
                  p-type ]

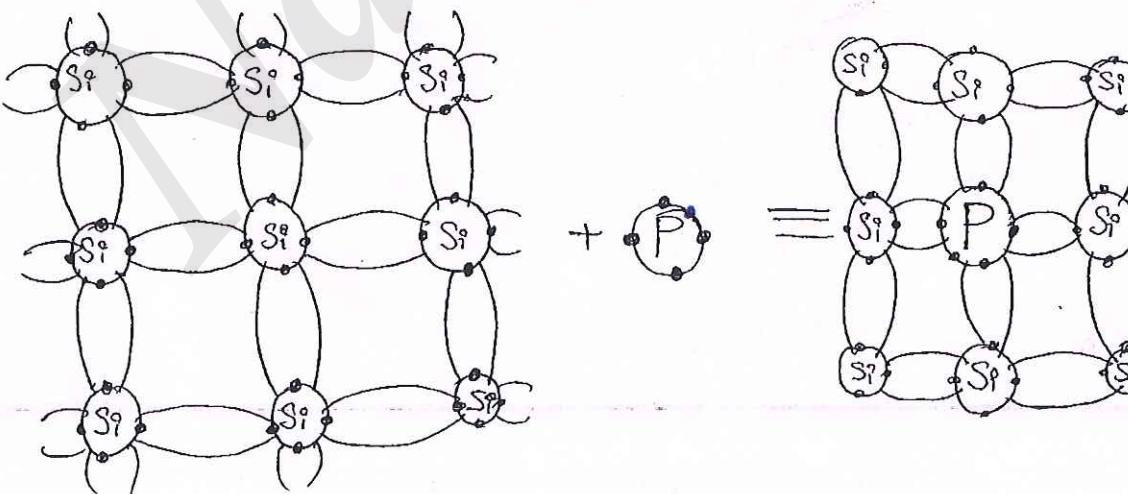
### n-type Semiconductor:

→ When V group or pentavalent impurities are added to an intrinsic semiconductor, then it is called n-type semiconductor.

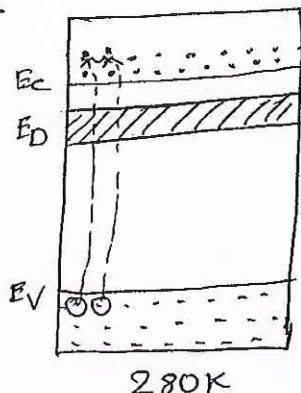
→ V group & pentavalent impurities are Arsenic (As), Antimony (Sb), Phosphorous (P) and Bismuth (Bi).

→ V group impurities have 5 valence electrons

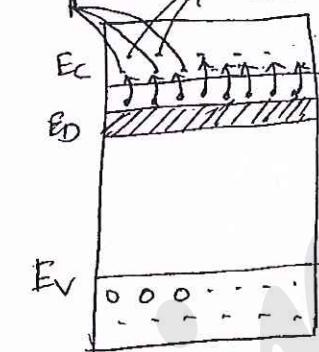
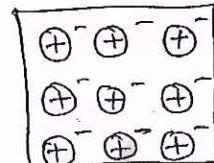
→ V group elements are also called Donors.  $\text{+} \rightarrow \cdot \Rightarrow \text{+}$ .



→ Concentration of Donor atoms is  $N_D$



n-Type

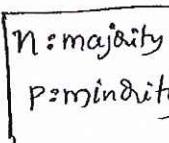
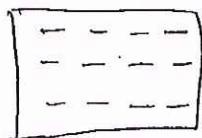
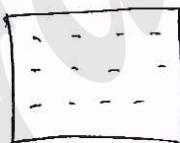


$I_n(II) \Rightarrow$  Current due to Impurity Ionization

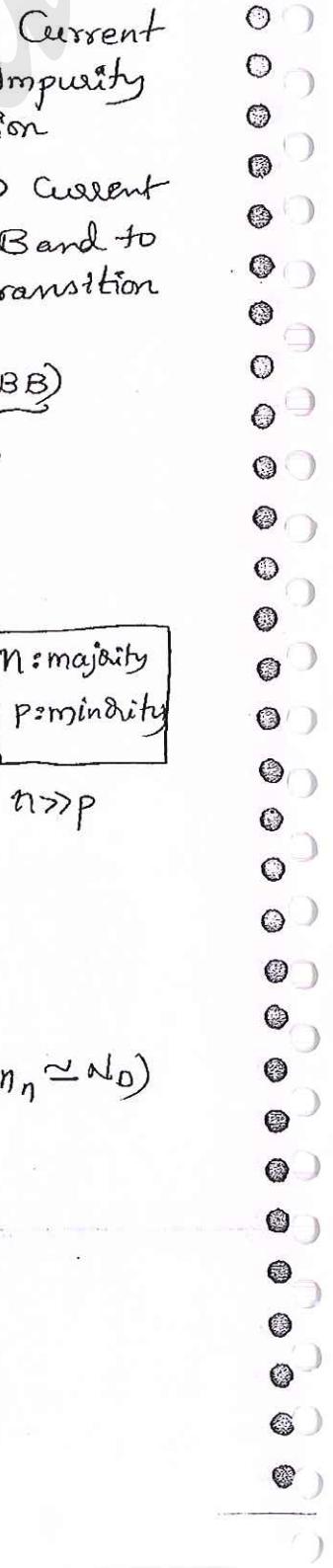
$I_n(BB) \Rightarrow$  Current due to Band to Band transition

$$I = \underbrace{I_n(II) + I_n(BB)}_{I_n} + \underbrace{I_p(BB)}_{I_p}$$

$$\Rightarrow I_n \gg I_p$$



$$n \gg p$$



$n_n$ : e<sup>-</sup> conc in n-type  
 $p_n$ : hole conc in n-type

$$n_n \gg p_n$$

Mass - Action Law:

$$n_n p_n = n_i^2$$

$$p_n = \frac{n_i^2}{n_n}$$

$$\Rightarrow p_n \simeq \frac{n_i^2}{N_D} \quad (\because n_n \simeq N_D)$$

Conductivity of n-type SC( $\sigma_n$ ):

$$\sigma_n = (n_n \mu_n + p_n \mu_p) e$$

$$\simeq n_n \mu_n e \quad (\because n_n \gg p_n)$$

$$\simeq N_D \mu_n e \quad (\because n_n \simeq N_D)$$

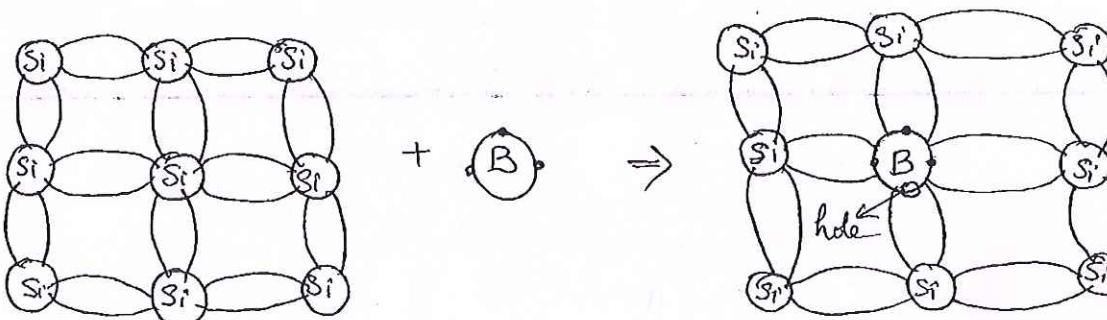
$$\begin{aligned}
 J_n &= \sigma_n E = (n_n \mu_n + p_n \mu_p) e E \\
 &\approx n_n \mu_n e E = n_n e v_n \quad (\because V_n = \mu_n E) \\
 &= N_D \mu_n e E = N_D e v_n
 \end{aligned}$$

Current ( $I_n$ ):

$$\begin{aligned}
 I_n &= (n_n \mu_n + p_n \mu_p) e EA \\
 &\approx n_n \mu_n e EA = n_n e v_n A \\
 &= N_D \mu_n e EA = N_D e v_n A
 \end{aligned}$$

P-Type Semiconductor:

- When III group or trivalent impurities are added to an intrinsic semiconductor, then it is called P-type semiconductor
- III group impurities are B, Ga, In
- III group impurities have three valence electrons
- III group impurities are also called acceptors
- Concentration of acceptor atoms is  $N_A$   $\text{---}^0 + \cdot \Rightarrow \text{---}$



P: Majority

P<sub>p</sub>: majority

$$P \gg n$$

$$P_p \gg n_p$$

$$n_p = \frac{n_i^2}{P_p} \approx \frac{n_i^2}{N_A} \quad (\because P_p \approx N_A)$$

$$I = \underbrace{I_p}_{I_p} (II) + I_p (BB) + \underbrace{I_n}_{I_n} (BB)$$

$$I = I_p + I_n$$

$$\rightarrow I_p \gg I_n$$

$\rightarrow P = N_A$  for doping concentration  $\gg$  intrinsic concentration

$$N_A \gg n_i$$

$$* P = \frac{N_A}{2} + \sqrt{\left(\frac{N_A}{2}\right)^2 + n_i^2}$$

Conductivity of P-type SC ( $\sigma_p$ ):

$$\begin{aligned} \sigma_p &= (n_p \mu_A + P_p \mu_p) e \approx P_p \mu_p e \quad (\because P_p \gg n_p) \\ &= N_A \mu_p e \quad (\because P_p \approx N_A) \end{aligned}$$

Resistivity of P-type SC ( $\rho_p$ ):

$$\begin{aligned} \rho_p = \frac{1}{\sigma_p} &= \frac{1}{(n_p \mu_p + P_p \mu_p) e} \approx \frac{1}{P_p \mu_p e} \quad (\because P_p \gg n_p) \\ &= \frac{1}{N_A \mu_p e} \quad (\because P_p \approx N_A) \end{aligned}$$

Current Density of P-type SC ( $J_p$ ):

$$\begin{aligned} J_p &= \sigma_p E = (n_p \mu_A + P_p \mu_p) e E \approx P_p \mu_p e E = N_A \mu_p e E \\ &\approx P_p v_p e = N_A v_p e \end{aligned}$$

$$\frac{N_c}{N_D} = e^{(E_C - E_F)/KT}$$



$$\ln\left(\frac{N_c}{N_D}\right) = (E_C - E_F)/KT$$

$$\Rightarrow E_F = E_C - KT \ln\left(\frac{N_c}{N_D}\right) \Rightarrow E_C - E_F = KT \ln\left(\frac{N_c}{N_D}\right)$$

$$\therefore E_{F_n} = E_C - KT \ln\left(\frac{N_c}{N_D}\right)$$

\* Position of the fermi level with reference to edge of the conduction band

$$E_C - E_F = KT \ln\left(\frac{N_c}{N_D}\right)$$

$$N_c = 4.8 \times 10^{21} \left(\frac{m_n}{m}\right)^{3/2} T^{3/2} / m^3$$

$$N_c = 4.8 \times 10^{15} \left(\frac{m_n}{m}\right)^{3/2} T^{3/2} / cm^3$$

$N_D$ : Donor Concentration

1:10  $\Rightarrow$  Donor atoms correspond to 1 in 10 Si atoms

$\Rightarrow$  1 donor impurity / 10 Si atoms

$N_D$  = Atomic Concentration  $\times$  no of donor impurity atoms /  $(Si/Ge)$  atoms

Calculate  $KT \ln\left(\frac{N_c}{N_D}\right)$  value,

if  $KT \ln\left(\frac{N_c}{N_D}\right) = 0 \Rightarrow E_F = E_C \Rightarrow$  Fermi level coincides with edge of conduction band

$$kT \left( \frac{n_i}{E_F - E_{F_i}} \right) = \ln \left( \frac{n}{n_i} \right)$$

$$E_F - E_{F_i} = kT \ln \left( \frac{n}{n_i} \right)$$

$$\boxed{E_F - E_{F_i} = kT \ln \left( \frac{N_D}{n_i} \right)}$$

Position of Fermi level in P-type Semiconductor:

$$P = N_V e^{-(E_F - E_V)/kT}$$

$$P = P_p \neq N_A = N_V e^{-(E_F - E_V)/kT}$$

$$\Rightarrow \frac{N_A}{N_V} = e^{-(E_F - E_V)/kT}$$

$$\Rightarrow e^{(E_F - E_V)/kT} = \frac{N_V}{N_A}$$

$$\Rightarrow E_F - E_V = kT \ln \left( \frac{N_V}{N_A} \right)$$

$$\Rightarrow \boxed{E_{F_p} - E_V = kT \ln \left( \frac{N_V}{N_A} \right)}$$

$$\boxed{E_{F_p} = E_V + kT \ln \left( \frac{N_V}{N_A} \right)}$$

Position of fermilevel with reference to edge of the valence band

$$N_V = 4.82 \times 10^{21} \left( \frac{m_p}{m} \right)^{3/2} T^{3/2} / m^3 = 4.82 \times 10^{15} \left( \frac{m_p}{m} \right)^{3/2} T^{3/2} / \text{cm}^{-3}$$

\* Position of the fermilevel with reference to centre of the energy gap & with reference to intrinsic fermilevel:

$$P = n_i e^{(E_{F_i} - E_F)/kT}$$

$$\frac{P}{n_i} = e^{(E_{F_i} - E_F)/kT}$$

$$\Rightarrow \frac{(E_{F_i} - E_F)}{kT} = \ln \left( \frac{P}{n_i} \right)$$

$$\Rightarrow E_{F_i} - E_F = kT \ln \left( \frac{P}{n_i} \right)$$

$$\boxed{E_{F_i} - E_F = kT \ln \left( \frac{N_A}{n_i} \right)}$$

Fermilevel with respect to Doping in n-type Semiconductor at fixed temperature.

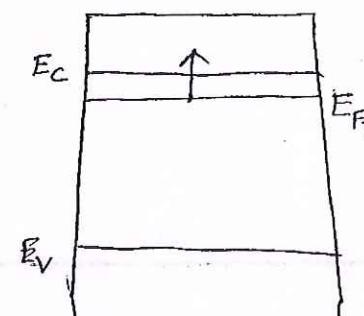
$$E_C - E_F = kT \ln \left( \frac{N_c}{N_D} \right)$$

$$N_c = 4.8 \times 10^{21} \left( \frac{mn}{m} \right)^{3/2} T^{3/2}$$

As  $T$  is const  $\Rightarrow N_c$  is const

$E_C$  is also constant

As  $N_D \uparrow \Rightarrow \frac{N_c}{N_D} \downarrow \Rightarrow E_C - E_F \downarrow \Rightarrow E_F$  moves upwards



In n-type semiconductor, as doping concentration increases, fermi level moves upwards.

Intrinsic Semiconductors.

i.e. As temp  $\uparrow \Rightarrow E_{Fn}$  moves downwards at fixed doping concentration

$$E_c - E_F = KT \ln \left( \frac{N_e}{N_{0^*}} \right)$$

Fermi level wrt doping in p-Type Semiconductor at fixed temperature:

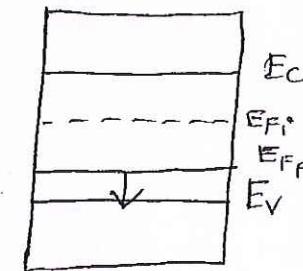
$$E_F - E_V = KT \ln \left( \frac{N_v}{N_A} \right)$$

$$N_N = 4.82 \times 10^{21} \left( \frac{m_p}{m_n} \right)^{3/2} T^{3/2} / m^3$$

As doping  $\uparrow \Rightarrow N_A \uparrow \Rightarrow (E_F - E_V) \downarrow$

$E_F$  is fixed  $\Rightarrow E_F$  decreases

$\Rightarrow E_F$  moves downwards.

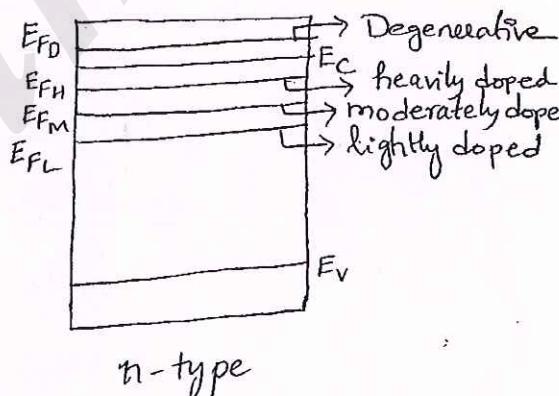
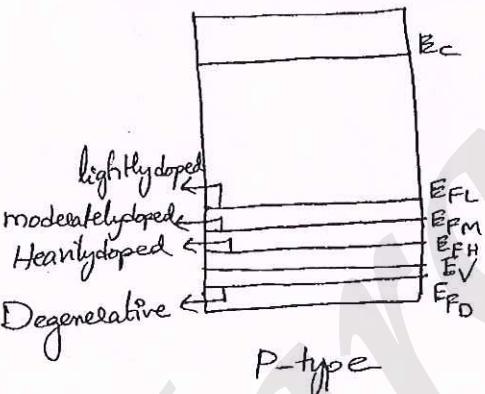


In p-type semiconductor, as doping concentration increases, fermilevel moves downwards at fixed temperature.

Fermilevel wrt temperature in p-type semiconductor at fixed doping:

$$E_F - E_V^* = [KT \ln \left( \frac{N_v}{N_A} \right)] \uparrow$$

1. Lightly doped Semiconductors  $\Rightarrow 10^{13}$  to  $10^{15}$  imp atoms/cm<sup>3</sup>
2. Moderately doped Semiconductors  $\Rightarrow 10^{15}$  to  $10^{16}$  imp atoms/cm<sup>3</sup>
3. Heavily doped Semiconductors  $\Rightarrow 10^{17}$  to  $10^{18}$  imp atoms/cm<sup>3</sup>
- \*4. Degenerative Semiconductors  $\Rightarrow > 10^{18}$  imp atoms/cm<sup>3</sup>  
 ↳ ( $E_F$  lies inside  $E_C$  ( $\Delta$ )  $E_D$  coincides with  $E_C$ )



Intrinsic Semiconductor doped with III and V group:

If acceptor concentration i.e.,  $N_A$  is greater than Donor Concentration

i.e.,  $N_A$

$\Rightarrow N_A > N_D \Rightarrow$  It forms p-type Semiconductor

$$\text{Hole concentration} = N_A - N_D \quad (\text{if } N_A - N_D \gg n_i)$$

*(If  $N_A \gg N_D$ )*

Otherwise

$$\frac{N_A - N_D}{2} + \sqrt{\left(\frac{N_A - N_D}{2}\right)^2 + n_i^2}$$

If Donor concentration ( $N_D$ ) is greater than Accepter concentration ( $N_A$ )

$\Rightarrow N_D > N_A \Rightarrow$  It forms n-type semiconductor

as well as extrinsic semiconductor.

$$\text{Total positive charge} = p + N_D$$

$$\text{Total Negative charge} = n + N_A$$

According to charge neutrality principle,

total positive charge = total negative charge.

$$\boxed{p + N_D = n + N_A}$$

### n-Type Semiconductor:

$$N_A = 0$$

$$\Rightarrow p + N_D = n + 0$$

$$\Rightarrow n = p + N_D$$

$$(\because n \gg p) \Rightarrow n \approx N_D$$

$$\Rightarrow n_n \approx N_D$$

$$n_n p_n = n_i^2$$

$$\boxed{P_n = \frac{n_i^2}{n_n} = \frac{n_i^2}{N_D}}$$

### p-Type Semiconductor:

$$N_D = 0$$

$$\Rightarrow 0 + p = n + N_A$$

$$\Rightarrow p = n + N_A$$

to  $e^-$  and  $\frac{1}{4}$ th of the current is due to  $e^-$  and  $\frac{3}{4}$ th of the current is due to holes, find drift velocity of the  $e^-$  is 3 times that of holes, find the ratio of  $e^-$  to holes.

$\frac{3}{4}$ th of current due to  $e^- \Rightarrow n$ -type

$$V_n = 3V_p$$

$$\mu_n E = 3\mu_p E$$

$$\Rightarrow \frac{\mu_n}{\mu_p} = 3$$

$$I = \text{hole current} + e^- \text{ current}$$

$$I_n = \frac{3}{4} I$$

$$I_p = \frac{1}{4} I$$

$$I_n = n \mu_n e A = n V_n e A$$

$$I_p = p \mu_p e A = p V_p e A$$

$$\frac{I_n}{I_p} = \frac{n}{p} \cdot \frac{V_n}{V_p}$$

$$\Rightarrow \frac{n}{p} = \frac{I_n V_p}{I_p V_n} = \frac{\frac{3}{4} I}{\frac{1}{4} I} \cdot \frac{1}{3}$$

$$\Rightarrow \frac{n}{p} = 1$$

$$\Rightarrow \boxed{n = p}$$

- Q) Find the density of the impurity atoms that must be added to an intrinsic germanium to convert it into  $10 \Omega\text{-cm}$   $n$ -type germanium at room temperature.

$$\rho = 10 \Omega\text{-cm}$$

$$\frac{1}{n \mu_n e} = 10 \Omega\text{-cm}$$

$$\Rightarrow N_D = \frac{1}{\rho \mu_n e} = 1.6 \times 10^{14} / \text{cm}^3$$

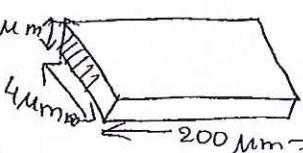
$$N_D = \frac{1}{\rho_n M_n e} = 3.69 \times 10^{14} / \text{cm}^3$$

From above two problems,  $\rho_n = 10 \Omega\text{-cm} \Rightarrow N_D = 1.6 \times 10^{14} / \text{cm}^3$   
 $\rho_n = 4.46 \Omega\text{-cm} \Rightarrow N_D = 3.7 \times 10^{14} / \text{cm}^3$

$\Rightarrow T \downarrow \rho \Rightarrow N_D \uparrow$

Q) A 1k $\Omega$  resistor is to be fabricated as a narrow strip of p-type Si with 4  $\mu\text{m}$  thick, 40  $\mu\text{m}$  width and 200  $\mu\text{m}$  length. Calculate density of the impurity atoms needed.

$$\begin{aligned} \text{Area} &= 40 \times 10^{-4} \text{ cm} \times 200 \times 10^{-4} \text{ cm} \\ &\approx 8 \times 10^3 \times 10^{-8} \text{ cm}^2 \\ &\approx 8 \times 10^{-5} \text{ cm}^2 \end{aligned}$$



$$R_p = \frac{\rho_p l}{A}$$

$$\rho_p = \frac{1 \text{ k} \times 8 \times 10^{-5}}{200 \mu\text{m}}$$

$$= \frac{10^3 \times 8 \times 10^{-5}}{200 \times 10^{-4}}$$

$$= \frac{8 \times 10^{-2}}{2 \times 10^{-2}} = 4 \Omega\text{-cm}$$

$$N_D = \frac{1}{1500 \times 4 \times 1.6 \times 10^{-19}}$$

$$N_D = 1.04 \times 10^{15} / \text{cm}^3$$

$$= \frac{8}{10^{+2}} \text{ N-cm} = 0.08 \text{ N-cm}$$

$$N_D = \frac{1}{500 \times 8 \times 1.6 \times 10^{-19} \times 10^{-2}}$$

$$= 1.56 \times 10^{17} / \text{cm}^3$$

Q) (a) In n-type Ge, donor concentration corresponds to 1 in  $10^8$  Ge atoms. If the effective mass of the  $e^-$  is half of its true mass, at room temperature, how far from the edge of the conduction band is the fermi level. Is  $E_F$  below or above  $E_C$ .

$$m_n = \frac{1}{2} m \Rightarrow \frac{m_n}{m} = 0.5$$

$$N_C = 4.82 \times 10^{21} \cdot \left( \frac{m_n}{m} \right)^{3/2} \cdot T^{3/2} / \text{m}^3$$

$$= 8.85 \times 10^{24} = 8.85 \times 10^{18} / \text{cm}^3$$

$$E_C - E_F = KT \ln \left( \frac{N_C}{N_D} \right) ; \quad N_D = \text{atomic conc} \times \text{no. of donor imp/Ge atoms}$$

$$= 4.4 \times 10^{22} \times 1/10^8 = 4.4 \times 10^{14} / \text{cm}^3$$

$$E_C - E_F = 26 m \ln \left( \frac{8.85 \times 10^{18}}{4.4 \times 10^{14}} \right)$$

$$= 0.02586 \times 9.909$$

$$E_C - E_F = 0.256 \text{ eV}$$

→ Fermi level is at a distance of 0.256 eV from the edge of the conduction band.

→  $E_F$  is below  $E_C$

$$\ln\left(\frac{N_c}{N_D}\right) = 26.7 \ln\left(\frac{8.85 \times 10^{18}}{4.4 \times 10^{19}}\right)$$

$$\Rightarrow E_C - E_F = -0.0414 \text{ eV}$$

→ Fermi level is at a distance of 0.0414 eV from the edge of conduction band.

→  $E_F$  is above  $E_C$ .

(c) Under what circumstances, will  $E_F$  coincides with  $E_C$

$$\Rightarrow E_F = E_C$$

If  $N_c = N_D$  then fermilevel coincides with edge of conduction band

$\Rightarrow 8.85 \times 10^{18} \text{ } \textcircled{*} = \text{Atomic concentration} \times \text{no: of Donor atoms/atom}$

$$\Rightarrow \text{No: of dond impurity atoms/Ge atoms} = \frac{8.85 \times 10^{18}}{4.4 \times 10^{22}} \\ = 2.01 \times 10^{-4}$$

$$= \frac{2}{10^4}$$

i.e if doping concentration is  $2 \times 10^4$  Ge atoms, then fermi level coincides with the edge of the conduction band.

$$E_F - E_V = KT \ln \left( \frac{N_V}{N_A} \right)$$

$$= 0.02586 \ln \left( \frac{8.818 \times 10^{18}}{4.22 \times 10^{19}} \right)$$

$$= -0.0404 \text{ eV}$$

→ Fermi level is at a distance of 0.0404 eV from the edge of the VB.

→  $E_F$  is below  $E_V$

(c) Under what circumstances, will  $E_F$  coincides with  $E_V$ .

$$\Rightarrow E_F = E_V$$

If  $N_V = N_A$ , fermilevel coincides with  $E_V$

$$8.85 \times 10^{18} = A \times \text{no: of acceptor impurity atoms/cm}^3$$

$$\begin{aligned} \text{No: of acceptor impurity atoms / Ge atom} &= \frac{8.85 \times 10^{18}}{4 \times 10^{22}} \\ &= 2.01 \times 10^{-4} \\ &= \frac{2}{10^4} \end{aligned}$$

i.e if doping concentration is 2 in  $10^4$  Ge atoms, then fermilevel coincides with the edge of valence band.

Q) a) In p-type Si, acceptor concentration corresponds to 1 in  $10^8$  Si atoms, If the effective mass of the hole is half of its true mass at room temperature, how far from the edge of the valence band is the fermilevel. Is  $E_F$  above & below  $E_V$ ?

$$N_V = 4.82 \times 10^{15} \left( \frac{m_p}{m} \right)^{3/2} T^{3/2} / \text{cm}^3$$

$$= 5 \times 10^{14} / \text{cm}^3$$

$$\begin{aligned} E_F - E_V &= KT \ln \left( \frac{N_V}{N_A} \right) \\ &= 0.02586 \ln \left( \frac{8.818 \times 10^{14}}{5 \times 10^{14}} \right) \\ &= 0.2528 \text{ eV} \end{aligned}$$

(b) Repeat part (a) for doping concentration of 1 in  $10^3$  Si atoms.

$$\begin{aligned} N_V &= 4.82 \times 10^{15} \times \left( \frac{m_p}{m} \right)^{3/2} T^{3/2} \\ &= 4.82 \times 10^{15} \times (0.5)^{3/2} T^{3/2} = 8.818 \times 10^{18} / \text{cm}^3 \end{aligned}$$

$$\begin{aligned} N_A &= 5 \times 10^{22} \times 1/10^3 / \text{cm}^3 \\ &= 5 \times 10^{19} / \text{cm}^3 \end{aligned}$$

$$\begin{aligned} E_F - E_V &= KT \ln \left( \frac{N_V}{N_A} \right) \\ &= 0.02586 \ln \left( \frac{8.818 \times 10^{18}}{5 \times 10^{19}} \right) \\ &= -0.0448 \text{ eV} \end{aligned}$$

→ Fermilevel is at a distance of 0.0448 eV from the edge of Valence Band.

→  $E_F$  is below  $E_V$

(c) Under what circumstances will  $E_F$  coincides with  $E_V$   
 $\Rightarrow E_F = E_V$

If  $N_V = N_A$ , Fermilevel coincides with  $E_V$ .

$8.85 \times 10^{18} = A \times \text{No. of Donor impurity atoms / atom}$

$$\begin{array}{c}
 I(\text{drift}) \\
 | \\
 I_{n(\text{drift})} \quad I_{p(\text{drift})}
 \end{array}
 \qquad
 \begin{array}{c}
 I(\text{diffusion}) \\
 | \\
 I_{n(\text{diff})} \quad I_{p(\text{diff})}
 \end{array}$$

### Drift Current:

The current which is due to drifting of the carriers by the applied external electric field is called drift current.

$$I = I_{n(\text{diff})} + I_{p(\text{diff})}$$

### Drift Current Density due to electrons

#### $J_{n(\text{drift})}$ :

$$J_{n(\text{drift})} = n e \mu_n E$$

### Drift Current Density due to holes $J_{p(\text{drift})}$ :

$$J_{p(\text{drift})} = p e \mu_p E$$

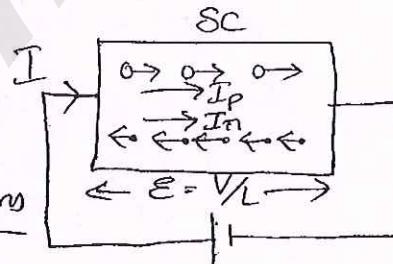
### Total drift current density $J_{(\text{drift})}$ :

$$\begin{aligned}
 J_{(\text{drift})} &= n e \mu_n E + p e \mu_p E \\
 &= (n \mu_n + p \mu_p) e E
 \end{aligned}$$

### Total drift current $I_{(\text{drift})}$ :

$$I_{(\text{drift})} = J_{(\text{drift})} \times \text{Area}$$

$$I_{(\text{drift})} = (n \mu_n + p \mu_p) e E A$$



$\frac{dx}{dx}$  is concentration gradient of holes

$D_p$  is diffusion constant for holes

$$D_p = 47 \text{ cm}^2/\text{s} \text{ for Ge}$$

$$D_p = 13 \text{ cm}^2/\text{s} \text{ for Si}$$

$$\frac{dP}{dx} = \frac{P_2 - P_1}{x_2 - x_1}$$

$$100 - 80 \Rightarrow I_1$$

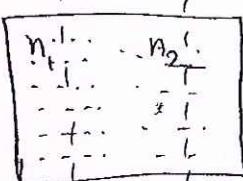
$$100 - 50 \Rightarrow I_2$$

Diffusion current density due to electrons  $I_2 > I_1$

$$J_n(\text{diff}) = +e D_n \frac{dn}{dx}$$

( $\because$  charge of  $e^-$  is negative)

$$\left( \frac{dn}{dx} \right) = \frac{n_1 - n_2}{x_2 - x_1}$$



Total diffusion current density

$$J_{\text{diff}} = J_n(\text{diff}) + J_p(\text{diff})$$

$$\frac{dn}{dx} = \frac{n_2 - n_1}{x_2 - x_1}$$

$$J_{\text{diff}} = e D_n \frac{dn}{dx} - e D_p \frac{dp}{dx}$$

$$D_n = 99 \text{ cm}^2/\text{s} \text{ for Ge}$$

$$D_n = 34 \text{ cm}^2/\text{s} \text{ for Si}$$

Total Diffusion Current  $I_{\text{diff}} = J_{\text{diff}} A$

$$I_{\text{diff}} = \left( e D_n \frac{dn}{dx} - e D_p \frac{dp}{dx} \right) A$$

Total Current Density  $J = J_{\text{drift}} + J_{\text{diff}}$

$$J = \underbrace{(n \mu_n + p \mu_p) e E}_{\text{drift}} + \underbrace{e \left[ e D_n \frac{dn}{dx} - e D_p \frac{dp}{dx} \right]}_{\text{diffusion}}$$

$$\text{Total Current } I = \underbrace{(n \mu_n + p \mu_p) e E A}_{\text{drift}} + \underbrace{\left[ e D_n \frac{dn}{dx} - e D_p \frac{dp}{dx} \right] A}_{\text{diffusion}}$$

$$\frac{D_n}{\mu_n} = \frac{D_p}{\mu_p} = V_T$$

n-Type:  $\frac{D_n}{\mu_n} = V_T = 0.02586$

$$\Rightarrow \mu_n = \frac{D_n}{0.02586} \approx 39 D_n$$

$$\Rightarrow \boxed{\mu_n = 39 D_n}$$

p-Type:  $\frac{D_p}{\mu_p} = V_T = 0.02586$

$$\Rightarrow \mu_p = \frac{D_p}{0.02586} \approx 39 D_p$$

$$\Rightarrow \boxed{\mu_p = 39 D_p}$$

$$\Rightarrow M = 39 D$$

### Carrier Lifetime:

Thermal agitation continues to produce e<sup>-</sup>-hole pairs, while e<sup>-</sup> and hole pairs disappears due to recombination.

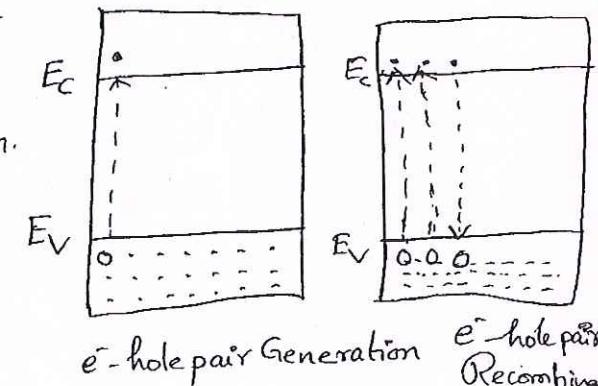
On an average, an e<sup>-</sup> or hole exists for  $\tau_n$  &  $\tau_p$  seconds before the recombination. This is called Carrier Life time.

→ Carrier Life time ranges from nanoseconds to microseconds.

$$\tau_n = \frac{L_n^2}{D_n} \Rightarrow L_n = \sqrt{\tau_n D_n} \quad \text{where } L_n \text{ is diffusion length for an e}^-$$

i.e. distance travelled by e<sup>-</sup> in its life time

$$\tau_p = \frac{L_p^2}{D_p} \Rightarrow L_p = \sqrt{\tau_p D_p}$$



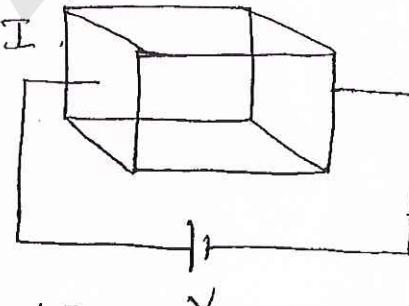
where  $\Delta n$  is excess carrier concentration  
 $\tau_p$  is minority carrier lifetime

If  $n$  &  $p$  is not given,

$$\gamma = \frac{L^2}{D} \Rightarrow L = \sqrt{\gamma D}$$

Hall Effect: (Faraday's law for Semiconductors)

When a specimen of a semiconductor carrying a current of  $I$  in the positive  $x$ -direction placed in a magnetic field  $B$  which is in positive  $z$ -direction, an electric field  $E$  induces perpendicular to both  $I$  and  $B$  in the negative  $y$ -direction.

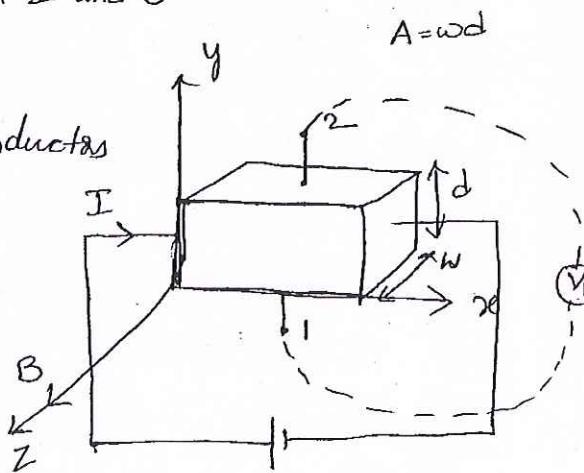


→ Hall effect is applicable to Semiconductors only.

→ It is used to find whether a semiconductor is  $n$ -type or  $p$ -type

→ To find carrier concentration.

→ Also used to calculate mobility by simultaneously measuring the conductivity.



$$E = \frac{V_H}{d} \quad \text{--- (1)}$$

$$V_H = Ed = \text{Hall Voltage} \quad \text{--- (2)}$$

$$\rho_V = J = \frac{I}{A}$$

$$\Rightarrow \rho_V = \frac{I}{wd} \quad \text{--- (4)}$$

$$V_H = Ed = Bvd = \frac{BId}{\rho} = \frac{BI}{\rho w}$$

n-type:

$$J_n = ne\mu_n E = nev_n = \rho v_n \quad \left. \begin{array}{l} \\ \end{array} \right] \rightarrow \rho_V$$

P-type:

$$J_p = pe\mu_p E = pev_p = \rho v_p$$

$$J = \rho V \Rightarrow V = \frac{J}{\rho}$$

$$J = \frac{I}{wd} \Rightarrow Jd = \frac{I}{w}$$

Hall Coefficient ( $\delta$ ) Hall Constant ( $R_H$ ):

$$R_H = \frac{1}{\rho} \quad (\rho \text{ is charge density but not resistivity})$$

$$\Rightarrow R_H = \frac{V_H w}{BI} = \frac{1}{\rho} ; \frac{\text{cm}^3}{\text{C}^2 \text{m}^3 / \text{C}} \quad \left( \because V_H = \frac{BI}{\rho w} \Rightarrow \frac{1}{\rho} = \frac{BI}{V_H} \right)$$

n-Type!

$$\sigma_n = ne\mu_n = \rho \mu_n$$

P-type

$$\sigma_p = pe\mu_p = \rho \mu_p$$

$$R_H = \frac{1}{\rho} = \frac{1}{ne} \cdot \frac{\text{ele}}{\text{cm}^3} \cdot \text{c} \Rightarrow \frac{\text{cm}^3}{\text{elec. c}}$$

$$= \frac{1}{pe} ; \frac{\text{cm}^3}{\text{hole-c}}$$

$$\sigma = \rho \mu \Rightarrow \mu = \sigma \cdot \frac{1}{\rho} \Rightarrow \boxed{\mu = \sigma R_H}$$

$$R_H = \frac{1}{\rho} = \frac{1}{ne} \Rightarrow n = \frac{1}{R_H q V} / \text{cm}^3$$

$$\rho = \frac{1}{R_H q V} / \text{cm}^3$$

Induced Electric force  $F_n = -q(v_n \times B)$  (for n-type)

$$E = \frac{F_n}{q} = -(v_n \times B)$$

$$F_p = q(v_p \times B)$$

$$\Rightarrow E = F_p/q = (v_p \times B) \quad (\text{for p-type})$$

$$\mu = \sigma R_H$$

$$\sigma = \frac{1}{300 \text{ K} \cdot \Omega \cdot \text{cm}} = 3.33 \times 10^{-6} \text{ S} \cdot \text{cm} = 3.33 \times 10^{-4} \text{ V/m}$$

$$R_H = \frac{V_H W}{BI} = \frac{60 \text{ m} \times 6 \times 10^{-3}}{0.1 \times 10 \times 10^{-6}} = 360 \text{ m}^3/\text{C}$$

$$\mu_p = \sigma R_H = 0.11988 = 0.12 \text{ m}^2/\text{V-sec}$$

~~0.11988~~ = 1200 cm<sup>2</sup>/V-sec

\* Continuity Equation & Hall-Shockley Experiment for IES.

$(E_G) \text{OK, eV}$	1.1
Energy gap ( $E_G$ ) 300K, eV	0.72
Intrinsic Concentration ( $n_i$ ) / cm <sup>3</sup>	$2.5 \times 10^{13}$
Intrinsic resistivity $\Omega \cdot \text{cm}$	45
Mobility of $e^-$ ( $\mu_n$ ) cm <sup>2</sup> /Vs	3800
Mobility of holes ( $\mu_p$ ) cm <sup>2</sup> /Vs	1800
$D_n$ ; cm <sup>2</sup> /s	99
$D_p$ ; cm <sup>2</sup> /s	47
	34
	\$3
	230K
	1300
	500

→ In n-type silicon, donor concentration is 1 atom /  $2 \times 10^8$  Si atoms

Assuming that the effective mass of the  $e^-$  equals to its true mass

At what temperature will the fermilevel coincides with the edge of conduction band.

$$N_D = \frac{1}{2 \times 10^8} \text{ atoms/cm}^3 \times \text{Atomic concentration of Si atoms} \\ \Rightarrow N_D = 2.5 \times 10^{14} / \text{cm}^3$$

$$m_n = m$$

$E_F = E_C \Rightarrow$  fermilevel coincides with conduction band

$$\boxed{N_C = N_D}$$

$$E_C - E_F = KT \ln \left( \frac{N_C}{N_D} \right)$$

$$N_C = 4.82 \times 10^{15} \times \left( \frac{m_n}{m} \right)^{3/2} \times T^{3/2}$$

$$N_C = 4.82 \times 10^{15} \times T^{3/2}$$

→ In an n-type semiconductor fermi level lies 0.3 eV below the conduction band at 300K. If the temperature is increased to 330K, find the new position of the fermi level.

$$E_C - E_F = 0.3 \text{ eV}; T = 300\text{K}$$

$$E_C - E_F = KT \ln \left( \frac{N_c}{N_D} \right)$$

$$0.3 = 0.02586 \ln \left( \frac{N_c}{N_D} \right)$$

$$\ln \left( \frac{N_c}{N_D} \right) = 11.6$$

$$E_C - E_F = KT \ln \left( \frac{N_c}{N_D} \right)$$

$$= 8.85 \times 10^{-5} \times 300 \times 11.6$$

$$= 0.338 \text{ eV}$$

$$\begin{aligned} E_C - E_F &\propto T \\ \Rightarrow \frac{(E_C - E_F)_{300}}{(E_C - E_F)_{330}} &= \frac{T_1}{T_2} \end{aligned}$$

$$\Rightarrow E_C - E_F = 0.33 \text{ eV}$$

→ If the effective mass of an  $e^-$  is equal to thrice the effective mass of a hole, find the distance of the fermi level in an intrinsic semiconductor from the centre of the forbidden band at room temperature.

$$\begin{aligned} m_n &= 3m_p & KT \ln \left( \frac{N_c}{N_V} \right) &= \frac{0.02586}{2} \ln (3^{3/2}) \\ \frac{m_n}{m_p} &= 3 & &= 0.021 \text{ eV} \end{aligned}$$

$$E_{F_i} = E_F = \frac{E_C + E_V}{2} - \frac{KT}{2} \ln \left( \frac{N_c}{N_V} \right)$$

i.e., Fermi level lies <sup>above</sup><sub>below</sub> the centre at a distance of 0.021 eV

$$= 10^{20} \text{ e-h pair/cm}^3/\text{sec}$$

→ A Si sample is uniformly doped with  $10^{16}$  phosphorous atoms/cm<sup>3</sup> and  $2 \times 10^{16}$  Boron atoms/cm<sup>3</sup>. If all the dopants are fully ionised, the material is ...

a) n-type with a carrier concentration of  $10^{16}/\text{cm}^3$

b) p-type " "  $10^{16}/\text{cm}^3$

c) n-type " "  $2 \times 10^{16}/\text{cm}^3$

d) p-type " "  $2 \times 10^{16}/\text{cm}^3$

$$N_A > N_D \Rightarrow \text{p-type}$$

$$P = N_A - N_D \quad \text{if doping concentration} \gg n_i \\ (N_A - N_D)$$

$$\therefore P = (2 \times 10^{16} - 10^{16}) \text{ atoms/cm}^3$$

$$\Rightarrow P = 10^{16} \text{ atoms/cm}^3 \quad (\text{Q) use } \left(\frac{N_A - N_D}{2}\right) + \sqrt{\left(\frac{N_A - N_D}{2}\right)^2 + n_i^2}$$

→ A small concentration of minority carriers are injected into a semiconductor crystal at one point. An electric field of  $10V/\text{cm}$  is applied across the crystal, and this moves the minority carriers a distance of 1 cm in 20 ms. The mobility of the carriers is ...

$$E = 10V/\text{cm}$$

$$V_d = \mu E \Rightarrow \mu = \frac{1 \text{ cm} / 20 \times 10^{-6}}{10} = 5000 \text{ cm}^2/\text{V-sec}$$

$$= 0.1 \text{ cm}$$

→  $e^-$  mobility and life time in a semiconductor at room temperature are  $0.36 \text{ m}^2/\text{V}\cdot\text{s}$  and  $340 \text{ ns}$ . Diffusion length is

$$* M = 39 D *$$

$$D = \frac{0.36}{39} = 9.23 \times 10^{-3}$$

$$L = \sqrt{9.23 \times 10^{-3} \times 340 \times 10^{-6}} \\ = 1.77 \times 10^{-3} \text{ m}$$

$$L = 1.77 \text{ mm}$$

→ The Hall constant in a p-type Si ball is given by  $5 \times 10^3 \text{ cm}^3/\text{C}$   
The hole concentration in ball is

$$R_H = \frac{1}{\rho e} = \frac{1}{R_H e} = \frac{1}{1.25 \times 10^{15} / \text{cm}^3}$$

→ Two pure specimens of a semiconductor materials are taken  
one is doped with  $10^{18}/\text{cm}^3$  no: of donors and the other  
is doped with  $10^{16}/\text{cm}^3$  no: of acceptors. The minority carrier  
density in first specimen is  $10^7/\text{cm}^3$ . What is the minority  
carrier density in the other specimen.

$$n_1 = 10^{18}/\text{cm}^3$$

$$P_2 = 10^{16}/\text{cm}^3$$

$$P_1 = 10^7/\text{cm}^3$$

$$n_2 = ?$$

According to mass action law,  $n P = n_i^2$

$$n_1 P_1 = n_2 P_2 \Rightarrow n_2 = \frac{n_1 P_1}{P_2} = 10^9 / \text{cm}^3$$

$$= -0.416 \text{ mA/cm}^2$$

→ A heavily doped n-type semiconductor has the following

data: Hole-e<sup>-</sup> mobility ratio =  $\frac{\mu_p}{\mu_n} = 0.4$

Doping Concentration =  $4.2 \times 10^8 / \text{m}^3$

Intrinsic Concentration =  $1.5 \times 10^4 / \text{m}^3$

The ratio of conductivity of the n-type semiconductor to that of the intrinsic semiconductor of same material under the same temperature is given by

$$\frac{\mu_p}{\mu_n} = 0.4; N_D = 4.2 \times 10^8 / \text{m}^3 \approx n$$

$$n_p = 1.5 \times 10^4 / \text{m}^3$$

$$\frac{\sigma_n}{\sigma_{n_i}} = \frac{n_p \mu_n}{n_i (\mu_n + \mu_p)} = \frac{n \mu_n}{(\mu_n + 0.4 \mu_n) n_i} = 20,000$$

$$= \frac{4.2 \times 10^8}{1.4 \times 1.5 \times 10^4}$$

→ e<sup>-</sup> concentration in a sample of uniformly doped n-type Si at 300K varies linearly from  $10^{17} / \text{cm}^3$  at  $x=0$  to  $6 \times 10^{16} / \text{cm}^3$  at  $x=2 \text{ mm}$ . If e<sup>-</sup> charge is  $1.6 \times 10^{-19} \text{ C}$  and Diffusion constant  $D_n = 35 \text{ cm}^2/\text{sec}$ , the  $J_n$  in Si if no electric field is present is

$$J_n = e D_n \frac{dn}{dx}$$

$$= 1.6 \times 10^{-19} \times 35 \times \frac{10^{17} - 6 \times 10^{16}}{2 \times 10^{-4} - 0}$$

$$= 1120 \text{ A/cm}^2$$

$$= 25 \times 10^{-3} \times \ln \left( \frac{4 \times 10^{17}}{1.5 \times 10^{10}} \right)$$

$$= 0.427 \text{ eV}$$

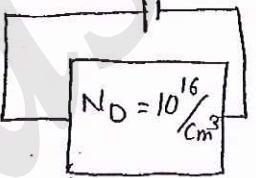
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→ A Si sample with unit cross sectional area shown below is in thermal equilibrium. The following information is given

$T = 300\text{K}$ , electric charge  $= 1.6 \times 10^{-19} \text{ C}$ , Thermal voltage  $V_f = 26\text{mV}$  and  $e^-$  mobility  $1350 \text{ cm}^2/\text{V-sec. 1V}$

$$V = 1\text{V}, L = 1\mu\text{m}$$

$$E = V/L = 10^6$$



$$J = nevE$$

$$v = ME$$

1) The magnitude of electric field at  $x = 0.5 \mu\text{m}$ . BS:

- a)  $1\text{KV/m}$  b)  $5\text{KV/m}$  c)  $10\text{KV/m}$  d)

\* Electric field remains same at any point. It is independent of Length.

$$E = V/L = 1/\mu\text{m} = 10^6 \text{ V/m}$$

$$= 10^4 \text{ V/cm}$$

$$= 10\text{ KV/cm}$$

2) The magnitude of the  $e^-$  drift current density at  $x = 0.5\mu\text{m}$ . BS

$$J_n = N_D evE$$

$$= 10^{16} \times 1.6 \times 10^{-19} \times 1350 \times 10 \times 10^3$$

$$= 21600 \text{ A/cm}^2$$

$$= B \times v$$

→ If sample A is doped with  $10^{18}$  atoms/cm<sup>3</sup> of Boron  
Another sample B of identical dimensions is doped with  
 $10^{18}$  atoms/cm<sup>3</sup> of Phosphorous. The ratio of e<sup>-</sup> to hole  
mobility is 3. The ratio of conductivity of the sample

A to B is

$$v = \mu E$$

$$N_A = P = 10^{18} \text{ atoms/cm}^3$$

$$N_B = n = 10^{18} \text{ atoms/cm}^3$$

$$\sigma = ne\mu$$

$$\frac{\sigma_A}{\sigma_B} = \frac{\mu_p N_A}{\mu_n N_B} = \frac{1}{3} \times \frac{10^{18}}{10^{18}} = \frac{1}{3} //$$

→ The resistivity of a uniformly doped n-type silicon sample  
is  $0.5 \Omega\text{-cm}$ . If the e<sup>-</sup> mobility is  $1250 \text{ cm}^2/\text{V}\cdot\text{sec}$ , and  
the charge of an e<sup>-</sup> is  $1.6 \times 10^{-19} \text{ C}$ , the donor impurity  
concentration in the sample is

$$\rho_n = 0.5 \Omega\text{-cm}$$

$$\rho_n = \frac{1}{N_D e \mu_n}$$

$$\Rightarrow N_D = \frac{0.5}{0.5 \times 1.6 \times 10^{-19} \times 1250} = 2 \times 10^{15} \text{ atoms/cm}^3$$

→ The intrinsic carrier concentration in Si is to be no greater  
than  $n_i = 1 \times 10^{12} \text{ /cm}^3$ . The maximum temperature allowed  
for Si is a) 300K b) 360K c) 399K d) 381K

Given  $E_G = 1.12 \text{ eV}$

$$(1 \times 10^{12})^2 = 2.33 \times 10^{31} \left[ \frac{m_n m_p}{m^2} \right]^{3/2} \cdot T^{3/2} \cdot e^{-E_G/kT}$$

$$10^{24} = 2.33 \times 10^{31} \left[ \frac{1.08 \times 0.56 \text{ m}^2}{m^2} \right]^{3/2} \cdot T^{3/2} \cdot e^{-1.12/kT}$$

$$K = 8.6 \times 10^{-5}$$

$$e^{\frac{-1.12}{kT}} = 10.95 \times 10^{-32}$$

$$\Rightarrow e^{-1.12/kT} T^{3/2} = 9.125 \times 10^{-8}$$

$$-\frac{1.12}{kT} + \frac{3}{2} \ln T = -16.21$$

$$3 \ln T = -16.21 + \frac{13023}{T}$$

$$\Rightarrow T = 381 \text{ K}$$

$$\begin{aligned} T=300 \text{ K} &\Rightarrow 17.11 \neq 27.2 \\ T=360 \text{ K} &\Rightarrow 5.88 \neq 19.96 \\ T=399 \text{ K} &\Rightarrow 17.96 \neq 16.42 \\ \checkmark T=381 &\Rightarrow 17.82 = 17.97 \end{aligned}$$

$\rightarrow$  Two semiconductor materials have exactly the same properties except that material A has a band gap of 1 eV. and material B has a band gap energy of 1.2 eV. The ratio of Intrinsic concentration of material A to that of material B is

$$\begin{aligned} \frac{n_1}{n_2} &= \frac{e^{-E_{G_1}/kT}}{e^{-E_{G_2}/kT}} \cdot \frac{10.95 \times 10^{-32}}{7.0 \times 10^{-32}} \\ &= \frac{5.798 \times 10^{-10}}{8.386 \times 10^{-11}} = 6.91 \end{aligned}$$

$n_{PB}$

→ In Si, at  $T=300K$  if the fermi energy level is 0.22eV above the valence band energy, calculate hole concentration

$$\times (E_F - E_V = KT \ln \left( \frac{N_V}{N_A} \right)) \Rightarrow P = N_V e^{-(E_F - E_V)/KT}$$

$$N_V = 4.82 \times 10^{15} \left( \frac{m_p^{3/2}}{m_e^{3/2}} T^{3/2} \right)$$

$$= 4.82 \times 10^{15} \left( \frac{0.56 m}{m} \right)^{3/2} 300^{3/2}$$

$$= 1.0496 \times 10^{19}$$

$$0.22 = 0.02586 \ln \left( \frac{1.0496 \times 10^{19}}{N_A} \right)$$

$$P = N_V e^{-(E_F - E_V)/KT}$$

$$= 2.12 \times 10^{15} / \text{cm}^3$$

→ In Ge semiconductor, at  $T=300K$ , the  $N_A$  is  $10^{13} / \text{cm}^3$  and donor concentration  $N_D = 0$ . calculate thermal equilibrium concentration of  $e^-$  and holes.

$$N_A = 10^{13} / \text{cm}^3 \quad n_p = n_i^2$$

$$N_D = 0$$

$$T = 300K$$

$$P = \frac{N_A - N_D}{2} + \sqrt{\left( \frac{N_A - N_D}{2} \right)^2 + n_i^2}$$

$$n_i \text{ in Ge} = 2.5 \times 10^{13} / \text{cm}^3$$

$$P \approx \frac{N_A - N_D}{2} + \frac{k_B T - k_B T_D}{2k_B} = k_B T e^{-\frac{E_D}{k_B T}}$$

$$\Rightarrow P = 3 \times 10^{13} / \text{cm}^3$$

is to be  $10^{-6} \text{ cm}^2$ . and also the doping efficiency is known to be 90 %. Calculate doping needed. Assume

$$M_n = 8000 \text{ cm}^2/\text{V-sec}$$

$$R = 2kA, L = 20 \mu\text{m}, A = 10^{-6} \text{ cm}^2$$

$$R = \frac{\rho L}{A} \Rightarrow \rho = \frac{RA}{L} = \frac{2 \times 10^3 \times 10^{-6}}{20 \times 10^{-4}} = 1$$

$$\rho = \frac{1}{ne\mu} \quad \text{doping efficiency} = 90\%$$

$$\Rightarrow \frac{1}{n} = \frac{1}{0.9 N_D} \Rightarrow n = 0.9 N_D$$

$$1 = \frac{1}{0.9 N_D \times 1.6 \times 10^{-19} \times 8000}$$

$$\Rightarrow N_D = 8.68 \times 10^{14} / \text{cm}^3$$

→ A Si sample doped n-type at  $10^{18} / \text{cm}^3$  have a resistance of  $10\Omega$ . The sample has an area of  $10^{-6} \text{ cm}^2$  and a length of  $10 \mu\text{m}$ . The doping efficiency of the sample is

$$\text{Assume } M_n = 800 \text{ cm}^2/\text{V-sec}$$

$$R = 10\Omega, L = 10^{-3} \text{ cm}, A = 10^{-6} \text{ cm}^2, N_D = 10^{18}$$

$$R = \frac{\rho L}{A} \Rightarrow \rho = \frac{RA}{L} = \frac{1}{100} \text{ n-ohm}$$

$$\rho = \frac{1}{n e \mu} \Rightarrow \text{Resistor}$$

$$A$$

$$P = \frac{1}{nem} \Rightarrow n = \frac{1}{Pem} = 7.8125 \times 10^{17} / \text{cm}^3$$

$$\text{Doping Efficiency} = \frac{n}{N_D} \times 100 = \frac{7.8 \times 10^{17}}{1 \times 10^{18}} \times 100 \\ = 78 \%$$

→ Three scattering mechanisms exist in a semiconductor if only the first mechanism was present, the mobility would be  $500 \text{ cm}^2/\text{V-sec}$ , if only second mechanism was present,  $\mu_e$  would be  $750 \text{ cm}^2/\text{V-sec}$ , if only third mechanism was present,  $1500 \text{ cm}^2/\text{V-sec}$ . Then the net mobility is

$$\frac{1}{\mu} = \frac{1}{\mu_1} + \frac{1}{\mu_2} + \frac{1}{\mu_3}$$

$$= \frac{1}{500} + \frac{1}{750} + \frac{1}{1500}$$

$$\Rightarrow \frac{1}{\mu} = \frac{1}{250} \Rightarrow \mu = 250 \text{ cm}^2/\text{V-sec}$$

→ 6V is applied across a 2cm long semiconductor bar the average drift velocity is  $10^4 \text{ cm/sec}$ . Then the e<sup>-</sup> mobility is

$$v = mE \quad E = \frac{6}{2} = 3 \text{ V/cm}$$

$$\mu = \frac{v}{E} = \frac{10^4}{6/2} = \frac{10^4}{3} = 3.333 \times 10^3 \text{ cm}^2/\text{V-sec}$$

→ In a GaAs sample, the e<sup>-</sup> are moving under an electric field of 5kV/cm and the carrier concentration is uniform at  $10^{16} / \text{cm}^3$ . The e<sup>-</sup> velocity is the saturated velocity of

For a sample of length, having time  $T_{sc}$  to sec  
and  $e^-$  effective mass  $m_n = 0.067 m$ . If an electric field  
of 1 KV/cm is applied, the drift velocity produced

75

$$\begin{aligned}\mu &= \frac{eT_{sc}}{m_n} & V &= \mu E \\ & & &= \frac{eT_{sc}}{m_n} \times E \\ & & &= \frac{1.6 \times 10^{-19} \times 10^{-13} \times 1000}{0.067 \times 9.1 \times 10^{-38}} \\ & & &= 262.42 \times 10^{-3} \text{ cm/sec} \\ & & &= 0.2624 \text{ cm/sec.}\end{aligned}$$

→ An n-type Ge sample of is 2mm wide and 0.2 mm thick  
A current of 10mA is passed through the sample (x-direction)  
and a magnetic field of 0.1 wb/m<sup>2</sup> is directed perpendicular  
to the current flow (z-direction). The developed Hall voltage  
is 1mV. Calculate Hall coefficient and  $e^-$  concentration

$$R_H = \frac{V_H W}{BI} = \frac{1 \times 10^{-3} \times 2 \times 10^{-3}}{0.1 \times 10^{-3} \times 10} = 2 \times 10^{-3} \text{ m}^3/\text{C}$$

$$R_H = \frac{1}{ne} \Rightarrow n = \frac{1}{2 \times 10^{-3} \times 1.6 \times 10^{-19}}$$

$$\begin{aligned}\Rightarrow n &= 3.125 \times 10^{22} / \text{cm}^3 \\ &= 3.125 \times 10^{15} / \text{cm}^3\end{aligned}$$

$$\begin{aligned}
 &= n_i e (\mu_n + \mu_p) \\
 &= 1.6 \times 10^{16} \times 1.6 \times 10^{-19} \times (1250 + 480) \\
 &= 4.4288 \times 10^{-4} (\text{A/m})^{-1}
 \end{aligned}$$

$$N_D = 10^{23} \frac{\text{Atoms}}{\text{m}^3} \approx n$$

$$\begin{aligned}
 E_F - E_{F_i} &= kT \ln \left( \frac{N_D}{n_i} \right) & n_p = n_i^2 \\
 &= +0.406 \text{ eV} & \Rightarrow p = \frac{n_i^2}{N_D} = 2.56 \times 10^9 / \text{m}^3
 \end{aligned}$$

$$\begin{aligned}
 \text{Conductivity } \sigma_n &= (n_n \mu_n + p_n \mu_p) v \quad \& \quad \sigma_n = n_n \mu_n v \\
 &= (10^{23} \times 0.125 + 2.56 \times 10^9 \times 0.048) 1.6 \times 10^{-19} \\
 &= 2000 (\text{A/m})^{-1}
 \end{aligned}$$

→ A Si body is doped with  $10^{17}$  As atoms/cm<sup>3</sup>. What is the equilibrium hole concentration at 300K? Where is the fermilevel of the sample located relative to intrinsic fermilevel? it is known that  $n_i = 1.5 \times 10^{10} / \text{cm}^3$

$$\begin{aligned}
 n_p &= n_i^2 \\
 N_D &\gg n_i \\
 \Rightarrow p &= \frac{n_i^2}{N_D} = 2250
 \end{aligned}$$

$$E_F - E_{F_i} = kT \ln \left( \frac{N_D}{n_i} \right) = 0.406 \text{ eV}$$

$$R = 100 \Omega$$

$$L = 10 \text{ cm}$$

$$A = 1 \times (10^{-3})^2$$

$$= 1 \times 10^{-6} \times 10^{-4} \text{ m}^2$$

$$\approx 1 \times 10^{-10} \text{ cm}^2$$

$$M_n = 1350$$

$$P = \frac{RA}{L}$$

$$P = 100 \times 10^{-10}$$

$$= 10^{-10} (\text{V/cm})^{-1}$$

$$P = \frac{1}{nem} \Rightarrow n = \frac{1}{PeM}$$

$$n = 4.62 \times 10^{15} / \text{cm}^3$$

→ In an n-type semiconductor at  $T = 300 \text{ K}$ , the  $e^-$  concentration varies linearly from  $2 \times 10^{18}$  to  $5 \times 10^{17} / \text{cm}^3$  over a distance of 1.5 mm and diffusion current density is  $360 \text{ A/cm}^2$

Find the mobility of  $e^-$

$$J_n = eD_n \frac{dn}{dx}$$

$$\Rightarrow D_n = \frac{360}{(2 \times 10^{18} - 5 \times 10^{17}) \times 1.6 \times 10^{-19}} = \frac{360}{\frac{1.5 \times 10^{-1} \text{ cm}}{0.15}} = \frac{15 \times 10^{17}}{0.15} \times 1.6 \times 10^{19} = 225 \text{ cm}^2/\text{sec}$$

$$M = 39 D_n$$

$$= 58500 \text{ cm}^2/\text{v-sec}$$

$$= 8775$$

→ In intrinsic GaAs, the  $e^-$  and hole mobilities are  $0.85 \text{ m}^2/\text{v-sec}$  and  $0.04 \text{ m}^2/\text{v-sec}$  and corresponding effective masses are  $0.068 m_0$  and  $0.5 m_0$  respectively where  $m_0$  is the rest

$$= 4 \cdot 44 \times 10^{17} / \text{m}^3$$

$$N_V = 4.82 \times 10^{15} \left( \frac{m_p}{m} \right)^{3/2} T^{3/2}$$

$$= 8.85 \times 10^{18} / \text{m}^3$$

$$n_i^2 = 2.33 \times 10^{31} \times \left( \frac{m_n m_p}{m^2} \right)^{3/2} T^3 e^{-E_g/kT} / \text{cm}^3$$

$$= 3.806 \times 10^{12} / \text{cm}^3$$

$$n_i = 1.9 \times 10^6 / \text{cm}^3$$

Conductivity  $\sigma_i = n_i e (\mu_n + \mu_p)$

$$= 1.9 \times 10^6 \times 1.6 \times 10^{-19} \times (8500 + 400)$$

$$= 2.7 \times 10^{-9} (\text{A/cm})^{-1}$$

→ The intrinsic resistivity of Ge at room temperature is ( $44.6 \Omega\text{-cm}$ ,  $0.47 (\text{A-m})$ ). The  $e^-$  and hole mobilities at room temperature are  $0.39 \text{ m}^2/\text{V-sec}$  and  $0.9 \text{ m}^2/\text{V-sec}$ . Calculate the density of  $e^-$  in the intrinsic semiconductor and also calculate drift velocities of charge carriers for a field of  $10 \text{ KV/m}$

$$\rho = 0.47 \Rightarrow \sigma = \frac{1}{\rho} = n_i e \mu$$

$$n_i e (\mu_n + \mu_p) = \frac{1}{0.47}$$

$$n = p = n_i = \frac{1}{0.47 \times 1.6 \times 10^{-19} \times (0.39 + 0.9)}$$

$$= 2.29 \times 10^{19} / \text{m}^3 = 2.29 \times 10^{13} / \text{cm}^3$$

$$v_n = \mu_n E$$

$$= 0.39 \times 10 \times 10^3$$

$$= 3.9 \times 10^3 \text{ m/sec}$$

$$v_p = \mu_p E$$

$$= 0.9 \times 10 \times 10^3$$

$$= 9 \times 10^3 \text{ m/sec}$$

$$\Rightarrow 4\mu_p = \frac{1}{\rho n_i e} = \frac{4 \times 3000 \times 1.6 \times 10^{-19}}{1.1 \times 10^6} = 4734.8485 \times 10^5 \text{ m}^2/\text{V-sec}$$

$$\mu_n = 3\mu_p = 1420.4545 \times 10^6 \text{ m}^2/\text{V-sec}$$

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→ A semiconductor has the following data

$$\mu_n = 7500 \text{ cm}^2/\text{V-s}$$

$$\mu_p = 300 \text{ cm}^2/\text{V-s}$$

$$n_i = 3.2 \times 10^9 \text{ cm}^2/\text{V-sec}$$

i) When conductivity is minimum, calculate hole concentration

$$\sigma = (n\mu_n + p\mu_p)q$$

$$np = n_i^2 \Rightarrow n = n_i^2/p$$

$$\sigma = (n_i^2/p \mu_n + p\mu_p)q$$

$$\frac{d\sigma}{dp} = -\frac{n_i^2}{p^2} \mu_n q + \mu_p q$$

$$\frac{d\sigma}{dp} = 0 \Rightarrow -\frac{n_i^2}{p^2} \mu_n q + \mu_p q = 0 \\ \Rightarrow \frac{n_i^2}{p^2} \mu_n = \mu_p$$

$$\Rightarrow p^2 = n_i^2 \frac{\mu_n}{\mu_p}$$

$$\Rightarrow P = n_i \sqrt{\frac{\mu_n}{\mu_p}}$$

$$P_{min} = n_i \sqrt{\frac{\mu_n}{\mu_p}}$$

$$P_{min} = 3.2 \times 10^9 \sqrt{\frac{7500}{300}} = 1.6 \times 10^{10} / \text{cm}^3.$$

$$\sigma_{min} = 2 \times 3.2 \times 10^9 \times \sqrt{7500 \times 300} \times 1.6 \times 10^{-19}$$

$$= 1.5 \times 10^{-6} (\text{A} \cdot \text{cm})^{-1}$$

iii) Calculate intrinsic conductivity.

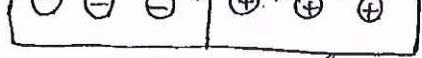
$$\sigma_i = n_i (\mu_n + \mu_p) v$$

$$= 3.2 \times 10^9 (7500 + 300) 1.6 \times 10^{-19}$$

$$= 3.99 \times 10^{-6}$$

$$\frac{P}{n_i} = \frac{1.6 \times 10^{10}}{3.2 \times 10^9} = 5$$

$$\frac{\sigma_{min}}{\sigma_i} = \frac{1.5 \times 10^{-6}}{3.99 \times 10^{-6}} = 0.37$$



Diffusion face  $\theta^\circ \rightarrow \cdot \Rightarrow \theta^\circ$  Diffusion face on electrons  
on holes

- Donor ions represented with +ve sign, because after donating  $e^-$ , donor atoms become +ve ions.
- Acceptor ions are represented with -ve sign because after accepting  $e^-$ , acceptor atoms becomes -ve ions.

### Direction of Charge

carriers



### Type of Carriers

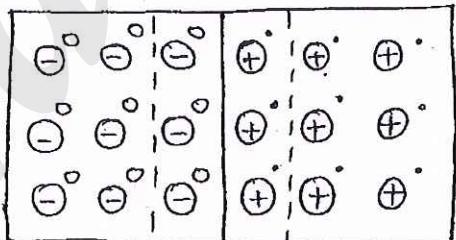
Hole-diffusion

$e^-$ . diffusion

### Direction of Current

$\rightarrow J_p$  (diff)

$\rightarrow J_n$  (diff)



Diffusion face on holes  $0 \rightarrow \leftarrow \rightarrow$  Diffusion force on  $e^-$

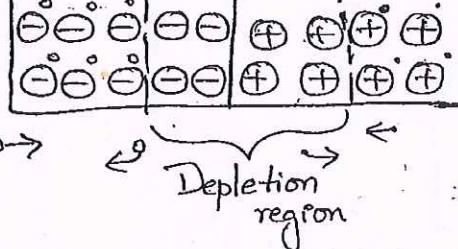
Drift Electric force on holes

$\leftarrow \dashrightarrow$  hole drift

$\dashrightarrow \rightarrow$  electron drift

$\leftarrow \dashrightarrow J_p$  (drift)

$\leftarrow \dashrightarrow J_n$  (drift)



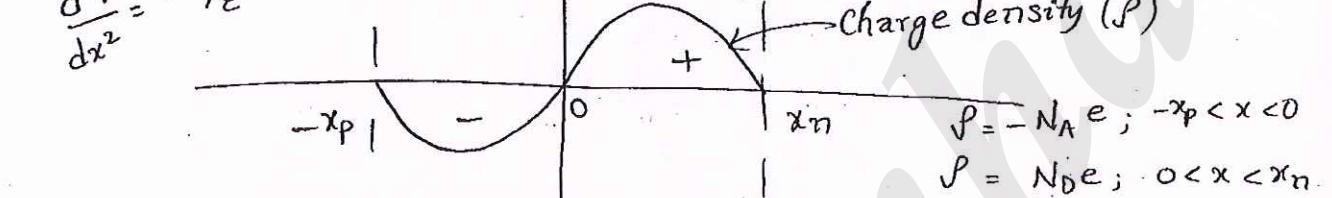
Here  $J_p(\text{drift}) = J_p(\text{diff})$   
 $J_n(\text{drift}) = J_n(\text{diff})$

- Depletion region is also called space charge region (d) Transition region.
- In normal p-n junction diodes, the width of the depletion region is in the order of  $\mu\text{m}$ .
- The width of the depletion region is inversely proportional to the square root of doping concentration.

$$W \propto \sqrt{\left( \frac{1}{N_A} + \frac{1}{N_D} \right)}$$

- In normal p-n junction diodes, the doping concentration is 1 impurity atom per  $10^8$  Si & Ge atoms.
- In Zener diode, the doping concentration is 1 impurity atom per  $10^5$  Si & Ge atoms.
- In Tunnel diode, the doping concentration is 1 impurity atom per  $10^3$  Si & Ge atoms.

$$\frac{d^2\phi}{dx^2} =$$



$$E = \int P/\epsilon dx$$

$$= P/\epsilon x$$

$$V = - \int \frac{P}{\epsilon} x \Rightarrow \frac{P x^2}{\epsilon} / 2$$

$\Rightarrow$  Integrating above  $P$

Electric field ( $E$ )

$$V_0 = V_{bi}$$

$\Rightarrow$  Barrier potential  
for holes  $\Rightarrow$  Integrating again  
above  $E$

Poisson's Equation:

$$\nabla^2 \psi = -P/\epsilon$$

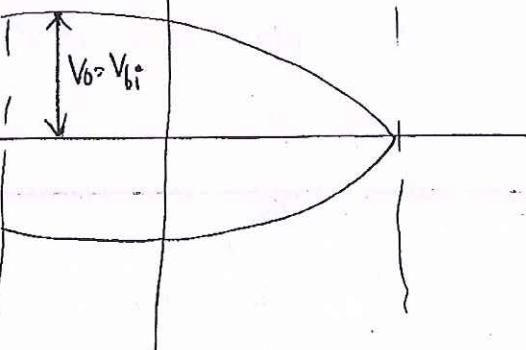
$$(2) \quad \nabla^2 \phi = -P/\epsilon$$

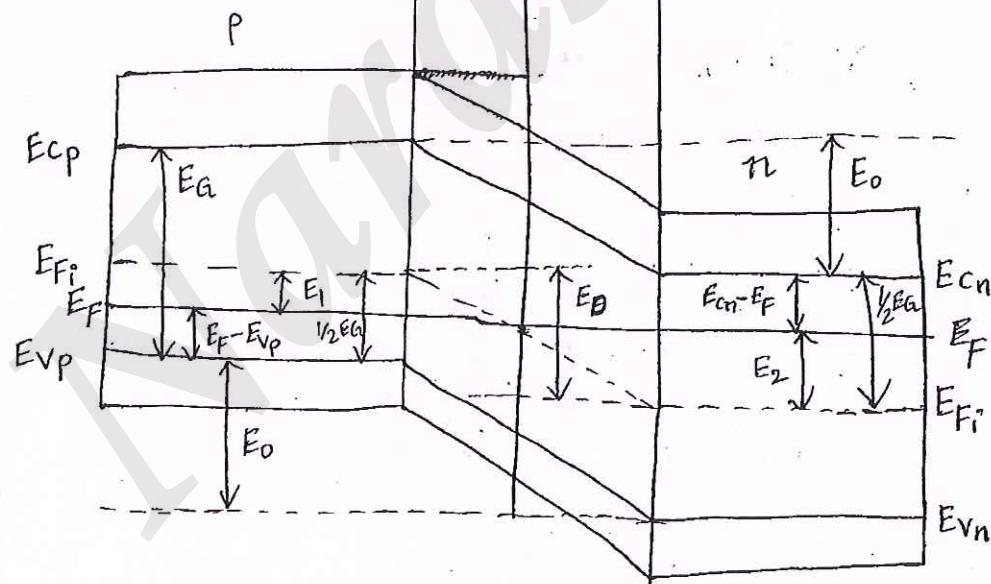
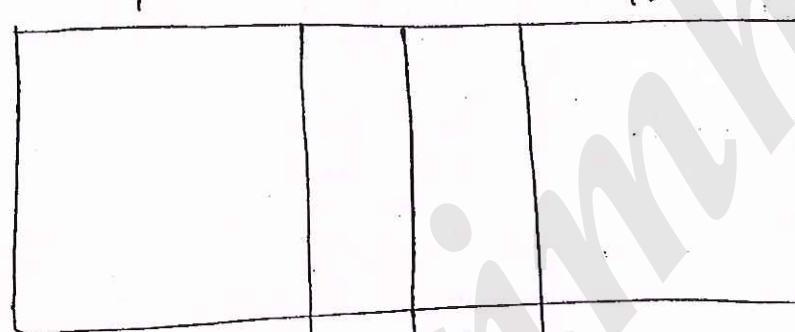
Laplace Equation

$$\nabla^2 \psi = 0$$

$$(2) \quad \nabla^2 \phi = 0$$

Barrier  
potential for e<sup>-</sup>





$$E_0 = E_{Cp} - E_{Cn} = E_{Vp} - E_{Vn} = E_1 + E_2$$

$$E_F - E_{Vp} = \frac{1}{2} E_G - E_1 \Rightarrow E_1 = \frac{1}{2} E_G - (E_F - E_{Vp}) \quad \textcircled{1}$$

$$E_{Cn} - E_F = \frac{1}{2} E_G - E_2 \Rightarrow E_2 = \frac{1}{2} E_G - (E_{Cn} - E_F) \quad \textcircled{2}$$

$$E_0 = E_1 + E_2 = E_G - (E_{Cn} - E_{Vp})$$

$$E_0 = KT \ln \left( \frac{N_C N_V}{n_i^2} \right)$$

$$= KT \ln \left( \frac{N_C N_V}{n_i^2} \cdot \frac{N_A}{N_V} \cdot \frac{N_D}{N_C} \right)$$

$$\Rightarrow E_0 = KT \ln \left( \frac{N_A N_D}{n_i^2} \right) \text{ eV}$$

$$eV_0 = E_0$$

$$\phi V_0 = KT \ln \left( \frac{N_A N_D}{n_i^2} \right) \phi V$$

$$V_0 = KT \ln \left( \frac{N_A N_D}{n_i^2} \right) \text{ volts}$$

M2

$$E_0 = E_1 + E_2$$

$$E_1 = E_{F_i} - E_F = KT \ln \left( \frac{N_A}{n_i} \right)$$

$$E_2 = E_F - E_{F_i} = KT \ln \left( \frac{N_D}{n_i} \right)$$

$$E_0 = KT \ln \left( \frac{N_A}{n_i} \right) + KT \ln \left( \frac{N_D}{n_i} \right)$$

$$E_0 = KT \ln \left( \frac{N_A N_D}{n_i^2} \right) \text{ eV}$$

$$V_0 = 0.6 \text{ V} \& 0.7 \text{ V for Si}$$

$$V_0 = 0.2 \text{ V} \& 0.3 \text{ V for Ge}$$

$$\frac{dV_o}{dT} = \frac{V_{o_2} - V_{o_1}}{T_2 - T_1} = -2.5 \text{ mV/}^{\circ}\text{C}$$

$$\Rightarrow V_{o_2} - V_{o_1} = -(T_2 - T_1) 2.5 \text{ mV/}^{\circ}\text{C}$$

$$\Rightarrow V_{o_2} = V_{o_1} - (T_2 - T_1) 2.5 \text{ mV/}^{\circ}\text{C}$$

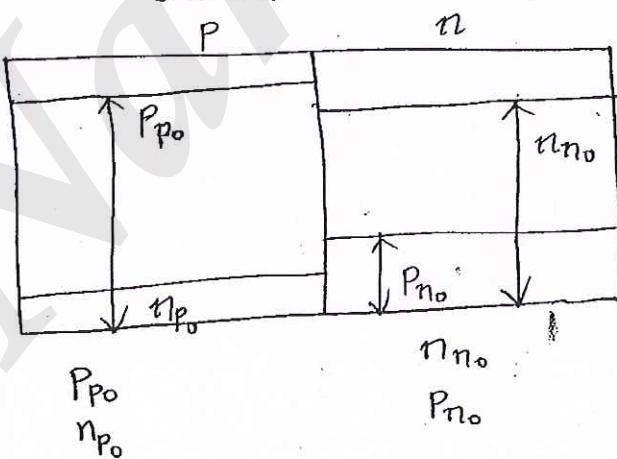
(Q) 700 mV at  $20^{\circ}\text{C}$ , then at  $40^{\circ}\text{C}$ ?

$$V_{o_2} = V_{o_1} - (T_2 - T_1) 2.5 \text{ mV/}^{\circ}\text{C}$$

$$= 700 - (40 - 20) 2.5 \text{ mV/}^{\circ}\text{C}$$

$$= 700 - (20)(2.5) \text{ mV/}^{\circ}\text{C}$$

$$= 650 \text{ mV}$$



$$n_{p_0} \cdot P_{p_0} = n_i^2$$

$$n_{p_0} = \frac{n_i^2}{P_{p_0}} = \frac{n_i^2}{N_A}$$

$$(\because P_{p_0} \approx N_A)$$

$$n_{n_0} \cdot P_{n_0} = n_i^2$$

$$P_{n_0} = \frac{n_i^2}{n_{n_0}} = \frac{n_i^2}{N_D}$$

$$(\because n_{n_0} \approx N_D)$$

( $\therefore$  As mobility of  $M_p$  is less than  $M_n$ )  
The doping concentration for p-type should be more than n-type and so minority carriers are less in p-type (doping mode)

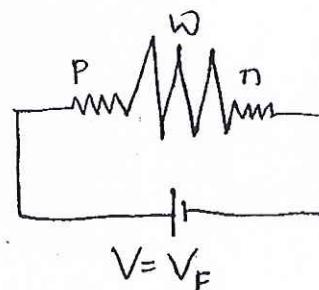
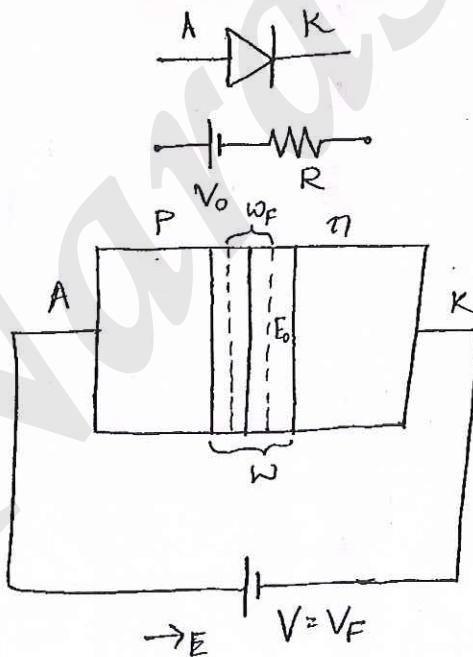
$$= kT \ln \left( \frac{N_D}{(n_i^2 / N_A)} \right)$$

$$\boxed{V_o = kT \ln \left( \frac{n_{n_0}}{n_{p_0}} \right)}$$

$$\boxed{\therefore V_o = V_{bi} = kT \ln \left( \frac{N_A N_D}{n_i^2} \right) = kT \ln \left( \frac{P_{p_0}}{P_{n_0}} \right) = kT \ln \left( \frac{n_{n_0}}{n_{p_0}} \right)}$$

Forward Bias:

Schematic Diagram



$$E = \frac{V}{w}$$

$$\boxed{w_F < w}$$

$$E_j = E_0 - E$$

$$\boxed{V_j = V_o - V = V_o - V_F}$$

$$V = V_R$$

$V_j$  = Junction Voltage

$$E_j = E_0 + E$$

$$\boxed{V_j = V_0 + V = V_0 + V_R}$$

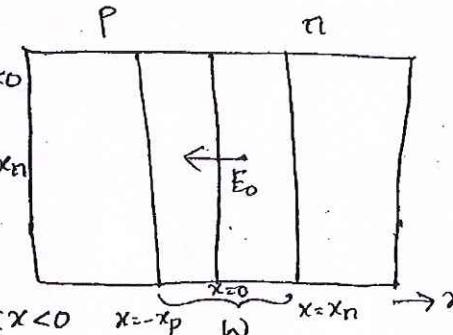
p-n junction Depletion Region & Width:

Forward Bias:

Charge density in p-side:  $\rho = N_A e$ ;  $-x_p < x < 0$

Charge density in n-side:  $\rho = N_D e$ ;  $0 < x < x_n$

Electric field in P-side ( $E$ ) =  $\int \frac{\rho}{\epsilon} dx$ ;



$$= \int \left( -\frac{e N_A}{\epsilon} \right) dx; -x_p < x < 0$$

$$E = -\frac{e N_A}{\epsilon} (x) + C_1; -x_p < x < 0$$

$$\text{At } x = -x_p \Rightarrow E = 0$$

$$0 = -\frac{e N_A}{\epsilon} (-x_p) + C_1$$

$$\Rightarrow C_1 = -\frac{e N_A}{\epsilon} x_p$$

$$\boxed{E_p = -\frac{e N_A}{\epsilon} (x_p + x); -x_p < x < 0} \quad -①$$

$$O = \frac{eN_D}{\epsilon} x + C_2$$

$$\Rightarrow C_2 = -\frac{eN_D}{\epsilon} x_n$$

$$E = \frac{eN_D}{\epsilon} x - \frac{eN_D}{\epsilon} x_n$$

$$= \frac{eN_D}{\epsilon} (x - x_n)$$

$$\boxed{E_n = -\frac{eN_D}{\epsilon} (x_n - x) ; 0 < x < x_n} \quad \text{--- (2)}$$

At  $x=0$ ,  $E_p = E_n$

$$-\frac{eN_A}{\epsilon} (x_p + 0) = -\frac{eN_D}{\epsilon} (x_n) \Rightarrow N_A x_p = N_D x_n$$

Potential on p-side:

$$\phi = + \int E dx ; -x_p < x < 0$$

$$E = -\frac{eN_A}{\epsilon} (x_p + x) ; -x_p < x < 0$$

$$\phi = \int \frac{eN_A}{\epsilon} (x_p + x) dx ; -x_p < x < 0$$

$$\phi = \frac{eN_A}{\epsilon} \left[ x_p x + \frac{x^2}{2} \right] + C_1 ; -x_p < x < 0$$

At  $x = -x_p \Rightarrow \phi = 0$

$$0 = \frac{eN_A}{\epsilon} \left( x_p (-x_p) + \frac{(-x_p)^2}{2} \right) + C_1 ; -x_p < x < 0$$

$$0 = \frac{eN_A}{\epsilon} \left( -x_p^2 + \frac{x_p^2}{2} \right) + C_1 ; -x_p < x < 0$$

$$\frac{x_p^2}{2} \frac{eN_A}{\epsilon} = C_1 ; -x_p < x < 0$$

$$\phi = \frac{eN_A}{\epsilon} \left( x_p x + \frac{x^2}{2} \right) + \frac{eN_A}{2\epsilon} x_p^2 ; -x_p < x < 0$$

$$\phi = \int \frac{eN_D}{\epsilon} (x_n - x) dx + C_2^1 \quad \dots \textcircled{5}$$

At  $x=0$ , potential on p-side = potential on n-side

$$\frac{eN_A}{2\epsilon} (x_p + 0)^2 = \frac{eN_D}{\epsilon} (x_n(0) - 0^2/2) + C_2^1$$

$$\frac{eN_A}{2\epsilon} x_p^2 = \frac{eN_D}{\epsilon} (0-0) + C_2^1$$

$$\therefore C_2^1 = \frac{eN_A}{2\epsilon} x_p^2$$

$$\phi = \frac{eN_D}{\epsilon} (x_n x - x^2/2) + \frac{eN_A}{2\epsilon} x_p^2; \quad 0 < x < x_n$$

At  $x=x_n$ ;  $V_0 = V_{bi}$  ?

$$V_0 = V_{bi} = \frac{eN_D}{\epsilon} (x_n x_n - x_n^2/2) + \frac{eN_A}{2\epsilon} x_p^2 \\ = \frac{eN_D}{2\epsilon} x_n^2 + \frac{eN_A}{2\epsilon} x_p^2$$

$$\boxed{V_0 = V_{bi} = \frac{e}{2\epsilon} [N_D x_n^2 + N_A x_p^2]} \quad \textcircled{6}$$

From eqn \textcircled{3};  $N_A x_p = N_D x_n$

$$x_p = \frac{N_D}{N_A} x_n$$

$$V_{bi} = \frac{e}{2\epsilon} \left[ N_D x_n^2 + N_A \left( \frac{N_D}{N_A} x_n \right)^2 \right]$$

$$V_{bi} = \frac{e}{2\epsilon} \left[ N_D x_n^2 + \frac{N_D^2}{N_A} x_n^2 \right]$$

$$V_{bi} = \frac{e}{2\epsilon} \left[ N_D \left[ x_p \frac{N_A}{N_D} \right]^2 + N_A x_p^2 \right]$$

$$= \frac{e}{2\epsilon} \left[ N_D x_p^2 \frac{N_A^2}{N_D^2} + N_A x_p^2 \right]$$

$$= \frac{e}{2\epsilon} \left[ \frac{N_A^2}{N_D} x_p^2 + N_A x_p^2 \right]$$

$$= \frac{e}{2\epsilon} \left[ \frac{N_A}{N_D} \right] [N_A + N_D] x_p^2$$

$$x_p^2 = \frac{2\epsilon}{e} V_{bi} \left[ \frac{N_D}{N_A} \right] \frac{1}{(N_A + N_D)}$$

$$x_p = \sqrt{\left( \frac{2\epsilon}{e} \right) (V_{bi}) \left( \frac{N_D}{N_A} \right) \left[ \frac{1}{N_A + N_D} \right]}$$

Width of the Depletion Region ( $w$ ):

$$w = x_n + x_p$$

$$= \sqrt{\left( \frac{2\epsilon}{e} \right) (V_{bi}) \left( \frac{1}{N_A + N_D} \right)} \left[ \sqrt{\frac{N_D}{N_A}} + \sqrt{\frac{N_A}{N_D}} \right]$$

$$= \sqrt{\left( \frac{2\epsilon}{e} \right) (V_{bi}) \left( \frac{1}{N_A + N_D} \right)} \left[ \frac{N_D + N_A}{\sqrt{N_A} \sqrt{N_D}} \right]$$

$$= \sqrt{\left( \frac{2\epsilon}{e} \right) (V_{bi}) \left( \frac{1}{N_A + N_D} \right)} \sqrt{\left[ \frac{N_D + N_A}{\sqrt{N_A N_D}} \right]^2}$$

(c) Under what circumstances will  $E_F$  coincide with  $E_C$ .

(d) Try this for p-type also.

(a)  $m_n = \frac{1}{2}m \Rightarrow \frac{m_n}{m} = 0.5$

$$N_C = 4.8 \times 10^{21} \cdot \left(\frac{m_n}{m}\right)^{3/2} \cdot T^{3/2} / \text{m}^3$$
$$= 4.8 \times 10^{15} \left(\frac{m_n}{m}\right)^{3/2} T^{3/2} / \text{cm}^3$$
$$= 8.818 \times 10^{18} / \text{cm}^3$$

$$E_C - E_F = KT \ln\left(\frac{N_C}{N_D}\right); N_D = A \times \text{no. of Donor atoms/S atom}$$
$$= 5 \times 10^{22} \times 10^{-8} / \text{Si atoms}$$
$$= 5 \times 10^{14}$$

$$E_C - E_F = 0.02586 \ln\left(\frac{8.818 \times 10^{18}}{5 \times 10^{14}}\right)$$
$$= 0.2528 \text{ eV}$$

→ Fermi level is at a distance of 0.2528 eV from the edge of CB

→  $E_F$  lies below  $E_C$

(b)  $N_C = 8.818 \times 10^{18} / \text{cm}^3$

$$N_D = \frac{5 \times 10^{22}}{10^3} = 5 \times 10^{19}$$

$$E_C - E_F = KT \ln\left(\frac{N_C}{N_D}\right) = 0.02586 \ln\left(\frac{8.818 \times 10^{18}}{5 \times 10^{19}}\right)$$
$$= -0.0448 \text{ eV}$$

→ Fermilevel is at a distance of 0.0448 eV from the edge of conduction band

→  $E_F$  is above  $E_C$ .

$$= \frac{1.77}{10^4} \times 10^{22}$$

i.e. if doping concentration is  $1.77 \times 10^4$  Si atoms, then fermi level coincides with the edge of conduction band.

- Q) a) In P-type Ge, acceptor concentration corresponds to  $1 \times 10^8$  Ge atoms, If the effective mass of the hole is half of its true mass at room temperature, how far from the edge of the valence band is the fermi level. Is  $E_F$  above or below  $E_V$ ?

$$N_V = 4.82 \times 10^{15} \left( \frac{m_p}{m_h} \right)^{3/2} T^{3/2} / \text{cm}^3$$

$$E_F - E_V = KT \ln \left( \frac{N_V}{N_A} \right)$$

$$N_V = 4.82 \times 10^{15} (0.5)^{3/2} 300^{3/2} / \text{cm}^3$$

$$N_V = 8.818 \times 10^{18} / \text{cm}^3$$

$$N_A = AC \times \text{No. of acceptor impurity atoms} / \text{cm}^3$$

$$= 4.4 \times 10^{22} \times 10^8 / \text{cm}^3$$

$$N_A = 4.4 \times 10^{14} / \text{cm}^3$$

$$E_F - E_V = KT \ln \left( \frac{N_V}{N_A} \right)$$

$$= 0.02586 \ln \left( \frac{8.818 \times 10^{18}}{4.4 \times 10^{14}} \right)$$

$$= 0.256 \text{ eV}$$

$$FB: V_j = V_{bi} - V = V_{bi} - V_F = V_0 - V = V_0 - V_F$$

$$RB: V_j = V_{bi} + V = V_{bi} + V_R = V_0 + V = V_0 + V_R$$

$$\underline{FB \downarrow} \omega = \sqrt{\left(\frac{2\epsilon}{e}\right)(V_{bi}-V)\left(\frac{1}{N_A} + \frac{1}{N_D}\right)}$$

$$\underline{RB \uparrow} \omega = \sqrt{\left(\frac{2\epsilon}{e}\right)(V_{bi}+V)\left(\frac{1}{N_A} + \frac{1}{N_D}\right)}$$

$$\therefore \omega \propto \sqrt{\frac{1}{N_A} + \frac{1}{N_D}}$$

Here  $x_p$  &  $w_p$  = Depletion region width on p-side

$x_n$  &  $w_n$  = Depletion region width on n-side

$\omega$  = Total depletion region width

$N_A$  = Acceptor concentration on p-side

$N_D$  = Donor Concentration on n-side

$$N_A x_p = N_D x_n$$

$$w_p N_A = w_n N_D$$

Depletion width on p-side:

$$x_p = \frac{N_D}{N_A} x_n$$

$$w_p = \frac{N_D}{N_A} x_n$$

$$w_p = x_p = \frac{N_D}{N_A + N_D} \omega$$

$$\omega = w_n + w_p = x_n + x_p$$

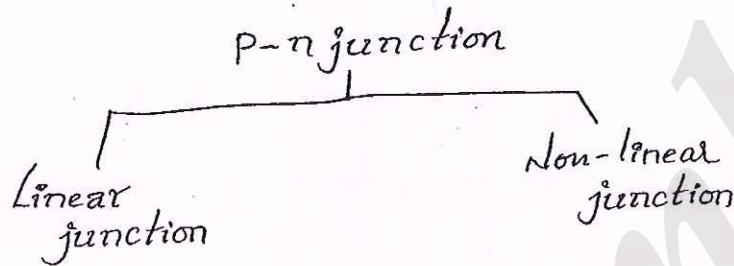
$$w_p = \frac{N_D}{N_A + N_D} (w_p + w_n)$$

$$w_p (N_A + N_D) = N_D (w_p + w_n)$$

$$w_p N_A + w_p N_D = N_D w_p + N_D w_n$$

$$w_p N_A = N_D w_n$$

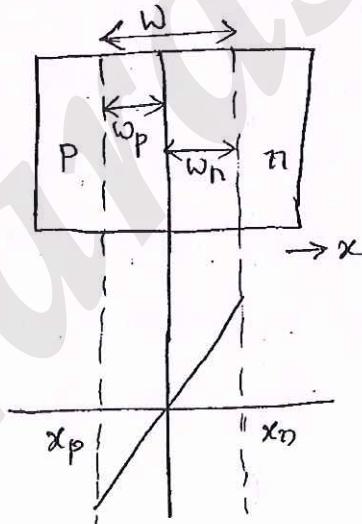
$$\Rightarrow w_p = \frac{N_D}{N_A} w_n$$



### Linear Junction:

If the doping concentrations are same on both the sides of the junction (i.e., p-side and n-side), it is called Linear junction.

→ Linear junction is also called grown junction (or) graded junction.

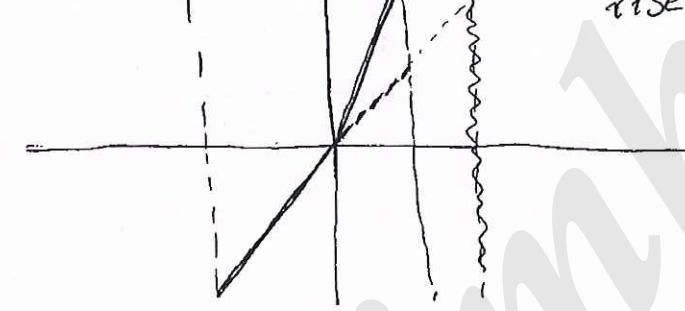


$$\Rightarrow \text{If } N_A = N_D \Rightarrow w_p = w_n \text{ & } x_p = x_n$$

$$\Leftrightarrow W = w_p + w_n = x_p + x_n$$

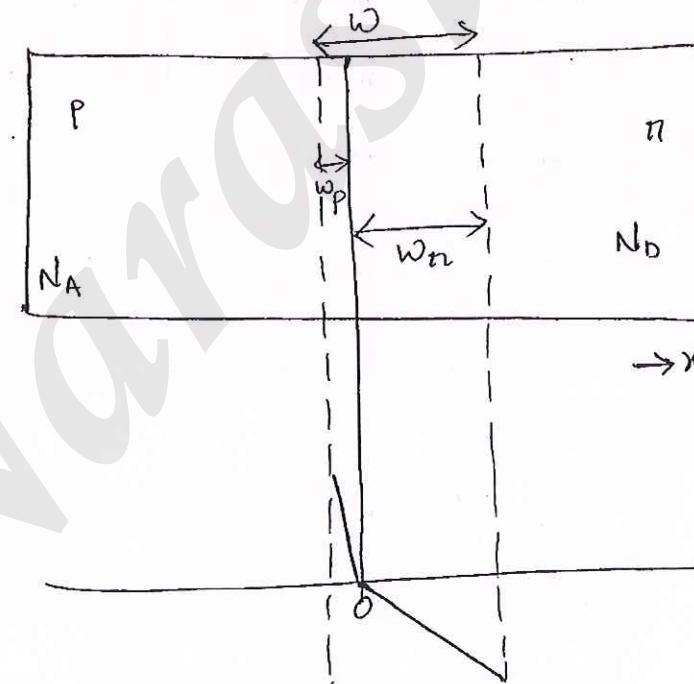
### Non-linear Junction:

If the doping concentrations are not same on both the sides of the junction (i.e., p-side and n-side) are called non-linear junction.



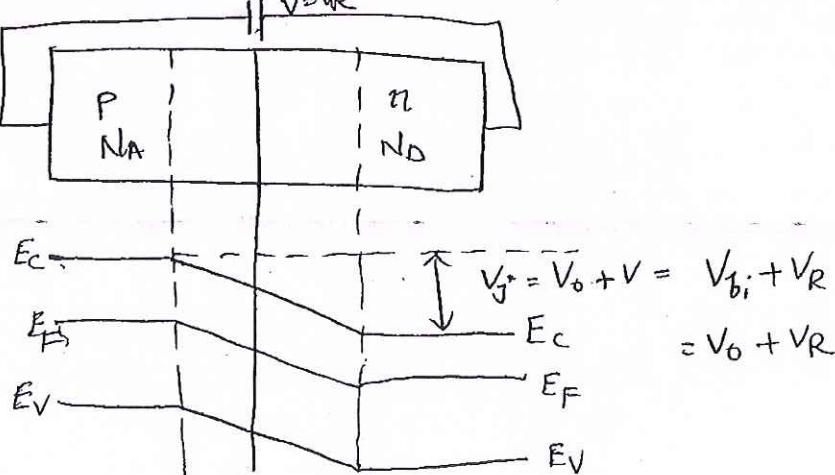
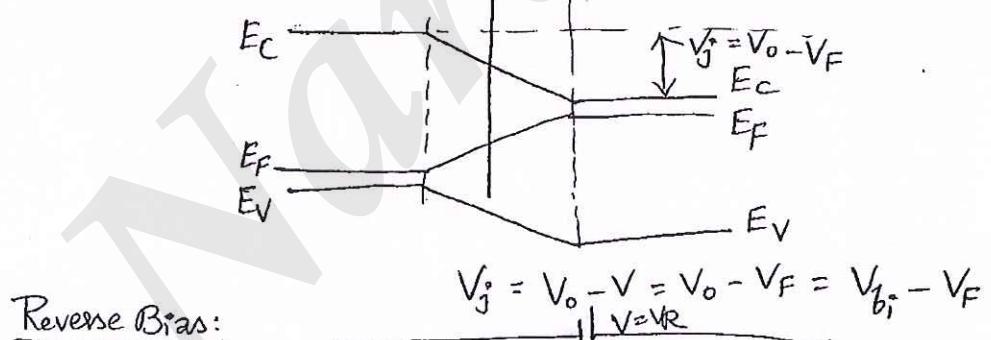
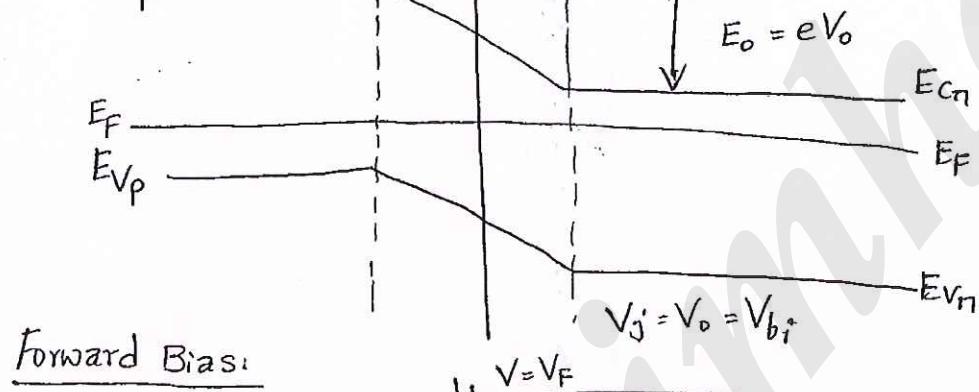
If  $N_A \ll N_D \Rightarrow \omega_p \gg \omega_n$

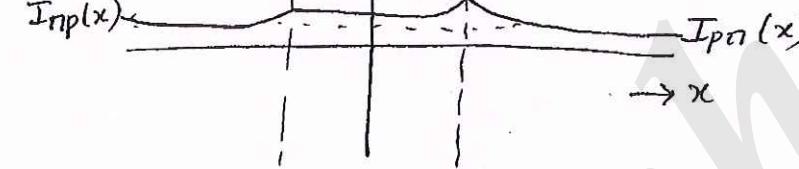
$$\rightarrow \omega = \omega_p + \omega_n \approx \omega_p$$



If  $N_A \gg N_D \Rightarrow \omega_p \ll \omega_n$

$$\rightarrow \omega = \omega_p + \omega_n \approx \omega_n$$





$$I = I_{pp}(x) + I_{pn}(x) \text{ on p-side}$$

$$I = I_{nn}(x) + I_{pn}(x) \text{ on n-side}$$

→ In a p-n junction, diffusion length of the carrier should be greater than the depletion width

$$I = I_{pp}(x) + I_{pn}(x) = I_{nn}(x) + I_{pn}(x)$$

$$\text{At } x=0 \Rightarrow I = I_{pn}(0) + I_{np}(0)$$

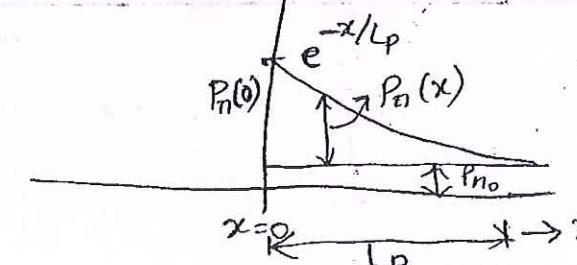
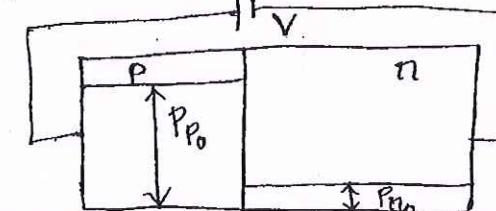
$$\boxed{I = I_{pp}(x) + I_{np}(x) = I_{nn}(x) + I_{pn}(x) = I_{pn}(0) + I_{np}(0)}$$

The concentration of holes on n-side

$$P_n(x) = P_{n_0} + P_n(0) e^{-x/L_p}$$

Hole concentration on n-side at  $x=0$

$$P_n(0) = P_{n_0} + P_n(0) \quad \text{--- (1)}$$



$P_n(x)$ : Concentration of holes on n-side at any point 'x' ( $\text{Å}$ ) at any distance  $x$ .

Diffusion Current due to holes on n-side:

$$I_{P_n}(x) = -AeD_p \frac{dP_n(x)}{dx}$$

$$\therefore J_p(\text{diff}) = J_p(\text{diff}) \cdot A$$

$$J_p(\text{diff}) = -eD_p \frac{dP}{dx}$$

$$J_p(\text{diff}) = -AeD_p \frac{dP}{dx}$$

$$I_{P_n}(x) = -AeD_p \frac{dP}{dx} P_n(0) e^{-x/l_p} (-1/l_p)$$

$$I_{P_n}(x) = -AeD_p P_n(0) e^{-x/l_p} (-1/l_p)$$

$$= AeD_p P_n(0) e^{-x/l_p} (1/l_p)$$

At  $x=0$

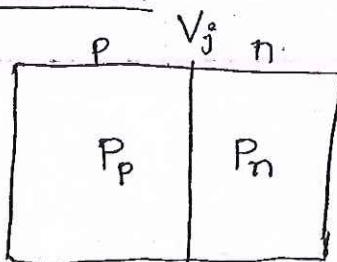
$$I_{P_n}(0) = \frac{AeD_p}{l_p} P_n(0)$$

From eqn (1)

$$P_n(0) = P_{n_0} + P_n(0)$$

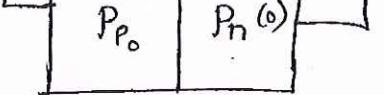
$$I_{P_n}(0) = \frac{AeD_p}{l_p} [P_n(0) - P_{n_0}] \quad \text{--- (2)}$$

Law of Junctions:



$$P_p = P_n \cdot e^{V_j/V_T}$$

$$P_n = P_p e^{-V_j/V_T}$$



$$P_n(0) = P_{P_0} e^{-(V_0 - V)/V_T}$$

$$\text{Eq } ③ = ④ \Rightarrow P_{n_0} e^{V_0/V_T} = P_{n(0)} e^{+(V_0 - V)/V_T}$$

$$P_{n_0} e^{V_0/V_T} = P_n(0) e^{+(V_0 - V)/V_T}$$

$$P_{n_0} e^{V_0/V_T} = P_n(0) e^{+V_0/V_T} \cdot e^{-V/V_T}$$

$$P_{n_0} = P_n(0) e^{-V/V_T}$$

$$\Rightarrow P_n(0) = P_{n_0} e^{V/V_T} \quad \text{--- } ⑤$$

$$I_{P_n(0)} = \frac{AeD_p}{L_p} [P_{n_0} e^{V/V_T} - P_{n_0}]$$

$$\boxed{I_{P_n(0)} = \frac{AeD_p}{L_p} [e^{V/V_T} - 1] (P_{n_0})} \quad \text{--- } ⑥$$

Similarly

$$I_{n_p(0)} = \frac{AeD_n}{L_n} (n_{p_0}) [e^{V/V_T} - 1]$$

$$I = I_{P_n(0)} + I_{n_p(0)}$$

$$= \frac{AeD_p}{L_p} (P_{n_0}) [e^{V/V_T} - 1] + \frac{AeD_n}{L_n} (n_{p_0}) [e^{V/V_T} - 1]$$

$$= Ae [e^{V/V_T} - 1] \left[ \frac{D_p}{L_p} (P_{n_0}) + \frac{D_n}{L_n} (n_{p_0}) \right]$$

$$= \underbrace{\left[ \frac{AeD_p}{L_p} (P_{n_0}) + \frac{AeD_n}{L_n} (n_{p_0}) \right]}_{I_o} (e^{V/V_T} - 1)$$

$$\boxed{I = I_o (e^{V/V_T} - 1)}$$

$I_o \Rightarrow$  Saturation Current (a) Leakage Current (a) Reverse Saturation current.

$$S_i \left\{ \begin{array}{l} I = I_0 [e^{V/2V_T - 1}] \text{ for small & rated currents} \\ I = I_0 [e^{V/V_T - 1}] \text{ for large currents.} \end{array} \right.$$

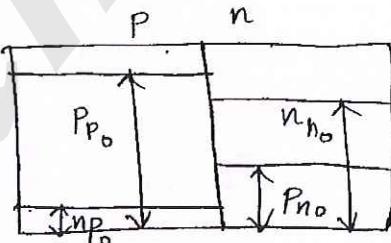
Ge  $\Rightarrow \eta=1$  for both small and large currents.

Saturation Current  $I_0$ :

$$P_{P_0} \cdot n_{P_0} = n_i^2 \quad n_{n_0} \cdot P_{n_0} = n_i^2$$

$$n_{P_0} = \frac{n_i^2}{P_{P_0}} = \frac{n_i^2}{N_A}$$

$$P_{n_0} = \frac{n_i^2}{n_{n_0}} = \frac{n_i^2}{N_D}$$



$$I_0 = \frac{A e D_p}{L_p} P_{n_0} + \frac{A e D_n}{L_n} n_{P_0}$$

$$I_0 = \frac{A e D_p}{L_p} \left( \frac{n_i^2}{N_D} \right) + \frac{A e D_n}{L_n} \left( \frac{n_i^2}{N_A} \right)$$

$$\boxed{I_0 = A e \left[ \frac{D_p}{L_p N_D} + \frac{D_n}{L_n N_A} \right] n_i^2}$$

$$\text{Ge: } I_0 = K_1 T^2 e^{-E_g/V_T}$$

$$I_0 \propto T^2$$

In Ge p-n junction diodes, saturation current is directly proportional to square of the temperature.

Therefore in Ge, p-n junction diode,  $I_0 \uparrow$  by 11% /°C rise in temperature.

temperature.

$$\Rightarrow I_0 = nA$$

$$\Rightarrow I = mA$$

$$\Rightarrow \frac{I}{I_0} = \frac{1mA}{nA} = 10^6$$

→ In all practical cases:

$I_0 \uparrow$  by 7% /°C rise in temperature.

$$I_{01} \rightarrow T_1; I_{02} \rightarrow T_2$$

$$I_{02} = I_{01} + 0.07 I_{01}$$

$$= (1 + 0.07) I_{01}$$

$$= (1.07) I_{01}$$

$$= (1.07)^{\Delta T} \cdot I_{01}$$

$$= (2^{1/10})^{\Delta T} \cdot I_{01}$$

$$= 2^{\Delta T/10} \cdot I_{01}$$

$$\boxed{I_{02} = 2^{(T_2 - T_1)/10} \cdot I_{01}}$$

$$I_{01} \rightarrow T_1 \quad I_{02} = 2^{10/10} \cdot I_{01}$$

$$I_{02} \rightarrow T_2 = T_1 + 10^\circ C = 2 \cdot I_{01}$$

$$I_{02} = 2^{20/10} \cdot I_{01}$$

$$= 4 I_{01}$$

$I_0$ : doubles / $10^\circ C$  //

$$ii) D_p = M_p V_T; D_n = M_n V_T$$

$$I_o = A e \left[ \frac{M_p V_T}{L_p N_D} + \frac{M_n V_T}{L_n N_A} \right] n_i^2$$

$$\boxed{I_o = A e V_T \left[ \frac{M_p}{L_p N_D} + \frac{M_n}{L_n N_A} \right] n_i^2}$$

iii) Multiply and divide first term with  $M_n e$  and second term with  $M_p e$ , then

$$I_o = A e V_T \left[ \underbrace{\frac{M_p M_n e}{L_p N_D M_n e}}_{\sigma_n} + \frac{M_p M_n e}{L_n N_A M_p e} \right] n_i^2$$

$$= A e V_T \left[ \frac{M_n M_p e}{L_p \sigma_n} + \frac{M_n M_p e}{L_n \sigma_p} \right] n_i^2$$

$$\boxed{I_o = A e^2 V_T M_n M_p \left[ \frac{1}{L_p \sigma_n} + \frac{1}{L_n \sigma_p} \right] n_i^2}$$

$$I_{Pn(0)} = \frac{A e^2 V_T M_n M_p n_i^2}{L_p \sigma_n} \left[ e^{V/V_T - 1} \right]$$

$$I_{nP(0)} = \frac{A e^2 V_T M_n M_p n_i^2}{L_n \sigma_p} \left[ e^{V/V_T - 1} \right]$$

$$\boxed{\frac{I_{Pn(0)}}{I_{nP(0)}} = \frac{L_n \sigma_p}{L_p \sigma_n}}$$

$$v) \text{ Let } b = \frac{M_n}{M_p}$$

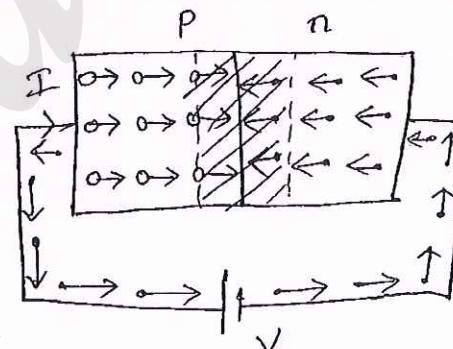
$$I_o = \frac{A M_n M_p V_T \sigma_i^2}{M_p^2 \left(1 + \frac{M_n}{M_p}\right)^2} \left[ \frac{1}{L_p \sigma_n} + \frac{1}{L_n \sigma_p} \right]$$

$$I_o = \frac{A M_n M_p V_T \sigma_i^2}{M_p (1+b)^2} \left[ \frac{1}{L_n \sigma_p} + \frac{1}{L_p \sigma_n} \right]$$

$$I_o = \frac{Ab V_T \sigma_i^2}{(1+b)^2} \left[ \frac{1}{L_p \sigma_n} + \frac{1}{L_n \sigma_p} \right]$$

### V-I Characteristics:

i) When p-n junction diode is Forward Bias:



When the applied net resultant voltage is positive at p-side wrt 'n' side, then p-n junction is in forward bias.

$$I = I_0 [e^{V/nV_T - 1}]$$

which current flows through the diode exceeds 1% of the rated current.

- 1) If  $V < V_8$  : Zero Current
- 2) If  $V_8 < V < V_{sat}$  : Current increases exponentially  
i.e.,  $I \propto e^{V/nV_T}$

- 3) If  $V > V_{sat}$  : very large current due to secondary effect.

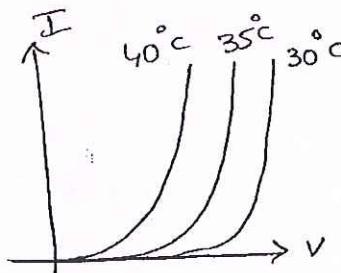
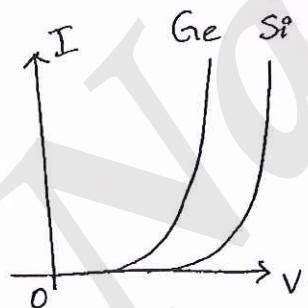
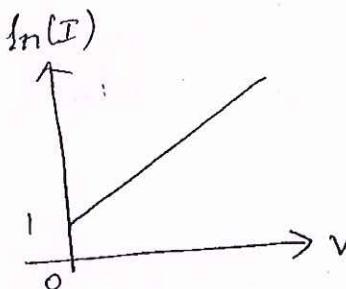
$$\Rightarrow I \approx I_0 e^{V/nV_T} (\because e^{V/nV_T} \gg 1)$$

$$e^{V/nV_T} = \frac{I}{I_0}$$

$$V/nV_T = \ln(I/I_0)$$

$$V = nV_T \ln(I/I_0)$$

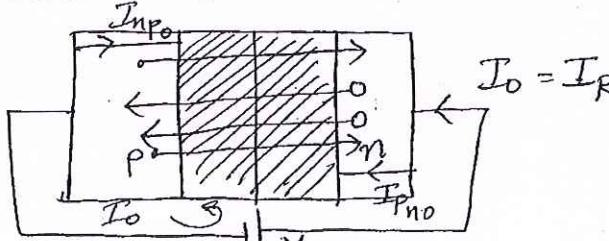
$$V \propto \ln(I)$$

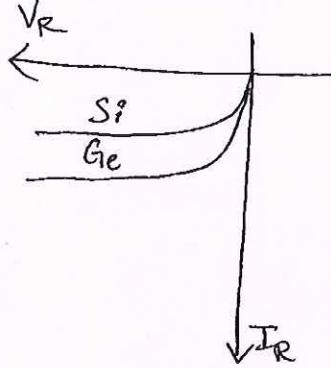


- 2) When p-n junction is in Reverse Bias:

When the applied net resultant voltage is -ve at p-side

wrt 'n' side, then p-n junction is in reverse bias.

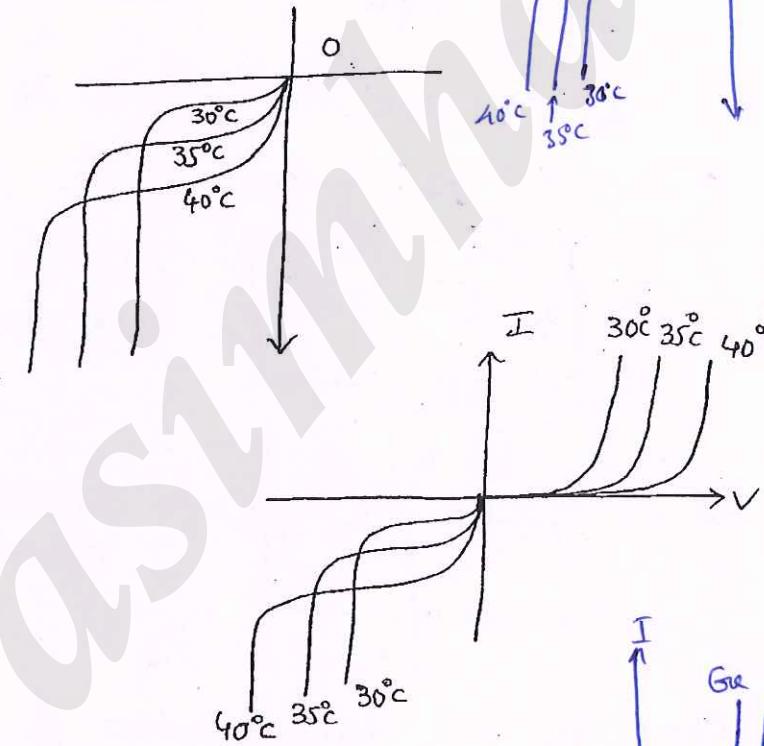




$$I_o(\text{Ge}) : \text{mA}$$

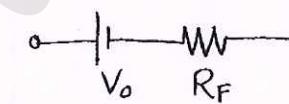
$$I_o(\text{Si}) : \text{nA}$$

$$\rightarrow I_o(\text{Ge}) \approx 1000 I_o(\text{Si})$$

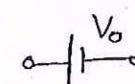


Diode equivalent Circuit (a) Forward Bias:

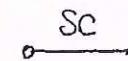
Piecewise linear equivalent Circuit:



Simplified linear equivalent Circuit:

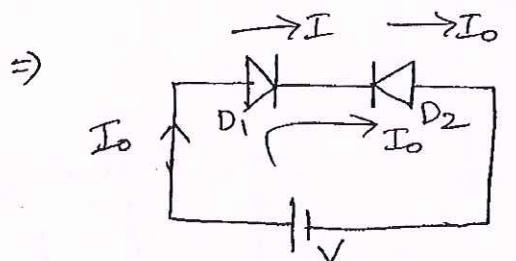


Ideal equivalent Circuit:



$$I = I_0 e^{\frac{V}{V_T}}$$

$$I_F = I \approx I_0 e^{\frac{V}{V_T}}$$



$$I \approx -I_0$$

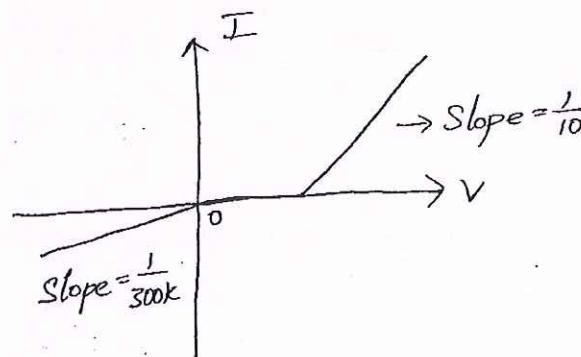
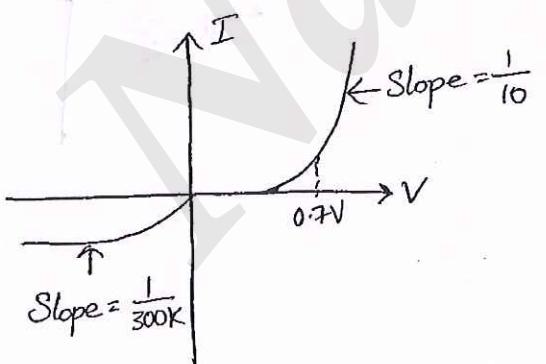
$$I_R = I \approx -I_0$$

$$\left. \begin{array}{l} D_1: FB \rightarrow I \\ D_2: RB \rightarrow I_0 \end{array} \right\} I_0$$

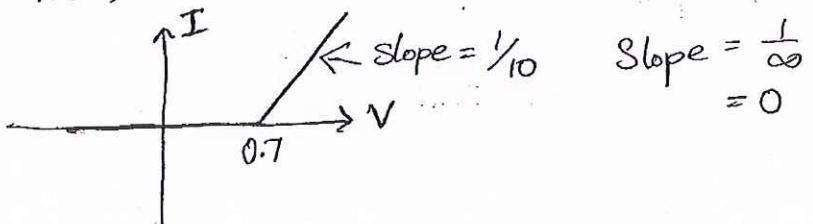
$$\left. \begin{array}{l} D_1: RB \rightarrow I_0 \\ D_2: FB \rightarrow I \end{array} \right\} I_0$$

→ Draw the v-I characteristics for the following specifications.

i)  $V_T = 0.7V$ ,  $R_F = 10\Omega$ ,  $R_Y = 300k\Omega$



ii)  $V_T = 0.7V$ ,  $R_F = 10\Omega$ ,  $R_Y = \infty$



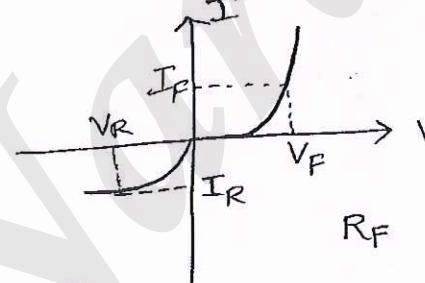
## Diode Resistance:

1. Static Resistance ( $R$ )
2. Dynamic Resistance ( $r$ )

### Static Resistance: ( $R$ )

It is the resistance offered by the p-n junction diode under dc condition. Therefore static resistance is also called dc resistance.

→ It is the ratio of voltage across the diode to the current through the diode



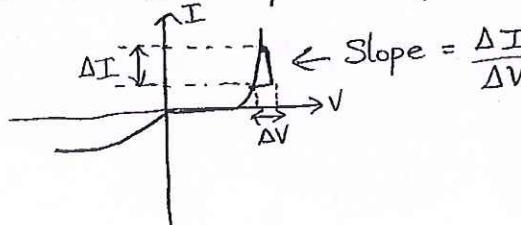
$$R_F = \frac{V_F}{I_F} = r$$

$$R_F = \frac{V_R}{I_R} = "100 \text{ k}\Omega \text{ to } \text{M}\Omega"$$

### Dynamic Resistance: ( $r$ )

Dynamic Resistance is the resistance offered by the p-n junction diode under ac condition. Therefore, dynamic resistance is also called ac resistance.

→ It is the reciprocal of the slope of the V-I characteristics



$$\frac{dI}{dV} = \frac{I + I_0}{\eta V_T} \approx \frac{I}{\eta V_T}$$

$$\gamma = \gamma_f = \frac{\eta V_T}{I}$$

Dynamic Resistance ( $\gamma$ ):

$$\gamma = \frac{dV}{dI} = \frac{\eta V_T}{I}$$

Dynamic Conductance (g):

$$g = \frac{dI}{dV} = \frac{1}{\gamma} = \frac{I}{\eta V_T}$$

Forward Dynamic Resistance ( $\gamma_F$ ):

$$\gamma_F = \frac{\eta V_T}{I_F} = \frac{\eta V_T}{I}$$

Reverse Dynamic Resistance ( $\gamma_R$ ):

$$\gamma_R = \frac{\eta V_T}{I_R} = \frac{\eta V_T}{I_0}$$

- Q) The resistivity of a Ge p-n junction diode is  $2 \Omega\text{-cm}$  on p-side and  $1 \Omega\text{-cm}$  on n-side. Calculate built-in potential of the junction.

Sol:  $\rho_p = 2 \Omega\text{-cm}$        $V_0 = V_{bi} = KT \ln \left( \frac{N_A N_D}{n_i^2} \right)$

$$\rho_n = 1 \Omega\text{-cm}$$

$$\rho_p = \frac{1}{N_A M_p q V}$$

$$N_A = \frac{1}{\rho_p M_p q V}$$

→ A Ge p-n junction diode is operating at a temperature of  $125^{\circ}\text{C}$  with a saturation current of  $30\text{mA}$ . Calculate its dynamic resistance when it is biased by a bias voltage of  $0.2\text{V}$  in forward and reverse direction.

$$r_f = \frac{\eta V_T}{I_F}$$

$$V_T = \frac{I}{11600} = \frac{273 + 125}{11600} = 0.034$$

$$I_F = I = I_0 \left[ e^{\frac{V}{\eta V_T}} - 1 \right]; I_R = I_0 \left[ e^{\frac{-V}{\eta V_T}} - 1 \right]$$

$$= 30\text{mA} \left[ e^{0.2/1 \times 0.034} - 1 \right]$$

$$= 0.0107\text{A}$$

$$r_f = \frac{1 \times 0.034}{0.0107} = 3.15\Omega$$

$$r_R = \frac{\eta V_T}{I_R} = \frac{\eta V_T}{I_0} = \frac{1 \times 0.034}{30 \times 10^{-6}} = 1.13\text{k}\Omega //$$

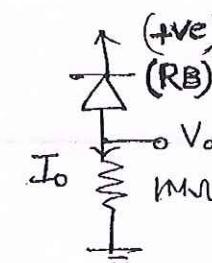
→ For the circuit shown in the figure,  $V_o = 1\text{V}$  at  $20^{\circ}\text{C}$ , Calculate  $V_o$  at  $40^{\circ}\text{C}$  and  $0^{\circ}\text{C}$

$$I_0 = \frac{V_o}{1\text{M}\Omega} = \frac{1\text{V}}{1\text{M}\Omega} = 1\text{mA} \text{ at } 20^{\circ}\text{C}$$

$$I_0 = ? \text{ at } 40^{\circ}\text{C}$$

$$I_0(40^{\circ}\text{C}) = 2^{\frac{(40-20)}{10}} \cdot I_0(20^{\circ}\text{C})$$

$$= 2^2 \cdot 1\text{mA} = 4\text{mA}$$

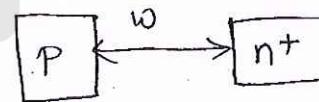
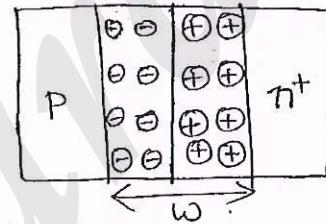


→ Transition Capacitor ( $C_T$ )  
→ Diffusion Capacitance ( $C_D$ )

### Transition Capacitance:

Change in charge wrt change in voltage, which exists in a p-n junction diode, when it is in reverse bias is called transition capacitance.

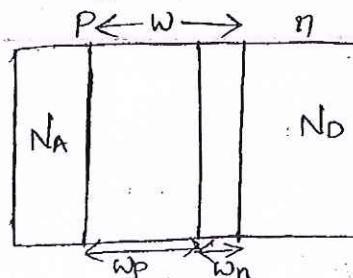
- Transition capacitance is the capacitance offered by the p-n junction diode when it is in reverse bias.
- Therefore transition capacitance is also called junction capacitance.



$$C_{T_0} = \frac{\epsilon A}{w}$$

⇒  $C_T$  is of the order of pF.

i)  $C_T$  for non-linear junction:



$$E = \frac{dV}{dx} = -\frac{\rho}{\epsilon} x$$

$$V = \int E dx = -\frac{\rho}{\epsilon} \frac{x^2}{2}$$

$$V = \frac{e N_A}{\epsilon} \frac{\omega^2}{2}$$

$$\boxed{V_J = \frac{e N_A}{2\epsilon} \omega^2} \quad \text{--- (1)}$$

→ Transition capacitance is also called depletion capacitance.  
space charge capacitance.

Total Charge on p-side:

$$Q = AwN_A e \quad \text{--- (2)}$$

$$\frac{dQ}{dV_J} = A e N_A \frac{d\omega}{dV_J}$$

$$V_J = \frac{e N_A}{2\epsilon} \omega^2$$

Diffr. wrt  $V_J$ , we have

$$I = \frac{e N_A}{2\epsilon} 2\omega \cdot \frac{d\omega}{dV_J} \Rightarrow \frac{d\omega}{dV_J} = \frac{\epsilon}{e N_A \omega}$$

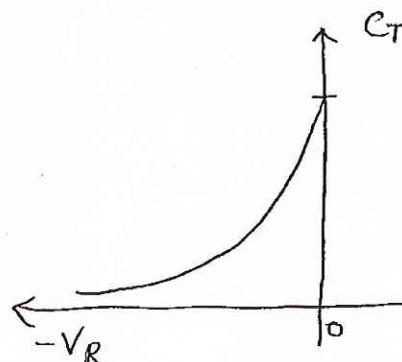
$$\frac{dQ}{dV_J} = A e N_A \frac{\epsilon}{e N_A \omega}$$

$$\Rightarrow \frac{dQ}{dV_J} = \frac{\epsilon A}{\omega}$$

$$G_{T_0} = \frac{\epsilon A}{\omega}$$

$$G_T \propto \frac{1}{\omega}$$

$$V_J \propto \omega^2 \Rightarrow \omega \propto V_J^{1/2} \Rightarrow G_T \propto \frac{1}{V_J^{1/2}} \Rightarrow G_T \propto V_J^{-1/2}$$



$$\Rightarrow V_R \uparrow \Rightarrow V_J \uparrow \Rightarrow \omega \uparrow \Rightarrow C_T \downarrow$$

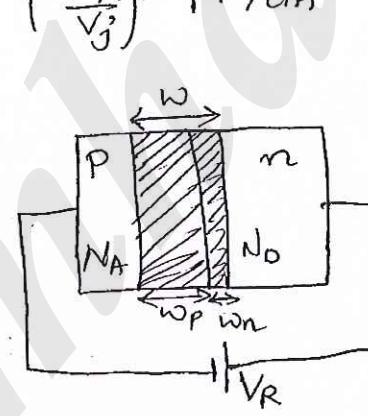
F& Si:

$$V_j = V_o + V_R = V_{bi} + V_R$$

$$V_j = \frac{e N_A}{2\epsilon} \omega^2 \quad \text{--- ①}$$

$$G_T = \frac{\epsilon A}{\omega} \quad \text{--- ②}$$

$$\text{From ①} \Rightarrow \omega = \sqrt{\frac{2\epsilon V_j}{e N_A}} \quad \text{--- ③}$$



③ in ②  $\Rightarrow$

$$G_T = \frac{\epsilon A}{\sqrt{\frac{2\epsilon V_j}{e N_A}}} = \sqrt{\frac{\epsilon N_A}{2 V_j}} \text{ F/cm}^2$$

$$\begin{aligned} G_T/A &= \sqrt{\frac{\epsilon}{\frac{2\epsilon V_j}{e N_A}}} = \sqrt{\frac{e N_A}{2 V_j}} \text{ F/cm}^2 \\ &= \sqrt{\frac{\epsilon P}{2}} \left(\frac{N_A}{V_j}\right)^{1/2} \text{ F/cm}^2 \\ &= \sqrt{\frac{\epsilon_0 \epsilon_r e}{2}} \left(\frac{N_A}{V_j}\right)^{1/2} \text{ F/cm}^2 \\ &= \sqrt{\frac{1.6 \times 10^{-19} \times 11.7 \times 8.85 \times 10^{-14}}{2}} \left(\frac{N_A}{V_j}\right)^{1/2} \text{ F/cm}^2 \end{aligned}$$

$$= 2.878 \times 10^{-16} \left(\frac{N_A}{V_j}\right)^{1/2} \text{ F/cm}^2$$

$$G_T/A = 2.9 \times 10^{-4} \left(\frac{N_A}{V_j}\right)^{1/2} \text{ pF/cm}^2$$

$\int \text{F& area} = 1 \Rightarrow G_T = 2.9 \times 10^{-4} \left(\frac{N_A}{V_j}\right)^{1/2} \text{ pF/cm}^2$

$$= 3.36 \times 10^{-4} \left( \frac{N_A}{V_j} \right)^{1/2} \text{ PF/cm}^2$$

→ The transition capacitance of a step graded Si p-n junction diode is 20 pF at a reverse bias voltage of 5V. If reverse bias voltage is increased by 1V, find the change in the capacitance.

$$C_T \propto \frac{1}{\sqrt{V_j}}$$

$$\frac{C_{T_1}}{C_{T_2}} = \sqrt{\frac{V_{j_2}}{V_{j_1}}}$$

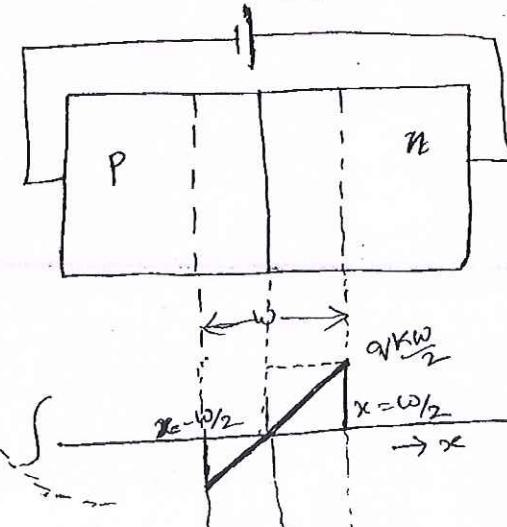
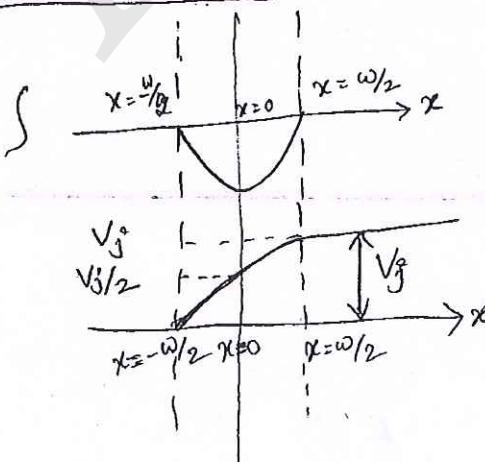
$$C_{T_2} = C_{T_1} \sqrt{\frac{V_{j_1}}{V_{j_2}}} = C_{T_1} \sqrt{\frac{V_0 + V_{R_1}}{V_0 + V_{R_2}}} = C_{T_1} \sqrt{\frac{0.7 + 5}{0.7 + 6}} = C_{T_1} \sqrt{\frac{5.7}{6.7}}$$

$$C_{T_2} = 18.26 \text{ pF}$$

$$\text{Change in Capacitance} = C_{T_2} - C_{T_1} = 18.26 - 20$$

$$= 1.74 \text{ pF}$$

### Linear Junction:



$$\frac{dV}{dx} = E = -\frac{\alpha K}{\epsilon} \frac{x^2}{2} + K_1 \quad \text{--- (1)}$$

At  $x = \pm \omega/2 \Rightarrow E = 0$

The  $K_1 - \frac{\alpha K}{\epsilon} \left( \frac{(\omega/2)^2}{2} \right) = 0$

$$\Rightarrow K_1 = \frac{\alpha K}{\epsilon} \frac{\omega^2}{8}$$

$$\Rightarrow \boxed{K_1 = \frac{\alpha K \cdot \omega^2}{8\epsilon}} \quad \text{--- (2)}$$

Substitute (2) in (1)

$$\Rightarrow \frac{dV}{dx} = -\frac{\alpha K}{2\epsilon} x^2 + \frac{\alpha K}{8\epsilon} \omega^2$$

$$\frac{dV}{dx} = \frac{\alpha K}{8\epsilon} \left[ -4x^2 + \omega^2 \right] \quad \text{--- (3)}$$

$$\int \frac{dV}{dx} = V = \frac{\alpha K}{8\epsilon} \left[ -\frac{4}{3}x^3 + \omega^2 x \right] + K_2 \quad \text{--- (4)}$$

$$V|_{x=\omega/2} = 0$$

$$V|_{x=0} = \frac{V_g}{2} \quad \left. \right\} \text{from graph.}$$

$$V|_{x=-\omega/2} = V_g$$

For linear junction

$$V_g \propto \omega^3 \Rightarrow \omega \propto V_g^{1/3}$$

For non-linear junction

$$V_g \propto \omega^2 \Rightarrow \omega \propto V_g^{1/2}$$

$$V_j^o = \frac{qV}{8\epsilon} \left[ -\frac{4}{3} \frac{\omega^3}{8} + \omega^2 (\omega/2) \right] + \frac{V_j^o}{2}$$

$$\frac{V_j^o}{2} = \frac{qV}{8\epsilon} \left[ -\frac{4}{3} \frac{\omega^3}{8} + \frac{\omega^3}{2} \right]$$

$$\frac{V_j^o}{2} = \frac{qV}{8\epsilon} \left[ -\frac{\omega^3}{6} + \frac{\omega^3}{2} \right]$$

$$\frac{V_j^o}{2} = \frac{qV}{8\epsilon} \left[ \frac{4\omega^3}{12} \right]$$

$$\Rightarrow V_{j/2}^o = \frac{qV}{8\epsilon} \cdot \left( \frac{\omega^3}{3} \right)$$

$$\boxed{V_j^o = \left( \frac{qV}{12\epsilon} \right) \cdot \omega^3} \quad \text{--- (6)}$$

$$Q = \frac{1}{2} \cdot \frac{\omega}{2} \cdot \left( \frac{qV\omega}{2} \right) \cdot A$$

$$Q = \frac{qVKA}{8} \omega^2 \quad \text{--- (7)}$$

$$\frac{dQ}{dV_j^o} = \frac{qVKA}{8\epsilon} \cancel{\omega} \frac{d\omega}{dV_j^o}$$

$$\frac{dQ}{dV_j^o} = \frac{qVKA}{4} \cdot \omega \frac{d\omega}{dV_j^o} \quad \text{--- (8)}$$

Differentiate (6) wrt  $V_j^o$

$$\Rightarrow 1 = \frac{qV}{4\epsilon} \cancel{\omega} \frac{d\omega^2}{dV_j^o} \frac{d\omega}{dV_j^o}$$

$$\Rightarrow \frac{d\omega}{dV_j^o} = \frac{4\epsilon}{qV\omega^2} \quad \text{--- (9)}$$

$$C_T \propto \frac{1}{V_j^{1/3}} \Rightarrow C_T \propto V_j^{-1/3}$$

$\rightarrow C_T = \frac{K}{V_j^{1/2}}$  for Non-linear Junction, where  $K$  is a constant.

$C_T = \frac{K}{V_j^{1/3}}$  for Linear Junction, where  $K$  is a constant.

$$\Rightarrow \boxed{C_T = \frac{K}{V_j^n}}$$

where  $n = \frac{1}{2}$  for non-linear junction  
 $n = \frac{1}{3}$  for linear junction

$$C_T = \frac{K}{V_j^n} = \frac{K}{(V_0 + V_R)^n} \quad (\because V_j = V_0 + V_R)$$

$$\text{At } V_R = 0 \Rightarrow C_T = \frac{K}{V_0^n} \Rightarrow C_{T_0} = \frac{K}{V_0^n}$$

$$\Rightarrow K = C_{T_0} V_0^n$$

$$C_T = \frac{C_{T_0} \cdot V_0^n}{(V_0 + V_R)^n} = \frac{C_{T_0} V_0^n}{V_0^n \left(1 + \frac{V_R}{V_0}\right)^n} = \frac{C_{T_0}}{\left(1 + \frac{V_R}{V_0}\right)^n}$$

$$\therefore C_T = \frac{C_{T_0}}{\left(1 + \frac{V_R}{V_0}\right)^n}; \quad C_{T_0} = \frac{\epsilon A}{\omega}$$

$$C_T = \frac{C_{T_0}}{\left(1 + \frac{V_R}{V_0}\right)^{1/2}} \quad \text{for non-linear junction}$$

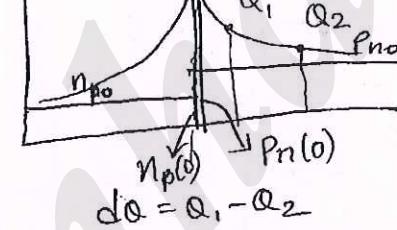
$$C_T = \frac{C_{T_0}}{\left(1 + \frac{V_R}{V_0}\right)^{1/3}} \quad \text{for linear junction}$$

forward bias, then it is called  
Diffusion capacitance.

$$\rightarrow C_D = \frac{dQ}{dV}$$

$\rightarrow C_D$  ranges from  $nF$  to  $MF$ .

$\rightarrow$  Diffusion capacitance is greater than transition capacitance.



$$C_D = \frac{dQ}{dV} \quad \text{---(1)}$$

$$I = Q/t$$

$$dI = dQ/t$$

$$\Rightarrow dQ = \tau dI \quad (t = \tau) \quad \text{---(2)}$$

Substitute (2) in (1),  $\Rightarrow C_D = \frac{\tau dI}{dV}$

$$\frac{dI}{dV} = g \Rightarrow C_D = \tau g$$

$$g = \frac{I}{\eta V_T}$$

$$\Rightarrow \boxed{C_D = \frac{\tau I}{\eta V_T}} \quad ***$$

$\tau$  is the lifetime  
of charge carriers

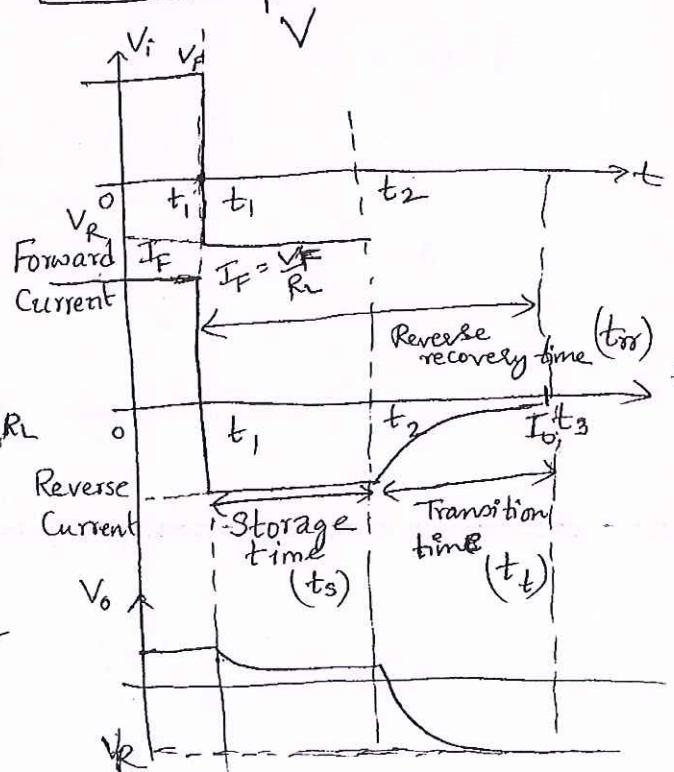
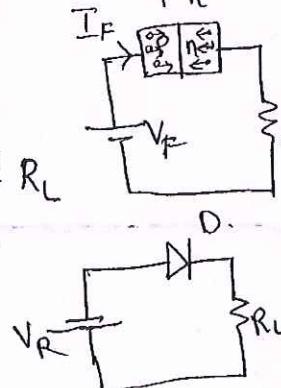
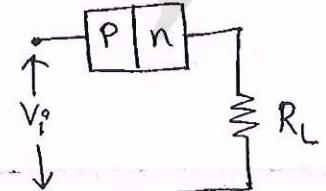
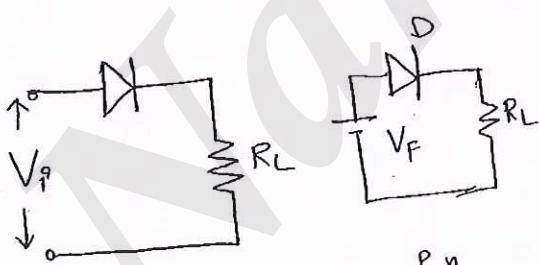
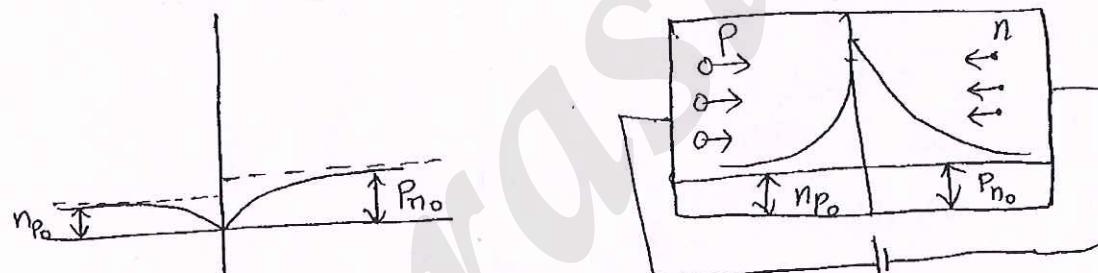
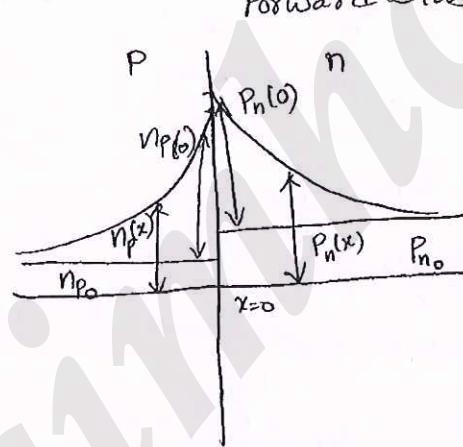
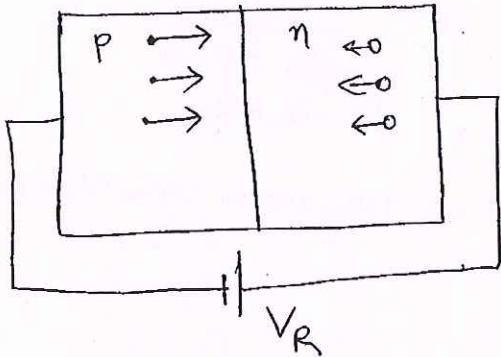
\* Diffusion capacitance is proportional to current.

$$\boxed{C_D = \frac{\tau_p I_p + \tau_n I_n}{\eta V_T}}$$

$$C_{Dp} = \frac{\tau_p I_p}{\eta V_T}$$

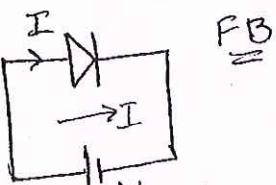
$$C_{Dn} = \frac{\tau_n I_n}{\eta V_T}$$

Reverse Bias



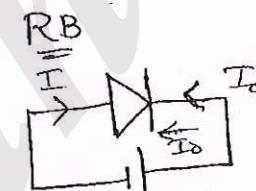
$\rightarrow$  ON time < OFF time (transistor in saturation or off state)

$$\rightarrow \text{Storage time } t_s = T/n \left(1 + \frac{I_E}{I_R}\right)$$



$$I = I_0 [e^{\frac{V}{nV_T}} - 1] \approx I_0 e^{\frac{V}{nV_T}}$$

$$I_F = I = I_0 e^{\frac{V}{nV_T}}$$



$$I = I_0 [e^{-\frac{V}{nV_T}} - 1] \approx -I_0$$

$$I_R = I \approx -I_0$$

Current  $I_F$  is in the order of mA

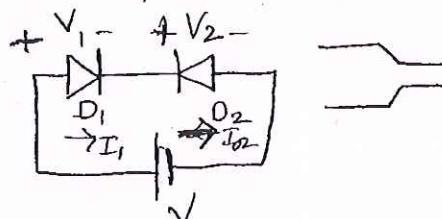
Q) For the circuit shown in the figure, show that  $e^{\frac{qV_1}{kT}} + e^{\frac{-qV_2}{kT}} = 2$   
if the diodes are identical and also made up of Ge.

$$I = I_0 [e^{\frac{V}{nV_T}} - 1]$$

$$V_T = KT = \frac{I}{11600} \quad n = 1 \text{ for Ge}$$

$$-V + V_1 + V_2 = 0$$

$$V = V_1 + V_2$$



D<sub>1</sub> is forward biased ( $I_1$  flows)

D<sub>2</sub> is reverse biased ( $I_{02}$  flows)

$$I_1 = I_{02} = -I_2 \quad (\because I_2 = -I_{02} \Rightarrow I_{02} = -I_2)$$

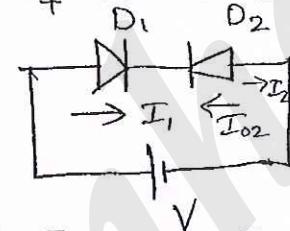
$$I_{01} [e^{\frac{V_1}{nV_T}} - 1] = -I_{02} [e^{-\frac{V_2}{nV_T}} - 1]$$

$$I_0 [e^{\frac{V_1}{nV_T}} - 1] = -I_0 [e^{-\frac{V_2}{nV_T}} - 1]$$

$$I_0 [e^{\frac{V_1}{nV_T}} + e^{-\frac{V_2}{nV_T}}] = 2I_0$$

$$I_1 = I_{02} = -I_{02}$$

$$I_{01} \left[ e^{\frac{V_1}{nV_T}} - 1 \right] = -I_{02} \left[ e^{-\frac{V_2}{nV_T}} - 1 \right]$$



$$I_0 \left[ e^{\frac{V_1}{nV_T}} - 1 \right] = -I_0 \left[ e^{-\frac{V_2}{nV_T}} - 1 \right] \text{ For Si, } n=2$$

$$I_0 \left[ e^{\frac{V_1}{2V_T}} + e^{-\frac{V_2}{2V_T}} \right] = 2I_0$$

$$\Rightarrow e^{\frac{V_1}{2KT/qV}} + e^{-\frac{V_2}{2KT/qV}} = 2$$

$$\Rightarrow \boxed{e^{\frac{qV_1}{2KT}} + e^{-\frac{qV_2}{2KT}} = 2}$$

→ For the circuit shown below, show that  $e^{\frac{qV_1}{2KT}} + e^{\frac{qV_2}{2KT}} = 2$

$$I_1 = -I_{01} = -I_2$$

$$I_1 = -I_2$$

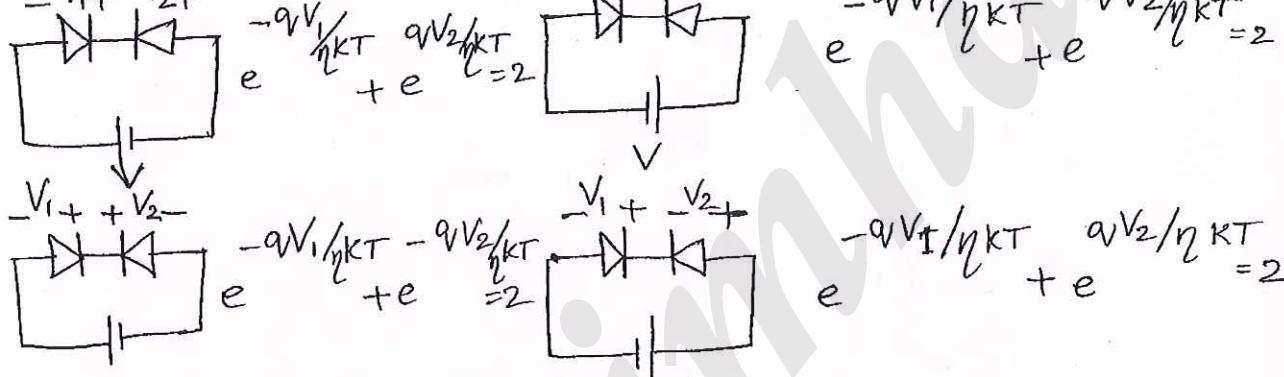
$$I_{01} \left[ e^{\frac{V_1}{nV_T}} - 1 \right] = -I_{02} \left[ e^{-\frac{V_2}{nV_T}} - 1 \right]$$

$$e^{\frac{V_{D1}}{nV_T}} + e^{-\frac{V_{D2}}{nV_T}} = 2$$

$$V_{D1} = V_1; -V_{D2} = -V_2$$

$$e^{\frac{V_1}{nV_T}} + e^{-\frac{V_2}{nV_T}} = 2$$

$$\text{Given: } n=2; V_T = \frac{KT}{qV} \Rightarrow \boxed{e^{\frac{qV_1}{2KT}} + e^{\frac{qV_2}{2KT}} = 2}$$



These equations are applicable only when the diodes are identical

→ For the circuit shown in the figure, calculate voltage across each diode, If the diodes are identical and also made up of Ge

$$-V + V_1 - V_2 = 0$$

$$V_2 = V_1 + V_T = V_1 - 0.2V$$

$$e^{+V_1/\eta V_T} + e^{V_2/\eta V_T} = 2$$

$$e^{(2V_1 + V)/\eta V_T} = 2$$

$$\frac{(2V_1 + V)}{V_T} = \ln 2$$

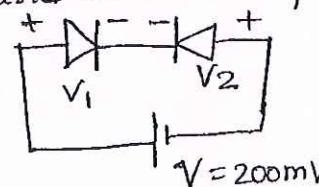
$$2V_1 + V = 0.0179$$

$$2V_1 = 0.0179 + 200 \times 10^{-3}$$

$$2V_1 = +0.182$$

$$V_1 = +0.09V$$

$$V_2 = 0.11V$$



$$V_2 = V_1 - 0.2$$

$$e^{V_1/V_T} + e^{V_2/V_T} = 2$$

$$e^{V_1/V_T} + e^{(V_1 - 0.2)/V_T} = 2$$

$$e^{V_1/V_T} \left[ 1 + e^{\frac{-0.2}{0.02586}} \right] = 2$$

$$e^{V_1/V_T} \approx 2$$

$$V_1 = V_T \ln 2$$

$$= 0.02586 \ln 2$$

$$= 0.0179V$$

$$V_2 = V_1 - 0.0179 - 0.2$$

$$= -0.182V$$

$$e^{\frac{V_1}{kT}} + e^{\frac{(V_1+25m-V)}{kT}} = 2$$

$$e^{\frac{V_1}{kT}} \left[ 1 + e^{\frac{(25m-200m)}{kT}} \right] = 2$$

$$e^{\frac{V_1}{kT}} \left[ 1 + e^{-\frac{175}{26}} \right] = 2$$

$$e^{\frac{V_1}{kT}} \left[ 1 + 1.1 \times 10^{-3} \right] = 2$$

$$e^{\frac{V_1}{kT}} = \frac{2}{1 + 1.1 \times 10^{-3}}$$

$$\Rightarrow V_1 = 0.0178 \text{ mV}$$

$$V_2 = -0.1572 \text{ V}$$

→ For the circuit shown in the figure calculate voltage across the each diode, If the diodes are identical and made up of Si

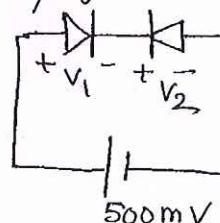
$$e^{\frac{V_1}{kT}} + e^{-\frac{V_2}{kT}} = 2$$

$$e^{\frac{V_1}{kT}} + e^{-\frac{V_2}{kT}} = 2$$

$$e^{\frac{V_1}{2kT}} + e^{-\frac{(0.5-V_1)}{2kT}} = 2$$

$$e^{\frac{V_1}{2kT}} \left[ 1 + e^{-\frac{0.5}{2kT}} \right] = 2$$

$$e^{\frac{V_1}{2kT}} \left[ 1 + 6.33 \times 10^{-5} \right] = 2$$



$$-V + V_1 + V_2 = 0$$

$$V_1 + V_2 = 500 \text{ mV}$$

$$V_2 = 0.50 - V_1$$

$$\frac{V_1}{2kT} = \ln 2$$

$$V_1 = 0.0358 \text{ V}$$

$$V_2 = 0.5 - 0.0358 \\ = 0.464 \text{ V}$$

$$I_2 = I_{01}$$

$$\frac{V}{I_{02}} = e^{-\frac{V}{V_T}} - 1$$

Applying KVL,

$$+V + V_1 - V_2 = 0$$

$$V_1 = V_2 - V = 0.0105 - 0.5$$

$$= -0.1895 \text{ V}_{\parallel}$$

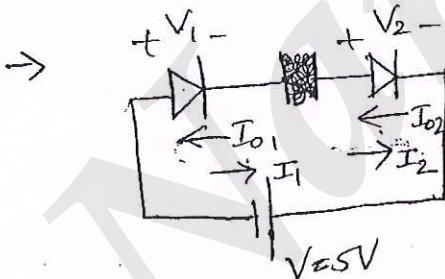
$$V_T \ln \left( 1 + \frac{I_2}{I_{02}} \right) = V_2$$

$$\Rightarrow V_2 = V_T \ln \left( 1 + \frac{I_2}{I_{02}} \right)$$

$$= 0.02586 \ln \left( 1 + \frac{I_{01}}{I_{02}} \right)$$

$$= 0.0105 \text{ V}$$

\* When two diodes are connected in series back to back, it is not possible to calculate the voltage across the reverse biased diode first.



$$I_1 = I_2$$

~~If  $I_1 = 0$  then  $I_2 = 0$~~

$$I_2 = I_{02} \left[ e^{\frac{V_2}{\eta V_T}} - 1 \right]$$

$$\frac{I_2}{I_{02}} = e^{\frac{V_2}{\eta V_T}} - 1$$

$$\frac{V_2}{\eta V_T} = \ln \left( 1 + \frac{I_2}{I_{02}} \right)$$

For the ckt shown in the figure, calculate voltage across the each diode  $V_1$  &  $V_2$  if the diodes are not identical and made up of Ge and also breakdown voltage of each diode Given  $I_{01} = 5 \text{ mA}$ ;  $I_{02} = 10 \text{ mA}$  is  $> 5 \text{ V}$

$$V + V_1 + V_2 = 0$$

$$V_1 = -V - V_2$$

$$V_2 = V_T \ln \left( 1 + \frac{I_2}{I_{02}} \right)$$

$$V_2 = 0.02586 \ln \left( 1 + \left( -\frac{I_{01}}{I_{02}} \right) \right)$$

$$= 0.02586 \ln \left( 1 - \frac{5}{10} \right) = -0.018 \text{ V}$$

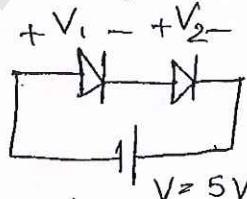
$$\begin{aligned} I_1 &= -I_{01} \\ I_2 &= -I_{02} \end{aligned}$$

$$I_2 = I_1 = -I_{01}$$

\* When two diodes are connected in series in reverse bias, it is not possible to calculate the voltage across diode first which has least saturation current.

→ For the circuit shown in figure, calculate voltage across the each diode  $V_1$  and  $V_2$ , if the diodes are identical and made up of Silicon and also breakdown voltage of each diode is greater than 5V.

$$V_1 = V_2 = -\frac{5}{2} = -2.5V$$

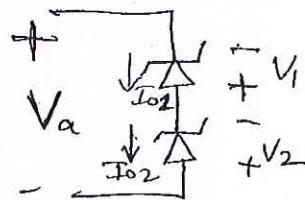


(Q) i) For the circuit shown in the figure, calculate voltage across each diode  $V_1$  and  $V_2$  if the diodes are not identical and made up of Ge.

for a)  $V_a = 9V$  Given  $I_{01} = 5MA$

b)  $V_a = 11V$   $I_{02} = 10MA$

$$V_{Z1} = V_{Z2} = 10V$$



$$I_2 = I_{02} \left[ e^{\frac{V_2}{\eta V_T}} - 1 \right]$$

$$\frac{I_2}{I_{02}} = e^{\frac{V_2}{\eta V_T}} - 1$$

$$\Rightarrow \frac{V_2}{\eta V_T} = \ln \left[ 1 + \frac{I_2}{I_{02}} \right]$$

$$V_2 = \eta V_T \ln \left[ 1 + \frac{I_2}{I_{02}} \right]$$

$$V_2 = \eta V_T \ln \left[ 1 - \frac{I_{01}}{I_{02}} \right]$$

$$\Rightarrow V_2 = 0.02586 \ln \left( 1 - \frac{5}{10} \right)$$

$$= -0.018V$$

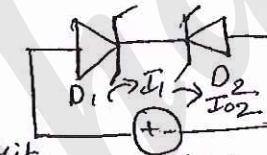
KVL  $\Rightarrow$

$$-V_a - V_1 - V_2 = 0$$

$$V_1 = -V_a - V_2$$

$$= -8.982V$$

→ For the circuit shown in the figure, calculate overall current in the circuit, if the diodes are not identical and also the breakdown voltage of diode is 5V. Given  $I_{o1} = 25\text{mA}$ ,  $I_{o2} = 50\text{mA}$



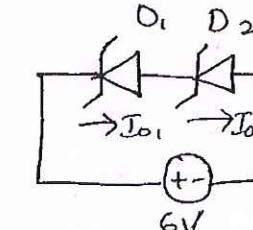
- a) 25mA clockwise
- b) 25mA anticlockwise
- c) 50mA clockwise ✓
- d) 50mA anticlockwise.

$$I_1 = I_{o2} = 50\text{mA} \text{ clockwise}$$

→ For the circuit shown in figure calculate overall current in the circuit (Same as above Q)

$6V > 5V \Rightarrow$  One diode gets breakdown  
i.e.,  $D_1$  gets breakdown.

So current is 50mA clockwise



If it is 4V  $\Rightarrow$  Current is 25mA clockwise

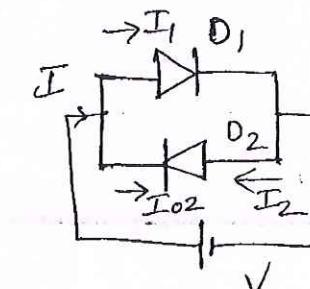
→ For the circuit shown in the figure, find the relation between  $I$  and  $V$  if the diodes are identical

a)  ~~$I = I_0 \sinh V / \eta V_T$~~

b)  $I = I_0 \cosh V / \eta V_T$

c)  $I = 2I_0 \sinh V / \eta V_T$

d)  $I = 2I_0 \cosh V / \eta V_T$



$$= I_0 \left[ e^{\frac{V}{nV_T}} - e^{-\frac{V}{nV_T}} \right]$$

$$I = I_0 \left[ e^{\frac{V}{nV_T}} - e^{-\frac{V}{nV_T}} \right]$$

$$= 2I_0 \left[ \frac{e^{\frac{V}{nV_T}} - e^{-\frac{V}{nV_T}}}{2} \right]$$

$$\Rightarrow I = 2I_0 \sinh \frac{V}{nV_T}$$

$$\frac{V}{nV_T} = \ln \left( \frac{I}{I_0} \right)$$

$$V = nV_T \ln \left( \frac{I}{I_0} \right)$$

in terms of log.

→ In a uniformly doped abrupt pn junction, the doping level of the n-side is 4 times the doping level of the p-side. The ratio of the depletion layer width of n-side vs p-side is.

$$N_A w_p = N_D w_n$$

$$\frac{w_n}{w_p} = \frac{N_A}{N_D} = \frac{N_A}{4N_A} = \frac{1}{4} = 0.25$$

→ The small signal capacitance of an abrupt p+n junction is INF at zero bias. If the built-in voltage is 1V, the capacitance at a reverse bias voltage of 99V is

$$V_{bi} = V_0 = 1V$$

$$V_R = 99V$$

$$C_T = \frac{G_T}{\left(1 + \frac{V_R}{V_0}\right)^{1/2}}$$

$$= \frac{\text{INF}}{\left(1 + \frac{99}{1}\right)^{1/2}} = \frac{\text{INF}}{10} = 0.1\text{NF}$$

$$V_{j2}^o = 0.8 + 7.2 = 8V$$

$$\omega_2 = ?$$

$$\frac{V_{j2}^o}{V_{j1}^o} = \frac{\omega_2^2}{\omega_1^2} \Rightarrow \omega_2 = \omega_1 \sqrt{\frac{V_{j2}^o}{V_{j1}^o}} = 2\mu m \sqrt{\frac{8}{2}}$$

$$\therefore \text{Width } \omega_2 = 4\mu m$$

→ In an abrupt p-n junction, the doping concentration on p-side and n-side are  $9 \times 10^{16}/cm^3$  and  $1 \times 10^{16}/cm^3$ . The p-n junction is reverse biased and the total depletion width is  $3\mu m$ . The depletion width on p-side is

$$N_A \omega_p = N_D \omega_n \quad (\text{d}) \text{ Use } \omega_p = \frac{N_A \cdot r_0}{N_A + N_D}$$

$$\omega_n = \frac{N_A}{N_D} \omega_p = \frac{9 \times 10^{16}}{1 \times 10^{16}} \times \omega_p$$

$$\Rightarrow \omega_n = 9\omega_p$$

$$\omega = \omega_n + \omega_p \Rightarrow \omega = 10\omega_p \Rightarrow \omega_p = 0.3\mu m //$$

→ Consider an abrupt p-n junction. Let  $V_{bi}$  be the built-in potential of the junction and  $V_R$  be the applied reverse bias. If the junction capacitance is  $1pF$  for  $V_{bi} + V_R = 1V$ , then for  $V_{bi} + V_R = 4V$ , the junction capacitance will be?

$$\frac{C_T}{C_{T1}} = \sqrt{\frac{V_{bi1} + V_{R1}}{V_{bi2} + V_{R2}}} \xrightarrow{\omega \propto \sqrt{V_j^o}} \Rightarrow C_{T2} = C_{T1} \sqrt{\frac{V_{j1}^o}{V_{j2}^o}} = 1p \times \sqrt{\frac{1}{4}} = 0.5pF$$

$$I_{Si} = I_{0Si} [e^{V/2V_T - 1}]$$

$$\frac{1}{I} = \frac{I_{0Ge}}{I_{0Si}} \left[ \frac{(e^{0.1435/V_T - 1})}{(e^{0.718/2V_T - 1})} \right]$$

$$\frac{e^{0.718/2V_T - 1}}{e^{0.1435/V_T - 1}} = \frac{I_{0(Ge)}}{I_{0(Si)}} = \frac{\cancel{1069223.234}}{\cancel{256.008}} \quad \frac{\cancel{363345.6}}{\cancel{1069223.234}}$$

$$\frac{I_{0(Ge)}}{I_{0(Si)}} = 4176 \approx 4 \times 10^3 //$$

→ A p-n junction is in series with a  $100\Omega$  resistor and is forward biased so that a current of  $100\text{mA}$  flows.

If the voltage across this combination is instantaneously reversed at  $t=0$ , current through diode is approximately given by.

- a)  $0\text{mA}$    b)  $\checkmark 100\text{mA}$    c)  $200\text{mA}$    d)  $30\text{mA}$

→ In a Ge p-n junction diode,  $\sigma_p = 1\text{s/cm}$  and  $\sigma_n = 0.1\text{s/cm}$  and  $L_n = L_p = 0.15\text{cm}$ . Find the ratio of diffusion current due to holes to electrons.

$$J_p = -eD_p \frac{dp}{dx}$$

$$J_n = eD_n \frac{dn}{dx}$$

$$\frac{I_{pn}(0)}{I_{np}(0)} = \frac{L_n \sigma_p}{L_p \sigma_n} = 10$$

$$e^{-0.05/0.02586} - 1 \leq 6.9$$

$$= \frac{6.9}{0.89}$$

$$= 6.9 \parallel$$

→ Show that for an alloy p-n junction with  $N_A \ll N_D$ , the width of the depletion region is  $w = \left[ \frac{2\epsilon \mu_p V_j^o}{\sigma_p} \right]^{1/2}$  where  $V_j^o$  is the junction potential.

$$V_j^o = \frac{eN_A}{2\epsilon} w^2$$

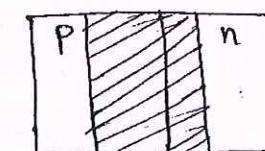
$$\Rightarrow w = \left[ \frac{2\epsilon V_j^o}{eN_A} \right]^{1/2}$$

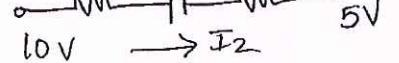
$$\sigma_p = PM_p e \approx N_A M_p e$$

$$\Rightarrow N_A e = \frac{\sigma_p}{M_p}$$

$$\Rightarrow w = \left[ \frac{2\epsilon V_j^o}{\frac{\sigma_p}{M_p}} \right]^{1/2}$$

$$\Rightarrow w = \left[ \frac{2\epsilon M_p V_j^o}{\sigma_p} \right]^{1/2} \parallel$$



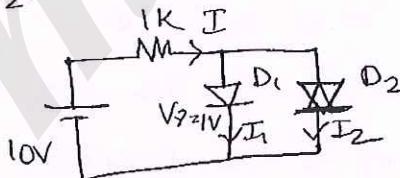


$$I_2 = \frac{10 - 1 - 5}{2K + 2K} = 1 \text{ mA.}$$

→ For the circuit shown in figure, diodes D<sub>1</sub> and D<sub>2</sub> are identical. Calculate currents I<sub>1</sub> & I<sub>2</sub>.

$$I = \frac{10 - 1}{1K} = 9 \text{ mA}$$

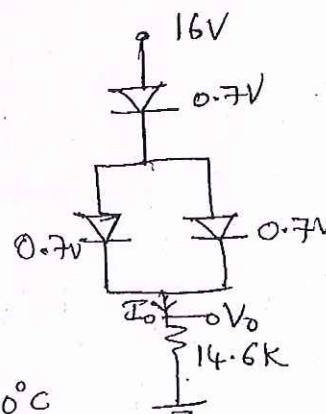
$$I_1 = I_2 = \frac{9}{2} \text{ mA} = 4.5 \text{ mA}$$



→ For the circuit shown in the figure, calculate V<sub>b</sub> and I<sub>o</sub>.

$$V_o = 16 - 0.7 - 0.7 = 14.6 \text{ V}$$

$$I_o = \frac{16 - 0.7}{14.6K} = 1 \text{ mA.}$$



→ Calculate the factor by which the reverse saturation current of diode is multiplied when temperature increases from 25°C to 80°C

$$\begin{aligned} I_{o2} &= I_{o1} \times 2^{\frac{(T_2 - T_1)}{10}} \\ &= I_{o1} \times 2^{\frac{(80 - 25)}{10}} \\ &= I_{o1} \times 2^{5.5} \end{aligned}$$

$$I_{o2} = 45.25 I_{o1}$$

$$\therefore \text{Multiplying factor} = 45.25$$

$$= 0.0259 \text{ cm}$$

→ In the circuit shown in figure, verify whether the diodes can withstand for maximum input signals or not.

$$P = 14 \text{ mW}$$

$$I = \frac{P}{V} = 0.00020 \text{ mA} \approx 20 \text{ mA}$$

$$I = \frac{150 - 0.7}{5\text{k}} \approx 30 \text{ mA}$$

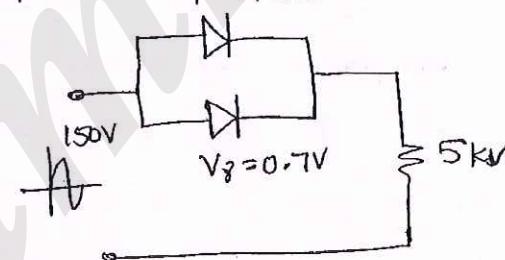
Current through each diode = 15mA > 20mA

∴ Diodes will withstand.

2/8/13

→ Consider a Si P-n junction at  $T = 300\text{K}$  with doping concentrations of  $N_A = 10^{16}/\text{cm}^3$ ,  $N_D = 10^{15}/\text{cm}^3$  and built in potential  $V_{bi} = 0.635$ . Calculate Space charge width.

$$\begin{aligned} W &= \sqrt{\frac{2\epsilon}{e} (V_{bi}) \left( \frac{1}{N_A} + \frac{1}{N_D} \right)} \cdot \text{cm} \\ &= \sqrt{\frac{2 \times 8.854 \times 10^{-14}}{1.6 \times 10^{-19}} \times 0.635} \left[ \frac{1}{10^{16}} + \frac{1}{10^{15}} \right] \\ &= 0.96 \mu\text{m}_{//} \end{aligned}$$



$$= 2.86 \text{ Nm} = \sqrt{\frac{2 \times 8.854 \times 10^{-12}}{1.6 \times 10^{-19}} (0.635 + 5) \left( \frac{1}{10^{16}} + \frac{1}{10^{15}} \right)} \Omega$$

→ Consider the following parameters in Si p-n junction

$$N_A = N_D = 10^{16}/\text{cm}^3, n_i = 1.5 \times 10^{10}/\text{cm}^3, D_n = 25 \text{ cm}^2/\text{s}, D_p = 10 \text{ cm}^2/\text{s}$$

$T_p = T_n = 5 \times 10^{-7} \text{ s}$  and  $\epsilon_r = 11.7$ . Calculate reverse saturation current density.

$$I_0 = A e \left[ \frac{D_p}{L_p N_D} + \frac{D_n}{L_n N_A} \right] n_i^2$$

$$L_p = \sqrt{T_p D_p}$$

$$\frac{I_0}{A} = n_i^2 e \left[ \frac{D_p}{L_p N_D} + \frac{D_n}{L_n N_A} \right]$$

$$L_n = \sqrt{T_n D_n}$$

$$J_0 = n_i^2 e \left[ \sqrt{\frac{D_p}{T_p}} \cdot \frac{1}{N_D} + \sqrt{\frac{D_n}{T_n}} \cdot \frac{1}{N_A} \right]$$

$$J_0 = 36 \left[ 4.47 \times 10^{-13} + 7.07 \times 10^{-13} \right]$$

$$= 4.155 \times 10^{-11} \text{ A/cm}^2 = 41.55 \text{ fA/cm}^2$$

→ Calculate the barrier capacitance of a Ge p-n junction

whose area is  $1\text{mm} \times 1\text{mm}$  and space charge thickness is  $2 \times 10^{-4} \text{ cm}$  and  $\epsilon_r = 16$

$$= 0.1 \times 10$$

$$= 0.07 \text{ nA}$$

→ A Ge diode has a saturation current of 0.1 pA at 20°C. Find its current when it is forward biased by 0.55V. and also find the current in the same diode when the temperature raised to 100°C.

$$I = I_0 [e^{\frac{V}{kT}} - 1]$$

In Ge

$$I = I_0 [e^{\frac{V}{kT}} - 1]$$

$$= 0.1 \times 10^{-12} \left[ e^{\frac{0.55}{20+273} / \frac{1}{11600}} - 1 \right]$$

$$= 0.286 \text{ mA}$$

$$\text{At } 100^\circ\text{C} \Rightarrow T = 100^\circ\text{C} \Rightarrow V_T = \frac{100+273}{11600}$$

$$(T_2 - T_1) / 10^\circ = 0.032$$

$$I_0|_{100^\circ\text{C}} = 2 \times I_0|_{20^\circ\text{C}}$$

$$= 2^{(100-20)/10} \times 0.1 \times 10^{-12}$$

$$= 2^8 \times 0.1 \times 10^{-12}$$

$$= 25.6 \text{ pA}$$

$$I = I_0 \left[ e^{\frac{V}{kT}} - 1 \right] = 25.6 \times 10^{-12} \left[ e^{\frac{0.55}{0.032}} - 1 \right]$$

$$= 7.4 \text{ mA}$$

$$\begin{aligned} V_T &= \frac{T}{11600} \\ &= \frac{273+20}{11600} \\ &= 0.025 \end{aligned}$$

$$\begin{aligned}
 V_0 &= KT \ln \left( \frac{N_A N_D}{n_i^2} \right) \\
 &= V_T \ln \left( \frac{N_A N_D}{n_i^2} \right) \\
 &= 0.0256 \ln \left( \frac{10^{22} \times 1.2 \times 10^{21}}{(1.5 \times 10^{16})^2} \right) \\
 &= 0.632V
 \end{aligned}$$

→ The capacitance of an abrupt p-n junction  $1 \times 10^{-8} \text{ m}^2$  in area measured at -1V reverse bias is 5pF. The built in voltage of this device is 0.9V. When the diode is forward biased with 0.5V, a current of 10mA flows. and the n-region minority hole life time is known to be 1 μsecond at 300K. Calculate

(a) Depletion layer capacitance of this junction at 0.5V forward bias.

(b) Diffusion capacitance of the diode operating as in part (a) at 300K.

Given  $A = 1 \times 10^{-8} \text{ m}^2$   $V = 0.5V$   
 $V_R = -1V$   $I = 10\text{mA}$   
 $C_T = 5\text{pF}$   $\tau_p = 1\text{μs.}$   
 $V_0 = 0.9V$

$$= 10.89 \text{ pF}$$

~~(a)~~ → A step graded Ge p-n junction has  $N_D = 500N_A$  where  $N_A$  corresponds to two acceptor atoms/ $10^8$  Ge atoms.<sup>(a)</sup> Calculate contact potential at room temperature. (b) Repeat part (a) for Si p-n junction. It is given that the no: of atoms/ $\text{cm}^3$  in Ge is  $4.4 \times 10^{22}$  atoms/ $\text{cm}^3$  and that in Si is  $5 \times 10^{22}$  atoms/ $\text{cm}^3$ .  $K = 1.38 \times 10^{-23} \text{ J/K}$ ,  $q = 1.6 \times 10^{-19} \text{ C}$ ,  $n_i$  for Ge is  $2.5 \times 10^{13} \text{ cm}^{-3}$  and  $n_i$  for Si is  $1.5 \times 10^{10} \text{ cm}^{-3}$

$$(a) V_0 = KT \ln \left( \frac{N_A N_D}{n_i^2} \right)$$

$$KT = \frac{T}{11600} = 0.02586$$

$$N_A = \frac{4.4 \times 10^{22}}{10^8} \times \frac{2}{10^8} = 8.8 \times 10^{14} \text{ /cm}^3$$

$$N_D = 500 N_A = 44 \times 10^{16} \text{ /cm}^3$$

$$V_0 = 0.02586 \left[ \ln \left[ \frac{8.8 \times 10^{14} \times 44 \times 10^{16}}{(2.5 \times 10^{13})^2} \right] \right]$$

$$= 0.3449 \text{ V}$$

$$(b) N_A = \frac{5 \times 10^{22} \times 2}{10^8} = 10^{15} \text{ /cm}^3$$

$$N_D = 500 N_A = 5 \times 10^{17} \text{ /cm}^3$$

$$V_0 = 0.0258 \ln \left[ \frac{10^{15} \times 5 \times 10^{17}}{(1.5 \times 10^{10})^2} \right] = 0.735 \text{ V}$$

$$= 0.02586 \ln \left( \frac{10^{23} \times 10^{21}}{(1.5 \times 10^{16})^2} \right)$$

$$= 0.02586 \times 0.69$$

$$\omega = \sqrt{\frac{2\epsilon V_0}{q} \left[ \frac{1}{N_A} + \frac{1}{N_D} \right]}$$

$$= \sqrt{\frac{2 \times 8.85 \times 10^{-12} \times 11.8}{1.6 \times 10^{-19}} \left[ \frac{1}{10^{23}} + \frac{1}{10^{21}} \right]}$$

$$= 0.95 \text{ nm}$$

→ A Si abrupt pn junction at 300K has acceptor density

$N_A = 10^{18}/\text{cm}^3$  and donor density  $N_D = 10^{15}/\text{cm}^3$ . If the

intrinsic concentration  $n_i = 1.5 \times 10^{10}/\text{cm}^3$  calculate

built-in voltage. Derive the relations used.

$$V_0 = kT \ln \left( \frac{N_A N_D}{n_i^2} \right)$$

$$= 0.02586 \ln \left( \frac{10^{15} \times 10^{18}}{(1.5 \times 10^{10})^2} \right)$$

$$= 0.753V$$

$$\gamma_F = \frac{0.034}{0.011} = 3.07 \text{ V}$$

$$\gamma_F = \frac{0.034}{30 \times 10^{-6}} = 1.1 \text{ kV}$$

→ A Si diode showed currents of 2mA and 10mA when the diode voltages were 0.6V and 0.7V. Estimate the operating temperature of the diode junction.

$$I_1 = 2 \text{ mA} \quad I_2 = 10 \text{ mA} \quad \eta = 2$$

$$V_1 = 0.6 \text{ V} \quad V_2 = 0.7 \text{ V}$$

$$I = I_0 (e^{\frac{V}{nV_T}} - 1) \quad (\text{neglect change in } I_0)$$

$$I_1 = 2 = I_0 (e^{\frac{0.6}{nV_T}} - 1)$$

$$I_2 = 10 = I_0 (e^{\frac{0.7}{nV_T}} - 1)$$

$$\frac{I_2}{I_1} = \frac{(e^{\frac{V_2}{nV_T}} - 1)}{(e^{\frac{V_1}{nV_T}} - 1)}$$

$$\frac{I_2}{I_1} \approx \frac{e^{\frac{V_2}{nV_T}}}{e^{\frac{V_1}{nV_T}}} \Rightarrow e^{\frac{(V_2 - V_1)}{nV_T}} = 5$$

$$5 e^{\frac{V_1}{nV_T}} = e^{\frac{V_2}{nV_T}} \Rightarrow e^{\frac{(0.7 - 0.6)}{2nV_T}} = 5$$

$$\Rightarrow e^{\frac{0.1}{2nV_T}} = 5$$

$$\Rightarrow nV_T = \frac{0.1}{2 \ln(5)}$$

$$\frac{T}{11600} = 0.03106$$

$$\Rightarrow T = 360.374 \text{ K}$$

$$\sigma_p = N_A M_p q V \Rightarrow N_A = \frac{\sigma_p}{M_p q} = 1.25 \times 10^{18}$$

$$\Rightarrow N_D = \frac{\sigma_n}{M_n q} = 4.8 \times 10^{15}$$

$$V_0 = kT \ln \left( \frac{N_A N_D}{n_i^2} \right)$$

$$= \frac{1.38 \times 10^{-23} \times 300}{1.6 \times 10^{-19}} \ln \left( \frac{1.25 \times 10^{18} \times 4.8 \times 10^{15}}{(1.5 \times 10^{10})^2} \right)$$

$$= 0.799 V$$

→ A step graded Ge diode has a resistivity of 2  $\Omega\text{-cm}$  on p-side and 1  $\Omega\text{-cm}$  on n-side. Calculate the height of the barrier potential and also derive the formula used.

$$M_p = 1800 \text{ cm}^2/\text{V-sec}, M_n = 3800 \text{ cm}^2/\text{V-sec}, n_i = 2.5 \times 10^{13}/\text{cm}^3$$

at 300K.

$$\rho_p = 2 \Omega\text{-cm} \Rightarrow \frac{1}{N_A M_p q} = 2 \Rightarrow N_A = \frac{1}{2 \times 1800 \times 1.6 \times 10^{-19}} = 8.22 \times 10^{14}$$

$$\rho_n = 1 \Omega\text{-cm} \Rightarrow \frac{1}{N_D M_n q} = 1 \Rightarrow N_D = \frac{1}{1 \times 3800 \times 1.6 \times 10^{-19}}$$

$$C_J = \frac{C_{J_0}}{\left(1 + \frac{V_R}{V_0}\right)^{1/2}}$$

$$= \frac{0.8P}{\left(1 + \frac{5}{0.753}\right)^{1/2}}$$

$$= 2.2 \text{ pF}$$

Transition  
Capacitance ( $C_T$ )  
&  
Junction Capacitance  
( $C_J$ )

$$V_0 = KT \ln \left( \frac{N_{AND}}{n_i^2} \right)$$

$$= 0.02586 \ln \left( \frac{10^{16} \times 10^{17}}{1.5 \times 10^{10}} \right) \text{ V}$$

$$= 0.753$$

→ A Si p-n junction at  $T = 300K$ , has a reverse saturation current of  $I_S = 2 \times 10^{-14} \text{ A}$ . Determine required forward bias voltage to produce a current of a)  $I_D = 50 \text{ mA}$  and

b)  $I_D = 1 \text{ mA}$ .

$$I = I_0 [e^{\frac{V}{kT}} - 1]$$

$$\times I_D = 50 \text{ mA} \Rightarrow \frac{6}{10 \times 50} = 2 \times 10^{-14} \left[ e^{\frac{V}{2 \times 0.02586}} - 1 \right]$$

$$2.5 \times 10^{15} = e^{\frac{V}{0.05172}} - 1$$

$$\frac{V}{0.05172} = \ln \left( 1 + 2.5 \times 10^{15} \right)$$

$$V = 1.12 \text{ V}$$

$$= 1.12V$$

b)  $I_D = 1mA$

$$\Rightarrow V = 2 \times 0.02586 \ln \left[ 1 + \frac{10^{-3}}{2 \times 10^{-14}} \right]$$

$$= 1.27V$$

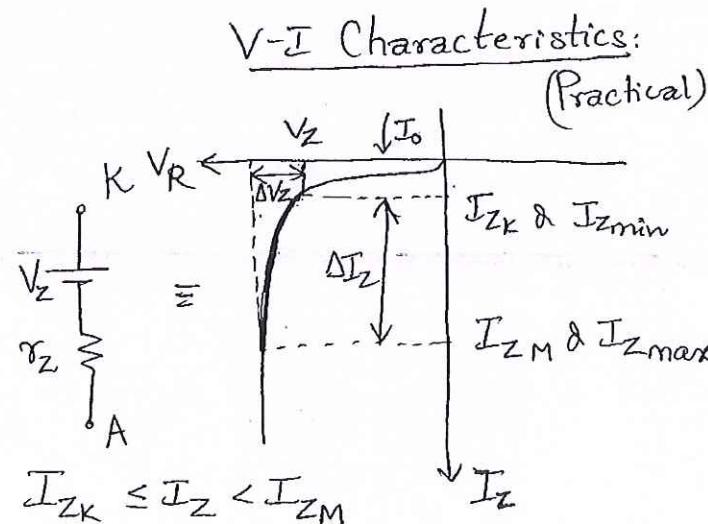
### Zener Diode:

A diode which is designed with sufficient power dissipation capabilities and operates in breakdown region may be employed as a voltage reference or constant voltage source is called Zener diode.

→ Zener diode is a heavily doped p-n junction diode and its doping concentration is  $1 \text{ impurity atom}/10^5 \text{ Si \& Ge atoms}$ .

→ Zener diode always operates in reverse biased breakdown region.

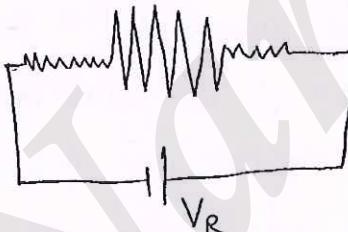
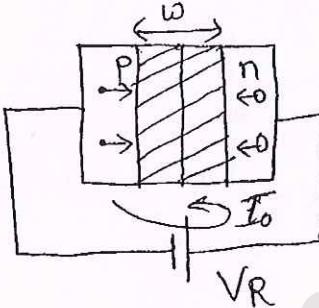
### Schematic Symbol:



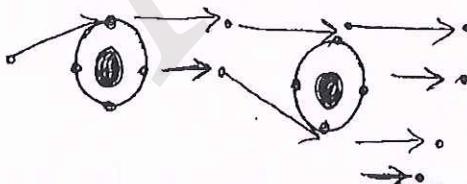
$\downarrow I_R$

### Avalanche Break Down

→ happens in lightly doped junctions

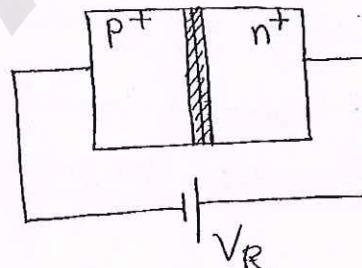


$$E = \frac{V_j}{w}$$



### Zener Breakdown

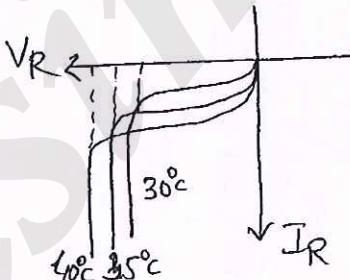
→ happen in heavily doped junctions.



$$E = \frac{V_j}{w}$$

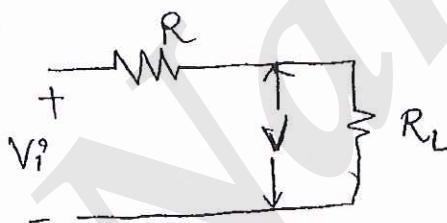
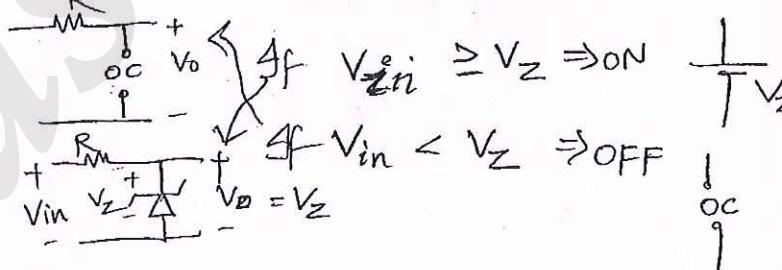
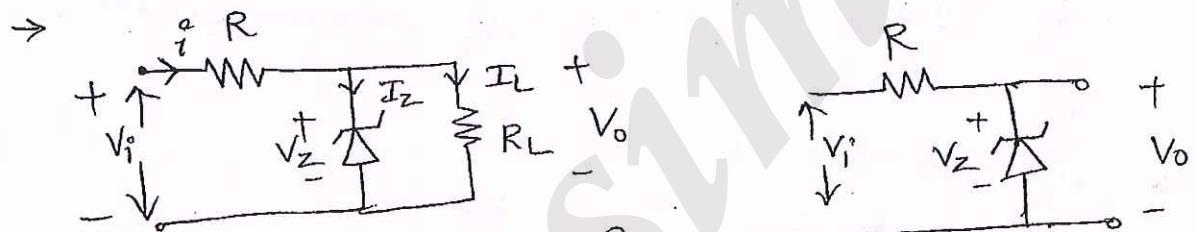
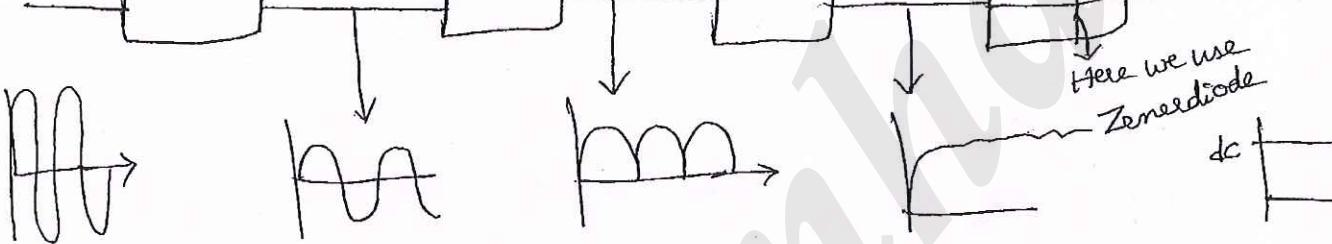
$E$  is more because  $w$  is small.

- It is a cumulative process.
- It happens due to collision of  $e^-$  with the ions.
- Low doping concentration.
- Avalanche breakdown is having positive temperature coefficient i.e., as temperature increases, avalanche breakdown voltage increases.
- Avalanche breakdown is a impact ionization process.



### Zener Breakdown:

- Initially available carriers do not acquire the sufficient energy to disturb the bonds but it is possible to initiate the breakdown through direct rupture of the bonds because of existence of strong electric field at the junction.
- It occurs at  $< 6\text{ eV}$ .
- It is not a cumulative process.
- It happens due to direct rupture of the bonds because of existence of strong electric field at the junction.
- High doping levels.
- Zener breakdown voltage is having negative temperature coefficient i.e., as temperature increases, breakdown voltage decreases.



Calculate  $V$

$$V = \frac{V_i R_L}{R + R_L}$$

(i) If  $V < V_Z \Rightarrow OFF$

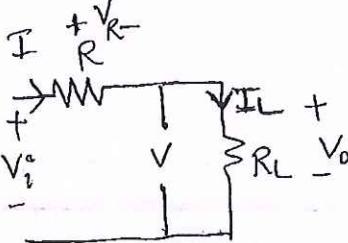
$$I_Z = 0$$

$$I_L = I$$

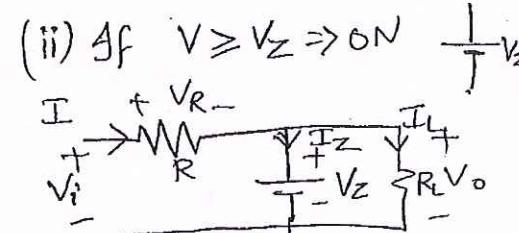
$$V_o = V$$

$$V_R = IR = V_i - V$$

$$P_Z = V_Z I_Z = 0$$



$$I = \frac{V_R}{R} = \frac{V_i - V}{R}$$



$$V_R = V_i - V_Z = IR$$

$$I = I_Z + I_L$$

$$I = \frac{V_R}{R} = \frac{V_i - V_Z}{R}$$

$$\boxed{I_Z = I - I_L}$$

$$V_R = V_i - V = 16 - 8 = 8V$$

$$I_Z = 0; P_Z = 0$$

$$V_Z = 10V$$

→ Repeat the above problem for  $R_L = 3k\Omega$ .

$$V = \frac{16 \times 3k}{3k + 1k} = \frac{48}{4} = 12V > V_Z \text{ Zen diode is ON state}$$

$$V_o = V_i + V_Z = 10V$$

$$V_R = V_i - V_Z = 16 - 10 = 6V$$

$$I_Z = \frac{V_R}{R} = \frac{6}{1k} = 6mA$$

$$\begin{aligned} I_Z &= I - I_L = I - \frac{V_Z}{R_L} \\ &= I - \frac{10}{3k} \end{aligned}$$

$$\begin{aligned} \therefore I_Z &= 6mA - 3.33mA \\ &= 2.67mA \end{aligned}$$

$$P_Z = I_Z V_Z = 10 \times 2.67m = 26.7mW$$

→ Case(ii):  $V_i$  fixed and  $R_L$  varies  $\frac{V_R}{R}$

$$R_L \text{ fixed: } I = I_Z + I_L \Rightarrow V_o = I_L R_L$$

$$R_L \uparrow: I = I_Z \uparrow + I_L \downarrow \Rightarrow V_o = I_L R_L \uparrow$$

$$I = \frac{V_i - V_Z}{R}$$

$$\left[ \because I_Z < I_{Zm} \text{ & } I_Z < I_{Zmax} \right]$$

$$\therefore I = I_{Zm} + I_{Lmin} \text{ & } I_{Zmax} + I_{Lmin}$$

$$\Rightarrow I_{L(\max)} = I - I_{ZK} = I - I_{Z(\min)}$$

$$R_{L(\min)} = \frac{V_Z}{I_{L(\max)}}$$

$$P_{Z(\max)} = V_Z I_{Z\max}$$

$$P_{Z(\min)} = V_Z I_{Z\min}$$

$$I_{L\max} \approx I = \frac{V_i - V_Z}{R}$$

$$R_{L\min} = \frac{V_Z}{\frac{V_i - V_Z}{R}} = \frac{V_Z R}{V_i - V_Z}$$

3/8/13

For the circuit shown in the figure find the range of load current and resistance that will maintain output voltage fixed at 10V. and also calculate  $P_{\max}$  across zener diode

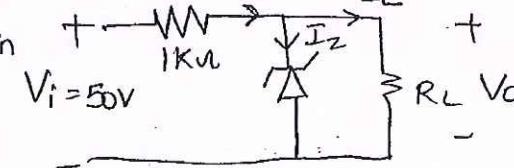
i.e, find  $R_{L\min}$ ,  $R_{L\max}$ ,  $I_{L\min}$

and  $I_{L\max}$ .

$$I = I_Z + I_L$$

$$V_o = I_L R_L$$

$$I = \frac{V_i - V_Z}{R}$$



$$I_{ZM} = 32 \text{ mA}$$

$$I_L R_L = 10V \Rightarrow V_Z = 10V$$

$I_{Z\min}$  is not given  
So take it as 0

$$10 = \frac{50 R_L}{1k + R_L}$$

$$10k + 10R_L = 50R_L \Rightarrow R_L = 250\Omega$$

$$R_{L\min} = \frac{V_Z R}{V_i - V_Z} = \frac{10 \times 1k}{50 - 10} = 250\Omega \quad I = \frac{V_i - V_Z}{R} = \frac{50 - 10}{1k} = 40 \text{ mA}$$

$$R_{L\max} = \frac{V_Z}{I_{L\min}} = \frac{10V}{8 \text{ mA}} = 1.25 \text{ k}\Omega \quad I_{L\min} = I - I_{Zm} \\ = 40 - 32 = 8 \text{ mA}$$

$$I_{L\max} = I - I_{ZK} = I - I_{Z\min} \approx I = 40 \text{ mA}$$

$$I_{max} = I_{Z_{max}} + I_L$$

$$\therefore I_Z < I_{Z_{max}}$$

$$V_{i_{max}} = V_{R_{max}} + V_Z$$

$$\Rightarrow V_{i_{max}} = I_{max} R + V_Z$$

$$V_i \downarrow : I \downarrow = I_Z + I_L^* \Rightarrow V_o = I_L^* R_L$$

$$\left[ \begin{array}{l} \because I_Z \geq I_{Z_K} \\ I_Z \geq I_{Z_{min}} \end{array} \right]$$

$$I_{min} = I_{Z_K} + I_L = I_{Z_{min}} + I_L$$

$$V_{i_{min}} = V_{R_{min}} + V_Z$$

$$\Rightarrow V_{i_{min}} = I_{min} R + V_Z$$

$$I_{min} = I_{Z_{min}} + I_L \approx I_L = \frac{V_Z}{R_L}$$

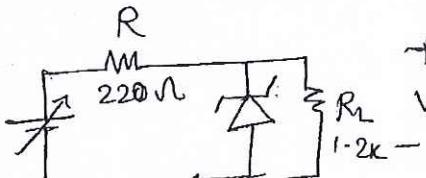
$$V_{i_{min}} = \frac{V_Z}{R_L} \cdot R + V_Z = \left(1 + \frac{R}{R_L}\right) V_Z = \left[\frac{R_L + R}{R_L}\right] V_Z$$

→ For the circuit shown in the figure, find the range of input voltage that will maintain o/p voltage fixed at 20V.

$$\begin{aligned} V_{i_{min}} &= \left(1 + \frac{R}{R_L}\right) V_Z \\ &= \left(1 + \frac{220}{1.2k}\right) 20 \\ &= 23.67V \end{aligned}$$

$$I_L = \frac{V_Z}{R_L} = \frac{20}{1.2k} = 0.017A \approx 16.67mA$$

$$\begin{aligned} I_{max} &= I_{Z_{max}} + I_L = 60mA + 16.67mA \\ &= 76.67mA \end{aligned}$$



$$I_{Z_m} \approx 60mA$$

$V_i$  Variable and  $R_L$  fixed:

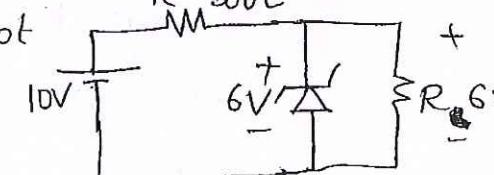
$$\frac{V_{i\min} - V_Z}{R} \geq I_{Z\min} + I_L \Rightarrow R \leq \frac{V_{i\min} - V_Z}{I_{Z\min} + I_L}$$

$V_i$  Variable and  $R_L$  variable:

$$\frac{V_{i\min} - V_Z}{R} \geq I_{Z\min} + I_{L\max} \Rightarrow R \leq \frac{V_{i\min} - V_Z}{I_{Z\min} + I_{L\max}}$$

→ A 6V Zener diode shown below has zero zener resistance and a knee current of 5mA. The minimum value of  $R$  so that the voltage across it does not fall below 6V is

$$V_Z = 6V, I_{Z\min} = I_{ZK} = 5mA$$



$$R_{\min} = \frac{V_Z}{I_{L\max}} = \frac{6}{75m} = 80\Omega$$

$$I = I_L + I_Z$$

$$I_{L\max} = I - I_{ZK}$$

$$I = \frac{10 - 6}{50} = \frac{4}{50} = 0.08A = 80mA$$

$$I_{L\max} = 80 - 5$$

$$= 75mA$$

→ If Zener diode shown in circuit shown in below figure has a knee current of 5mA and a maximum allowed power dissipation of 300mW. What are the min and max load currents that can be drawn safely from the circuit keeping the output voltage  $V_o$  constant at 6V.

$$I_{ZK} = 5mA \quad P_{\max} = 300mW$$

$$V_Z = V_o = 6V$$

$$V_Z I_{ZK} \quad P_{\max} = V_Z I_{Z\max}$$

$$\Rightarrow I_{Z\max} = P_{\max}/V_Z$$

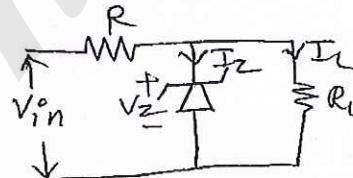
$$\begin{aligned}
 I_{L\min} &= I_{Z\max} \\
 &= 60 - 50mA \\
 &= 10mA
 \end{aligned}$$

→ A Zener diode regulator as shown in the figure is to be designed to meet the following specifications.

$$I_L = 10mA, V_o = 10V, V_i = 30 \text{ to } 50V$$

$$V_Z = 10V \text{ and } I_{ZK} = 1mA$$

For proper operation of the circuit,  
the value of  $R$  is



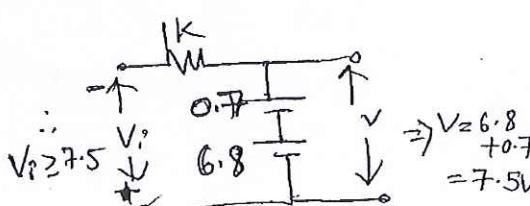
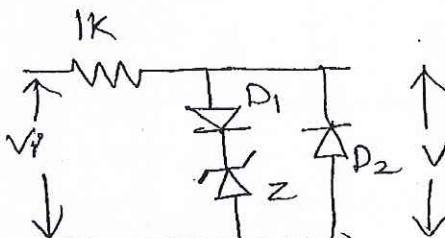
$$I = I_Z + I_L$$

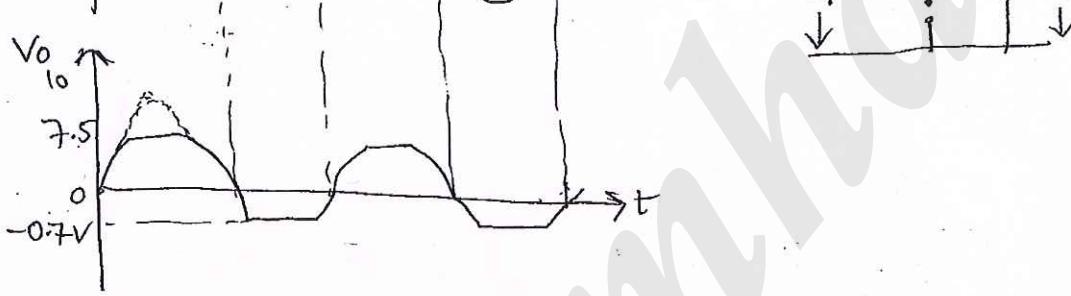
$$R \leq \frac{V_{i\min} - V_Z}{I_{Z\min} + I_L} = \frac{30 - 10}{1m + 10m} = \frac{20}{11m} = 1.8k\Omega$$

→ In the following limiter circuit, an input Voltage  $V_i = 10 \sin 100\pi t$  is applied. Assume that the diode drop is 0.7V when it is forward biased and the zener breakdown voltage 6.8V. The max and minimum values of the output voltages are

$$V_Z = 6.8V, V_{D_1} = V_{D_2} = 0.7V$$

for +ve  $V_i \Rightarrow Z$  is in reverse bias





→ The Zener diode in the regulator circuit shown in the figure has Zener voltage of 5.8V and a knee current of 0.5mA. The maximum load current drawn from this circuit ensuring proper functioning over the input voltage range between 20 and 30V is

$$V_Z = 5.8V$$

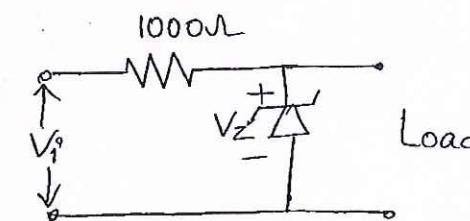
$$I_{ZK} = 0.5mA$$

$$V_i = 20 \text{ to } 30V$$

$$I_{L\max} = ?$$

$$I = I_Z + I_L$$

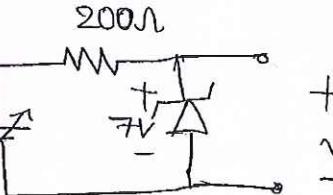
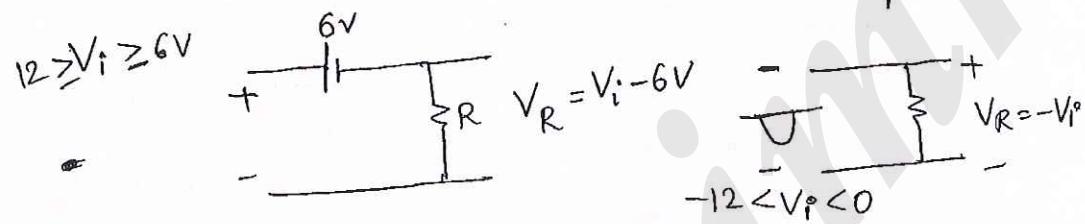
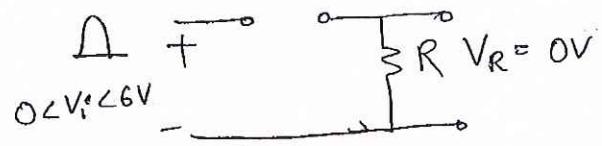
$$\begin{aligned} I_{L(\max)} &= I - I_{ZK} \\ &= 14.2 - 0.5 \\ &= 13.7mA \end{aligned}$$



$$I_{R\min} = \frac{20 - 5.8}{1000} = 14.2mA$$

$$I_{R\max} = \frac{30 - 5.8}{1000} = 24.2mA$$

→ For the circuit shown below, assume that the Zener diode is identical with a breakdown voltage of 6V. The waveform observed across R is.

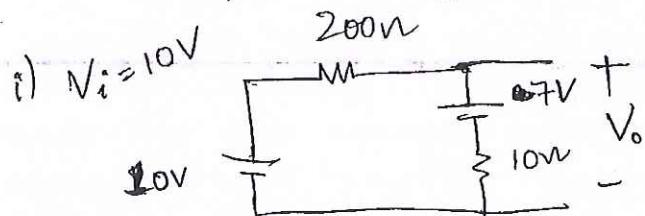


→ For the zener diode shown in figure, the Zener voltage at Knee is 7V. The knee current is negligible and the Zener dynamic resistance is  $10\Omega$ . If the input voltage  $V_i$  range is from 10V to 16V, the output voltage  $V_o$  range is

$$V_Z = 7V, r_Z = 10\Omega$$

$$V_i = 10 \text{ to } 16.$$

$$I_Z = \frac{V_o - V_Z}{R} = \frac{10 - 7}{R + r_Z} = \frac{3}{210} = 0.014A = I_Z$$



$$\begin{aligned} V_o &= 7V + 10 \times 0.014 \\ &= 7 + 0.14 \\ &= 7.14V \end{aligned}$$

$$V_i = 21 \text{ to } 27V$$

$$R_L = 250 \text{ to } 2k\Omega$$

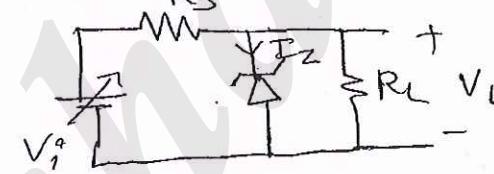
$$V_Z = 16V$$

$$I_{ZK} = 15mA$$

$$R \leq \frac{V_{i\min} - V_Z}{I_{Z\min} + I_{L\max}}$$

$$= \frac{21 - 16}{15m + 64m}$$

$$= 0.06329 \Omega \approx 63.3 \Omega$$



$$\begin{aligned} I_{L\max} &= \frac{V_Z}{R_{L\min}} = \frac{16}{250} \\ &= 0.064 \\ &\approx 64mA \end{aligned}$$

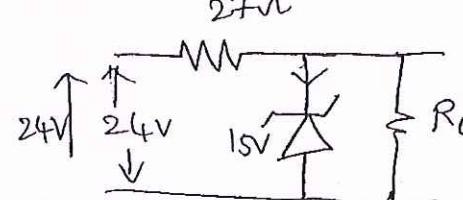
→ The circuit in figure shows Zener regulator DC power supply. The minimum value of  $R_L$  down to which the output voltage remains constant is 27Ω.

$$I_R = \frac{24 - 15}{27} = 0.33A$$

$$I = I_Z + I_L$$

$$R_{L\min} = \frac{V_Z - V_Z}{I_{L\max}}$$

$$\begin{aligned} I_{L\max} &= I - I_{ZK} \\ &\approx I = 0.33 \end{aligned}$$



$$R_{L\min} = \frac{V_Z}{I_{L\max}}$$

$$\approx \frac{15}{0.33} = 45\Omega$$

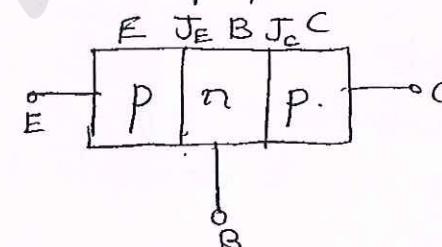
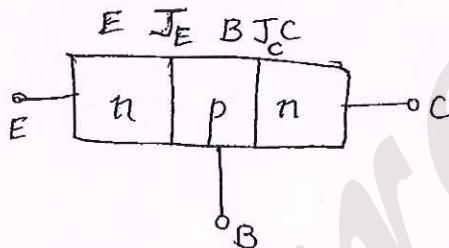
(∴ It will never get 0.6 V  
as  $D_1$  is forward biased  
at 0.2V)

p-type Si is sandwiched between two n-type Silicon layers alternatively Junction transistor consists of Si & Ge Crystal in which a layer of n-type Si is sandwiched between two p-type Si layers. Former one is called npn transistor and latter is called pnp transistor.

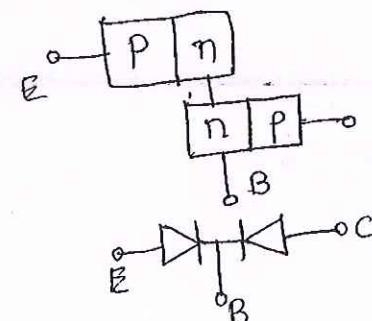
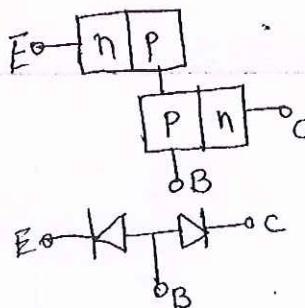
Depletion Enhancement

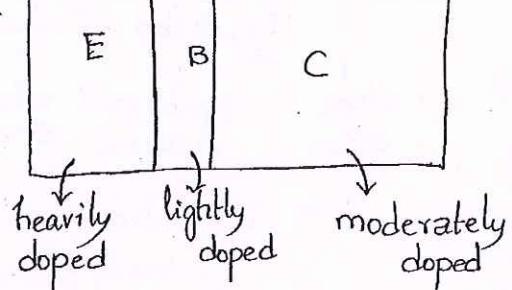
n-channel	p-channel	n-channel	p-channel
D MOSFET	D MOSFET	EMOSFET	EMOSFET

\* Two diodes connected back to back will never act like transistor.



→ BJT consists of three layers & three regions (i.e., Emitter, Base and Collector), three terminals (i.e., Emitter terminal, Base terminal and Collector Terminal) and two junctions (i.e., Emitter to Base Junction & Emitter Junction and Collector to Base Junction & Collector Junction)





### Emitter:

Emitter is heavily doped and medium in size because it has to emit the carriers.

### Collector:

Collector is large in size and moderately doped because it has to dissipate the power.

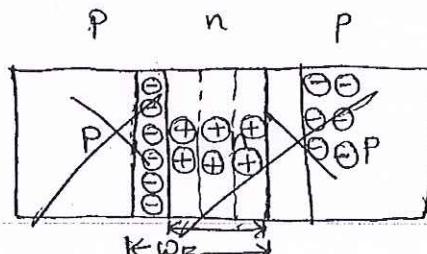
### Base:

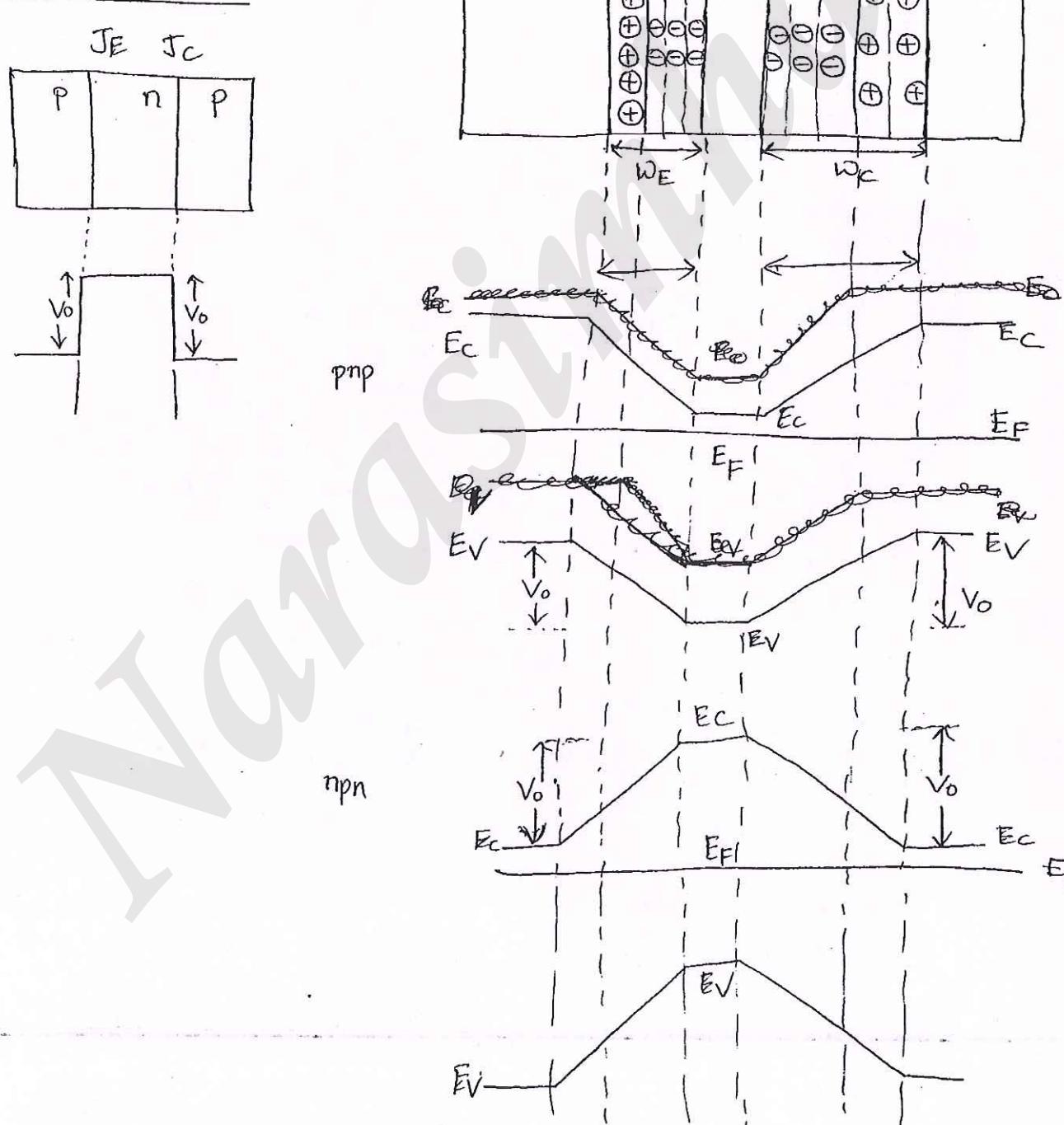
Base is lightly doped and thin in size because it has to reduce the recombinations.

- In BJT, the diffusion length of the carrier should be  $L > \omega$  where ' $\omega$ ' is basewidth.
- We are transferring current from one resistance path to another resistance path, hence the name transistor.

Transfer + Resistor  $\Rightarrow$  Transistor

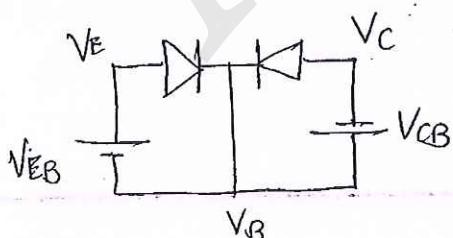
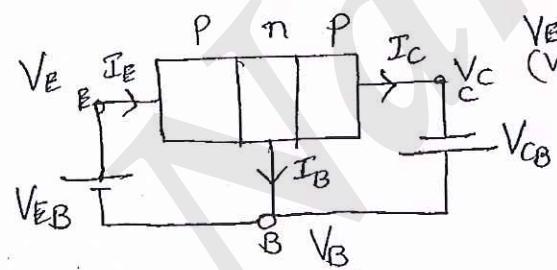
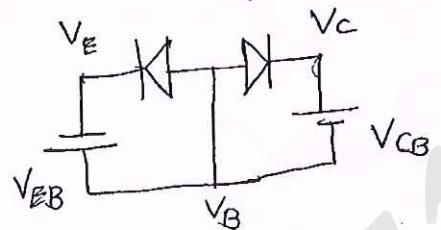
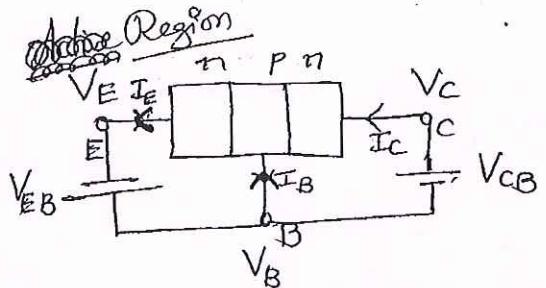
### Unbiased BJT:





Inverse Active  
Region /

Reverse Active  
Region



RB

FB

Attenuation

O

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$J_E : FB$ $J_C : RB$ Forward Active	$V_{CB}$
$J_E : FB$ $J_C : FB$ Saturation	$V_{EB}$
$J_E : RB$ $J_C : FB$ Inverse Active	$V_{CB}$

Condition

$V_E < V_B < V_C$   
( $V_{EB} = -ve$ ,  $V_{CB} +ve$ )

$V_E < V_B$ ,  $V_B > V_C$   
( $V_{EB} = -ve$ ,  $V_{CB} = -ve$ )

$J_E : RB$ $J_C : FB$ Inverse Active	$V_{CB}$
$J_E : RB$ $J_C : RB$ Cut-off	$V_{EB}$
$J_E : FB$ $J_C : RB$ Forward Active	$V_{CB}$

Region

Forward Active

Saturation

Cutoff

$V_E \geq V_B < V_C$  Cutoff  
( $V_{EB} = +ve$ ,  $V_{CB} = +ve$ )

$V_E > V_B$ ,  $V_B > V_C$   
( $V_{EB} = +ve$ ,  $V_{CB} = -ve$ )

Forward Active

Condition

$V_E > V_B > V_C$  Forward Active  
( $V_{EB} = +ve$ ,  $V_{CB} = -ve$ )

$V_E > V_B < V_C$   
( $V_{EB} = +ve$ ,  $V_{CB} = +ve$ )

$V_E < V_B > V_C$   
( $V_{EB} = -ve$ ,  $V_{CB} = -ve$ )

$V_E < V_B < V_C$   
( $V_{EB} = -ve$ ,  $V_{CB} = +ve$ )

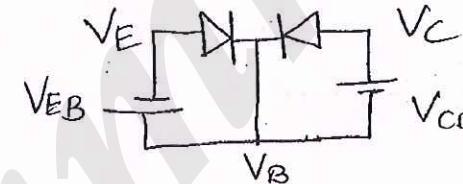
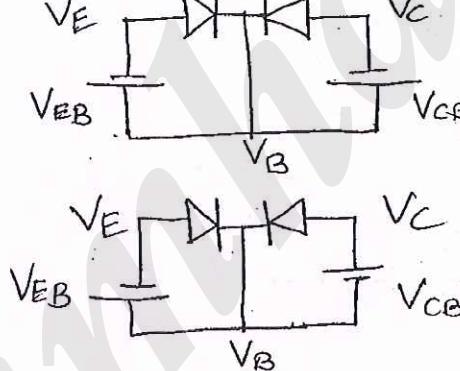
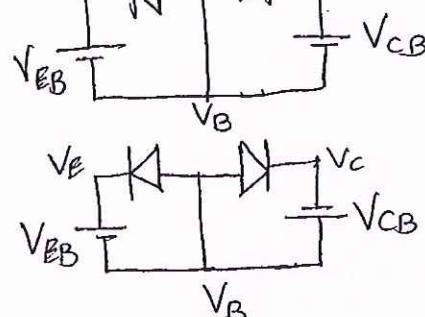
Region

Forward Active

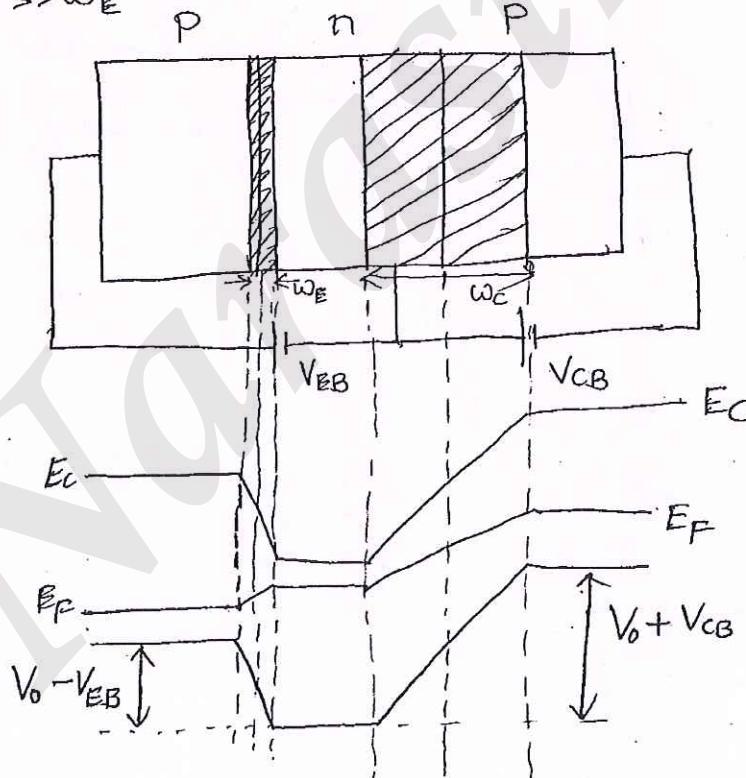
Saturation

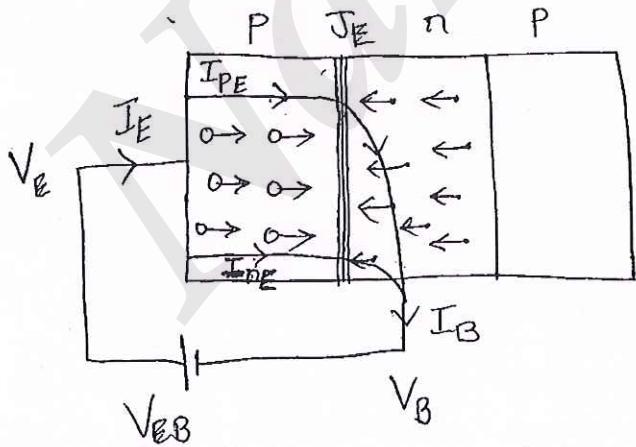
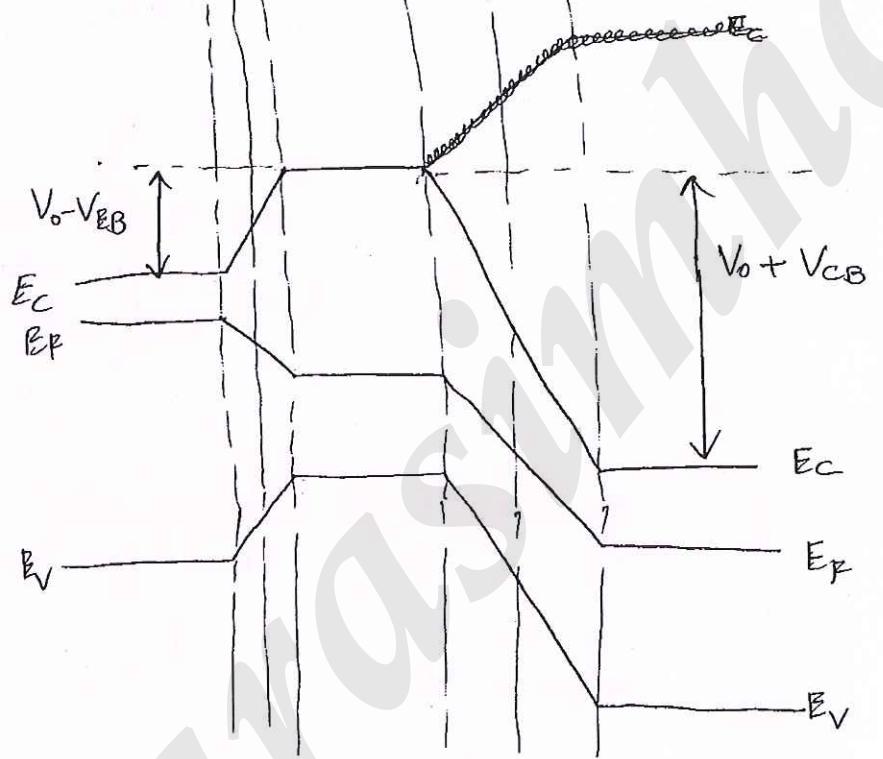
Cutoff

Forward Active

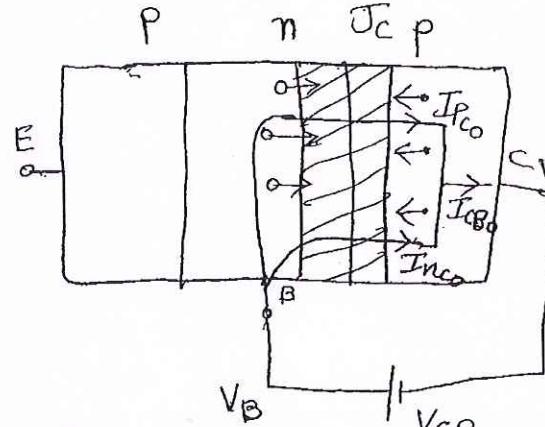
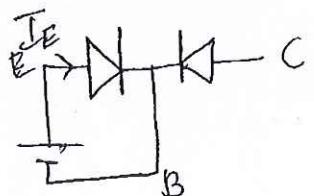


$\rightarrow \omega_c > \omega_e$

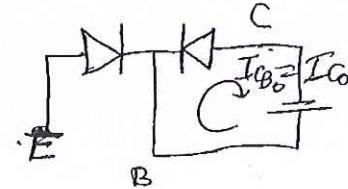


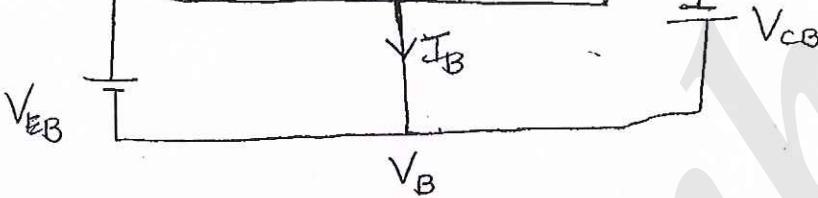


$$V_E > V_B \Rightarrow I_E = I_{PE} + I_{nE}$$



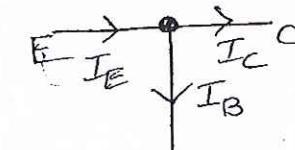
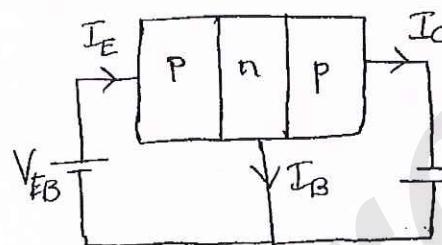
$$V_B > V_C \Rightarrow I_C = I_{Co} = I_{CB_0}$$





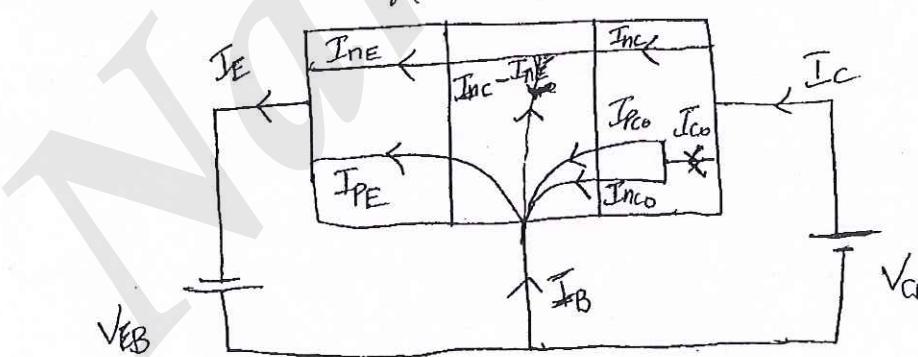
$V_C$  is more negative as compared to  $V_B$ . So holes moves to collect from Emitter.

$$I_C = I_{Pc} + I_{Co} = I_{Pc} + I_{CB0}$$



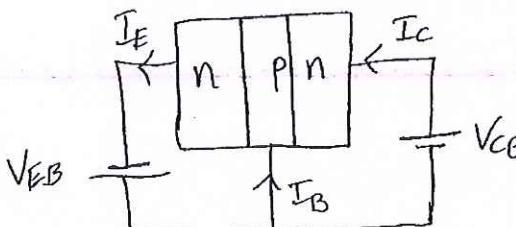
$$I_E = I_C + I_B$$

n P n

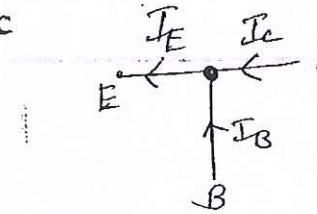


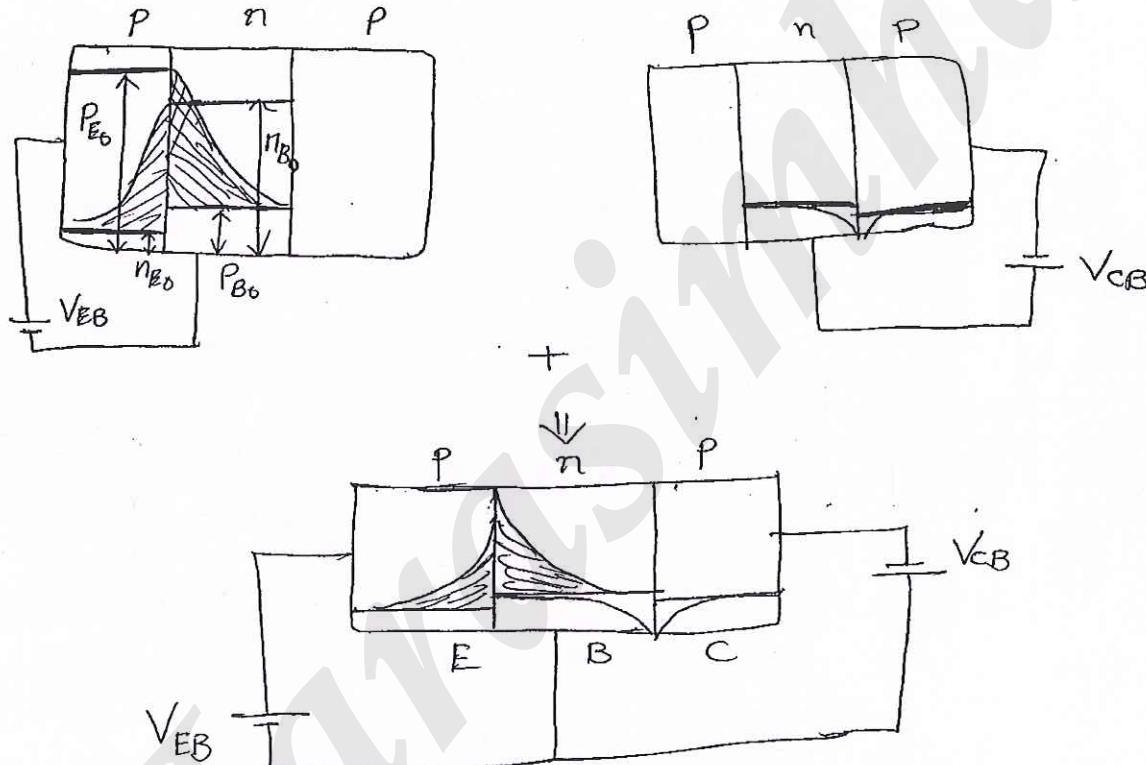
$$I_C = I_{nC} + I_{CB0}$$

$$= I_{nC} + I_{Co}$$

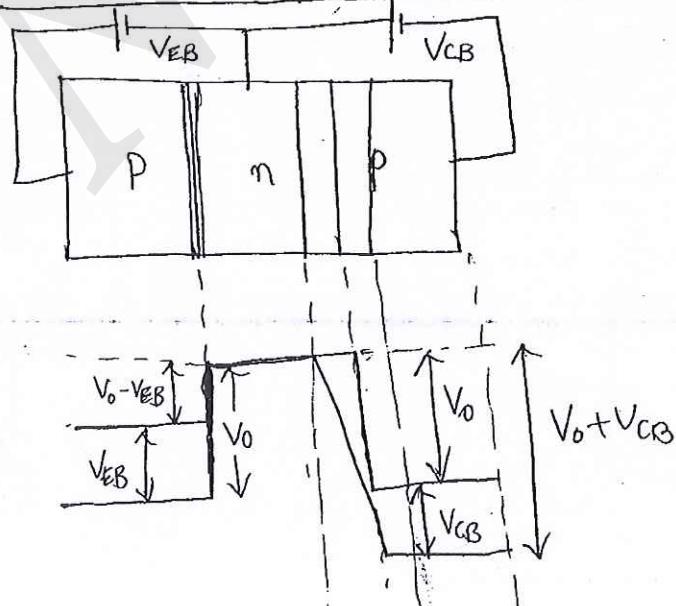


$$I_E = I_C + I_B$$





Potential Distribution for biased BJT across the junctions:



Total Emitter Current

$$= \frac{I_{PE}}{I_E} = \frac{I_{PE}}{I_{PE} + I_{NE}} \quad \gamma^* = \frac{I_{NE}}{I_{PE} + I_{NE}} \text{ for (npn)}$$

$$\gamma^* \approx \frac{I_{PE}}{I_{PE}} = 1 //$$

Base Transport Factor ( $\beta^*$ ):

It is the ratio of injected carrier current reaching at collector junction to injected carrier current at emitter junction.

$$\beta^* = \frac{\text{Injected carrier current reaching at } J_C}{\text{Injected carrier current reaching at } J_E}$$

$$= \frac{I_{PC}}{I_E} \quad \beta^* \frac{I_{PC}}{I_E} \text{ for (npn)}$$

Large Signal Current Gain ( $\alpha$ ): (0.95 to 0.998)

It is the ratio of injected carrier current reaching at collector junction to the total emitter current.

$$\alpha = \frac{\text{Injected carrier current reaching at } J_C}{\text{Total Emitter Current}}$$

$$\alpha = \frac{I_{PC}}{I_E}$$

$$\alpha = \frac{I_{NE}}{I_E} \text{ for (npn)}$$

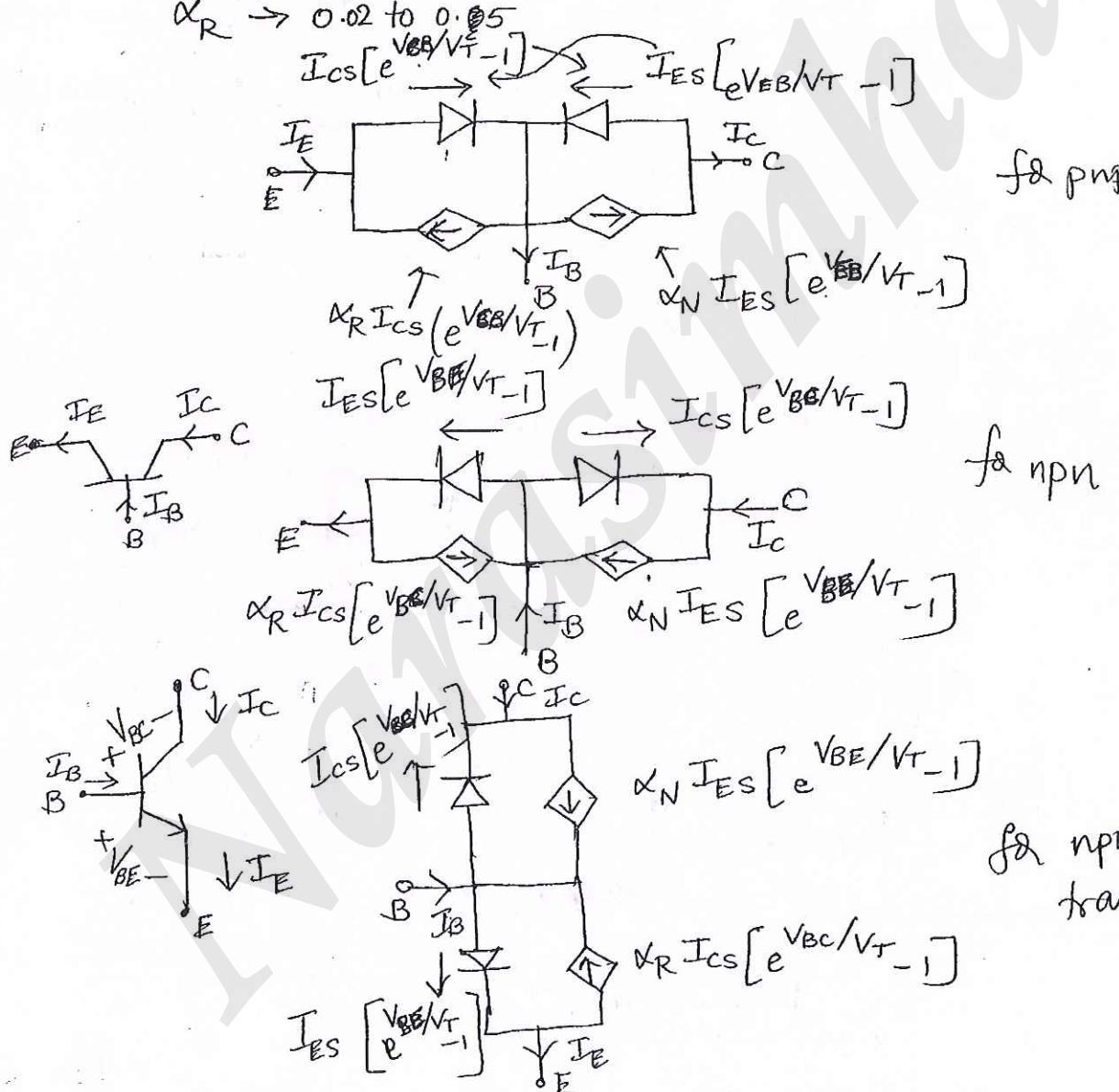
$$\Rightarrow \alpha = \frac{I_C - I_{C_0}}{I_E}$$

$$I_C = I_{PC} + I_{C_0}$$

$$\Rightarrow I_{PC} = I_C - I_{C_0}$$

$$\beta^* \gamma^* = \frac{I_{PC}}{I_{PE}} \times \frac{I_{PE}}{I_E} = \frac{I_{PC}}{I_E} = \alpha$$

$$\therefore \alpha = \beta^* \gamma^*$$



EBOR'S MOLL MODEL relates the terminal voltages in terms of junction currents where  $I_{ES}$  is the emitter junction saturation current and  $\alpha_N$  is the Normal mode current transfer ratio.

$$I_E = I_{ES} [e^{V_{BE}/V_T - 1}] + \alpha_R I_{CS} [e^{V_{BC}/V_T - 1}]$$

$$I_C = -I_{CS} [e^{V_{BC}/V_T - 1}] + \alpha_N I_{ES} [e^{V_{BE}/V_T - 1}]$$

$$I_B = I_E - I_C$$

$$= I_{ES} [e^{V_{BE}/V_T - 1}] - \alpha_R I_{CS} [e^{V_{BC}/V_T - 1}]$$

$$- \alpha_N I_{ES} [e^{V_{BE}/V_T - 1}] + I_{CS} [e^{V_{BC}/V_T - 1}]$$

$$\Rightarrow I_B = I_{ES} [e^{V_{BE}/V_T - 1}] [1 - \alpha_N] + I_{CS} [e^{V_{BC}/V_T - 1}] [1 - \alpha_R]$$

Normal Mode:  $J_E$  is FB;  $J_C$  is RB.  $\Rightarrow V_{BE}$  +ve,  $V_{BC}$  -ve

$$I_E = I_{ES} [e^{V_{BE}/V_T - 1}] - \alpha_R I_{CS} [e^{-V_{BC}/V_T - 1}]$$

$$= I_{ES} [e^{V_{BE}/V_T - 1}] - (\alpha_R I_{CS})$$

neglected  $\because \alpha_R \approx 0.02$

$$\Rightarrow I_E = I_{ES} [e^{V_{BE}/V_T - 1}]$$

$I_{CS}$  is reverse saturation current  $e^{-V_{BC}/V_T} \ll 1$

$$I_C = \alpha_N I_{ES} [e^{V_{BE}/V_T - 1}] - I_{CS} [e^{-V_{BC}/V_T - 1}]$$

$$= \alpha_N I_{ES} [e^{V_{BE}/V_T - 1}]$$

neglected

$$I_B = I_E - I_C$$

$$= I_{ES} [e^{V_{BE}/V_T - 1}] - \alpha_N I_{ES} [e^{V_{BE}/V_T - 1}]$$

$$= [I_{ES} [e^{V_{BE}/V_T - 1}]] [1 - \alpha_N]$$

$$\alpha_N = 0.98 \text{ to } 0.998$$

If  $\alpha_N = 0.99 \Rightarrow \beta_N = \frac{\alpha_N}{1-\alpha_N} = 99.$

$$\frac{I_C}{I_E} = \frac{\alpha_N I_{ES} [e^{V_{BE}/V_T - 1}]}{I_{ES} [e^{V_{BE}/V_T - 1}]} = \alpha_N$$

$$\alpha_N = \frac{I_C}{I_E}, \quad \alpha = \frac{I_C}{I_E}$$

$$\frac{I_E}{I_B} = \frac{I_{ES} [e^{V_{BE}/V_T - 1}]}{(1-\alpha_N) I_{ES} [e^{V_{BE}/V_T - 1}]} = \frac{1}{1-\alpha_N} = \gamma_N$$

$$= 1 + \beta_N$$

$$\therefore \gamma_N = \frac{1}{1-\alpha_N}$$

$$\gamma = \frac{1}{1-\alpha}$$

$$\gamma_N = 1 + \beta_N$$

$$\gamma = 1 + \beta$$

Reverse Mode:  $J_E : RB, J_C : FB \Rightarrow V_{BE} = -ve, V_{BC} = +ve$

$$I_E = I_{ES} [e^{-V_{BE}/V_T - 1}] - \alpha_R I_{CS} [e^{V_{BC}/V_T - 1}]$$

$$I_E = -\alpha_R I_{CS} [e^{V_{BC}/V_T - 1}]$$

$$I_C = \alpha_N I_{ES} [e^{-V_{BE}/V_T - 1}] - I_{CS} [e^{V_{BC}/V_T - 1}]$$

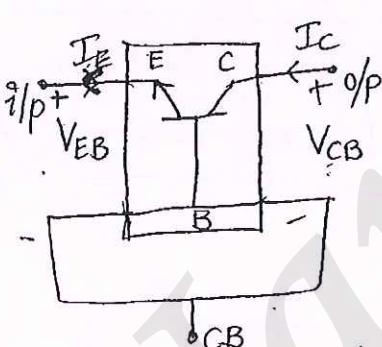
$$= -I_{CS} [e^{V_{BC}/V_T - 1}]$$

$$\beta_R = \frac{-I_E}{I_B} = \frac{\alpha_R}{1 - \alpha_R}$$

$$\alpha_R = 0.02 \text{ to } 0.5 \Rightarrow \beta_R = 0.02 \text{ to } 1$$

i.e., JF is acting as attenuator. Hence we will not use reverse mode

→ In order to take BJT as any amplifier, we need only two terminals hence we take either one terminal as common. Hence CB, CB and CC.



Common Base Configuration  
(CB)

$V_{EB}, I_c$ : dep

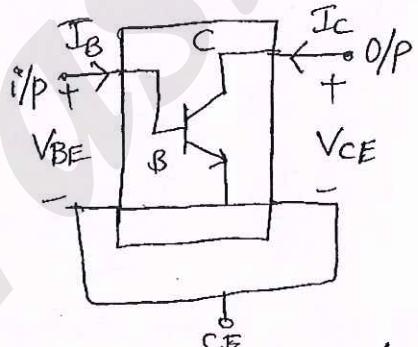
$V_{CB}, I_E$ : Indep

$$V_{BE} = Q_1(V_{EB}, I_E)$$

$$I_c : Q_2(I_E, V_{CB})$$

$$i/p \text{ char: } V_{EB} \text{ vs } I_E$$

$$o/p \text{ char: } I_c \text{ vs } V_{CB}/I_E$$



Common Emitter (CE)  
Configuration

$V_{BE}, I_c$ : dep

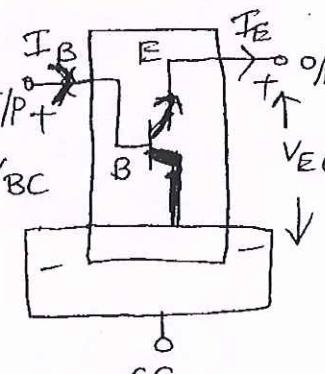
$V_{CE}, I_B$ : Ind

$$V_{BE} = Q_1(I_B, V_{CE})$$

$$V_c = Q_2(I_B, V_{CE})$$

$$i/p \text{ char: } V_{BE} \text{ vs } I_B/V_{CE}$$

$$o/p \text{ char: } I_c \text{ vs } V_{CE}/I_B$$



Common collector  
(CC) Configuration

$V_{CC}, I_E$ : dep

$V_{EC}, I_B$ : Ind

$$V_{EC} = Q_1(I_B, V_{EC})$$

$$I_E = Q_2(I_B, V_{EC})$$

$$i/p \text{ char: } V_{EC} \text{ vs } I_B/V_{EC}$$

$$o/p \text{ char: } I_E \text{ vs } V_{EC}/I_B$$

In transistor,

$V_1, I_2$  are Dependent

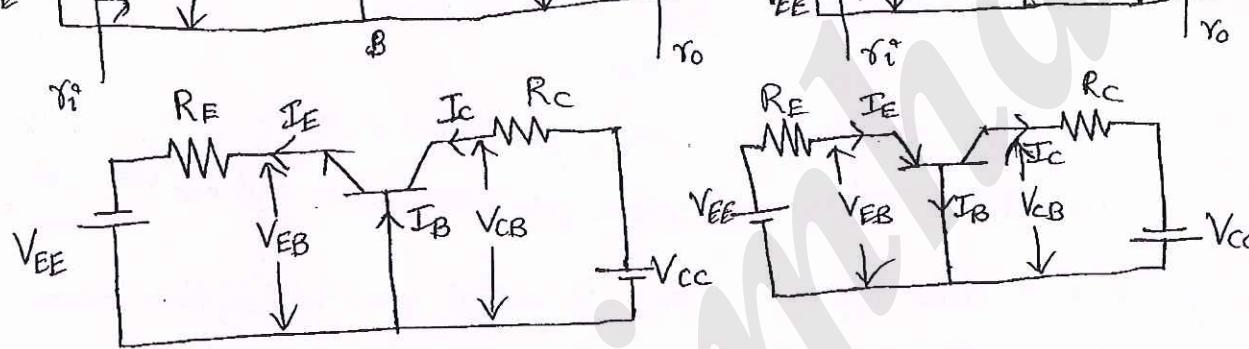
$I_1, V_2$  are Independent

$$V_1 = Q(I_1, V_2) \quad V_1 = h_{11}I_1 + h_{12}V_2$$

$$I_2 = Q(I_1, V_2) \quad I_2 = h_{21}I_1 + h_{22}V_2$$

So we use h-parameter

In BJT



$$\alpha = \frac{I_p C}{I_E}$$

$$I_C = I_{pC} + I_{CB0} = I_{pC} + I_{Co}$$

$$\Rightarrow I_{pC} = I_C - I_{Co} = I_C - I_{CB0}$$

$$I_{pC} = \alpha I_E \Rightarrow \alpha = \frac{I_{pC}}{I_E} = \frac{I_C - I_{CB0}}{I_E}$$

$\rightarrow I_{CB0}$  &  $I_{Co}$ : depends on temperature

: Increases by 7% /  $^{\circ}\text{C}$

: doubles /  $10^{\circ}\text{C}$

$I_{CB0}$  &  $I_{Co}$  is of order of nA

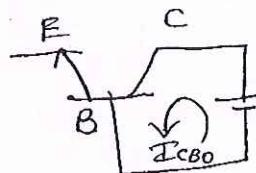
$$I_C \approx \alpha I_E$$

$\Rightarrow \alpha = \frac{I_C}{I_E}$  where ' $\alpha$ ' is the current gain in CB configuration.

$$\alpha_{dc} = \frac{I_C}{I_E}$$

$$\alpha_{ac} = \frac{\Delta i_C}{\Delta i_E}$$

$$\boxed{\alpha_{DC} = \alpha_{AC} = \alpha}$$



→ In CB configuration, as collected to base junction reverse bias voltage increases, emitter current increases due to early effect (Base width modulation effect)

Therefore the slope of the i/p characteristic curves are increasing

→ Early effect is also called Base width modulation.

### Early Effect:

Total Basewidth

$$= \text{Electrical Basewidth} + \text{Depletion Basewidth}$$

As  $V_{CB} \uparrow$ , EBW  $\downarrow$ , DBW  $\uparrow$   
and total basewidth remains constant

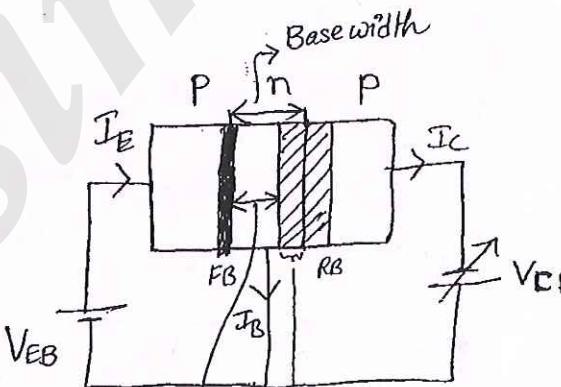
$$TBW = EBW \downarrow + DBW \uparrow$$

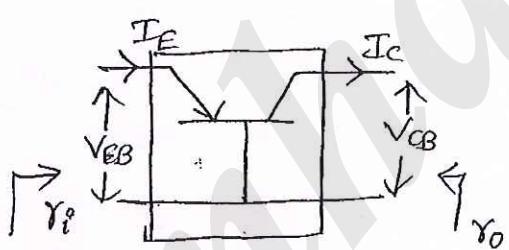
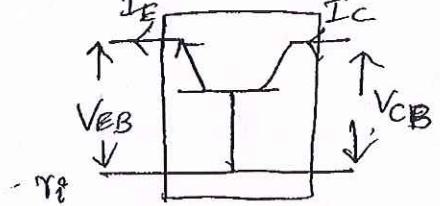
Since the base width is varying  
wrt  $V_{CB}$ , we call it as Basewidth modulation

As EBW  $\downarrow$ , more holes reach from E to C as recombination  $\downarrow$  in B.

\* As Collected to Base junction reverse bias voltage increases, the width of the collector junction depletion region increases. Due to this the electrical & physical base width decreases, i.e., as collector junction reverse bias voltage varies, the width of the base is

Varying. Therefore, it is called base width modulation or early effect.





$\gamma_i$  is the ratio of change in Emitter to Base voltage to the change in emitter current (or)  $\gamma_i$  is the reciprocal of the slope of the input characteristics.

$$\text{Slope} = \frac{\Delta I_E}{\Delta V_{EB}} \Big|_{V_{CB}}$$

$$\gamma_i = \frac{1}{\frac{\Delta I_E}{\Delta V_{EB}} \Big|_{V_{CB}}} = \frac{\Delta V_{EB}}{\Delta I_E} \Big|_{V_{CB}}$$

$$\gamma_i = \gamma_e = \frac{2V_T}{I_E}$$

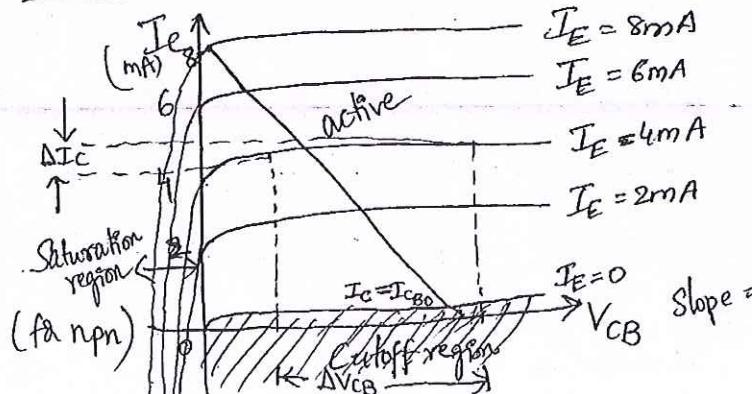
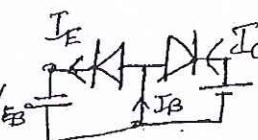
$\gamma_i \Rightarrow \text{low}$   
 $\gamma_e \approx 10\Omega$

$$\gamma_i = \gamma_e = \frac{26}{I_E}$$

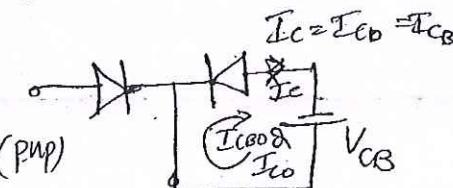
$I_E \rightarrow \text{mA}$

### Output Characteristics:

$$I_c \text{ vs } V_{CB} \Big|_{I_E}$$



$$\text{Slope} = \frac{\Delta I_C}{\Delta V_{CB}} \Big|_{I_E} \quad I_C \propto I_E \quad (I_{C0} \rightarrow \text{nA}, \alpha \approx 1)$$



- bias.
- In cutoff region, collector current  $I_c = I_{cB_0} = I_{c0}$
  - It can be used as a OFF switch in cutoff region.

### Saturation Region:

- Saturation region is the region left side to  $V_{CB} = 0$  line.
- In saturation region, emitter and collector junctions are in forward bias
- In saturation region, collector current increases exponentially.
- It can be used as ON switch in saturation region.

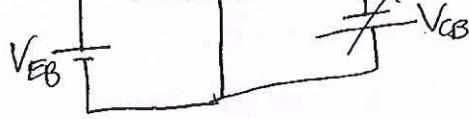
### Active Region:

- Active Region is the region between saturation and cutoff regions.
- In active region, Emitter junction is FB and collector junction is RB.
- In active region,  $I_c = \alpha I_E + I_{cB_0}$  (This equation is applicable only in active region).
- It can be used as an amplifier in the active region.

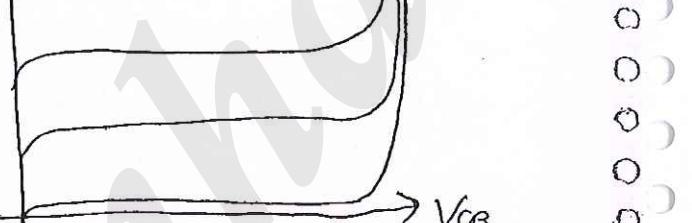
### Output Resistance:

It is the ratio of change in collector to base voltage to the change in collector current (a) if it is the reciprocal of the slope of the output characteristics.

$$r_o = \frac{1}{\Delta I_c / \Delta V_{CB}} \Big|_{I_E} = \frac{\Delta V_{CB}}{\Delta I_c} \Big|_{I_E}$$



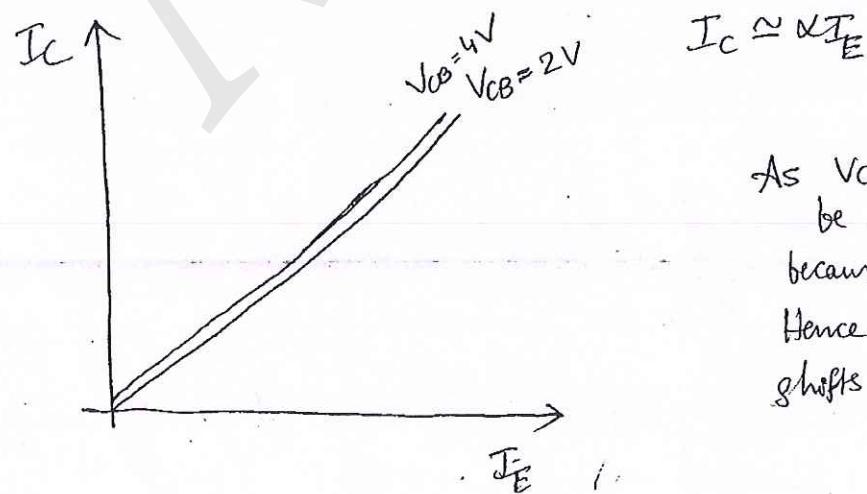
(As  $V_{CB}$  is increased, at a particular value of  $V_{CB}$ , the base width disappears)



- As collector to base junction reverse bias voltage increases, the width of the collector junction depletion region increases.
- At a particular value of  $V_{CB}$ , this collector junction depletion region penetrates through emitter junction. It is called Punchthrough effect.
- Punch through is also called Reachthrough effect.

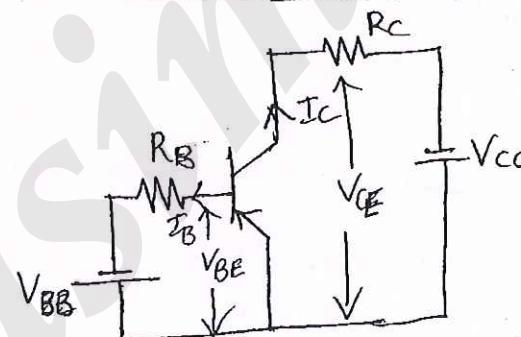
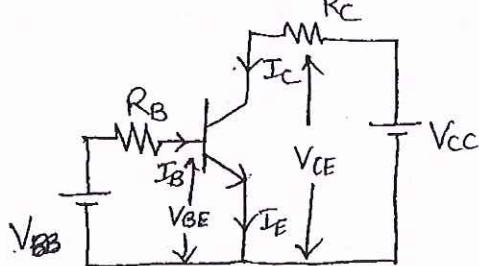
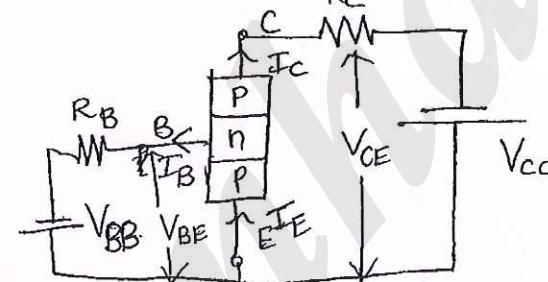
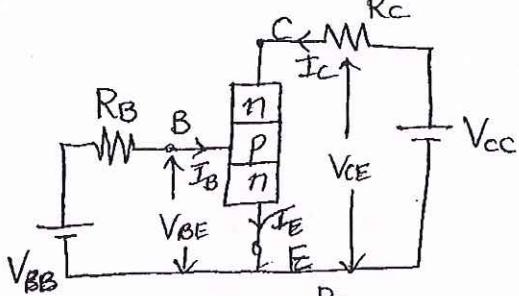
### Transfer Characteristics:

BJT is a current controlled current source. Hence transfer characteristics are plotted b/w  $I_C$  vs  $I_E$ .



As  $V_{CB} \uparrow$ , small slope will be there in o/p characteristics because of small  $\uparrow$  in  $I_C$ .

Hence As  $V_{CB} \uparrow$ , the graph shifts left in Transfer characteristics.



$$\alpha = \frac{I_{pc}}{I_E} = \frac{I_c - I_{c0}}{I_E} = \frac{I_c - I_{c0}}{I_E}$$

$$I_c = \alpha I_E + I_{c0} = \alpha I_E + I_{c0}$$

$$I_E = I_c + I_B$$

$\beta: 50 \text{ to } 500$

$$I_c = \alpha(I_c + I_B) + I_{c0}$$

$$\Rightarrow \frac{I_c[1-\alpha]}{\alpha} - I_{c0} = I_B.$$

$$\Rightarrow I_B = \frac{1-\alpha}{\alpha} I_c - \frac{1}{\alpha} I_{c0}$$

$$I_c = \frac{\alpha}{1-\alpha} I_B + \frac{1}{1-\alpha} I_{c0}$$

$$\boxed{I_c = \beta I_B + (1+\beta) I_{c0}}$$

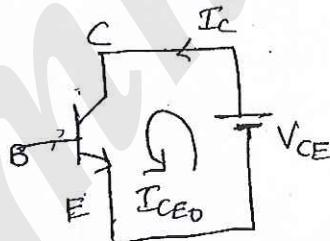
$$\beta = \frac{\alpha}{1-\alpha}; \quad \alpha = \frac{\beta}{1+\beta}$$

$I_{CEO} \rightarrow I_{BO}$

Hence biasing is needed in CE configuration to protect transistor from thermal runaway.

$$I_C \approx \beta I_B$$

$$\Rightarrow \beta = \frac{I_C}{I_B}$$



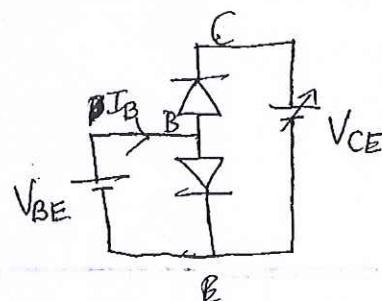
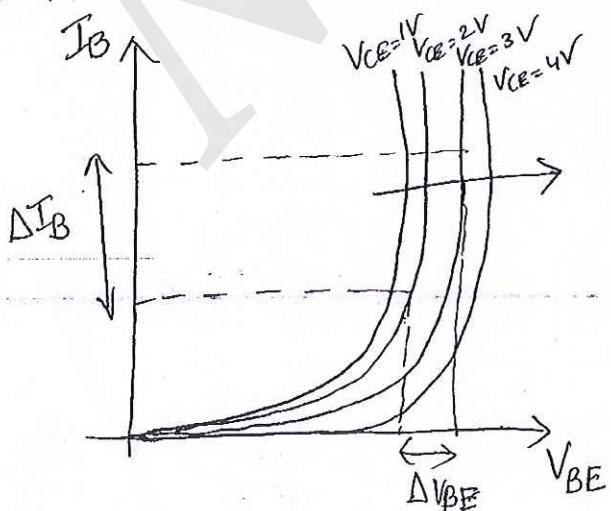
B: Current gain in CE configuration

$$\beta_{dc} = \frac{I_C}{I_B}$$

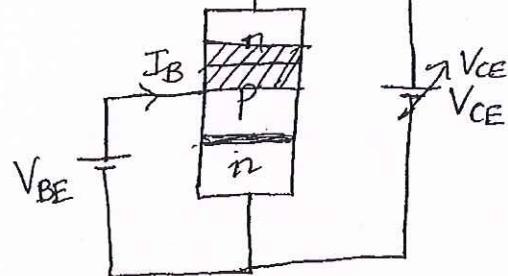
$$\beta_{ac} = \frac{\Delta i_C}{\Delta i_B}$$

$$\boxed{\beta_{dc} = \beta_{ac} = \beta}$$

Input Characteristics:  $I_B$  vs  $V_{BE}$  |  $V_{CE}$



$$\text{Slope} = \frac{\Delta I_B}{\Delta V_{BE}}$$



### Input Resistance (\$r\_i\$):

It is the ratio of change in base to emitter voltage to the change in base current or It is the reciprocal of the slope of the input characteristics.

$$r_i = \frac{1}{\left. \frac{\Delta I_B}{\Delta V_{BE}} \right|_{V_{CE}}} = \left. \frac{\Delta V_{BE}}{\Delta I_B} \right|_{V_{CE}}$$

$$r_i < \text{medium } \approx 1\text{ k}\Omega$$

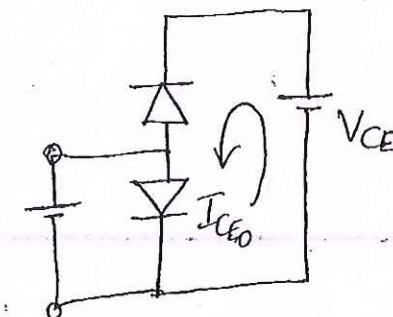
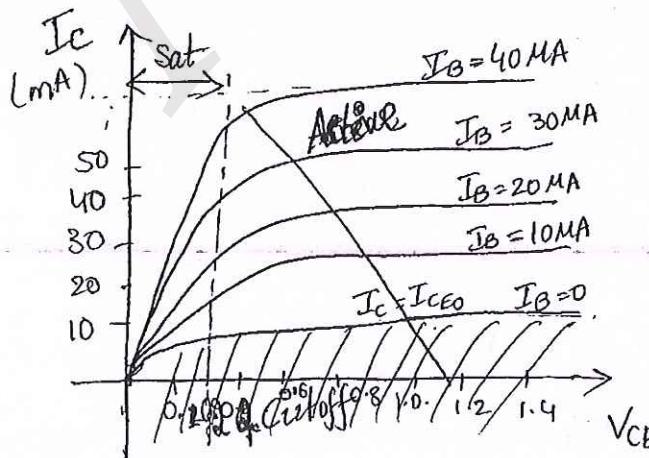
In a BJT

$$I_B \rightarrow \text{mA}$$

$$I_C, I_E \rightarrow \text{mA}$$

$$I_{CBO}, I_{CEO} \rightarrow \text{nA}$$

### Output Characteristics: \$I\_C\$ vs \$V\_{CE}\$ | \$I\_B\$



$$I_{CEO} = (1 + \beta) I_{CBO}$$

$$I_C = \beta I_B + I_{CEO}$$

→ It can be used as a OFF switch in cutoff region

### Saturation Region:

- Saturation region is the region left side to  $V_{CE} = 0.2V$
- In saturation region, emitter junction and collector junction are in forward bias.
- In saturation region,  $I_C$  increases exponentially
- In saturation region,  $V_{CE} \leq V_{CE(\text{sat})}$
- It can be used as a ON switch in saturation region

$$V_{CE} = 0.2V \text{ for Si transistor}$$

$\approx 0.3V$

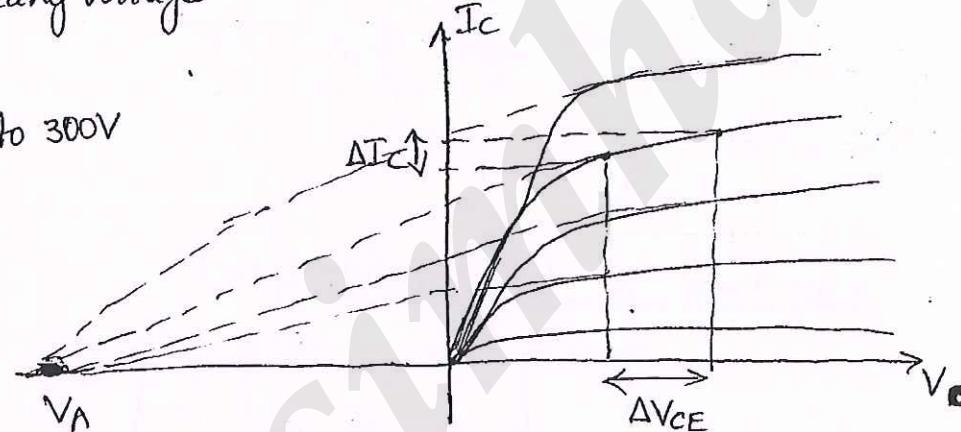
$$V_{CE} = 0.1V \text{ for Ge transistor}$$

### Active Region:

- Active region is the region between saturation and cutoff regions.
- In active region, emitter junction is FB and collector junction is RB.
- Collector Current in active region,  $I_C = \beta I_B + (1+\beta)I_{CBO}$   
$$I_C = \beta I_B + I_{CEO}$$
- In active region,  $V_{CE} > V_{CE(\text{sat})}$  and  $V_{CE} < \frac{V_{CC}}{2}$   
$$\therefore V_{CE(\text{sat})} < V_{CE} < \frac{V_{CC}}{2}$$
- It can be used as an amplifier in the active region.

$V_A$  : Early Voltage

$V_A$  : 100 to 300V



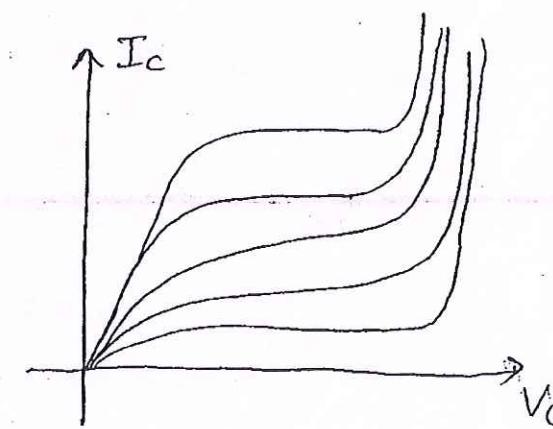
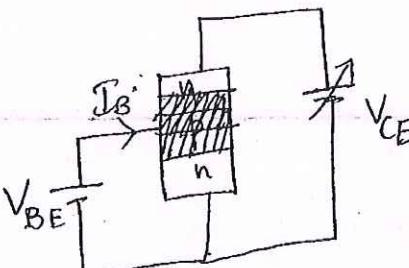
### Output Resistance:

It is the ratio of change in Collector to Emitter voltage to the change in collector current (as It is the reciprocal of the slope of the output characteristics)

$r_o > \text{Medium} \approx 10\text{ k}\Omega$

$$r_o = \left. \frac{1}{\frac{\Delta I_c}{\Delta V_{CE}}} \right|_{I_B} = \left. \frac{\Delta V_{CE}}{\Delta I_c} \right|_{I_B}$$

### Punchthrough:

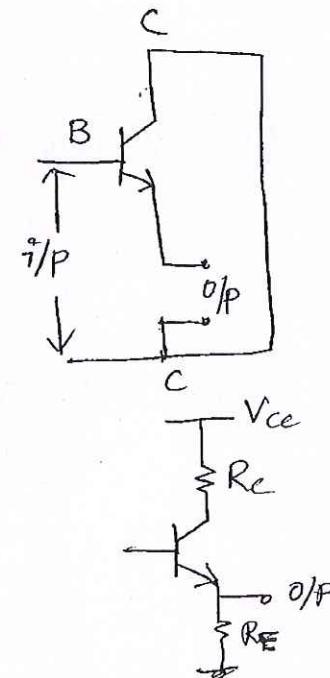
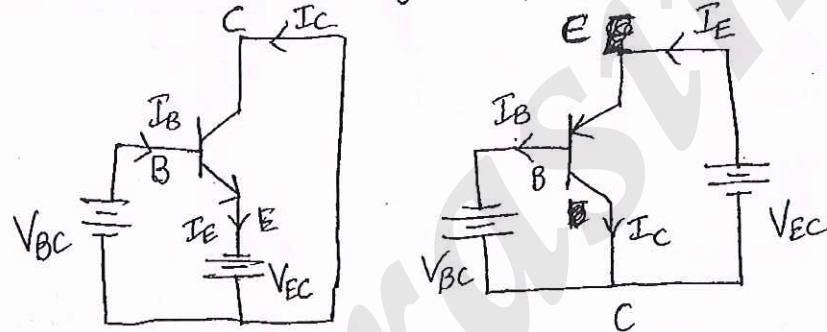


	$r_i$	$r_o$	$A_I$	$A_v$	$A_p$
CE	< Medium	> Medium		High	High

Applications:

→ AF amplifier

### Common Collector Configuration: (CC)



$$\alpha = \frac{I_{pc}}{I_E} = \frac{I_c - I_{CB_0}}{I_E} = \frac{I_c - I_{C_0}}{I_E}$$

$$I_c = \alpha I_E + I_{CB_0} = \alpha I_E + I_{C_0}$$

$$I_E = I_c + I_B \Rightarrow I_c = I_E - I_B$$

$$I_E - I_B = \alpha I_E + I_{CB_0}$$

$$(1-\alpha)I_E = I_B + I_{CB_0}$$

$$\Rightarrow I_E = \frac{1}{1-\alpha} I_B + \frac{1}{1-\alpha} I_{CB_0}$$

$$* \boxed{I_E = (1+\beta) I_B + (1+\beta) I_{CB_0}}$$

$$* \boxed{I_E = \gamma I_B + \gamma I_{CB_0}}$$

$$\frac{\text{Base}}{\text{Emiss.}} = \frac{1}{1-\alpha}$$

$$\boxed{r = 1+\beta = \frac{1}{1-\alpha}}$$

$$r_{ac} = r_{dc} = r$$

$$\alpha \cdot r = \frac{I_c}{I_E} \cdot \frac{I_E}{I_B} = \frac{I_c}{I_B} = \beta$$

$$\therefore \alpha r = \beta$$

$\beta = \alpha r$  Also  $\alpha = \beta^* r^*$   
 ↓↓ Current gains.      ↓↓ transport factors & emitter efficiency

### Input Characteristics:

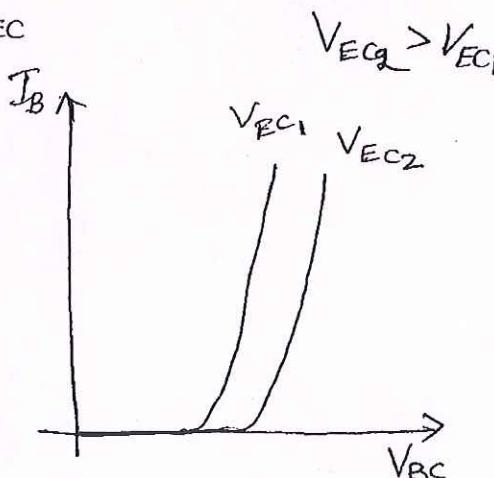
Input resistance ( $r_i$ )

$$r_i = \frac{\Delta V_{BC}}{\Delta I_B}$$

$r_i = \text{High}$

$$r_i \approx 100k\Omega$$

$$I_B \text{ vs } V_{BC} \Big| V_{EC}$$



### Output Characteristics:

$$I_E \text{ vs } V_{EC} \Big| I_B$$

$$I_C \approx I_E$$

$$V_{CE} = -V_{EC}$$

Similar to CE o/p characteristics

but are present in 2nd Quadrant

$$\Delta I_E / I_B$$

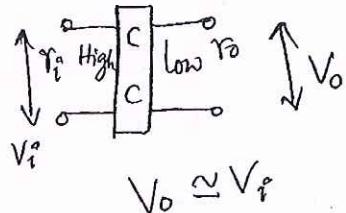
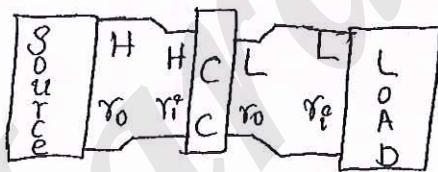
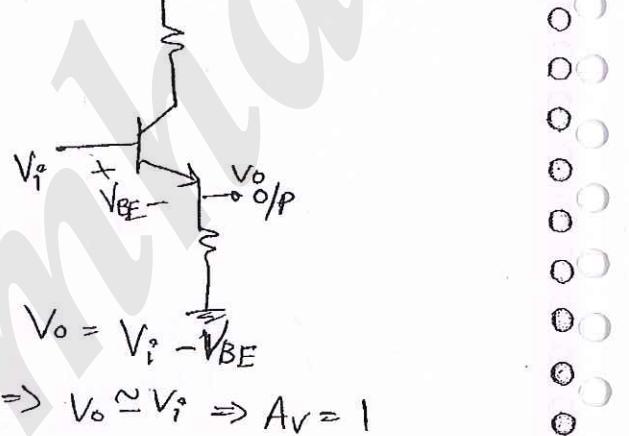
$r_o : \text{Low}$

$r_o \approx 10\Omega$

	$r_i$	$r_o$	$A_I$	$A_v$	$A_p$
CC:	High	Low	High	$\approx 1$	Low

### Applications:

→ Buffer.



	$A_I$	$A_v$
CB	$\approx 1$	High
CE	High	High
CC	High	$\approx 1$

### Voltage Gain ( $A_v$ ):

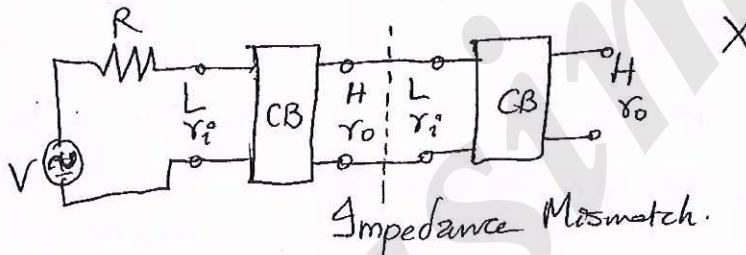
$$A_{vCC} \approx 1$$

$$A_{vCB} > A_{vCE}$$

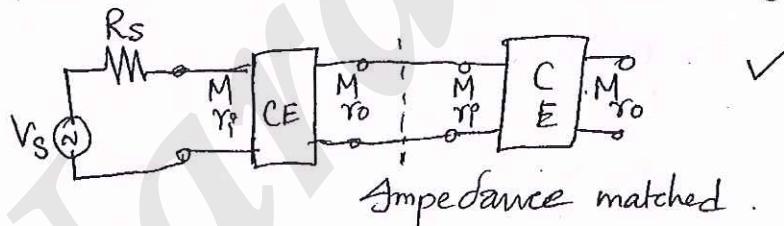
$$A_{vCB} > A_{vCE} > A_{vCC}$$

$$A_{vCC} < A_{vCE} < A_{vCB}$$

→ For high voltage gain, CB configuration can be taken as cascaded.   
 $A_{V_{CB}}$  is high. But it is not preferred because there is impedance mismatch between two CB stages.



In place of CB, we can take cascading of CE configuration.



Why CE?

→ CE configuration has voltage as well as current gains. Therefore its power gain is high.

→ It has medium input and output impedances.

Therefore we prefer CE configurations than other configurations.

Typical npn transistor junction voltages at room temperature:

$$V_{CE(\text{sat})} = 0.3V \text{ & } 0.2V \text{ for Si} \\ = 0.1V \text{ for Ge}$$

$$V_{BE(\text{active})} = 0.7V \text{ for Si} \\ = 0.2V \text{ for Ge}$$

$$V_{BE(\text{sat})} = 0.8V \text{ or } 0.7V \text{ for Si} \\ = 0.3V \text{ for Ge}$$

\* Change the polarities for pnp transistor.

$\rightarrow V_{BE}$  depends on temperature

$$\frac{dV_{BE}}{dT} = -2.5 \text{ mV/}^{\circ}\text{C}$$

$$\frac{V_{BE_2} - V_{BE_1}}{T_2 - T_1} = -2.5 \text{ mV/}^{\circ}\text{C}$$

$$V_{BE_2} - V_{BE_1} = -2.5(T_2 - T_1) \text{ mV/}^{\circ}\text{C}$$

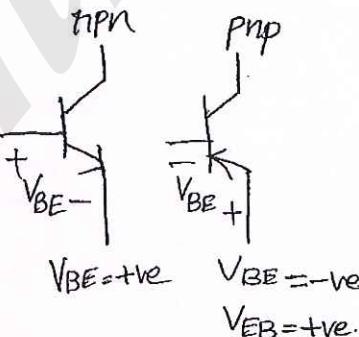
$$V_{BE_2} = V_{BE_1} - (T_2 - T_1) 2.5 \text{ mV/}^{\circ}\text{C}$$

Q) If  $I_E$  is doubled; then what is  $V_{BE}$ .

$$I_{E_1} = I_S e^{\frac{V_{BE_1}}{V_T}}$$

Ans is increases by 20mV

$$2I_{E_1} = I_S e^{\frac{V_{BE_2}}{V_T}}$$



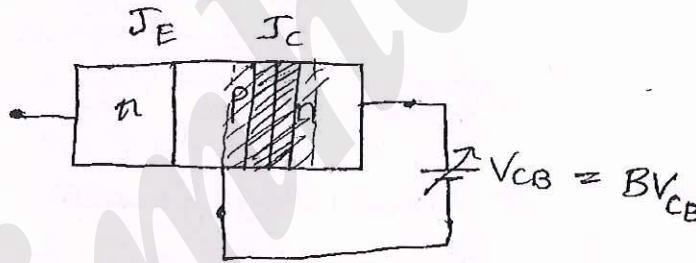
Voltage breakdown

(CB Configuration)

$BV_{CBO} \Rightarrow$  Breakdown

Voltage in

CB configuration when the  
emitter is open.



(d) Collector to Base voltage when  
emitter is open. (CBO)

Multiplication factor (M):

It is a cumulative  
breakdown.

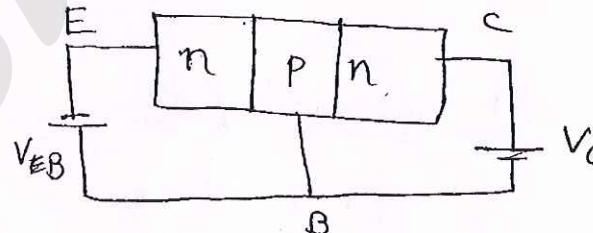
$$M = \frac{1}{1 - \left(\frac{V_{CB}}{BV_{CBO}}\right)^n}$$

$n$ : 2 to 10 and depends on type of semiconductor

(CE Configuration)

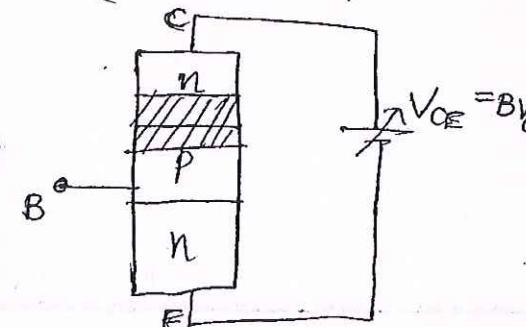
$BV_{CEO} \Rightarrow$  Collector to Emitter voltage  
when Base is Open

(d) Breakdown voltage in CE configuration  
when the Base is open.

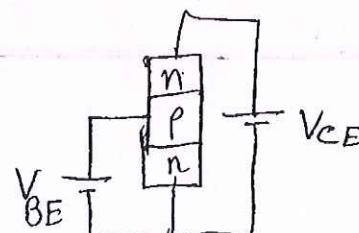


(CB configuration)

(CE configuration)



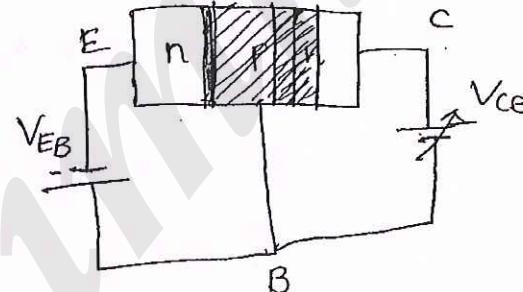
$$M = \frac{1}{1 - \left(\frac{V_{CE}}{BV_{CEO}}\right)^n}$$



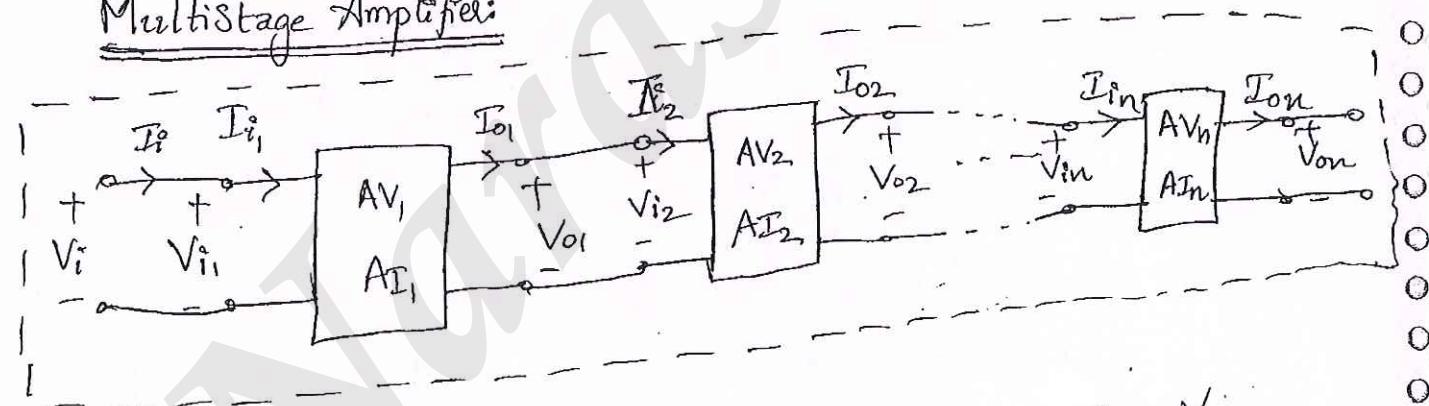
$$BV_{CBO} > BV_{CEO}$$

Punchthrough:

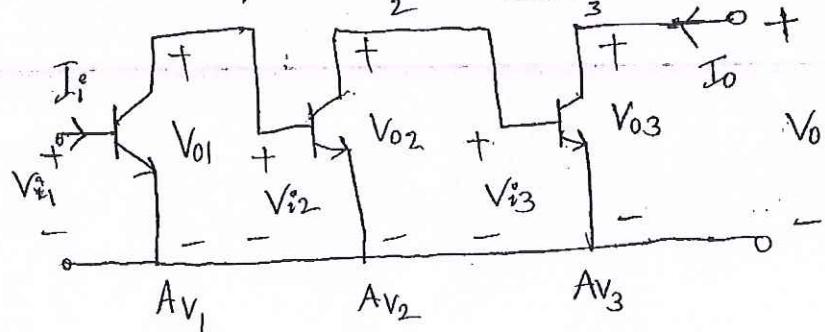
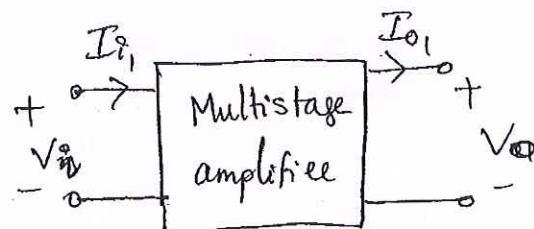
The Base-Collector junction penetrates through the Emitter-Base junction.



Multistage Amplifier:



$$AV = \frac{V_o}{V_i}$$



$$A_V = \frac{V_o}{V_i} = A_{V_1} \cdot A_{V_2} \cdot A_{V_3} \cdot \dots \cdot A_{V_n}$$

Q) For the circuit shown in the figure, FET has a transconductance of 5mA/volts and BJT has a common base current gain of 0.8. Calculate overall transconductance of the composite amplifier.

$$g_m = \frac{I_o}{V_i} = \frac{I_o}{I_{o2}} \cdot \frac{I_{o2}}{I_{i2}} \cdot \frac{I_{i2}}{I_{o1}} \cdot \frac{I_{o1}}{V_i}$$

small  $i_e \approx 1$   
in fact  $\beta \approx 1$

$5 \text{ mA/V}$        $0.8$

$$\frac{I_{o1}}{V_i} \cdot \frac{V_{i2}}{V_i} = 0.8 \times 5 = 4 \text{ mA/V}$$

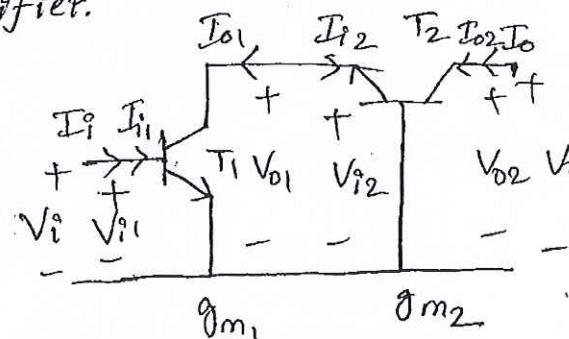
Q) For the circuit shown in the figure, transistors T<sub>1</sub> and T<sub>2</sub> are having transconductances of g<sub>m1</sub> and g<sub>m2</sub>. Calculate the overall transconductance of the amplifier.

$$g_m = \frac{I_o}{V_i} = \frac{I_o}{I_{o2}} \cdot \frac{I_{o2}}{I_{i2}} \cdot \frac{I_{i2}}{I_{o1}} \cdot \frac{I_{o1}}{V_i}$$

$\beta \approx 1$

$$\cdot \frac{I_{o1}}{V_{i1}} \cdot \frac{V_{i2}}{V_i}$$

$g_{m1}$



- a) g<sub>m1</sub>, g<sub>m2</sub>
- b) g<sub>m1</sub> // g<sub>m2</sub>
- c) g<sub>m1</sub>
- d) g<sub>m2</sub>

$$g_m = g_{m1}$$

$$V_1^+ - V_{02} \approx V_2^- - V_{01} = -\frac{V_{01} + V_{02}}{2}$$

$$\frac{V_{01}}{V_{01} - V_i^+} \cdot \frac{V_{01}}{V_i^-} = g_{m2}.$$

(cc) 1 1

$$\text{If } g_{m1} = g_{m2} = g_m \text{ then } g_m = \frac{g_m}{2}$$

Q) In a certain npn transistor,  $10^8$  holes/ $\mu\text{sec}$  moved from Base to emitter and  $10^{10}$  e $^-$ / $\mu\text{sec}$  moved from emitter to base. An ammeter reading gives the base current of 16 mA, calculate emitter and collector currents.

$$I_B = 16 \text{ mA}$$

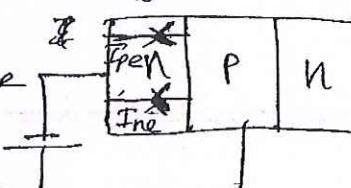
$$\alpha \times \frac{I_{pc}}{I_B} = \frac{10^8}{10^8 + 10^{10}} = \frac{1}{1 + 10^2} = 9.9 \times 10^{-3}.$$

$$\beta = \frac{\alpha}{1-\alpha} = \frac{1}{1-9.9 \times 10^{-3}} = 10.8 \times 10^3.$$

$$I_C = \beta I_B$$

$$= 10.8 \times 10^3 \times 10^{-6} = 1.08 \times 10^{-2} \text{ A}$$

$$I_E = I_{pe} + I_{ne}$$



$$I_E = \frac{Q_p}{T} + \frac{Q_n}{T} = \frac{P.a}{T} + \frac{N.a}{T}$$

$$= \frac{10^8 \text{ holes}/\mu\text{s} \times 1.6 \times 10^{-19}}{10^{-6}} + \frac{10^{10} \text{ holes}/\mu\text{s} \times 1.6 \times 10^{-19}}{10^{-6}}$$

$$\Rightarrow 10^8 \text{ holes}/\mu\text{s} \times 1.6 \times 10^{-19} + 10^{10} \text{ holes}/\mu\text{s} \times 1.6 \times 10^{-19}$$

$$I_B = 16 \text{ mA}$$

$$= 0.016 \text{ mA}$$

$$I_E = I_B + I_C \Rightarrow I_C = I_E - I_B$$

$$\Rightarrow I_C = 1.616 - 0.016$$

$$= 1.6 \text{ mA}$$

$\therefore I_B = 0.016 \text{ mA}$

$I_C = 1.6 \text{ mA}$

- Q) In a certain transistor, emitter current is 1.02 times as large as that of collector current. If the emitter current is 12mA, Find its base current

$$I_E = 1.02 I_C$$

$$\Rightarrow \frac{12 \text{ m}}{1.02} = I_C \Rightarrow I_C = 11.764 \text{ mA}$$

$$I_E = I_B + I_C \Rightarrow I_B = 12 \text{ m} - 11.764 \text{ m}$$

$$= 0.235 \text{ mA}$$

- Q) For the above problem, calculate  $\alpha, \beta, \gamma$ .

$$I_C > \beta I_B \quad I_C = \alpha I_E \quad \gamma = \frac{I_E}{I_B}$$

(a)

$$\beta = \frac{I_C}{I_B} = 50.06 \Rightarrow \alpha = \frac{I_C}{I_E} = \frac{11.764}{12} = 0.98$$

$$\beta = \frac{\alpha}{1-\alpha}, \gamma = \frac{1}{1-\alpha} = \frac{1}{1-0.98} = 49.05$$

$$I_C = \beta I_B + I_{CBO} (1 + P) \\ = 99(25\mu) + (200 \times 10^{-9})(100) \\ = 2.475 \text{ mA}$$

$$I_E = I_B + I_C = 2.5 \text{ mA} = 2.50 \text{ mA}$$

Neglecting the leakage current,

$$I'_E = I_B + I_C = 2.5 \text{ mA}$$

$$\% \text{ Percentage Error in } I_E = \frac{I_E - I'_E}{I_E} \times 100 \\ = \frac{2.52 - 2.5}{2.52} \times 100 \\ = 0.79\%$$

Q) The DC current gain ( $\beta$ ) of a BJT is 50. Assuming that the emitter injection efficiency is 0.995. Then the base transport factor is.

$$\gamma^* = 0.995$$

$$\beta = 50$$

$$\Rightarrow \alpha = \frac{\beta}{1+\beta} = \frac{50}{51} = 0.98 \quad \alpha = \frac{\beta^* \gamma^*}{\beta^* + \gamma^*} = 0.985$$

$$\frac{I_{E_2}}{I_{E_1}} = 2 \Rightarrow \frac{I_2}{I_1} = e^{\frac{V_{BE_2}/V_T}{V_{BE_1}/V_T}}$$

$$\Rightarrow I_2 = e^{(\frac{V_{BE_2} - V_{BE_1}}{V_T})}$$

$$\Rightarrow (\ln 2) = \frac{V_{BE_2} - V_{BE_1}}{V_T}$$

$$\Rightarrow V_{BE_2} - V_{BE_1} = 26m(\ln 2)$$

$$= 18.018mV \approx 20mV$$

$\approx$  increases by  $20mV$

$$\boxed{\Delta V_{BE} = V_{BE_2} - V_{BE_1} = V_T \ln \left( \frac{I_{E_2}}{I_{E_1}} \right)}$$

- Q)  $\rightarrow$  The base to emitter voltage  $V_{BE}$  of a Si BJT has a temperature coefficient of approximately  $-2.2mV/\text{ }^\circ\text{C}$ . If the transistor's  $V_{BE}$  is  $0.7V$  at  $25^\circ\text{C}$ , calculate its value at  $50^\circ\text{C}$

$$V_{B2} - V_{B1} = -2.2(T_2 - T_1) \quad \frac{dV_B}{dT} = -2.2mV/\text{ }^\circ\text{C}$$

$$V_{B2} = 0.7 - ((2.2)(50)) \times 10^{-3}$$

$$\Rightarrow V_{B2} = 0.7 - 0.22 = 0.478V$$

$$\therefore V_{B2} = 0.7 - 0.0077 = 0.6923V$$

$$I_C = \beta I_B + (1+\beta) I_{C0}$$

$$= 49(20\mu) + (50)(0.6\mu)$$

$$= 1.01 \times 10^{-3}$$

$$= 1.01 \text{ mA}$$

Q) The reverse saturation current of the collector base junction of a BJT is found to be 10nA at lower collector voltages. The low voltage current amplification factor ( $\alpha$ ) is 0.98. Find reverse saturation current with base open.

$$\alpha = 0.98 \Rightarrow \beta = \frac{\alpha}{1-\alpha} = 49$$

$$I_{CB0} = 10 \text{nA}$$

$$I_{CEO} = (1+\beta) I_{CB0}$$

$$= 50 \times 10 \text{nA}$$

$$= 500 \text{nA}$$

$$= 0.5 \text{ mA}$$

Q) A transistor has a current gain of 0.99 in CB mode.

Its current gain in CC mode is

$$\alpha = 0.99$$

$$\gamma = \frac{1}{1-\alpha} = \frac{1}{0.01} = 100$$

$$\alpha = 0.99$$

$$\beta = \frac{\alpha}{1-\alpha} = \frac{0.99}{1-0.99} = 99$$

Q) A BJT is in saturation region given  $V_{CC} = 10V$ ,

$R_C = 1k\Omega$ ,  $h_{FE} = 100$  and  $V_{CE(sat)} = 0.3V$ . What is the collector current in saturation?

$$\beta = 1 + h_{FE}$$
$$I_C = \frac{V_{CC} - V_{CE(sat)}}{R_C} = \frac{10 - 0.3}{1k} = 9.7mA$$

Q) The reverse leakage current of the transistor when connected in CB configuration is 0.1mA. While it is 16mA, when the same transistor is connected in CE configuration. Calculate  $\alpha, \beta, \gamma$

$$I_{CB0} = 0.1mA$$

$$I_{CE0} = 16mA$$

$$I_{CE0} = (\beta + 1) I_{CB0}$$

$$\Rightarrow \beta = \frac{I_{CE0}}{I_{CB0}} - 1$$

$$\Rightarrow \beta = 159$$

$$\beta \cdot \alpha = \frac{\beta}{1+\beta}$$
$$= \frac{159}{160} = 0.99$$

$$\gamma = \frac{\beta}{\beta + 1}$$

$$\Rightarrow \gamma = 160$$

Q) For the circuit shown in the figure, find the region of operation

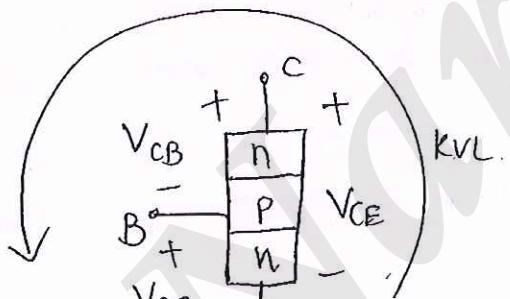
$$V_{BE} = 2V$$

$$V_{CC} = \frac{R_B}{R_B + 100K} \cdot 10V = 2 + 100K I_B + 100$$

$$I_B = \frac{+1}{100K} = +0.01mA \Rightarrow V_{CE} = I_C R_E = \beta I_B = 100 \times 0.01mA = 1mA$$

$V_{CE} = 0 \Rightarrow V_{CE} < 0.2 \Rightarrow$  Saturation Region

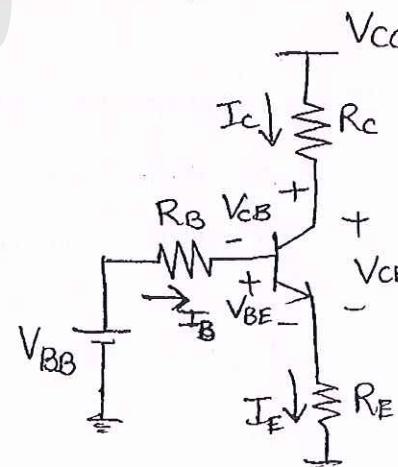
### Regions of Operation:



$$-V_{CE} + V_{CB} + V_{BE} = 0$$

$$\Rightarrow V_{CE} = V_{CB} + V_{BE}$$

$$V_{CB} = V_{CE} - V_{BE}$$



## Cutoff Region:

→ If  $I_E = 0$

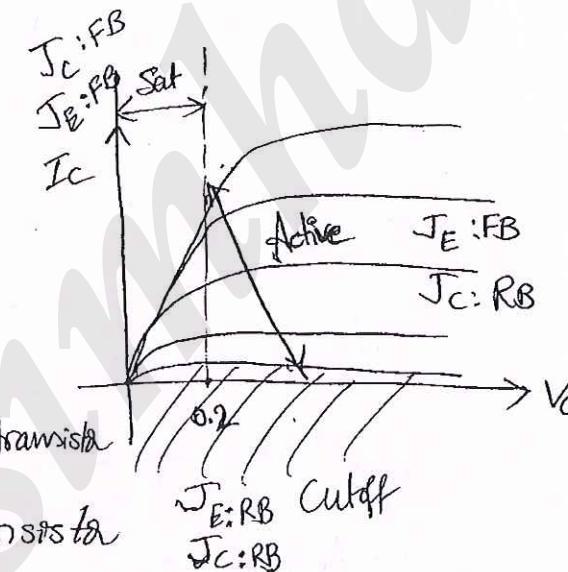
→ If  $I_B = 0$

→ If  $V_{BE} \leq 0$  for Si Transistor

$V_{BE} \leq -0.1$  for Ge Transistor

→ If  $V_{BB}$  is negative for n-p-n transistor

→ If  $V_{BB}$  is +ve for p-n-p transistor



## Saturation Region:

(Current Method)

→ If  $I_B \geq \frac{I_{ccsat}}{h_{fe}}$  &  $I_B \geq \frac{I_{ccsat}}{h_{fe}}$

KVL at S/P side  $\Rightarrow -V_{BB} + I_B R_B + V_{BE} + I_E R_E = 0$

$$\Rightarrow V_{BB} - V_{BE} = I_B R_B + I_E R_E$$

$$\Rightarrow I_B R_B + (I_C + I_B) R_E = V_{BB} - V_{BE}$$

$$\Rightarrow I_B (R_B + R_E) + I_C R_E = V_{BB} - V_{BE}$$

$$I_C = h_{fe} I_B \Rightarrow I_B (R_B + R_E + h_{fe} R_E) = V_{BB} - V_{BE}$$

$$\Rightarrow I_B = \frac{V_{BB} - V_{BE}}{R_B + (1+h_{fe}) R_E}$$

$$\Rightarrow I_C = \frac{V_{CC} - V_{CE}}{(R_C + R_E + \frac{R_E}{h_{FE}})}$$

$$\Rightarrow I_C = \frac{V_{CC} - V_{CE}}{R_C + R_E + \frac{R_E}{h_{FE}}}$$

$$I_{C(sat)} = \frac{V_{CC} - V_{CE(sat)}}{R_C + R_E + \frac{R_E}{h_{FE}}}$$

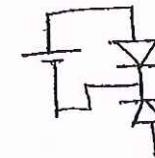
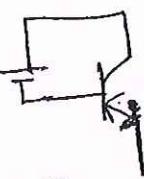
Condition for Saturation:

$$h_{FE} I_B \geq I_{C(sat)}$$

$$* h_{FE} \left[ \frac{V_{BB} - V_{BE}}{R_B + (1+h_{FE})R_E} \right] \geq \frac{V_{CC} - V_{CE(sat)}}{R_C + R_E + \frac{R_E}{h_{FE}}} \quad (1)$$

$$h_{FE} = \beta$$

$$h_{FE} \left[ \frac{V_{BB} - V_{BE}}{R_B + h_{FE}R_E} \right] \geq \frac{V_{CC} - V_{CE(sat)}}{R_C + R_E} \quad (2) \quad (\because h_{FE} \gg 1)$$



Q Cutoff RB RB

### Active Region:

If it is not satisfying ① and  $V_{BB} > V_{BE}$ , then it operates in active region.

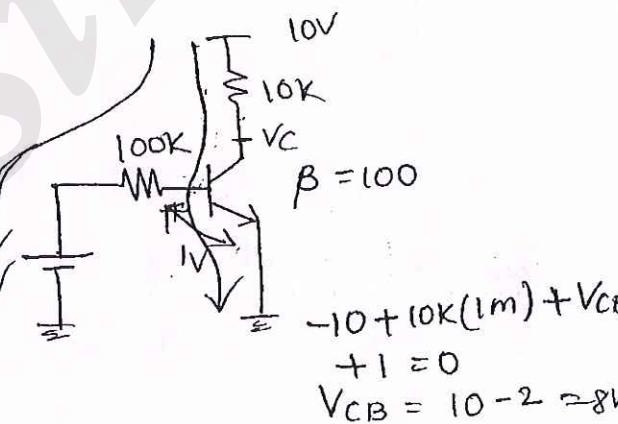
Q)

#### ② Verification

$$100 \left[ \frac{2 - 1}{100k + 0} \right] \geq \left[ \frac{10 - 0.3}{10k + 0} \right]$$

$$\frac{100}{100k} \geq \frac{9.7}{10k}$$

$1m \geq 0.97m$  (Condition is satisfied)



Transistor operates in saturation region.

#### Voltage Method:

npn transistor

$$-10 + b + V_{CE} = 0$$

$$V_{CE} = 0 \quad I_C = 1mA$$

$$I_B = 0.01mA$$

$$V_{CB} = V_{CE} - V_{BE} \approx -1V$$

$$\frac{V_{CC} - V_C}{10K} = 1m$$

$$V_C = V_{CC} - 10 = 0$$

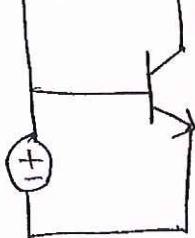
$$V_B = 1V$$

$$V_{CB} = V_C - V_B = 0 - 1 = -1V$$

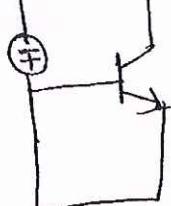
$$V_{CB} = -1V$$

$$-V_{CC} + 10k(1m) + 100k(0.01m) + 2 + V_{CB} = 0$$

$$10 - 10 - 1 - 2 = V_{CB} = -ve$$



$J_E : PB$   
 $J_C : RB$   
(Foward Active)



$J_E : RB$   
 $J_C : FB$   
(Reverse Active)



$J_E : RB$   
 $J_C : RB$   
(cutoff)

Q) For the circuit shown in the figure,

$$V_{BE} = 0.7V \text{ and } hfe = 100$$

(Part a) Calculate  $I_B$ ,  $I_C$ ,  $I_E$ ,  $V_{CE}$  and  $V_{CB}$

KVL at Input loop

$$-V_{BB} + I_B R_B + V_{BE} + I_E R_E = 0$$

$$\Rightarrow -5 + 10K I_B + 0.7 + I_E (100) = 0$$

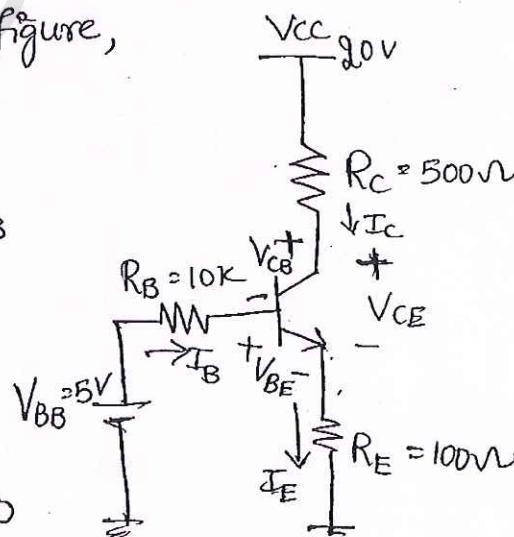
$$10K I_B + 100 I_E = 4.3$$

$$\Rightarrow 10K I_B + 100 (101) I_B = 4.3$$

$$\Rightarrow I_B = \frac{4.3}{10K + 10.1K}$$

$$= 2.14 \times 10^{-4} A$$

$$= 0.214 mA$$



$$I_E = I_B + I_C$$

$$I_C = \beta I_B$$

$$\Rightarrow I_E = (1 + \beta) I_B$$

$$I_C = \beta I_B \Rightarrow 100 \times 0.214 mA$$

$$= 21.4 mA$$

$$V_{CB} = V_{CE} - V_{BE}$$

$$= 6.4386V$$

$$(Q8) . I_B = \frac{V_{BB} - V_{BE}}{R_B + (1+h_{fe})R_E} \approx \frac{V_{BB} - V_{BE}}{R_B + h_{fe}R_E} = 2.15$$

Region of operation:  $V_{CE} > 0.2 \Rightarrow$  Active Region

Part(b)  $\frac{I_C}{h_{fe}} = \frac{21.5m}{100} = 2.153 \times 10^{-4}$   $I_B = 0.214$   
 $I_B < I_C/h_{fe}$  \*Hence no saturation region

If  $V_{BB}$  is varied while maintaining other parameters unchanged in part(a), what is the minimum  $V_{BB}$  required to drive the transistor into saturation. Assume  $V_{CE(sat)} = 0.3V$

$$\left( I_B = \frac{V_{BB} - V_{BE}}{R_B + h_{fe}R_E} \approx \frac{V_{BB} - V_{CE(sat)}}{R_C + R_E} \right)$$

$$V_{CE(sat)} = 0.3V$$

$$h_{fe} \left[ \frac{V_{BB} - V_{BE}}{R_B + h_{fe}R_E} \right] \geq \frac{V_{CC} - V_{CE(sat)}}{R_C + R_E}$$

$$100 \left[ \frac{V_{BB} - 0.7}{10k + 10k} \right] \geq \frac{20 - 0.3}{500 + 100}$$

$$\Rightarrow V_{BB} \geq 7.26V$$

$$\Rightarrow V_{BB_{min}} = 7.26V$$

$$R_E = R_L$$

$$\Rightarrow 100 \left[ \frac{12 - 0.8}{200k + 100R_L} \right] \geq \frac{10 - 0.2}{0 + R_L}$$

$$\frac{1120}{200k + 100R_L} \geq \frac{9.8}{R_L}$$

$$1120R_L \geq 1960000 + 980R_L$$

$$140R_L \geq 1960000$$

$$\Rightarrow R_L \geq 14k\Omega$$

$$R_{L\min} = 14k\Omega$$

(Q)

$$h_{FE} = \beta = 50, V_{BE} = 0.7V, V_{CE} = 5V$$

For the circuit shown in the figure  
transistor has above values

If  $V_{CE} = 5V$ , find the value of  $R$

Sol: Applying KVL at the o/p side

$$-V_{CC} + I_C R_C + V_{CE} + I_E R_E = 0$$

$$V_{CC} = I_C R_C + V_{CE} + I_E R_E$$

$$R = \frac{V_{CB}}{I_B} = \frac{5 - 0.7}{I_B} = \frac{4.3}{I_B}$$

(b) Determine Voltage  $V_o$  at saturation fa

$$R_L = R_{L\min}$$

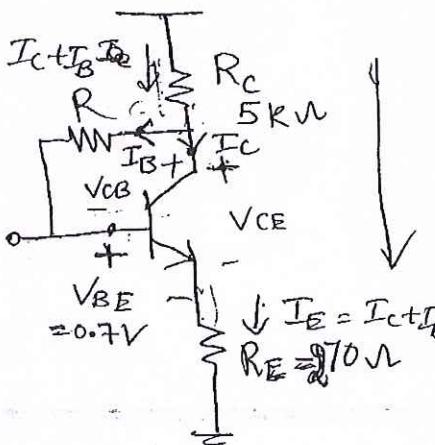
$$V_{CE} = V_{CE(\text{sat})}$$

$$V_o = V_{CC} - V_{CE(\text{sat})}$$

$$= 10 - 0.2 \\ = 9.8V$$

$$(a) V_o = V_{CC} - I_{C(\text{sat})} R_L$$

$$- - - \quad V_{CC} = 20V$$



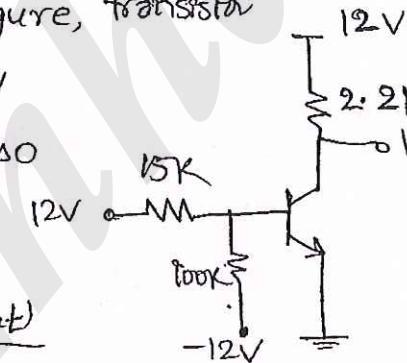
$$+V_{BE}$$

$$V_{CB} = V_{CE} - V_{BE}$$

18/81B

Q) For the circuit shown in the figure, transistor has  $\beta = 30$ ,  $V_{BE} = 0.7V$ ,  $V_{CE(sat)} = 0.2V$

Find the region of operation and also calculate  $V_o$ .

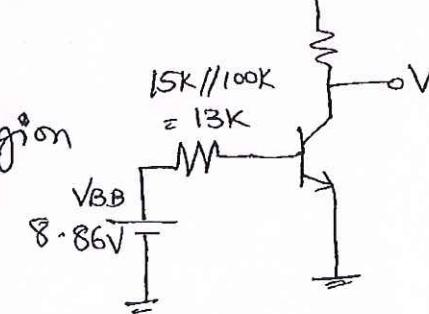


$$h_{fe} \left( \frac{V_{BB} - V_{BE}}{R_B + h_{fe} R_E} \right) \geq \frac{V_{CC} - V_{CE(sat)}}{R_C + R_E}$$

$$30 \left( \frac{8.86 - 0.7}{15k + 0} \right) \geq \frac{12 - 0.2}{2.2k}$$

$$18.83m \geq 5.36m.$$

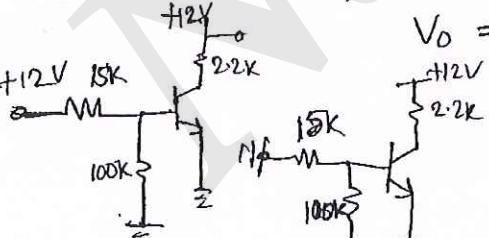
Region of operation is Saturation region



$$-12 + I_{C(sat)}(2.2k) + V_o = 0$$

$$V_o = 12 - I_{C(sat)}(2.2k)$$

$$\begin{aligned} V_o &= V_{CE(sat)} \\ &= 0.2V \end{aligned}$$



$$V_{BB}' = \frac{12 \times 100k}{15k + 100k}$$

$$V_{BB}'' = -\frac{12 \times 15k}{15k + 100k}$$

$$V_{BB} = V_{BB}' + V_{BB}''$$

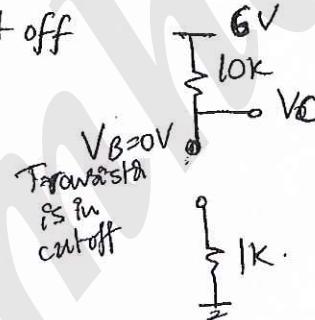
$$= \frac{12}{115k} [100k - 15k] = 8.86V$$

For  $V_B = 0V$

$V_B = 0V \Rightarrow I_B = 0 \Rightarrow I_C \approx I_E$ . Cut off

$$I_C \approx \frac{6 - 0.7}{10k + 1k} =$$

$$V_C = 6V, I_C = 0, I_E = 0$$



For  $V_B = 1V$

$$V_B = 1V \Rightarrow$$

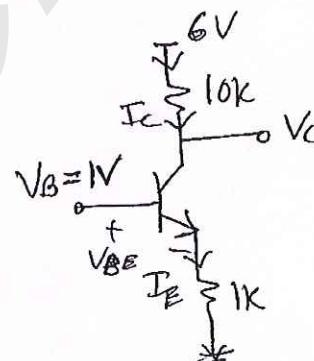
$$I_E = \frac{V_B - V_{BE}}{1k}$$

$\rightarrow 0.7 + 10k (I_E)$

$I_E \approx$

$$I_E \approx I_C = 0.3mA$$

$$= \frac{1 - 0.7}{1k} = 0.3mA$$



(active)

( $V_{CB}$  is +ve)

$$-6 + 10k I_C + V_C = 0$$

$$\Rightarrow V_C = 6 - (10k)(0.3m)$$

$$= 6 - 3 = 3V$$

For  $V_B = 2V$

$$I_E = \frac{V_B - V_{BE}}{1k} = \frac{2 - 0.7}{1k} = 1.3mA$$

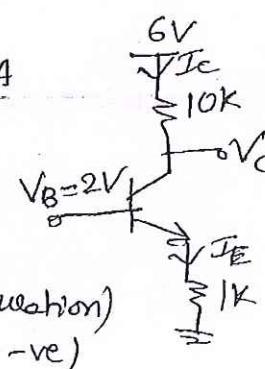
$$I_C \approx I_E = 1.3mA$$

So these  
are wrong  
values

$$V_C = 6 - (10k)(1.3m)$$

$$= 6 - 13 = -7V$$

(Saturation)  
( $V_{CB}$  is -ve)



$\Rightarrow$  For the circuit shown in the figure, transistor has

$\beta = 75$ . Calculate  $V_o$  for  $V_{BE} = 0V, 1V$  and  $2V$

For  $V_B = 0V$

Transistor is in Cutoff

$$\Rightarrow V_O = \frac{5V \times 10k}{5k + 10k} = 3.33V$$

For  $V_B = 1V$ ,

$$I_B = \frac{V_B - V_{BE}}{50k} = \frac{1 - 0.7}{50k} = 6mA$$

$$I_E = I_B + I_C$$

$$\Rightarrow I_E \approx I_B = I_E$$

$$I_C = \beta I_B = 75 \times 6mA = 0.45mA$$

$$\left\{ \begin{array}{l} V_C = 5 - 5k(0.45m) \\ \approx 2.75V \end{array} \right.$$

$$V_O = \frac{2.75 \times 10k}{10k + 5k} = 1.83V$$

For  $V_B = 2V$

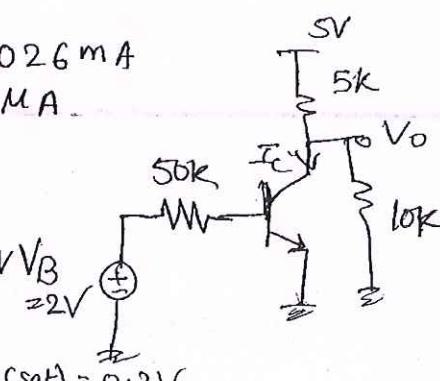
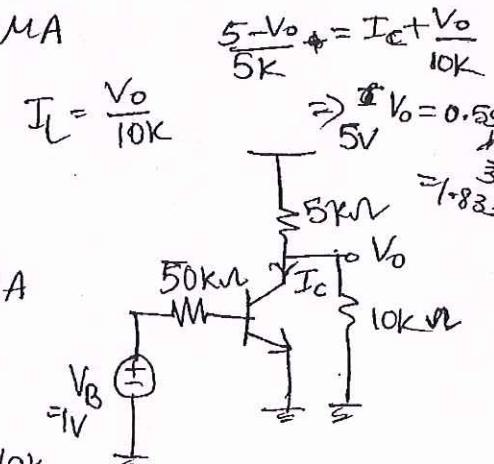
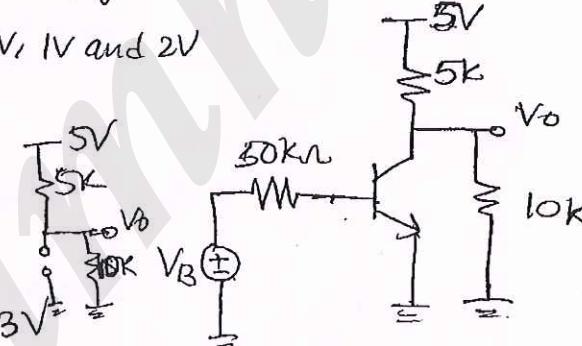
$$\frac{5 - V_O}{5k} = I_C + \frac{V_O}{10k} \quad I_B = \frac{V_B - V_{BE}}{50k} = \frac{2 - 0.7}{50k} = 0.026mA = 26mA$$

$$\Rightarrow 0.45m = \frac{3V_O}{10k} \quad I_C = \beta I_B = 1.95mA$$

$$\Rightarrow V_O = \frac{0.95 \times 10}{3} \quad V_C = 5 - 5k(1.95m) \\ = -3.1667V \quad = -3.1667V$$

$\Rightarrow$  Saturation region

$$\Rightarrow V_O = V_{CE(CSAT)} = 0.71V$$



$$I_C = 0.099 \text{ mA}$$

$$V_o = 5 - (0.099) 5k = 4.5V$$

For  $I_E = 0.5 \text{ mA}$

$$I_c = \alpha I_E = 0.4967 \text{ mA}$$

$$V_o = 5 - (24835) = 2.5165V$$

Q) For the circuit shown in the figure,

$$V_B = V_C \text{ and } \beta = 50. \text{ Calculate } V_B$$

$$\Rightarrow (I_C = I_E \Rightarrow I_E = \frac{6 - 0}{11k} = 0.545 \text{ mA})$$

$$V_C = 0.55$$

$$V_C = V_B = 0.55 \Rightarrow -0.55 + V_{BE} + (0.545 \text{ mA})(1k) = 0$$

$$\Rightarrow V_{BE} =$$

$$\text{KVL at o/p side} \Rightarrow 6V = 10k I_1 + V_{BE} + 1k (I_1)$$

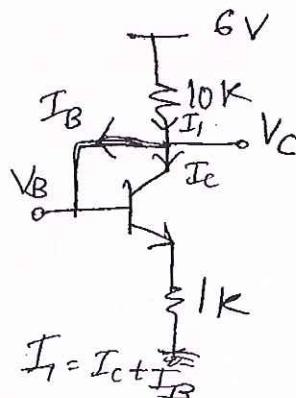
$$\Rightarrow 6V - V_{BE} = 11k I_1$$

$$\Rightarrow I_1 = \frac{6V - 0.7V}{11k}$$

$$V_C = 6 - 10k(0.4818 \text{ mA}) = \frac{5.3}{11k} = 0.4818 \text{ mA.}$$

$$= 6 - 4.818$$

$$= 1.182 \approx 1.2V$$



$$1+\beta = \frac{101}{10} = 0.99$$

$$= 0.89 \text{ mA}$$

-5V

$$I_E = \frac{1}{\alpha} I_C = \frac{0.90}{0.99} = 0.909 \text{ mA}$$

Q) For the circuit shown in the figure,  $V_E = 2V$ , Calculate  $\alpha$  value.

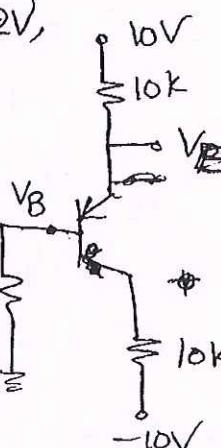
$$V_E = 2 \Rightarrow I_E = \frac{V_{EE} - V_E}{10k} = \frac{10 - 2}{10k} = 0.8 \text{ mA}$$

$$I_C = \alpha I_E \quad I_C = \alpha I_E$$

$$V_{CE} = 0.7 \text{ V (sat)} \quad I_E = 0.8 \text{ mA}$$

$$\alpha = 0.96$$

$$V_{CC} = -10V$$



$$V_{EB} = 0.7$$

$$I_B = \frac{0.7 - 0.7}{50k} = 0 + 1.3 = 26 \text{ mA} \quad V_E - V_B = 0.7$$

$$I_E = I_B + I_C$$

$$\Rightarrow I_C = I_E - I_B = 0.774 \text{ mA}$$

$$\alpha = \frac{I_C}{I_E}$$

$$= 2 - 0.7 \\ = 1.3 \text{ V}$$

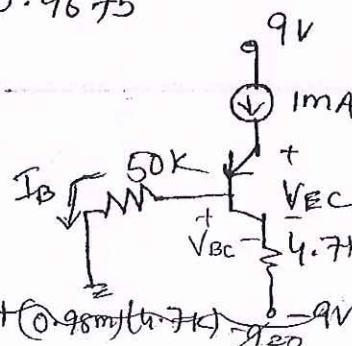
Q) For the circuit shown in the figure,  $\alpha = 0.9675$   
transistor has  $\beta = 50$ . Calculate  $V_{EC}$

$$I_E = 1 \text{ mA}$$

$$\alpha = \frac{\beta}{1+\beta} = 0.98$$

$$I_C = \alpha I_E = 0.98 \text{ mA}$$

$$V_{BC} = V_{EC} + (0.98 \text{ mA})(50k)$$



$$V_{EB} = V_E - V_B \Rightarrow V_{EC} = 6.07V_{\parallel}$$

$$\begin{aligned} V_E &= V_{EB} + V_B \\ &= 0.7 + 50k(20\mu) \\ &= 0.7 + 0.02 \times 50 \\ &\approx 1.68V \end{aligned}$$

$$\begin{aligned} V_C &= 4.7k \times I_C - 9 \\ &= 4.7k \times 0.98m - 9 \\ &= -4.394V \end{aligned}$$

$$V_{EC} = V_E - V_C = 1.68 - (-4.394) = 6.07V_{\parallel}$$

Q) For the circuit shown in the figure, transistor has  $\beta = 50$ , calculate power dissipated in the transistor.

$$pnp \Rightarrow P_d = V_{EC} \times I_C$$

$$I_E = 0.5mA$$

$$\alpha = 0.98$$

$$I_C = \alpha I_E = 0.49mA$$

$$\begin{aligned} I_B &= I_E - I_C \\ &= 0.5 - 0.49 \\ &= 0.01mA \end{aligned}$$

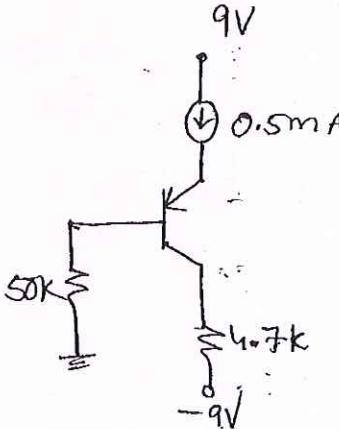
$$V_{EB} = V_E - V_B$$

$$\begin{aligned} V_E &= V_{EB} + V_B \\ &= 0.7 + (50k)(10\mu) \\ &\approx 1.2 \end{aligned}$$

$$V_C = 4.7k \times I_C - 9$$

$$\begin{aligned} &= 4.7k \times 0.49m - 9 \\ &\approx -6.697V \end{aligned}$$

$$\begin{aligned} V_{EC} &= V_E - V_C \\ &= 1.2 + 6.697 \\ &= 7.897V \\ P_d &= V_{EC} \times I_C = 3.869mW \end{aligned}$$



$$I_C = \beta I_B \Rightarrow I_B = \frac{I_C}{\beta} = 33.3 \text{ mA}$$

$$-24 + I_B R_B + V_{BE} = 0$$

$$R_B = \frac{24 - 0.7}{33.3 \text{ mA}}$$

$$= 0.7 \text{ M}\Omega \approx 699 \text{ k}\Omega$$

Q) For the circuit shown in the figure, transistor has  $\beta = 100$ , calculate  $V_B$ .

$$\times (-10 + I_E(1\text{k}) + V_{EC} = 0)$$

$$20k(I_B) - V_{EB} - I_E(1\text{k}) = 0 \rightarrow$$

$$I_C = \alpha I_E$$

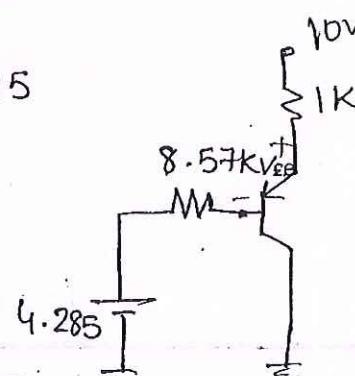
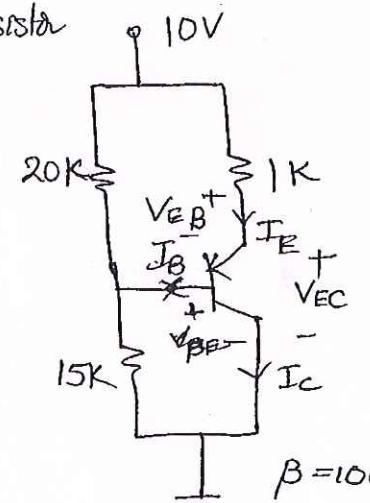
$$\alpha = \frac{\beta}{1+\beta} = \frac{100}{1+100} = \frac{100}{101} \approx 0.99$$

$$V_{Th} = \frac{10 \times 15k}{20k + 15k} = 4.285$$

$$R_{Th} = 8.57k$$

$$I_B = \left( -10 + (1k + 8.57k) I_E + V_{EB} + 4.285 \right) \approx 0$$

$$\Rightarrow I_C = \frac{10 - 4.285 - 0.7}{9.857k} = 0.5087 \text{ mA}$$



$$\times \left( I_B = \frac{V_{BB} - V_B}{8.57k} \right)$$

$$\Rightarrow V_B = -I_B(8.57k) + V_{EB}$$

$$\begin{aligned}
 V_B &= V_{BB} + I_B R_B \\
 &= 4.286 + (45.8\mu)(8.57k) \\
 &= 4.67V
 \end{aligned}$$

Q) The transistor circuit shown in the figure,  $V_Z = 5V$  and  $\beta = 100$   
Calculate  $V_{CE}$  and  $I_C$

$$-12 + I_c(500\Omega) + 5 + 0.7 = 0$$

$$\begin{aligned}
 \Rightarrow I_C &= \frac{12 - 5 - 0.7}{500} \\
 &= 12.6mA
 \end{aligned}$$

$$-12 + I_c R_C + 5 + V_{CE} = 0$$

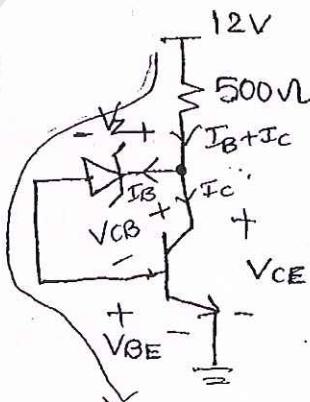
$$V_{CE} = 12 - 6.3 + 5 \quad (\text{Ans})$$

$$-12 + 500(I_c + I_B) \quad (\text{Ans}) + V_{CE} = 0$$

$$\begin{aligned}
 \Rightarrow (101)I_B &= \frac{12 - 5.7}{500} \\
 &= 0.0126mA
 \end{aligned}$$

$$\therefore I_C = 12.6mA$$

$$V_{CB} = V_Z$$



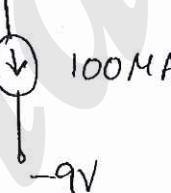
$$\begin{aligned}
 V_{CE} &= V_z + V_{BE} \\
 &= 5 + 0.7 \\
 &= 5.7V
 \end{aligned}$$

$$I_E = I_S e^{\frac{V_{BE}}{V_T}}$$

$$V_{BE} = V_T \ln \left( \frac{I_E}{I_S} \right)$$

$$= 26m \ln \left( \frac{100M}{10^{-16}} \right)$$

$$= 0.718V$$



$$\alpha = 0.95$$

$$I_S = 10^{-16}A$$

$$I_C = \alpha I_E = 95mA = 0.095mA$$

$$I_B = I_E - I_C = 100 - 95 = 5mA = 0.005mA$$

Q) Calculate  $I_E, I_C, I_B$  currents and also calculate  $V_{BE}, V_{BC}$  voltages for the transistor biased by a base current source as shown in the figure

$$I_B = 100mA$$

$$V_{BE}/V_T$$

$$I_C = I_S e^{V_{BE}/V_T}$$

$$I_C = \alpha I_E$$

$$\beta = \frac{\alpha}{1-\alpha}$$

$$= 19$$

$$I_C = \beta I_B$$

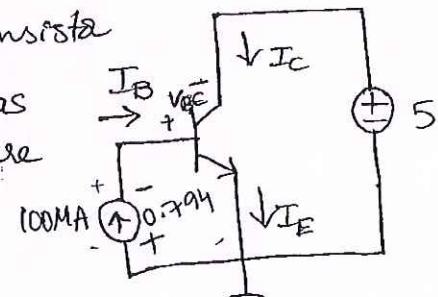
$$= 1900mA$$

$$= 1.9mA$$

$$I_C = I_S e^{V_{BE}/V_T}$$

$$\Rightarrow V_{BE} = 26m \ln \left( \frac{1.9mA}{10^{-16}A} \right)$$

$$= 0.794V$$



$$\alpha = 0.95$$

$$I_S = 10^{-16}A$$

$$I_E = I_C + I_B$$

$$\Rightarrow I_E = 1900mA + 100mA$$

$$= 2mA$$

$$-V_{100mA} + V_{BE} = 0$$

$$\Rightarrow V_{100mA} = +0.794V$$

$$-5V + V_{BC} + 0.794 = 0$$

$$\Rightarrow V_{BC} = @. 0.794V - 4.206V$$

$$I_C = \frac{12 - 6}{10k} = 0.6 \text{ mA}$$

$$\beta = \alpha = \frac{\beta}{1+\beta} = 0.987$$

$$R_C = \frac{18 - I_C 10k}{I_C} = 20k\Omega$$

$$I_E = \frac{12 - 6}{10k} = 0.6 \text{ mA}$$

$$I_E = \frac{I_C}{\alpha} = \frac{0.6}{0.987} = 0.608 \text{ mA}$$

~~Q1~~

$$V_{EB} = V_E - V_B = -0 + V_E = V_E - 0$$

$$\Rightarrow V_E = V_{EB} = 0.7$$

$$I_E = \frac{12 - 0.7}{10k} = 1.13 \text{ mA}$$

$$I_C = \alpha I_E = \frac{\beta}{1+\beta} I_E \Rightarrow I_C = 1.115 \text{ mA}$$

KVL at o/p

$$-12 + 10k(1.13m) + 6 + I_C R_C - 12 = 0$$

$$\Rightarrow R_C = \frac{24 - 6 - 11.3}{1.115m}$$

$$= 5.82 \text{ k}\Omega$$

$$\approx 6 \text{ k}\Omega$$

18V  
10k

$$\Rightarrow I_B = \frac{10}{10k + 750k}$$

$$= 0.012 \text{ mA}$$

$$= 12.07 \text{ mA}$$

$$I_C = \beta I_B$$

$$= 75 \times 12.07 \text{ mA} = 0.9 \text{ mA}$$

$$I_E = I_B + I_C \Rightarrow I_E = I_B + I_C$$

$$= 0.912 \text{ mA}$$

$$-8 + 9.12 + V_{EC} + 2.7 - 8 = 0$$

$$\Rightarrow V_{EC} = 4.18 \text{ V}$$

Q) For the circuit shown in the figure, transistor has  $\beta = 75$  and  $V_{BE} = 0.7 \text{ V}$ . Calculate  $I_C$  and  $R_C$  values.

$$I_E = 1 \text{ mA}$$

$$I_C = \frac{5-2}{R_C}$$

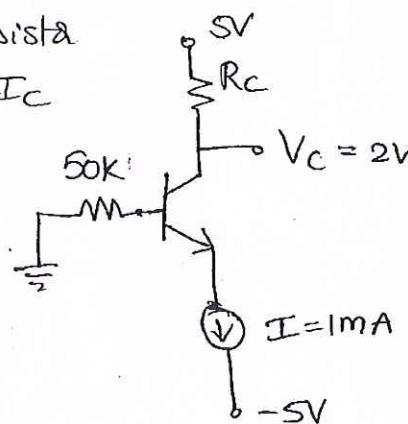
$$I_B = \frac{V_B - 0}{50k}$$

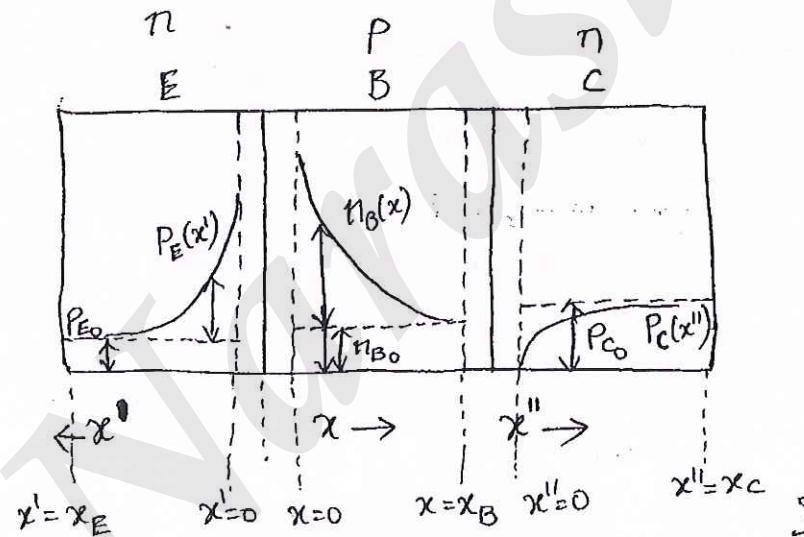
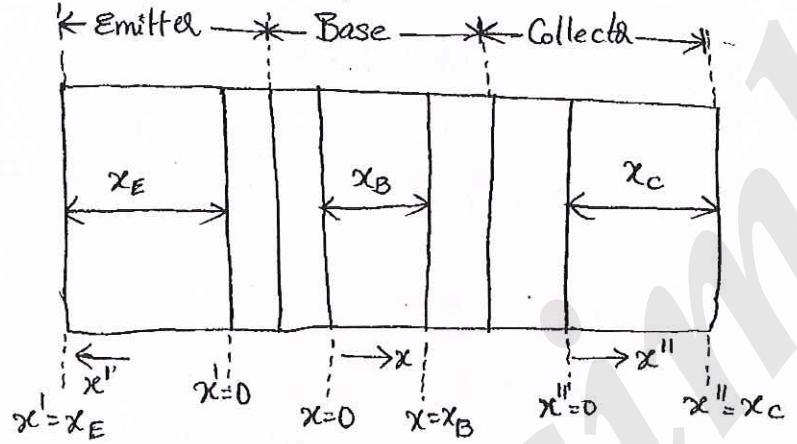
$$I_C = \alpha I_E$$

$$\alpha = \frac{\beta}{1+\beta} = \frac{75}{76} = 0.98$$

$$I_C = 0.98 \text{ mA}$$

$$R_C = \frac{5-2}{0.98 \text{ mA}} = \frac{3}{0.98 \text{ mA}} = 3.06 \text{ k}\Omega$$





$$I_C = I_S e^{V_{BE}/V_T}$$

$$n_B(x) \Big|_{x=0} = n_{B0} e^{V_{BE}/V_T}$$

$$P_E(x') \Big|_{x=0} = P_{E0} e^{V_{BE}/V_T}$$

If EB junction is forward biased

$$I_S = \frac{A_{BE} V D_n}{x_B} n_{B0}$$

$$I_0 = \frac{A_e D_{n0}}{L_p} P_{n0} + \frac{A_e D_{n0}}{L_n} \eta_p n_{p0}$$

Q) The parameters in the base region of an  $npn$  bipolar transistor are as follows:

$n_{pn}$

$$D_n = 20 \text{ cm}^2/\text{s}$$

$$n_{B0} = 10^4 / \text{cm}^3$$

$$\chi_B = 1 \mu\text{m}$$

$$A_{BE} = 10^{-4} \text{ cm}^2$$

① If  $V_{BE} = 0.5V$  then the collector current  $I_C$  is

$$I_S = \frac{A_{BE} V D_n}{\chi_B} n_{B0} = \frac{10^{-4} \times 1.6 \times 10^{-19} \times 20}{10^{-4}} \times 10^4$$

$$= 3.2 \times 10^{-14}$$

$$I_C = I_S e^{V_{BE}/V_T} = 3.2 \times 10^{-14} \times e^{0.5/0.02586}$$

$$= 7.98 \times 10^{-6} \text{ A}$$

$$= 7.98 \text{ mA. (Cut-off Region)}$$

② If  $V_{BE} = 0.7V$ , then the collector current  $I_C$  is

$$I_C = I_S e^{V_{BE}/V_T} = 3.2 \times 10^{-14} \times e^{0.7/0.02586}$$

$$= 18.24 \text{ mA. (Forward biased).}$$

Q) In a bipolar transistor biased in the forward active region the base current  $I_B = 50 \text{ mA}$  and the collector current  $I_C$  is  $2.7 \text{ mA}$ . Then the  $\alpha$  value is

$$\beta = \frac{\alpha}{1-\alpha} \quad I_C = \beta I_B$$

$$\beta = \frac{I_C}{I_B} = 54$$

$$\alpha = \frac{\beta}{1+\beta} = \frac{54}{55} = 0.982$$

$$\ln n_{B_0} = \ln n_B(x) - \frac{V_{BE}}{V_T}$$

$$\Rightarrow n_{B_0} = 1.7 \times 10^4 / \text{cm}^3$$

$$\ln P_{E_0} = \ln P_E(x) - \frac{V_{BE}}{V_T}$$

$$\Rightarrow P_{E_0} \propto$$

$$n_{B_0} = \frac{n_i^2}{N_B}$$

$$P_{E_0} = \frac{n_i^2}{N_E}$$

$$P_{C_0} = \frac{n_i^2}{N_C}$$

$$n_i = 1.5 \times 10^{10} / \text{cm}^3$$

$$n_{B_0} = \frac{(1.5 \times 10^{10})^2}{10^{16}}$$

$$P_{E_0} = \frac{(1.5 \times 10^{10})^2}{5 \times 10^{17}}$$

$$P_{C_0} = \frac{(1.5 \times 10^{10})^2}{10^{15}}$$

$$= 2.25 \times 10^{14} / \text{cm}^3$$

$$= 450 / \text{cm}^3$$

$$= 2.25 \times 10^5 / \text{cm}^3$$

Q) A uniformly doped Si pnp transistor is biased in the forward active mode. The transistor doping concentrations are

$$N_E = 10^{18} / \text{cm}^3, N_B = 5 \times 10^{16} / \text{cm}^3, N_C = 10^{15} / \text{cm}^3. \quad \text{For } V_{EB} = 0.6 \text{ V}$$

$P_B$  at  $x=0$  is

$$P_B(x) = P_{B_0} \cdot e^{-\frac{V_{BB}}{V_T}}$$

$$= 4500 \times e^{0.6 / 0.02586}$$

$$P_B(0) = 5.366 \times 10^{13} / \text{cm}^3$$

$$P_{B_0} = \frac{k_{B_0} n_i^2}{N_B}$$

$$= \frac{(1.5 \times 10^{10})^2}{5 \times 10^{16}} = 4500 / \text{cm}^3$$

Q) An npn bipolar transistor having uniform doping of  
 $N_E = 10^{18}/\text{cm}^3$ ,  $N_B = 10^{16}/\text{cm}^3$ ,  $N_C = 6 \times 10^{15}/\text{cm}^3$  is operating  
 in the inverse active mode with  $V_{BE} = -2V$  and  
 $V_{BC} = 0.6V$ .

① The minority carrier concentration at  $x = x_B$  is

$$n_{B0} = \frac{n_i^2}{N_B} = \frac{(1.5 \times 10^{10})^2}{10^{16}} = 2.25 \times 10^4/\text{cm}^3$$

$$n_B(x_B) = 2.25 \times 10^4 \times e^{0.6/0.02586} \\ = 2.68 \times 10^{14}/\text{cm}^3$$

② The minority carrier concentration at  $x^n = 0$  is

$$P_E = \frac{n_i^2}{N_C}$$

$$\approx 37200/\text{cm}^3$$

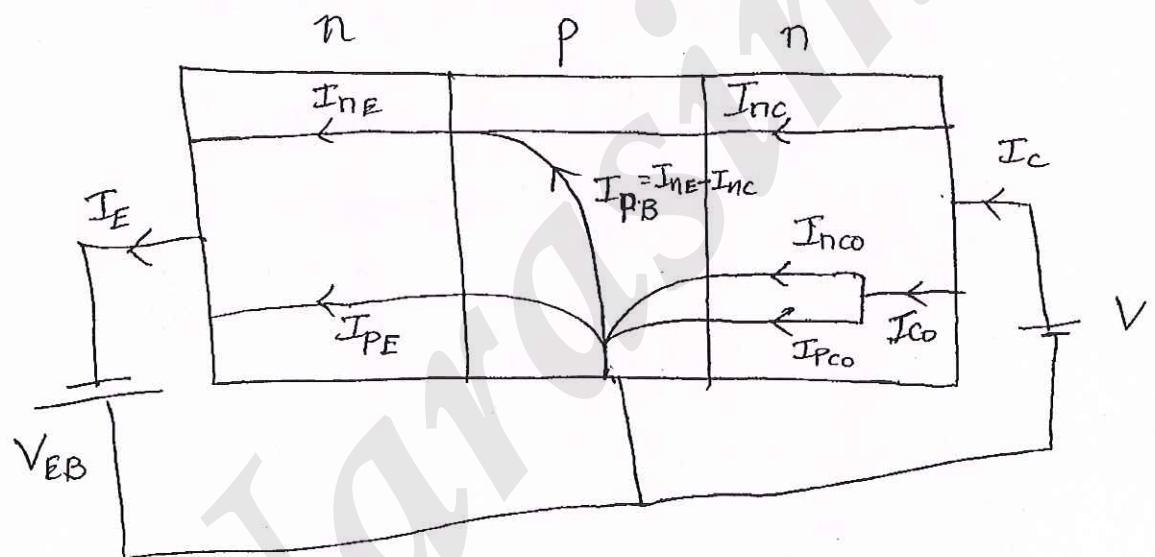
$$P_C(x) = P_{C0} e^{V_{BC}/V_T} \\ = 37200 \times e^{0.6/0.02586}$$

$$= 4.47 \times 10^{14}/\text{cm}^3$$

$$= 4.47 \times 10^{14}/\text{cm}^3$$

$$\beta^* = \frac{I_{nC}}{I_{nE}} = \frac{1.18m}{1.2m} = 0.983$$

$$\alpha = \beta^* \gamma^* = 0.907$$



$$\gamma^* = \frac{I_{nE}}{I_E} = \frac{I_{nE}}{I_{nE} + I_{PE}}$$

$$\beta^* = \frac{I_{nC}}{I_{nE}}$$

$$\alpha = \frac{I_{nC}}{I_E} = \frac{I_{nC}}{I_{nE} + I_{PE}}$$

$I_B$ ,  $I_C$ ,  $I_E$ ,  $V_{CE}$ ,  $V_{CB}$ .

Given  $V_{BE} = 0.7V$ .

$$\beta = 150$$

$$-5 + 10K I_B + V_{BE} = 0$$

$$\Rightarrow I_B = \frac{5 - 0.7}{10K}$$

$$= \frac{4.3}{10K} = 0.43mA$$

$$-10 + 100I_C + V_{CE} = 0$$

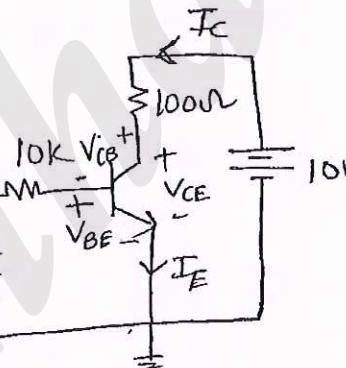
$$V_{CE} = 10 - 100(64.5mA)$$

$$= 3.55V$$

$$I_E = I_B + I_C$$

$$= 0.43 + 64.5mA$$

$$= 64.93mA$$



$$I_C = \beta I_B$$

$$= 150(0.43)$$

$$= 64.5mA$$

$$V_{CE} = V_{BE} + V_{CB}$$

$$\approx 0.7 + 3.55$$

$$= 3.55V$$

$$\Rightarrow V_{CB} = V_{CE} - V_{BE}$$

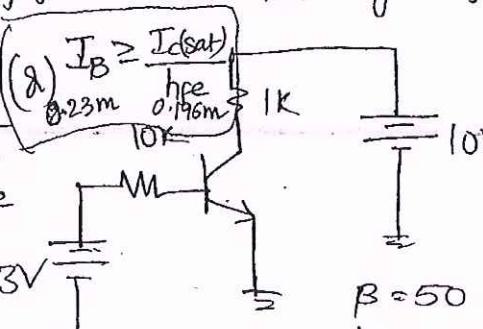
$$= 3.55 - 0.7 = 2.85V$$

Q) The transistor circuit shown in the figure. Find the region of operation. Assume  $V_{CE(sat)} = 0.2V$

$$h_{FE} \left[ \frac{V_{BB} - V_{BE}}{R_B + (1+h_{FE})R_E} \right] \geq \frac{V_{CC} - V_{CE(sat)}}{R_C + R_E + \frac{R_E}{h_{FE}}} \quad (d) \quad I_B \geq I_{D(sat)}$$

$$\Rightarrow 50 \left[ \frac{3 - 0.7}{10K + 51(0)} \right] \geq \frac{10 - 0.2}{1K + 0}$$

$$0.0115 \geq 0.0098 \quad \text{Transistor is in saturation.}$$



$$V_{BE} \approx V_{DD} - V_{DS}$$



$$I_B = \frac{5 - 0.7}{22k} = 0.195 \text{ mA}$$

$$\beta = 100$$
$$V_{BE} = 0.7 \text{ V}$$

$$I_C = \beta I_B = 19.5 \text{ mA}$$

$$19.5 \text{ mA} = \frac{V_{CC} - V_{CE(\max)}}{R_C} \Rightarrow V_{CC} = 19.5 \text{ mA} (1k) + 15$$

$$= 34.5 \text{ V}$$

(d)  ~~$V_{CE} = 19.5 \text{ V}$~~

$$V_{CC(\max)} = V_{CE(\max)} + V_{RC}$$
$$= 15 + 19.5 = 34.5 \text{ V}$$

$I_C$  is independent of  $V_{CC}$ .

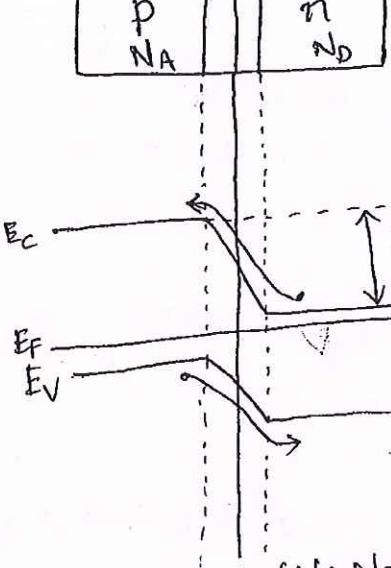
It depends on  $\beta$  and  $I_B$  values.

If  $V_{CC} > V_{CC(\max)}$  then remaining drop will come across transistor that will damage the transistor.

$$P_D = V_{CE(\max)} \times I_C$$

$$= 15 \times 19.5 \text{ mA} = 292.5 \text{ mW} < P_D(\max)$$

→  $V_{CE(\max)}$  and  $I_C(\max)$  will not be taken at a time. When voltage is max, current is min and vice versa to achieve max power rating.



$$E_C - E_F = KT \ln\left(\frac{N_C}{N_D}\right) \quad E_F - E_V = KT \ln\left(\frac{N_V}{N_A}\right)$$

$$\rightarrow N_C > N_D \quad \rightarrow N_V > N_A$$

$$N_C = 4.82 \times 10^{15} \left(\frac{m_n}{m}\right)^{3/2} T^{3/2} \quad N_V = 4.82 \times 10^{15} \left(\frac{m_p}{m}\right)^{3/2} T^{3/2}$$

cm<sup>3</sup> cm<sup>3</sup>

ND: Donor Concentration NA: Acceptor concentration

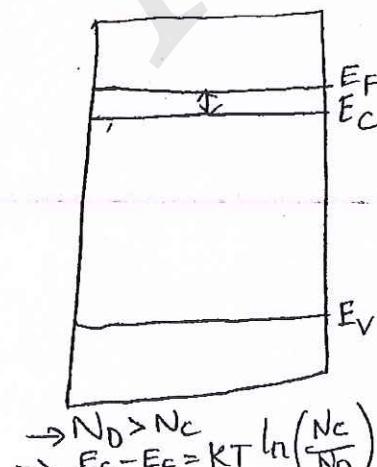
$$E_0 = KT \ln\left(\frac{N_A N_D}{n_i^2}\right) \text{ eV}$$

$$V_0 = KT \ln\left(\frac{N_A N_D}{n_i^2}\right) V$$

Tunnel diode is made up of degenerative semiconductors.

Doping:  $1 \text{ in } 10^3$  Si or Ge atoms.

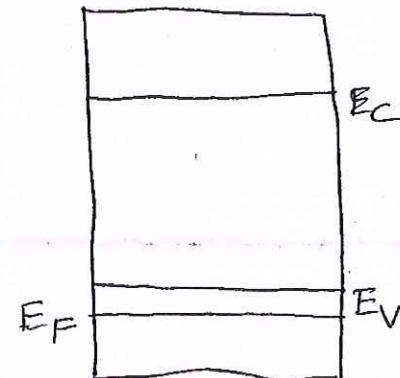
n-Type



$$\rightarrow N_D > N_C$$

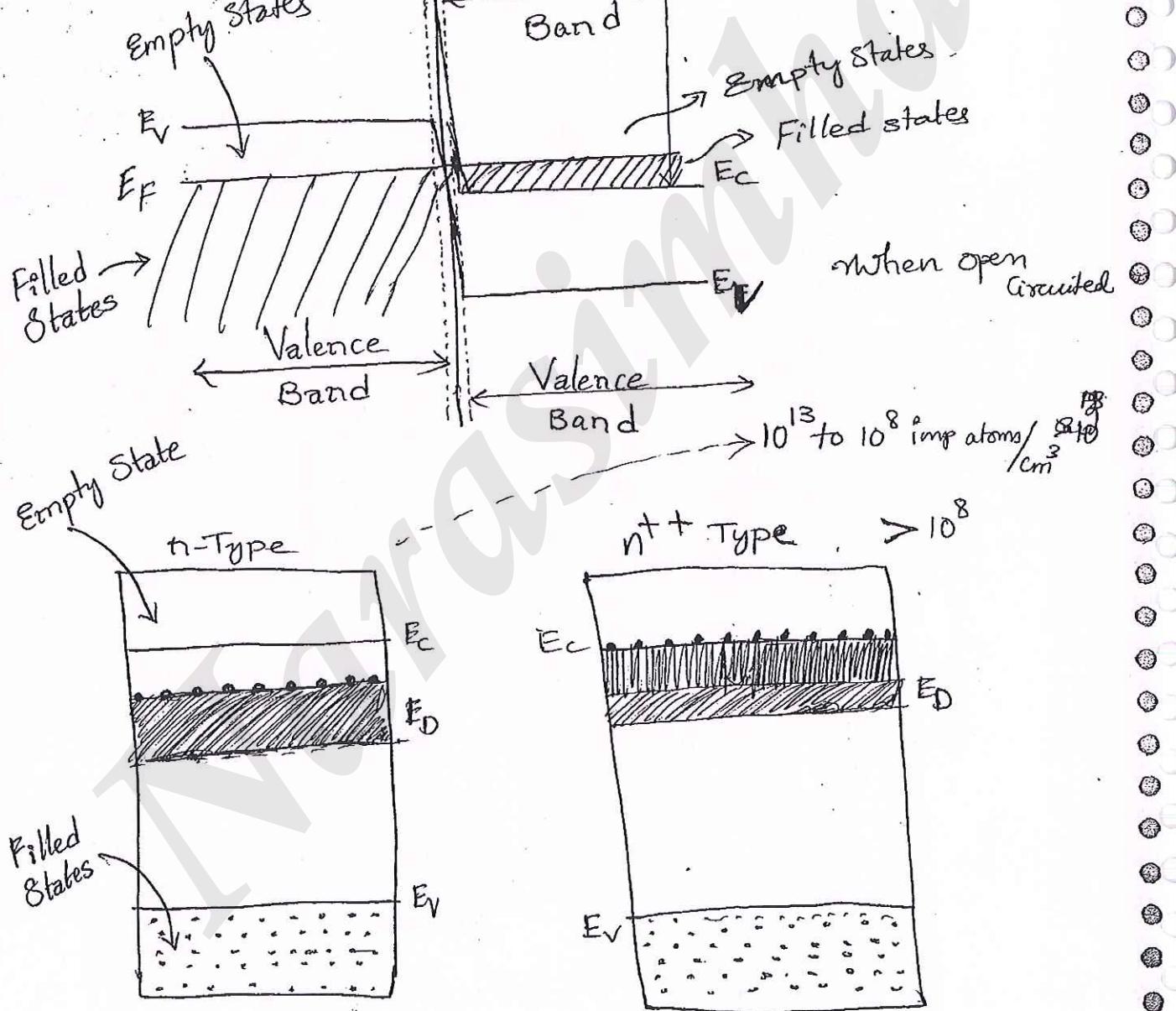
$$E_C - E_F = KT \ln\left(\frac{N_C}{N_D}\right)$$

p-type



$$\rightarrow N_A > N_V$$

$$\rightarrow E_F - E_V = KT \ln\left(\frac{N_V}{N_A}\right)$$



OK

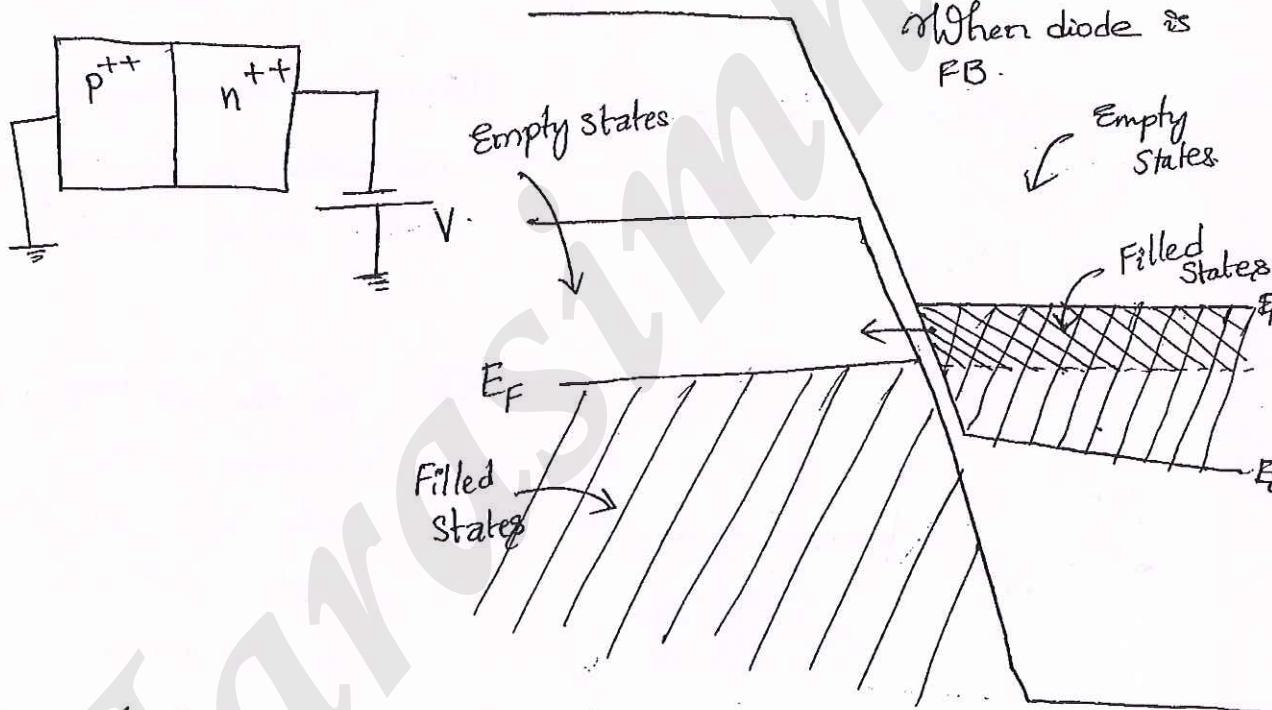
$E_D$ : Donor atom energy  
states having  $e^-$

$$\rightarrow \omega = 100\text{ A}^\circ$$

$$\text{A}^\circ = 10^{-10}\text{ m}$$

$$\Rightarrow \omega \approx 0.01\text{ } \mu\text{m}$$

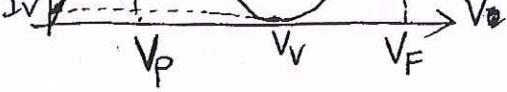
less than  $E_0$  is applied. This is called tunneling.  
(ESAKI in 1958)



Tunnel diode is a special type of p-n junction diode  
and also it is made up of degenerative semiconductors.

The doping concentration in Tunnel diode is  $1 \times 10^{13}$  sp  
or Ge or GaAs atoms. The width of the depletion region  
in tunnel diode is around  $100 \text{ \AA}$ .

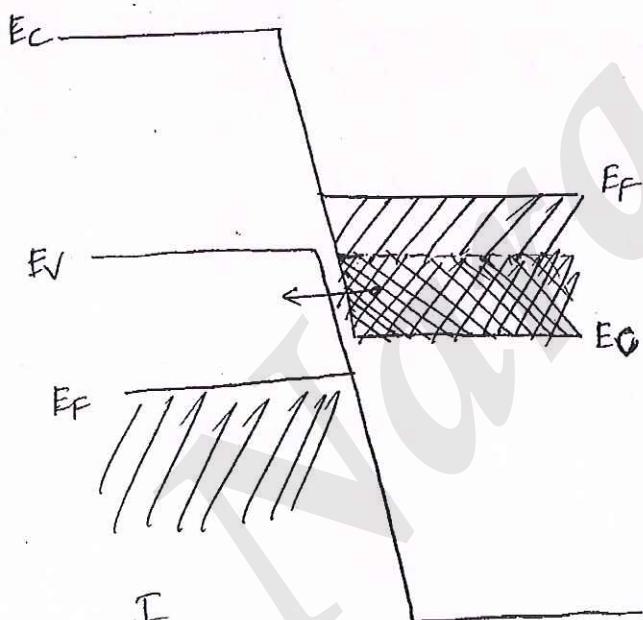
Tunnel diode works based on tunnelling phenomenon.  
It was invented by ESASI in 1958.



As the voltage is further increased,  $E_F$  moves further up on n-side.

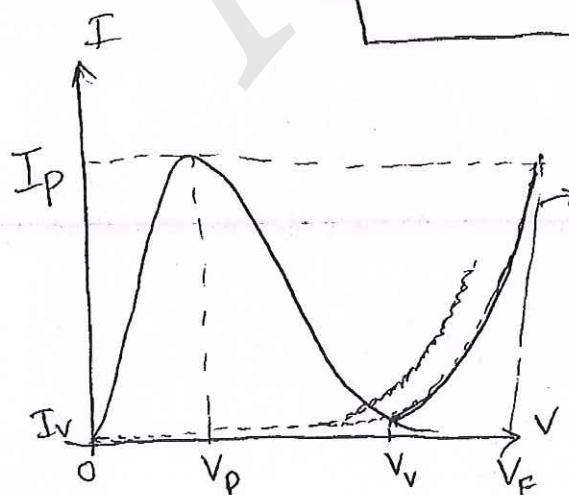
Maximum Tunneling occurs here

filled states are exactly opposite to the empty states



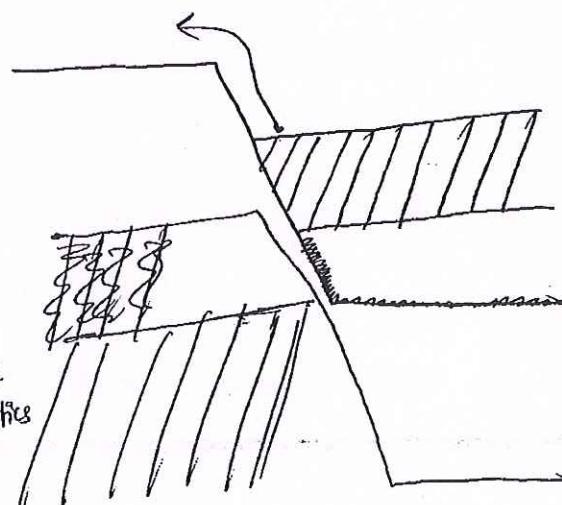
③

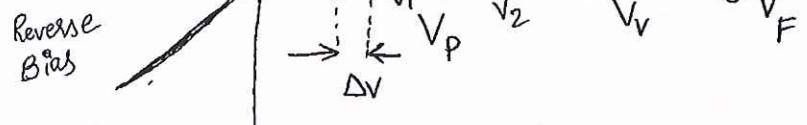
As the voltage, further increased, empty states of p-side and filled states of n-side will not be opposite to each other



Normal diode characteristics

e.g. it acts like a normal p-n junction diode again





the resistance is infinite ( $\therefore \text{slope} = 0$ )

i.e. Conductance is 0.

$\rightarrow I_p$  &  $V_p$ : 10% variation  $-50^\circ\text{C}$  to  $150^\circ\text{C}$

$I_p$ : +ve or -ve temperature coefficient.

$V_p$ : -ve temperature coefficient

$\rightarrow I_V$ : +ve temperature coefficient.

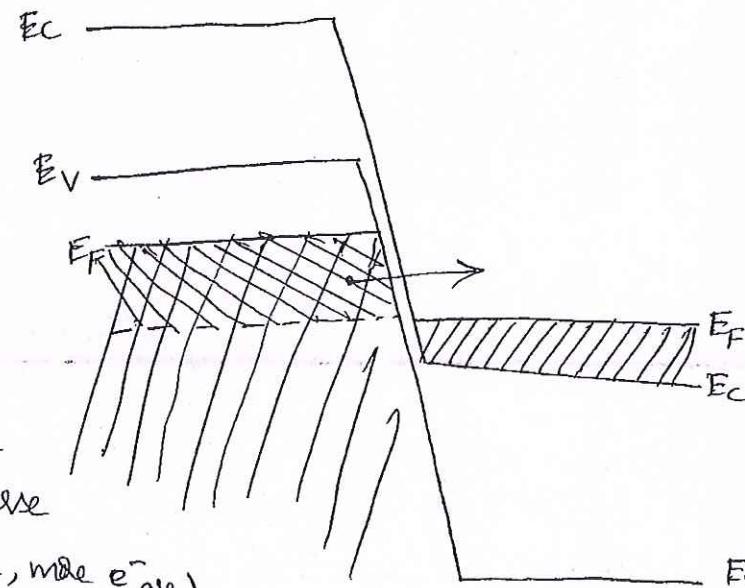
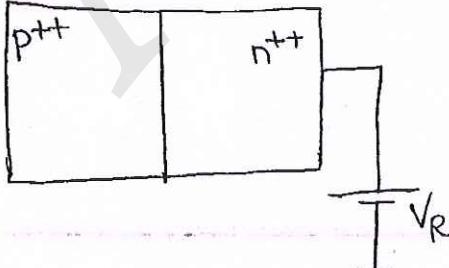
: Two & three times  $-50^\circ\text{C}$  to  $150^\circ\text{C}$ .

$V_V$ : decreases by  $1\text{mV}/^\circ\text{C}$ .

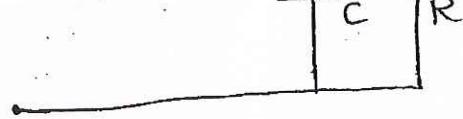
In tunnel diode a single current value (ex: 6mA)

corresponds to multiple voltages (i.e, 3 voltage values from graph)

Reverse Bias:



\* Tunnel diode acts like a conductor when it is reverse biased (As  $V_R \uparrow$ ,  $E_F \downarrow$  on n-side, more  $e^-$  are tunneled)



### Advantages:

- Low Cost
- Simple to fabricate
- Low Noise
- High Speed
- Environmental immunity
- Low Power

\* Performance of tunnel diode is expressed in terms of the ratio of peak current to valley current.

$$\frac{I_p}{I_v} = 3.5 \text{ for Si}$$

$$= 8 \text{ for Ge}$$

$$= 15 \text{ for GaAs}$$

Hence GaAs is preferred for tunnel diode.

### Applications:

- Microwave Oscillator
- High Speed Switch (i.e., MW switch)

### Disadvantages:

- Low output swing
- Two terminal device  
(∴ Amplifier should have atleast three terminals)

\* Performance of tunnel diode is expressed in terms of the ratio of peak current to valley current.

$$N_D = N_A \cdot \quad E_0 = kT \ln\left(\frac{N_D}{n_i^2}\right).$$

$$4.4 \times 10^{22} - ?$$

$$n_i^2 (\text{Ge}) = 4.4 \times 10^{22} / \text{cm}^3. \quad = 0.2586 \ln\left(\frac{N_A^2}{(4.4 \times 10^{22})^2}\right)$$

$$W \propto \sqrt{\frac{1}{N_A} + \frac{1}{N_D}} \quad = 0.2586 \ln\left(\frac{(4.4 \times 10^{19})^2}{(4.4 \times 10^{22})^2}\right). \\ \propto = 0.99 \text{ eV}$$

i)  $V_0 = kT \ln\left(\frac{N_A N_D}{n_i^2}\right) \quad N_D = \text{Atomic Conc} \times \text{No: of Donor impatoms.}$

$$V_0 = 0.02586 \ln\left(\frac{(4.4 \times 10^{19})^2}{(4.4 \times 10^{22})^2}\right) = 4.4 \times 10^{22} \times 1/10^3 \\ = 4.4 \times 10^{19} / \text{cm}^3 = N_A.$$

$$= 0.74 \text{ V.}$$

ii)  $W = \sqrt{\frac{2\epsilon V_{bi}}{qV} \left(\frac{1}{N_A} + \frac{1}{N_D}\right)}$

$$= \sqrt{\frac{2\epsilon V_0}{qV} \left(\frac{2}{N_A}\right)}$$

$$= \sqrt{\frac{2 \times 1.41664 \times 10^{-12} \times 0.74 \times 2}{1.6 \times 10^{-19} \times 4.4 \times 10^{19}}}$$

$$= 77.17 \times 10^{-8} \text{ cm}$$

$$= 77.17 \text{ Å}$$

$$V_0 = 0.74 \text{ V}$$

$$\epsilon = \epsilon_0 \epsilon_r = 8.854 \times 10^{-12} \text{ F/m} \times 16$$

$$= 8.854 \times 10^{-14} \text{ F/cm}$$

$$= 1.41664 \times 10^{-12}$$

$$qV = 1.6 \times 10^{-19}$$

$$W = \sqrt{\frac{2\epsilon V_0}{\alpha r} \left( \frac{1}{N_A} + \frac{1}{N_D} \right)}$$

$$\epsilon_f = 11.7 \approx 12$$

$$= \sqrt{\frac{2 \times 8.854 \times 10^{-14} \times 1.12 \times 11.7 \left( \frac{2}{5 \times 10^{19}} \right)}{1.6 \times 10^{-19}}}$$

$$= 76.5 \text{ A}^\circ = 76.5 \times 10^{-8} \text{ cm}$$

$$= 76.5 \text{ A}^\circ$$

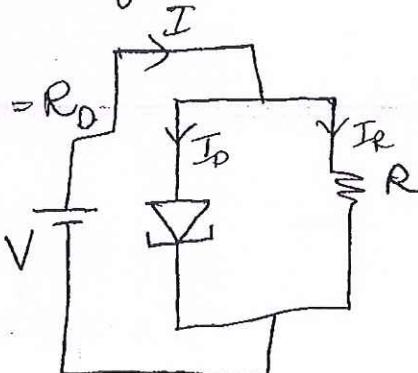
For same doping concentration, Si has less  $w$  because its atomic concentration is more.

- Q) A resistor  $R$  is placed in parallel with GaAs tunnel diode which has  $\left| \frac{dI_D}{dV} \right|_{\max} = \frac{1}{10} \text{ V}$ . Find the value of  $R$  such that

the combination does not give -ve region in  $V$ - $I$  characteristics.

$$\text{Sol: } \left| \frac{dI_D}{dV} \right|_{\max} = \frac{1}{10} \text{ V} \Rightarrow \frac{dV}{dI_D} = 10 \Omega = R_D$$

$$\frac{dI}{dV} \geq 0 \quad I = I_D + I_R$$



$$\Rightarrow R \leq \left| \frac{dv}{dI_0} \right|$$

$$\Rightarrow R \leq 10\Omega$$

### Optical Sources:

1. Wide band Continuous spectra : Ex: Incandescent lamp.
2. Monochromatic incoherent : Ex: LED
3. Monochromatic coherent : Ex: LASER

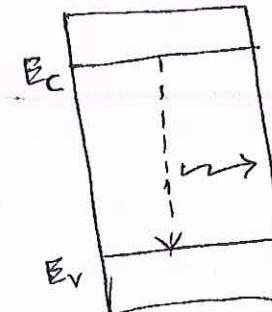
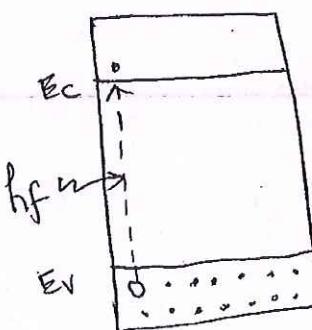
### 26/9/13 Light Emitting Diode:

→ LED is also like a normal p-n junction diode but its doping concentration is slightly greater than the normal p-n junction diode.

→ LED operates with forward bias condition

→ LED works based on stimulated absorption and spontaneous emission.

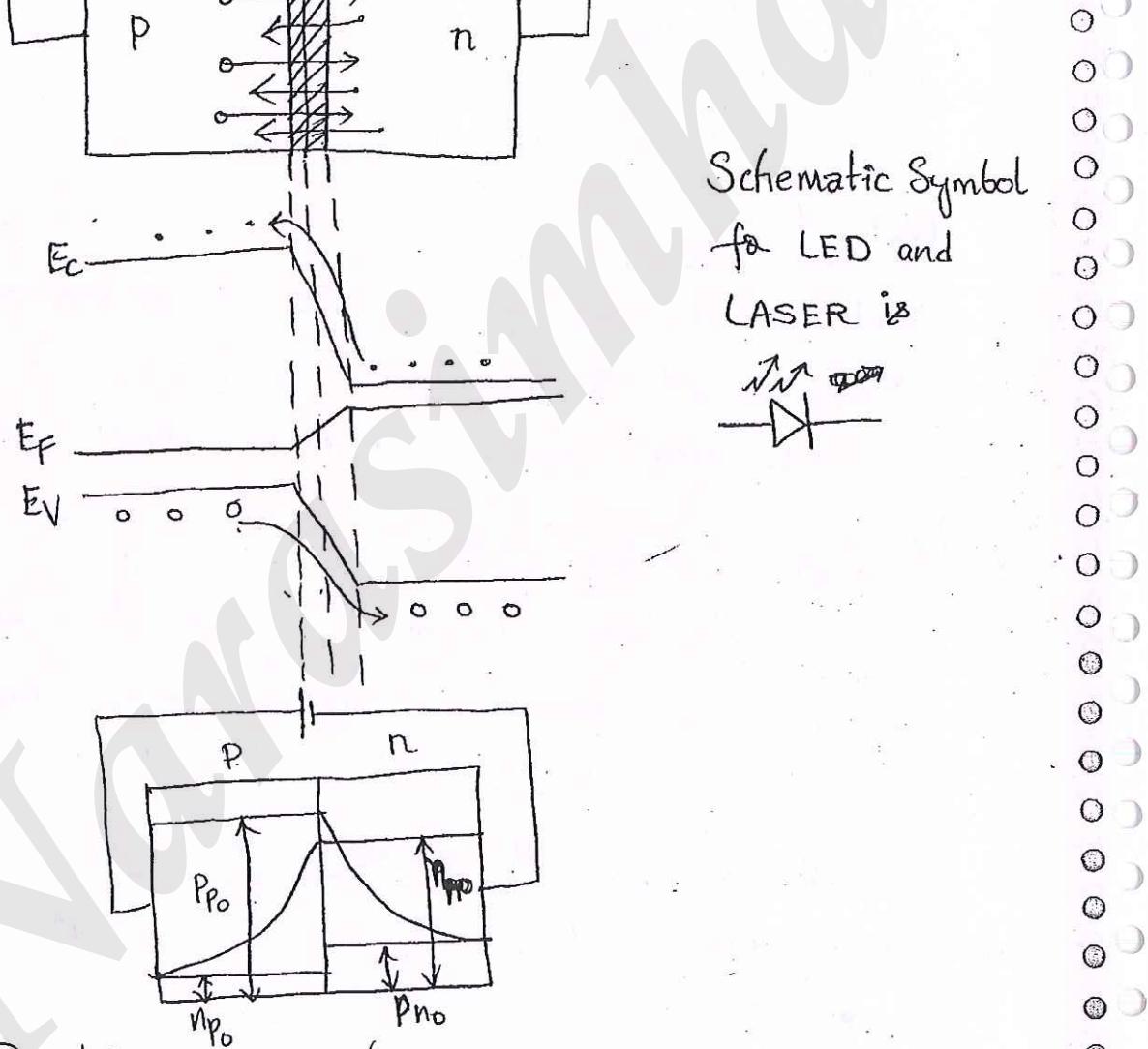
→ LED is a monochromatic incoherent light source



$$E_G = E_C - E_V = hf$$

$$\lambda = \frac{1.24}{E_G} \text{ nm}$$

$$= \frac{12400}{E_G} \text{ Å}$$



### Direct Band Gap Semiconductor:

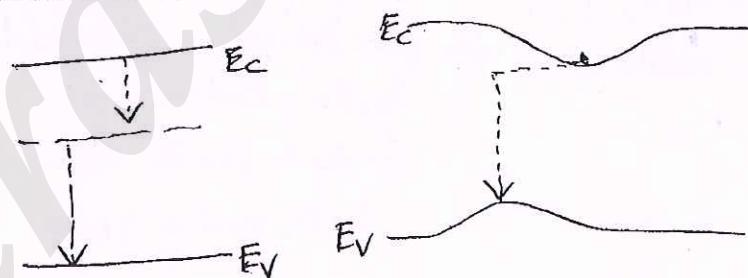
When the maximum energy of the valency band and minimum energy of the conduction band comes at the same point, those are called direct band gap semiconductors.

band and valence bands  
semiconductors.

Ex:  $\text{c}_\text{GaAs}$ ,  $\text{c}_\text{GaAsP}$ ,  $\text{GaP}$

### Indirect Bandgap Semiconductors

When the maximum energy of the valency band and minimum energy of the conduction band are not at the same point, those are called indirect bandgap semiconductors.



→ If the momentum of the  $e^-$  is not same in the conduction band and valency band, those are called indirect band gap semiconductors.

Ex: Si, Ge

LED and LASERS are made up of direct band gap semiconductors

i) Stimulated absorption

ii) Spontaneous emission

Elections don't return to  $E_V$  in only a single path, it will return in different paths. Hence beamwidth is wide and directivity is less in LED. It is an incoherent light source.

### i) Visible LED

→ Used in optical signals.

→ GaAsP, GaP

→ Made of homo junctions  
GaAs: Red

GaAsP: Red & Yellow

GaP: Red & Green

### ii) InfraRed LED

→ Used in communications

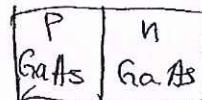
→ GaAs

→ made of double hetero junctions

### Homo junction:

P-type and n-type are made of same type of semiconductor

Internal efficiency: < 50%



### Hetero junction:

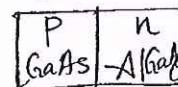
P-type is made of GaAs and n-type is made of AlGaAs

### Double hetero junction:

P-type is made of GaAs is sandwiched between

P-type AlGaAs and AlGaAs

Internal efficiency: 60 to 80%



$\tau_r$ : radiative recombination carrier lifetime

$\tau_{nr}$ : Non-radiative recombination carrier life time.

$\tau$ : Total recombination carrier life time.

$$\frac{1}{\tau} = \frac{1}{\tau_r} + \frac{1}{\tau_{nr}}$$

$$\tau = \frac{\tau_r \cdot \tau_{nr}}{\tau_r + \tau_{nr}}$$

Internal efficiency ( $\eta_{int}$ ):

$$\eta_{int} = \frac{\tau}{\tau_r}$$

Internal Power (P<sub>int</sub>):

$$P_{int} = \eta_{int} \frac{hcI}{\lambda e}$$

$h$ : Planck's constant =  $6.625 \times 10^{-34}$  J.sec

$c$ : Velocity of light =  $3 \times 10^8$  m/sec.

$I$ : Current through LED

$\lambda$ : wavelength of radiation

$e$ : Charge of the  $e^-$  =  $1.6 \times 10^{-19}$  C

Emitting Power (P<sub>e</sub>):

$$P_e = \frac{P_{int} \cdot F \cdot \eta^2}{4\eta_x^2}$$

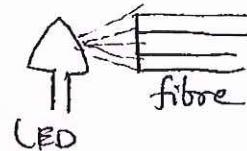
$$\eta_{ep} = \frac{P_e}{P} \times 100$$

P: Input power

$P_e$ : External power

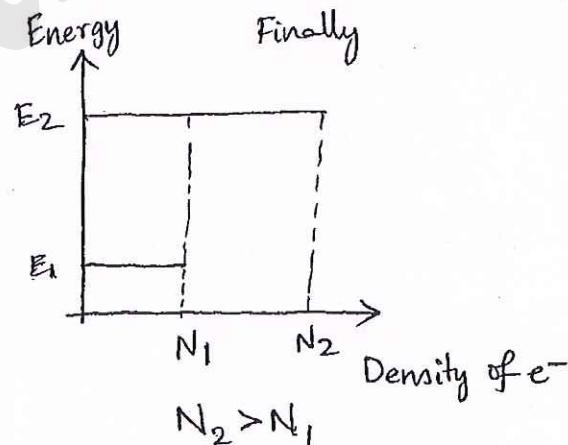
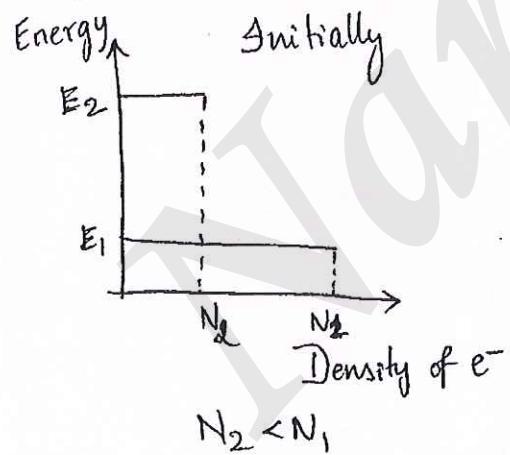
Power Conversion (a) Coupling Power = Efficiency ( $\eta_{CP}$ ):

$$\eta_{CP} = \frac{P_c}{P} \times 100 = \frac{P_c}{VI} \times 100$$



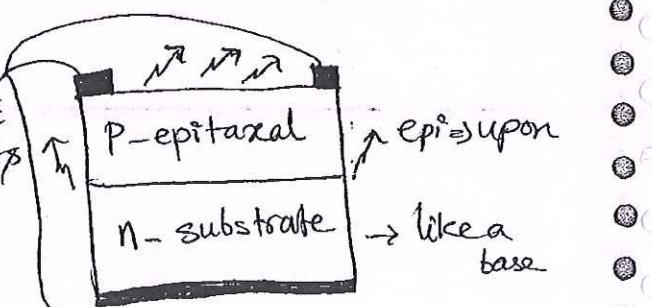
$P_c$ : Coupling Power

Population Inversion:



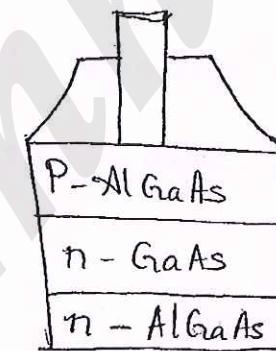
i) Planar LED:

- It has less external efficiency, directivity and radiance
- Because of the structure, it has more internal reflections and entire power is not radiated: → mostly found in embedded boards

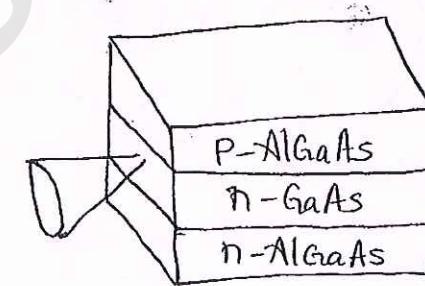


Hence, we go for double heterogenous junctions.

### 1) Surface Emitting LED:



### 2) Edge Emitting LED:

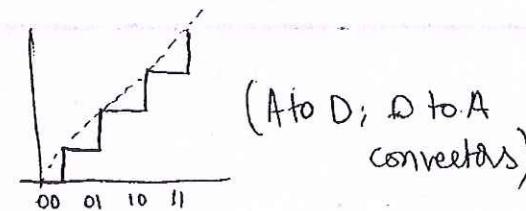


#### Advantages of LED:

- Simple to fabricate
- Low Cost
- Reliability
- Low temperature dependence
- <sup>requires</sup> Simple drive circuit
- Linearity (Lineal Conversion)

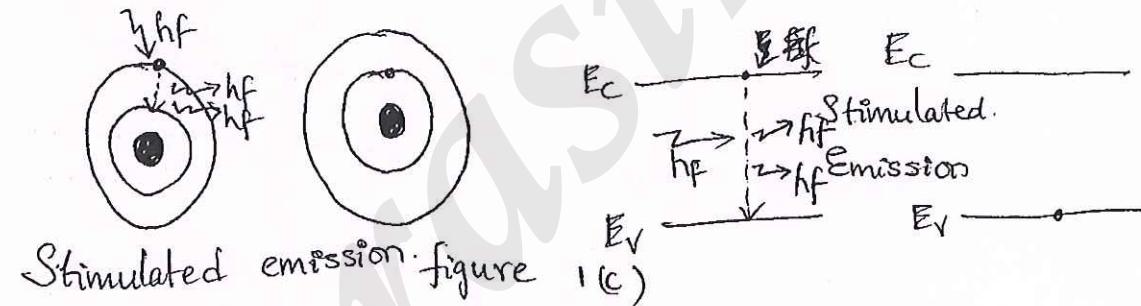
#### Drawbacks of LED:

- 1. More beamwidth
- 2. Low directivity
- 3. Harmonic distortion
- 4. Low coupling power efficiency



light source:

- LASER works based on stimulated absorption, spontaneous emission and stimulated emission.
- Beamwidth in LED is 30 to 40nm  
n n LASER is 0.1nm



LASER also works on the population inversion.

$$\frac{N_1}{N_2} = e^{+\frac{[E_2 - E_1]}{KT}} = e^{+\frac{hf}{KT}}$$

Boltzmann's relation

$$\frac{\text{Stimulated emission rate}}{\text{Spontaneous emission rate}} = \frac{B_{21} P_f}{A_{21}} = \frac{1}{\left[e^{\frac{hf}{KT}} - 1\right]}$$

$B_{21}$ : Einstein coefficient of stimulated emission rate

$A_{21}$ : Einstein coefficient of Spontaneous emission rate

$P_f$ : Spectral density

$$\frac{A_{21}}{B_{21}} = \frac{8\pi hf^3}{c^3}$$

In LASER, along with conversion of electrical energy into light energy, light amplification also takes place.

→ Mirrors are used for amplification.

which produce oscillations because of reflections.

$$\rightarrow \text{No. of longitudinal modes} = \frac{2\eta L}{c}$$

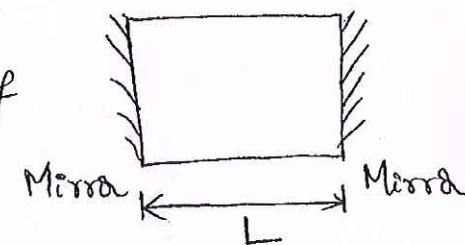
$$\rightarrow \text{Frequency of Separation} = \frac{c}{2\eta L}$$

L : Optical distance

C : Velocity of light

$\eta$  : Refractive index

→ Drawbacks of LEDs are advantages of LASER and  
Advantages of LEDs are drawbacks of LASER.



resulting in a diode emitting photons and a light output.

→ This inversion mechanism is called injection electroluminescence.

→ This device is known as Light-Emitting Diode.

→ The spectral output of an LED may have a relatively wide wavelength bandwidth b/w 30 to 40nm.

→ Photons may be emitted if an  $e^-$  and hole recombine by a direct band to band recombination process in a direct band gap material.

→ The emission wavelength is  $\lambda = \frac{hf}{E_G}$  &  $\frac{1.24}{E_G} \mu\text{m} \& \frac{12400}{E_G} \text{\AA}$   
where  $E_G$  is the bandgap energy measured in eV.

→ When voltage is applied across a p-n junction,  $e^-$  and holes are injected across the space charge region where they become excess minority carriers.

→ These excess minority carriers diffuse into the neutral semiconductor regions where they recombine with majority carriers.

→ If this recombination process is a direct band to band

giving up energy as it make a transition from the conduction band to the valency band.

- The LED photon emission is spontaneous, in that, each band to band transition is an independent event.
- This spontaneous emission process gives a spectral output of the LED with a wide bandwidth.
- If the structure and operating condition of LED are modified, the device can operate in a new mode producing a coherent spectral output with a bandwidth of wavelength less than 0.1 nm.
- This new device is a LASER diode.
- figure 1(a) shows the case, when an incident photon is absorbed, and an  $e^-$  is elevated from an energy state  $E_1$  to an energy state  $E_2$ . This process is known as stimulated or induced absorption.
- If the  $e^-$  spontaneously makes the transition back to the lower energy level with a photon being emitted, we have a spontaneous emission process as indicated on fig 1(b).

the process is called stimulated emission.

→ This stimulated emission process produced two photons.

Therefore we can have optical gain (a) amplification.

→ Emitted two photons are in phase so that the spectral output will be coherent.

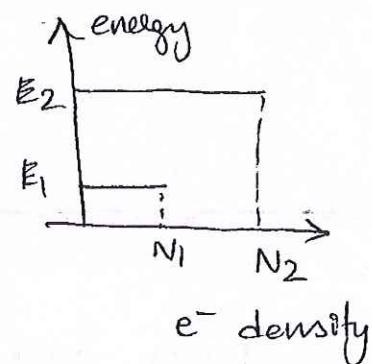
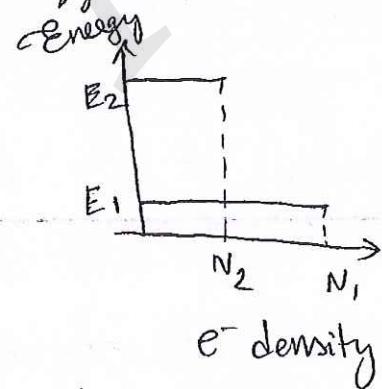
→ In thermal equilibrium, the  $e^-$  distribution in a semiconductor is determined by the fermidirac statistics.

→ If the Boltzmann's approximation applies, then we

can write

$$\frac{N_1}{N_2} = e^{\left(\frac{E_2 - E_1}{kT}\right)} = e^{\frac{hf}{kT}}$$

where  $N_1$  and  $N_2$  are the ~~energy~~  $e^-$  concentrations in the energy levels  $E_1$  and  $E_2$ , where  $E_2 > E_1$ .



where  $A_{12}$  is Einstein coefficient of stimulated emission  
spontaneous

$$R_{21} = N_2 A_{21} + N_2 P_f B_{21}$$

$$R_{12} = R_{21} \Rightarrow A_{12} N_1 P_f = N_2 A_{21} + N_2 B_{21} P_f$$

( $\because$  Generation = Recombination)

$$P_f (A_{12} N_1 - B_{21} N_2) = N_2 A_{21}$$

$$P_f = \frac{N_2 A_{21}}{A_{12} N_1 - B_{21} N_2} = \frac{\frac{A_{21}}{B_{21}}}{\frac{A_{12} N_1}{B_{21} N_2} - 1}$$

$$\text{From this, } P_f = \frac{A_{21}}{B_{21}} \left[ \frac{1}{e^{h\nu/kT} - 1} \right]$$

$\rightarrow$  The no: of photons absorbed is proportional to  $N_1$ , and  
the no: of additional photons emitted is proportional to  $N_2$

In order to achieve optical amplification (lasing action),  
we must have  $N_2 > N_1$ . This is called Population

inversion

Q) A planar LED is fabricated from GaAs which has a  
refractive index of 3.6.

a) Calculate optical power emitted into the air as a  
percentage of the internal optical power for the device

$$= \frac{P_{int} \cdot 0.68 \times 1^2}{4 \times 3.6^2}$$

$$P_e = P_{int} \cdot (0.013)$$

$$P_e = 0.013 P_{int}$$

b) Given,  $P_{int} = \frac{P}{2}$

$$P_e = \frac{P_{int} \cdot F \cdot \eta^2}{4 \eta_x d}$$

$$\eta_e = \frac{P_e}{P} \times 100$$

$$= \frac{6.559 \times 10^{-3} \times P}{P} \times 100$$

$$= 6.559 \times 10^{-1}$$

$$= 0.6559 \%$$

Q) The radiative and non radiative recombination lifetimes

of the minority carriers in the active region of a double heterojunction LED are 60 ns and 100 ns. Determine

total carrier recombination lifetime and the power internally generated within the device when the peak emission

$$= 0.625 \times \frac{6.625 \times 10^{-34} \times 3 \times 10^8 \times 40 \times 10^{-3}}{0.87 \times 10^{-6} \times 1.6 \times 10^{-19}}$$

$$\approx 3.56 \times 10^{-20} \text{ W} = 35.69 \text{ mW}$$

Q) Calculate the ratio of Stimulated emission rate to the spontaneous emission rate for an incandescent lamp operating at a temperature of 1000K. It may be assumed that average operating wavelength is 0.5 nm.

$$f = \frac{C}{\lambda} = \frac{3 \times 10^8}{5 \times 10^{-7}} = \frac{3}{5} \times 10^{15} \text{ Hz}$$

$$\left[ \frac{1}{e^{\frac{hf}{kT}} - 1} \right] = \frac{1}{\left[ e^{\frac{6.625 \times 10^{-34} \times 3/5 \times 10^{15}}{1.38 \times 10^{-20} \times 1000} - 1} \right]}$$

$$= 3.13 \times 10^{-13}$$

Q) A LASER contains a crystal length 4 cm with a refractive index of 1.78. The peak emission wavelength from the device is 0.55 nm. Determine no: of longitudinal modes, frequency of separation

$$\text{No: of longitudinal modes} = \frac{2 \times 1.78 \times 4 \times 10^{-2}}{3 \times 10^8} = 4.75 \times 10^{-10}$$

$$\eta_{CP} = \frac{P_c}{P} \times 100 = \frac{P_c}{VI} \times 100$$

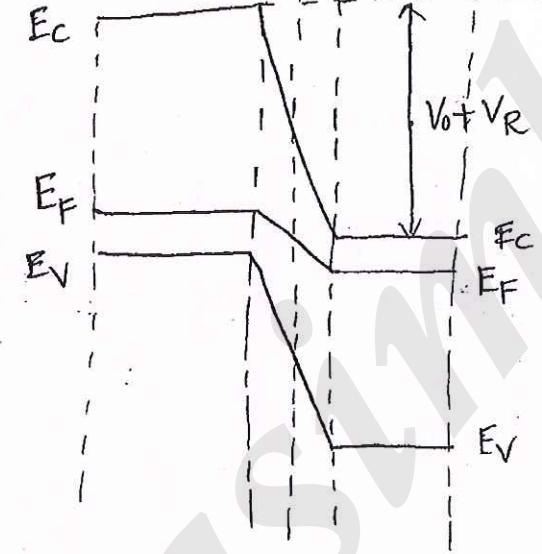
$$= \frac{190 \times 10^{-6}}{1.5 \times 25 \times 10^{-3}} \times 100$$

$$= 0.507$$

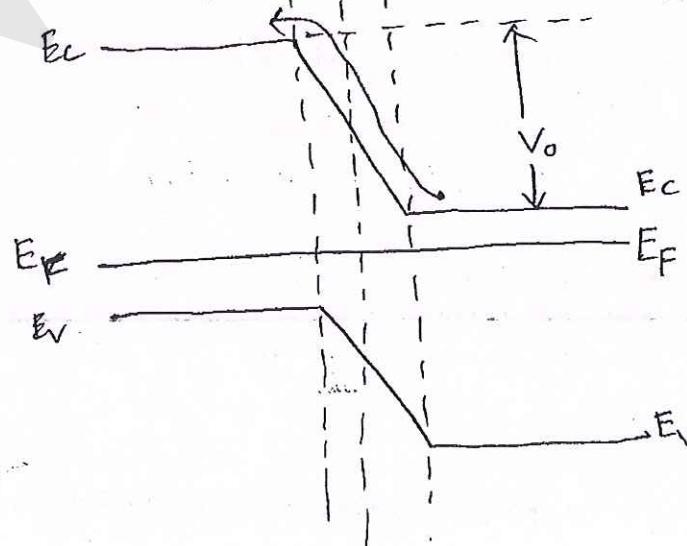
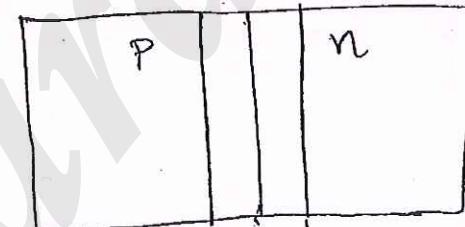
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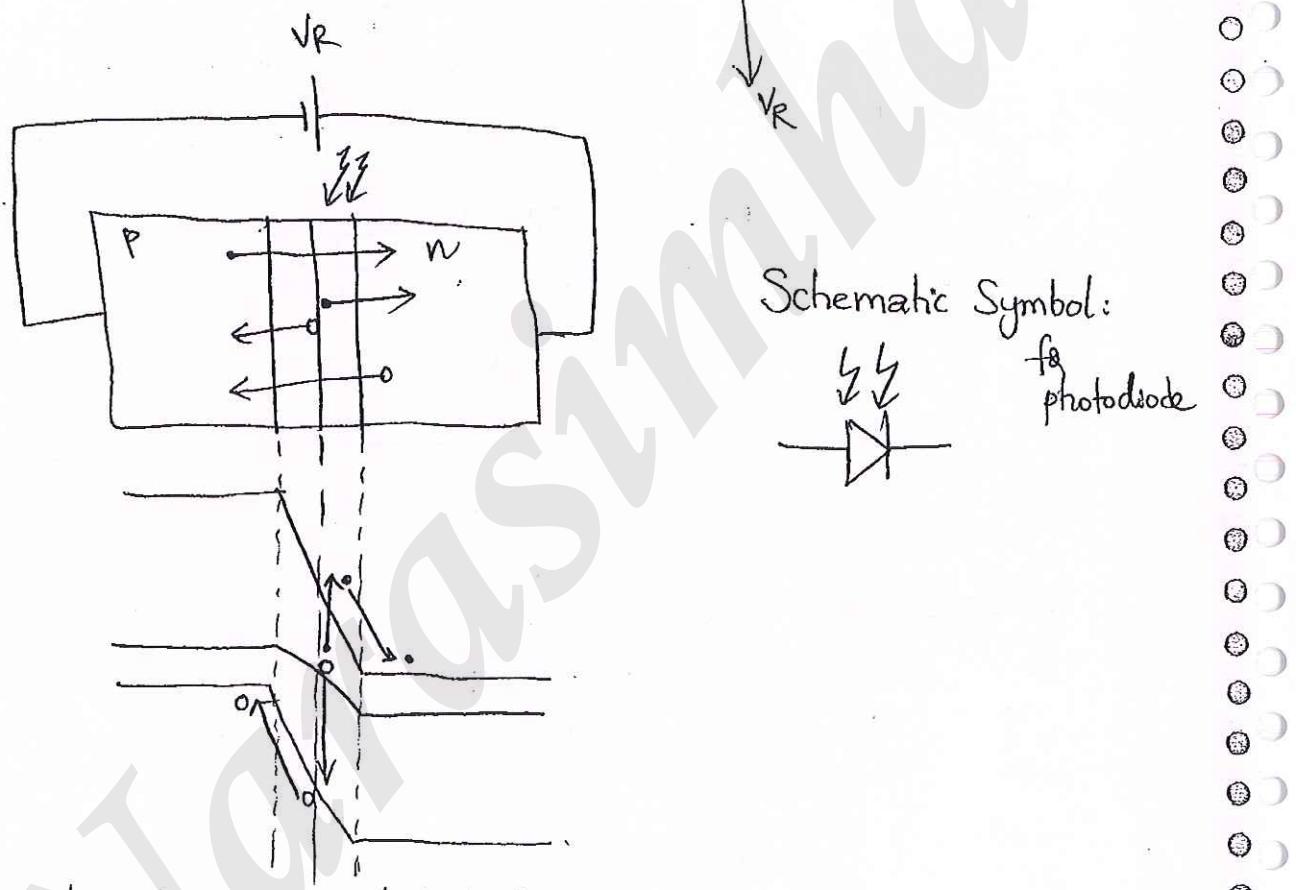
### Photo Diode:

- It always operates in reverse bias condition.
- The doping concentration should be less than normal p-n junction diode because in reverse bias condition, current is due to minority carriers. Hence we require more minority carriers which implies that doping concentration should be less. Also the light falls on the junction of the diode. Hence to absorb more light, the junction area should be more.
- \* Photo diode is also like a normal p-n junction diode. But its doping concentration is less than the normal p-n junction diode.
- \* Photo diode always operates in reverse bias

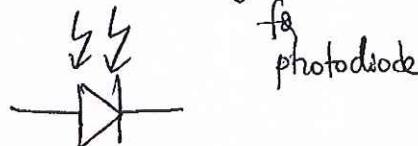


Open Circuit:  $V_J = V_o$





Schematic Symbol:



### Characteristics of a photodiode:

- 1) High Sensitivity (It should be able to detect small light signals, and produce the corresponding electrical signals)
- 2) High Fidelity (Faithful reproduction of signals at  $R_x$ )
- 3) Large Electrical Signals for the received optical light
- 4) Short response time.
- 5) Minimum noise
- 6) Stability of the performance characteristics.
- 7) Small size

$$Qe^{\alpha\eta} = \frac{no. \gamma}{\gamma P}$$

no: of incident photons

Responsivity (R):

It is the ratio of photodiode output current to the incident optical power.

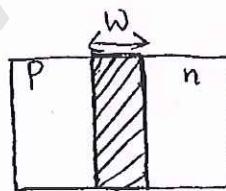
$$R = \frac{I_p}{P_0} \text{ (A/W)}$$

$$R = \frac{\eta e}{hf} = \frac{\eta e \lambda}{hc} \quad \left( \because f = \frac{c}{\lambda} \right)$$

Response time:

1. Transit time
2. RC time constant

Transit time is the time taken by the carriers to move from one side of the depletion region to other side.



p and n regions act like the plates of a capacitor

$$C_{T_0} = \frac{\epsilon A}{W}$$

$$C_T = \frac{C_{T_0}}{\left[1 + \frac{V_R}{V_0}\right]^n}$$

$n=3$  for linear junction  
 $n=2$  for abrupt junction

$p+pn \rightarrow i$  is p-type

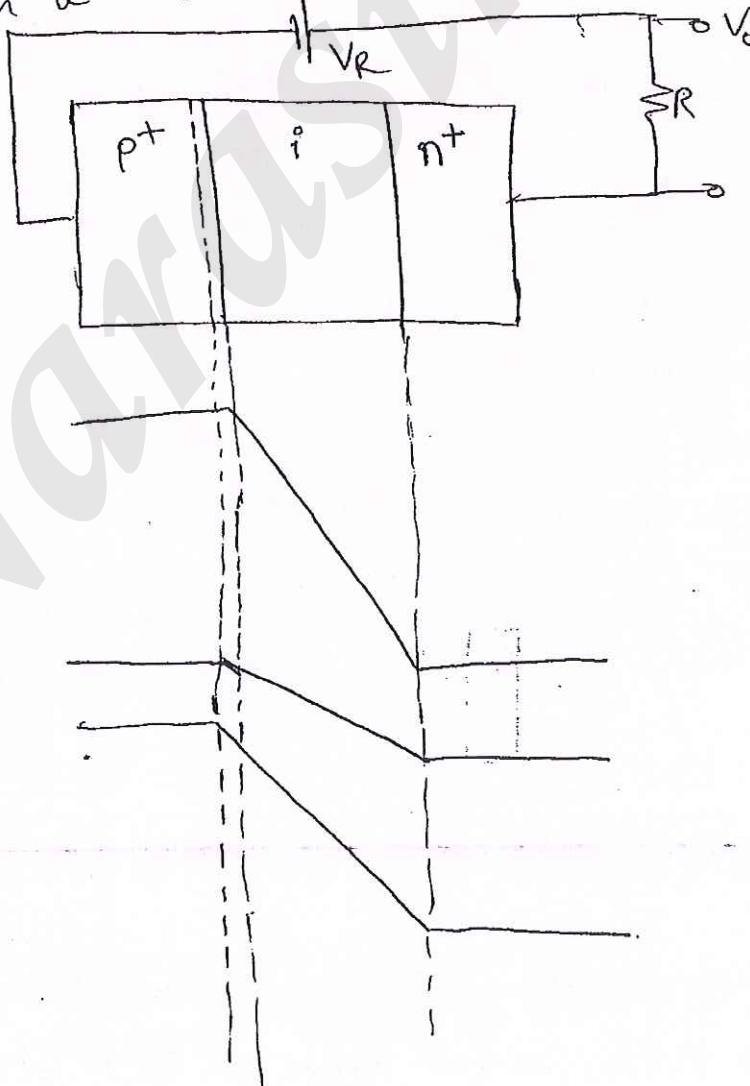
$\rightarrow p+n \rightarrow i$  is n-type

$\rightarrow$  It gives faster response time.

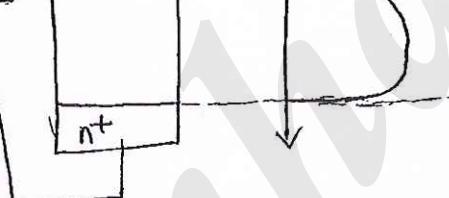
$\rightarrow$  PIN diode can also be operated in forward bias.

\*  $\rightarrow$  As the forward bias  $\uparrow$  resistance of ' $i$ '  $\downarrow$  and viceversa.

Hence it can be used as a variable ~~variable~~ resistor.



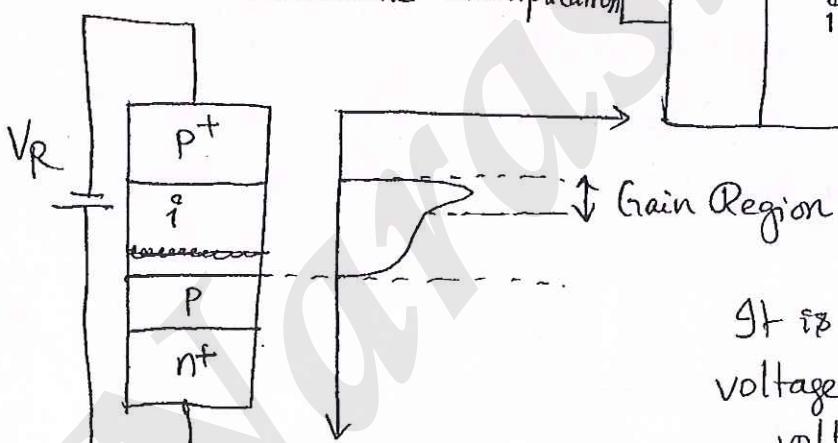
signals whereas APD converts and amplifies the signals.



## Avalanche Photodiode: (APD)

Response time:

- depends on i) Transit time
- ii) Time taken for Avalanche multiplication



It is always operated at a voltage less than the breakdown voltage.

Amplification occurs through Avalanche phenomenon multiplication

Multiplication factor (M)

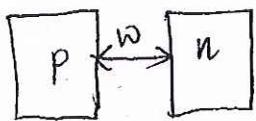
$$M = \frac{I}{I_p}$$

$I$  is the o/p current after avalanche multiplication

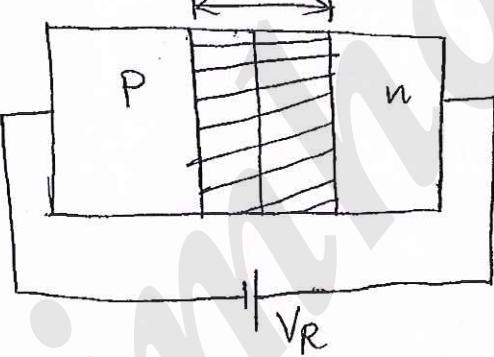
$$M \rightarrow \text{upto } 10^4$$

$I_p$  is the o/p current before avalanche multiplication.

The drawback with APD is it requires large reverse bias voltages like 100V to 400V. It is similar to phototransistor.



$$G_{T0} = \frac{EA}{W}$$



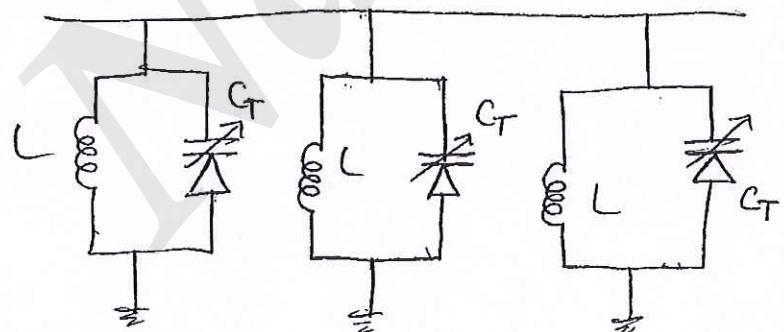
### Applications:

1. Tuned circuits
2. FM modulators
3. Automated frequency control circuits
4. Adjustable band pass filters
5. Parametric amplifiers.

$$C_T = \frac{G_{T0}}{\left[1 + \frac{V_R}{V_0}\right]^{1/n}}$$

$n = 2$  for Non-linear junction  
 $n = 3$  for linear junction

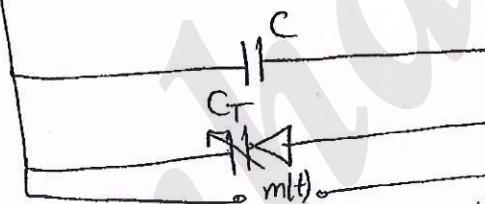
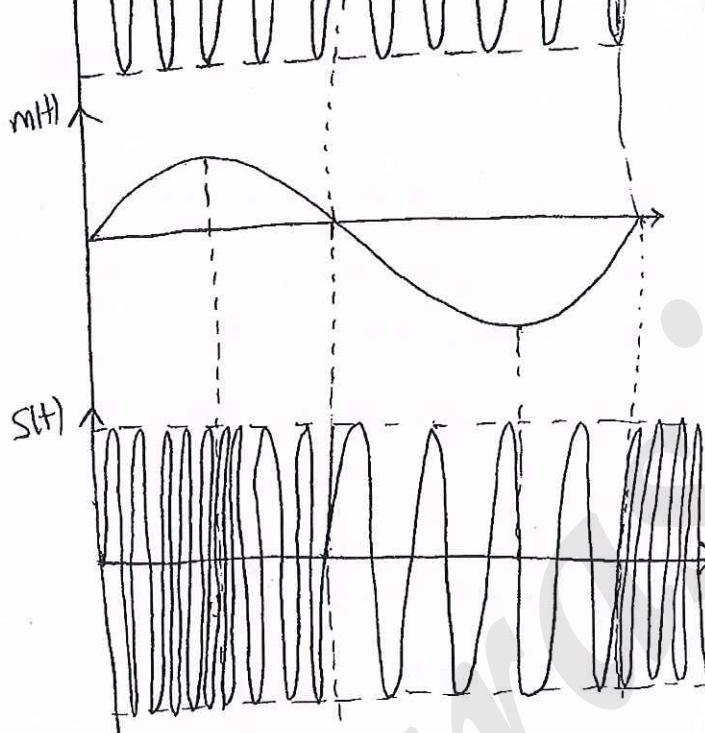
### Tuned Circuits :



$$f_0 = \frac{1}{2\pi\sqrt{LC_T}}$$

=  
FM Modulator

=  
VCO is used in direct method of FM modulation.

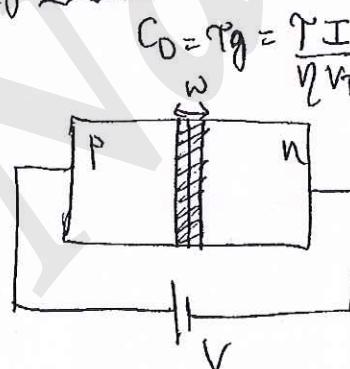


Choose the component values  
such that it generates frequency  
of 100 kHz.

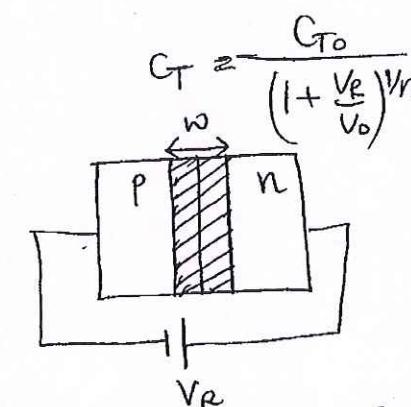
$$G_T = \frac{G_{T0}}{\left[1 + \frac{V_R}{V_0}\right]^n} \quad \begin{matrix} \text{(applicable} \\ \text{only for} \\ \text{reverse bias} \\ \text{case)} \end{matrix}$$

$$V_R \uparrow \Rightarrow G_T \downarrow \Rightarrow C_V \downarrow \Rightarrow f \uparrow$$

### Schottky Diode:



$$C_D = \frac{qI}{\eta V_T} = \frac{T I}{\eta k T}$$

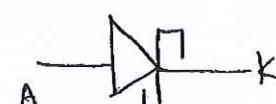


$$G_T = \frac{G_{T0}}{\left(1 + \frac{V_R}{V_0}\right)^n}$$

These capacitances effect increases at  
higher frequencies which is not required.

Schematic Symbol of Schottky diode

(In this  $C_D$  and very small  $G_T$ )



\* Schottky is a diode which is formed with metal and semiconductor junction.

→ In schottky diodes, diffusion capacitance is almost all zero and it offers very small transition capacitance.  
∴ It can be used as a high speed switch

→ The switching speed of the diode depends on transition and diffusion capacitors.

→ In schottky diode, current is due to only majority carriers. Therefore, schottky diode is also called majority carrier diode or hot carrier diode.

→ Generally used metals in Schottky diode are Molybdenum, Platinum and Tungsten.

→ To form a schottky diode between metal and n-type semiconductor, the work function of the metal should be greater than the semiconductor.

→ Schottky diodes also forming b/n metal and p-type semiconductor where the work function of the semiconductor should be greater than the metal.

$$Q_e = \frac{\text{no: of } e^- \text{ collected}}{\text{no: of photons incident}}$$

$$\eta \& Q_e = \frac{1.2 \times 10^{11}}{3 \times 10^{11}} = \frac{1.2}{3} = 0.4 \Rightarrow 40\%$$

$$R = \frac{\eta e}{hf} = \frac{\eta e \lambda}{hc} = \frac{0.4 \times 1.6 \times 10^{-19} \times 0.85 \times 10^{-6}}{6.625 \times 10^{-34} \times 3 \times 10^8}$$

$$= 0.027 \times 10 = 0.27 \text{ A/W}$$

$\Rightarrow$  A photodiode has a  $Q_e$  of 65%. When photons of energy  $1.5 \times 10^{-19} \text{ J}$  are incident upon it.

- At what wavelength, is the photodiode operating
- Calculate the incident optical power required to obtain a photo current of 2.5 mA

$$\text{Given } \eta = 0.65$$

$$R = \frac{\eta e}{hf}$$

$$\Rightarrow R = \frac{0.65 \times 1.6 \times 10^{-19}}{1.5 \times 10^{-19}}$$

$$\approx 0.693$$

$$\Rightarrow \lambda = \frac{hc}{E} = \frac{hc}{\frac{hf}{\lambda}} = \frac{hc}{\frac{hf}{\frac{hc}{E}}} = \frac{6.625 \times 10^{-34} \times 3 \times 10^8}{1.5 \times 10^{-19}}$$

$$\Rightarrow \lambda = 1.325 \mu\text{m}$$

$$\frac{\eta e \lambda}{hc} = R$$

$$\Rightarrow \lambda = \frac{R \times h \times c}{\eta e}$$

~~= 0.693~~

$$E = hf = \frac{hc}{\lambda} \Rightarrow \lambda = \frac{hc}{E}$$

$$= \frac{6.625 \times 10^{-34} \times 3 \times 10^8}{1.5 \times 10^{-19}}$$

detection of radiation at a wavelength of  $0.9 \mu\text{m}$ . When the incident optical power is  $0.5 \mu\text{W}$ , and the output current from the device after Avalanche gain is  $11 \mu\text{A}$ . Determine the Multiplication factor of the photo diode under these conditions.

$$\eta_e = \eta = 0.8$$

$$R = \frac{\eta_e}{hf} = \frac{\eta_e \lambda}{hc} = \frac{0.8 \times 1.6 \times 10^{-19} \times 0.9 \times 10^{-6}}{6.625 \times 10^{-34} \times 3 \times 10^8} \\ = 0.5796 \text{ A/W}$$

$$R = \frac{I_p}{P}$$

$$\Rightarrow I_p = R \times P = 0.5796 \times 0.5 \times 10^{-6} \\ = 0.2898 \mu\text{A}$$

$$M = \frac{I}{I_p} = \frac{11}{0.2898} = 37.956$$

Q) Determine the  $C_T$  of an abrupt junction varactor diode

at a reverse bias voltage of  $4.2 \text{ V}$  given  $G_{T0} = 80 \text{ pF}$

and  $V_0 = 0.7 \text{ V}$ .

$$C_T = \frac{G_{T0}}{\left(1 + \frac{V_R}{V_0}\right)^{1/n}} = \frac{80 \text{ pF}}{\left(1 + \frac{4.2}{0.7}\right)^{1/2}} = 30.237 \text{ pF}$$

$= 5.16 \text{ pF}$